Hewlett Packard Enterprise

HPE ProLiant DL325 Gen10 Plus v2 Server Maintenance and Service Guide

Part Number: 30-233C53C9-005
Published: April 2022
Edition: 5

HPE ProLiant DL325 Gen10 Plus v2 Server Maintenance and Service Guide

Abstract
This document is for the person who installs, administers, and troubleshoots servers and storage systems. Hewlett Packard Enterprise assumes you are qualified in the servicing of computer equipment, trained in recognizing hazards in products with hazardous energy levels, and are familiar with the weight and stability precautions for rack installations.

Part Number: 30-233C53C9-005
Published: April 2022
Edition: 5

Notices

Acknowledgments

Revision history

Part number	Publication date	Edition	Summary of changes
30-233C53C9-005	April 2022	5	

Table of contents

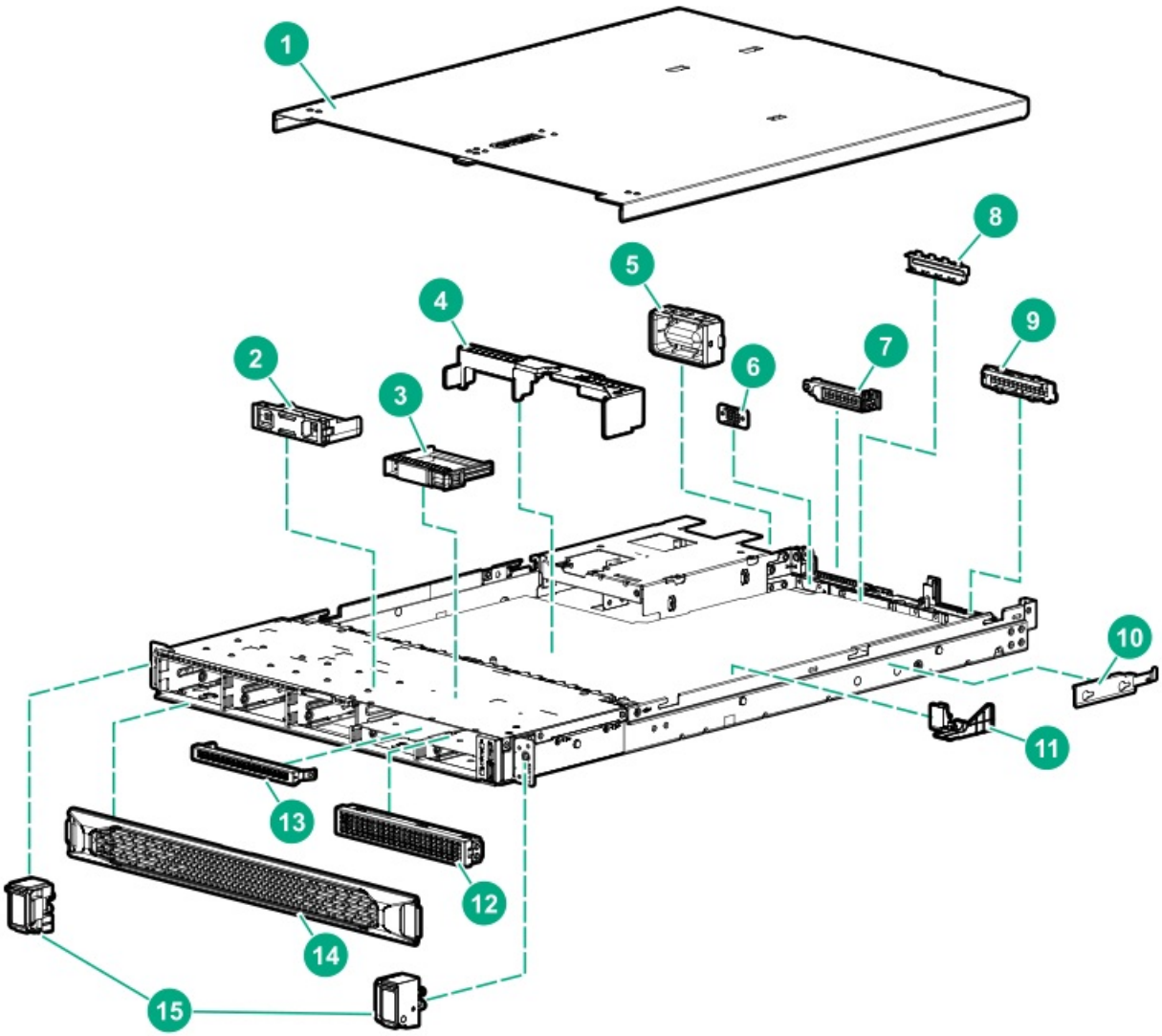
Illustrated parts catalog

This chapter lists the hardware spare parts supported by the server.

Mechanical components

Hewlett Packard Enterprise continually improves and changes product parts. For complete and current supported spare parts information, see the Hewlett Packard Enterprise PartSurfer website:

https://www.hpe.com/info/partssurfer



Item	Description
1	Access panel spare part
2	LFF drive blank spare part
3	SFF drive blank spare part
4	Air baffle spare part
5	Power supply blank spare part
6	Serial port blank spare part
7	Low-profile retainer bracket spare part
8	Quad NIC port blank spare part
9	OCP NIC adapter blank spare part
10	Full-height card retainer spare part
11	Energy pack holder spare part
12	Universal media bay blank spare part
13	Optical drive blank spare part for the LFF chassis
14	Front bezel spare part

Item	Description
15	Chassis ears spare part
15	Rack rails spare part
16	Cable management arm spare part [1]
17	Rack rails spare part [1]

[1] Not shown

Access panel spare part

Customer self repair: **Mandatory**

Description	Spare part number
Access panel	P40842-001

For more information on the removal and replacement procedures, see Removing and replacing the access panel .

Drive blank spare parts

Customer self repair: **Mandatory**

Description	Spare part number
LFF drive blank	827363-001
SFF drive blank	670033-001

For more information on the removal and replacement procedures, see Removing and replacing a drive blank.

Miscellaneous plastic spare parts

Customer self repair: **Mandatory**

Description	Spare part number
• Air baffle • Energy pack holder	P23255-001

For more information on the removal and replacement procedures, see:

- Removing and replacing the air baffle
- Removing and replacing the energy pack holder

Miscellaneous blank spare parts

Customer self repair: **Mandatory**

Description	Spare part number
• Optical drive blank for the LFF chassis • Universal media bay blank • OCP NIC adapter blank	P23254-001 [1]
Quad NIC port blank	P19929-001
Serial port blank	P40857-001
Power supply blank	775423-001 [1]

[1] This is a miscellaneous blank spare kit; only the component blanks listed in this table are used in this server.

For more information on the removal and replacement procedures, see:

- Removing and replacing the optical drive blank
- Removing and replacing the universal media bay blank
- Removing and replacing the OCP NIC adapter blank
- Removing and replacing the quad NIC port blank
- Removing and replacing the serial port blank
- Removing and replacing a power supply blank

Low-profile retainer bracket spare part

Customer self repair: **Mandatory**

Description	Spare part number
Low-profile retainer bracket for the secondary riser	875537-001

For more information on the removal and replacement procedures, see Removing and replacing the low-profile retainer bracket .

Full-height card retainer spare part

Customer self repair: **Optional**

Description	Spare part number
Full-height card retainer	875540-001

For more information on the removal and replacement procedures, see Removing and replacing the full-height card retainer .

Front bezel spare part

Customer self repair: **Mandatory**

Description	Spare part number
Front bezel	P22815-001

For more information on the removal and replacement procedures, see Removing and replacing the front bezel.

Chassis ears spare part

Customer self repair: **Mandatory**

Description	Spare part number
Chassis ears (left and right)—This spare part includes a set of labels for the server model number and drive configuration.	P40843-001

For more information on the removal and replacement procedures, see Removing and replacing the chassis ears .

Cable management arm spare part

Customer self repair: **Mandatory**

Description	Spare part number
Cable management arm (CMA)	P38900-001

For more information on the removal and replacement procedures, see Removing and replacing the cable management arm .

Rack rails spare part

Customer self repair: **Mandatory**

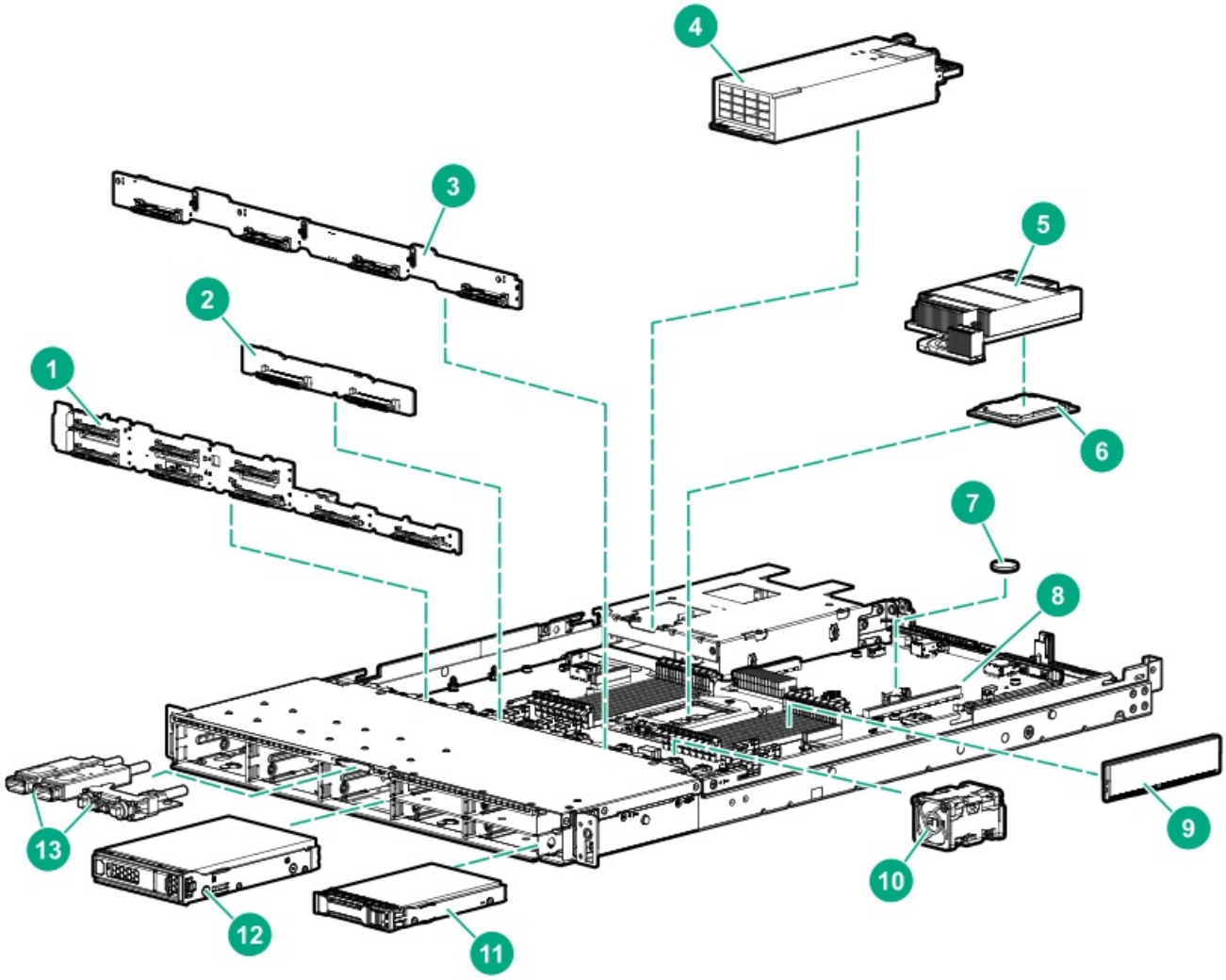
Description	Spare part number
Rack rails	P38898-001

For more information on the removal and replacement procedures, see Removing and replacing the rack rails.

System components

Hewlett Packard Enterprise continually improves and changes product parts. For complete and current supported spare parts information, see the Hewlett Packard Enterprise PartSurfer website:

https://www.hpe.com/info/partssurfer



Item	Description
1	8 SFF drive backplane spare parts
2	2 SFF U.2 NVMe drive backplane spare parts
3	4 LFF drive backplane spare part
4	Power supply spare parts
5	Heatsink spare part
6	Processor spare parts
7	System battery spare part
8	System board assembly spare part
9	DIMM spare parts
10	Fan spare parts
11	SFF drive For more information on the removal and replacement procedures, see Removing and replacing a hot-plug drive.

Item	Description
12	LFF drive For more information on the removal and replacement procedures, see Removing and replacing a hot-plug drive.
13	Front I/O assembly spare part
14	Drive cable spare parts [1]

[1] Not shown

Drive backplane spare parts

Customer self repair: **Optional**

Description	Spare part number
4 LFF SAS/SATA drive backplane	P40451-001
2 SFF SAS/SATA/U.2 NVMe drive backplane	P40859-001
2 SFF SAS/SATA/U.3 NVMe drive backplane	P39783-001
8 SFF SAS/SATA drive backplane	P31227-001
8 SFF SAS/SATA/U.2 NVMe drive backplane	P31225-001
8 SFF SAS/SATA/U.3 NVMe drive backplane	P40445-001

For more information on the removal and replacement procedures, see:

- Removing and replacing the 4 LFF drive backplane
- Removing and replacing the 2 SFF drive backplane
- Removing and replacing the 8 SFF drive backplane

Power supply spare parts

Customer self repair: **Mandatory**

Description	Spare part number
HPE 500 W Flex Slot Platinum Hot-plug Low Halogen Power Supply	866729-001
HPE 800 W Flex Slot Platinum Hot-plug Low Halogen Power Supply	P39385-001
HPE 800 W Flex Slot Titanium Hot-plug Low Halogen Power Supply	866793-001
HPE 800 W Flex Slot Universal Hot-plug Low Halogen Power Supply	866727-001
HPE 800 W Flex Slot -48 VDC Hot-plug Low Halogen Power Supply	866728-001
HPE 1600 W Flex Slot Platinum Hot-plug Low Halogen Power Supply	P39384-001

For more information on the removal and replacement procedures, see Removing and replacing a Flexible Slot power supply .

Heatsink spare part

Customer self repair: **Optional**

Description	Spare part number
High-performance heatsink	P22766-001

For more information on the removal and replacement procedures, see Removing and replacing a heatsink.

Processor spare parts

Customer self repair: **Optional**

Description	Spare part number
AMD EPYC 7232P, 3.10 GHz, 8C, 120 W	P22808-001
AMD EPYC 72F3, 3.70 GHz, 8C, 180 W	P39063-001
AMD EPYC 7313P, 3.00 GHz, 16C, 155 W	P39067-001
AMD EPYC 7343, 3.20 GHz, 16C, 190 W	P39054-001
AMD EPYC 7373X, 3.05 GHz, 16C, 240 W	P46981-001
AMD EPYC 73F3, 3.50 GHz, 16C, 240 W	P39064-001
AMD EPYC 7413, 2.65 GHz, 24C, 180 W	P39055-001
AMD EPYC 7443P, 2.85 GHz, 24C, 200 W	P39068-001
AMD EPYC 7453, 2.75 GHz, 28C, 225 W	P39056-001
AMD EPYC 7473X, 2.80 GHz, 24C, 240 W	P46980-001
AMD EPYC 74F3, 3.20 GHz, 24C, 240 W	P39065-001
AMD EPYC 7513, 2.60 GHz, 32C, 200 W	P39058-001
AMD EPYC 7543P, 2.80 GHz, 32C, 225 W	P39069-001
AMD EPYC 7573X, 2.80 GHz, 32C, 280 W	P46979-001
AMD EPYC 75F3, 2.95 GHz, 32C, 280 W	P39066-001
AMD EPYC 7643, 2.30 GHz, 48C, 225 W	P39489-001
AMD EPYC 7663, 2.00 GHz, 56C, 240 W	P39060-001
AMD EPYC 7713P, 2.00 GHz, 64C, 225 W	P39070-001
AMD EPYC 7763, 2.45 GHz, 64C, 280 W	P39062-001
AMD EPYC 7773X, 2.20 GHz, 64C, 280 W	P46977-001

For more information on the removal and replacement procedures, see Removing and replacing a processor.

System battery spare part

Customer self repair: **Mandatory**

Description	Spare part number
3.3-V lithium battery coin (CR2032)	319603-001

For more information on the removal and replacement procedures, see Removing and replacing the system battery .

System board assembly spare part

Customer self repair: **Optional**

Description	Spare part number
System board assembly includes: • System board • System board handle • Metal subpan • OCP NIC adapter left and right guide rails	P40841-001

For more information on the removal and replacement procedures, see Removing and replacing the system board assembly .

DIMM spare parts

Customer self repair: **Mandatory**

Description	Spare part number
8 GB, single-rank x8 PC4-3200AA-R	P20499-001
16 GB, single-rank x4 PC4-3200AA-R	P20500-001
16 GB, dual-rank x8 PC4-3200AA-R	P20501-001
32 GB, single-rank x4 PC4-3200AA-R	P39381-001
32 GB, dual-rank x4 PC4-3200AA-R	P20503-001
32 GB, dual-rank x8 PC4-3200AA-R	P20502-001
64 GB, dual-rank x4 PC4-3200AA-R	P20504-001
128 GB, quad-rank x4 PC4-3200AA-L	P20505-001
256 GB, octal-rank x4 PC4-3200AA-L 3DS	P20506-001

For more information on the removal and replacement procedures, see Removing and replacing a DIMM.

Fan spare parts

Customer self repair: **Mandatory**

Description	Spare part number
High-performance fan (dual-rotor)	P40844-001
Standard fan (single-rotor)	P22813-001

For more information on the removal and replacement procedures, see Removing and replacing a fan.

Front I/O assembly spare part

Customer self repair: **Mandatory**

Description	Spare part number
Front I/O assemblies for the LFF and SFF drive configurations	P40845-001

For more information on the removal and replacement procedures, see Removing and replacing the front I/O assembly .

Drive cable spare parts

Customer self repair: **Mandatory**

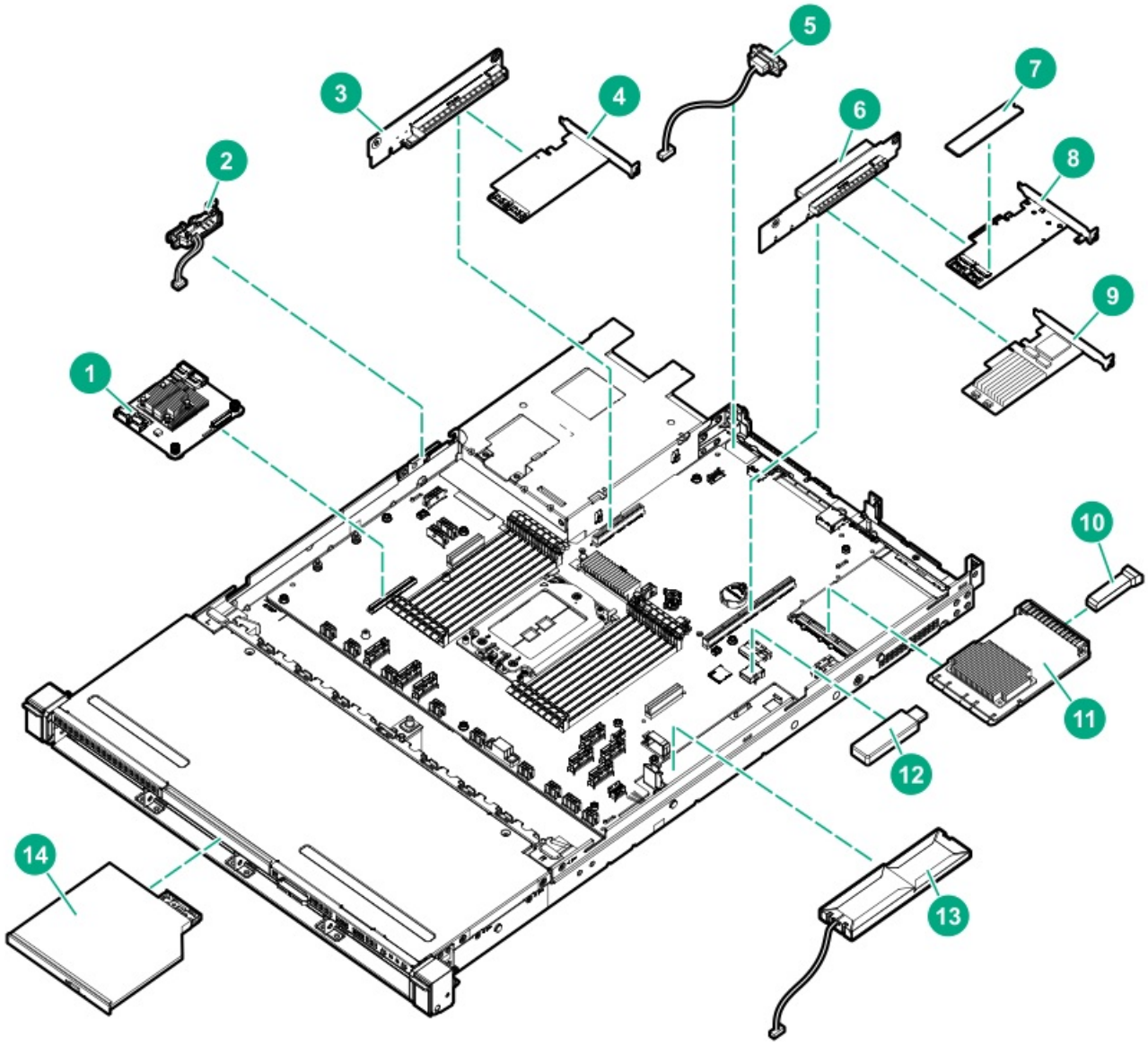
Description	Spare part number
4 LFF/8 SFF drive cable spare kit, includes: • 4 LFF drive power cable • 8 SFF drive power cable • Mini-SAS Y-cable for system board connection	P40846-001
2 SFF drive power cable	P23256-001 [1]
Miscellaneous cable spare kit, includes: • 2 SFF SlimSAS cable for onboard SATA connection • Optical drive-M.2 SSD SATA splitter cable	P40847-001
2 SFF U.3 drive cable spare kit, includes: • Mini-SAS cable to type-a Gen10 controller port 3 • Mini-SAS cable to type-a Gen10 controller port 1 • Mini-SAS cable for type-p Gen10 controller	P40850-001
2 SFF U.3 drive cable spare kit, includes: • Mini-SAS cable to type-a Gen10 controller port 3 • Mini-SAS cable to type-a Gen10 controller port 1 • Mini-SAS cable for type-p Gen10 controller	P40851-001
8 SFF SAS/SATA drive cable spare kit for type-a Gen10 controller, includes: • Box 1 port 1 Mini-SAS cable • Box 2 port 2 Mini-SAS cable	P40849-001
8 SFF SAS/SATA drive cable spare kit for type-p Gen10 controller, includes: • Box 1 port 1 Mini-SAS cable • Box 2 port 2 Mini-SAS cable	P40848-001
8 SFF U.2/U.3 drive cable spare kit for system board connections, includes: • Box 1 port 1 SlimSAS cable • Box 1 port 2 SlimSAS cable • Box 1 port 3 SlimSAS cable • Box 2 port 4 SlimSAS cable	P40852-001
8 SFF U.2/U.3 drive cable spare kit for type-a Gen10 Plus tri-mode controller, includes: • Box 1 port 1 SlimSAS Y-cable • Box 1 port 2 SlimSAS Y-cable	P40854-001
8 SFF U.2/U.3 drive cable spare kit for type-a Gen10 Plus tri-mode controller, includes: • Box 1 ports 1–2 SlimSAS Y-cable • Box 1 ports 3–4 SlimSAS Y-cable	P40856-001
8 SFF U.2/U.3 drive cable spare kit for type-p Gen10 Plus tri-mode controller, includes: • Box 1 port 1 SlimSAS cable • Box 1 port 2 SlimSAS cable • Box 1 port 3 SlimSAS cable	P40853-001
8 SFF U.2/U.3 drive cable spare kit for type-p Gen10 Plus tri-mode controller, includes: • Box 1 ports 1–2 SlimSAS Y-cable • Box 1 ports 3–4 SlimSAS Y-cable	P40855-001

[1] This is a miscellaneous cable spare kit; only the 2 SFF drive power cable is used in this server.

Server options

Hewlett Packard Enterprise continually improves and changes product parts. For complete and current supported spare parts information, see the Hewlett Packard Enterprise PartSurfer website:

https://www.hpe.com/info/partssurfer



Item	Description
1	Type-a modular storage controller spare parts (AROC)
2	Chassis intrusion detection switch spare part
3	Secondary riser board spare part
4	Type-p PCIe plug-in storage controller spare parts
5	Serial port cable spare part
6	Primary riser board spare part
7	M.2 SSD spare part For more information on the removal and replacement procedures, see • Removing and replacing the M.2 SATA SSD from the add-in card • Removing and replacing the M.2 NVMe SSD from the HPE NS204i-p NVMe OS Boot Device
8	M.2 SATA SSD add-in card spare part
9	HPE NS204i-p NVMe OS Boot Device spare part

Item	Description
10	Transceiver spare part For more information on the removal and replacement procedures, see Removing and replacing a transceiver.
11	OCP NIC 3.0 adapter spare part For more information on the removal and replacement procedures, see Removing and replacing the OCP NIC 3.0 adapter.
12	Internal USB device spare part For more information on the removal and replacement procedures, see Removing and replacing an internal USB device.
13	Energy pack spare part
14	Optical drive spare part For more information on the removal and replacement procedures, see: • Removing and replacing the LFF optical drive • Removing and replacing the SFF optical drive
15	OCP NIC 3.0 x16 upgrade cable spare part [1]
16	Trusted Platform Module 2.0 Gen10 Plus spare part [1]

[1] Not shown

Storage controller spare parts

Customer self repair: **Mandatory**

Description	Spare part number
HPE Gen10 Plus tri-mode type-a controllers	
HPE MR216i-a Gen10 Plus Controller	P28348-001
HPE MR416i-a Gen10 Plus Controller	P28335-001
HPE SR416i-a Gen10 Plus Controller	P13928-001
HPE Gen10 Plus tri-mode type-p controllers	
HPE MR216i-p Gen10 Plus Controller	P28336-001
HPE MR416i-p Gen10 Plus Controller	P17303-001
HPE SR932i-p Gen10 Plus Controller	P18875-001
HPE Gen10 type-a controllers	
HPE Smart Array E208i-a SR Gen10 Controller	871039-001
HPE Smart Array P408i-a SR Gen10 Controller	871040-002
HPE Smart Array P816i-a SR Gen10 Controller	871041-002
HPE Gen10 type-p controllers	
HPE Smart Array E208e-p SR Gen10 Controller	836267-001
HPE Smart Array E208i-p SR Gen10 Controller	836266-001
HPE Smart Array P408e-p SR Gen10 Controller	836270-001
HPE Smart Array P408i-p SR Gen10 Controller	836269-001

For more information on the removal and replacement procedures, see:

- Removing and replacing a type-a storage controller
- Removing and replacing an expansion card

Chassis intrusion detection switch spare part

Customer self repair: **Mandatory**

Description	Spare part number
Chassis intrusion detection switch	P23687-001

For more information on the removal and replacement procedures, see Removing and replacing the chassis intrusion detection switch .

Riser board spare parts

Customer self repair: **Optional**

Description	Spare part number
Primary riser board	P20155-001
Secondary riser board	P20156-001

For more information on the removal and replacement procedures, see:

- Removing and replacing the primary riser board
- Removing and replacing the secondary riser board

M.2 SATA SSD add-in card spare part

Customer self repair: **Mandatory**

Description	Spare part number
M.2 SATA SSD add-in card	882359-001

For more information on the removal and replacement procedures, see Removing and replacing the M.2 SATA SSD add-in card .

HPE NS204i-p NVMe OS Boot Device spare parts

Customer self repair: **Mandatory**

Description	Spare part number
HPE NS204i-p NVMe OS Boot Device	P14379-001
480 GB NVMe x4 RI M.2 22110 DS SSD	P24886-001

For more information on the removal and replacement procedures, see:

- Removing and replacing the boot device
- Removing and replacing a boot device drive

Energy pack spare part

Customer self repair: **Mandatory**

Description	Spare part number
HPE Smart Storage Battery, 12W, 230 mm cable	878641-001

For more information on the removal and replacement procedures, see Removing and replacing the energy pack.

Serial port cable spare part

Customer self repair: **Mandatory**

Description	Spare part number
Serial port cable	875571-001

For more information on the removal and replacement procedures, see Removing and replacing the serial port cable .

OCP NIC 3.0 x16 upgrade cable spare part

Customer self repair: **Mandatory**

Description	Spare part number
OCP NIC 3.0 x16 upgrade cable kit	P23751-001 [1]

[1] This is a miscellaneous cable spare kit; only the OCP NIC 3.0 x16 upgrade cable is used in this server.

Trusted Platform Module 2.0 Gen10 Plus spare part

Customer self repair: **No**

Description	Spare part number
Trusted Platform Module (TPM) 2.0 Gen10 Plus	P23625-001

For more information, see HPE Trusted Platform Module 2.0 Gen10 Plus option .

Customer self repair

Hewlett Packard Enterprise products are designed with many Customer Self Repair (CSR) parts to minimize repair time and allow for greater flexibility in performing defective parts replacement. If during the diagnosis period Hewlett Packard Enterprise (or Hewlett Packard Enterprise service providers or service partners) identifies that the repair can be accomplished by the use of a CSR part, Hewlett Packard Enterprise will ship that part directly to you for replacement. There are two categories of CSR parts:

- **Mandatory**—Parts for which customer self repair is mandatory. If you request Hewlett Packard Enterprise to replace these parts, you will be charged for the travel and labor costs of this service.
- **Optional**—Parts for which customer self repair is optional. These parts are also designed for customer self repair. If, however, you require that Hewlett Packard Enterprise replace them for you, there may or may not be additional charges, depending on the type of warranty service designated for your product.

NOTE: Some Hewlett Packard Enterprise parts are not designed for customer self repair. In order to satisfy the customer warranty, Hewlett Packard Enterprise requires that an authorized service provider replace the part. These parts are identified as "No" in the Illustrated Parts Catalog.

Based on availability and where geography permits, CSR parts will be shipped for next business day delivery. Same day or four-hour delivery may be offered at an additional charge where geography permits. If assistance is required, you can call the Hewlett Packard Enterprise Support Center and a technician will help you over the telephone. Hewlett Packard Enterprise specifies in the materials shipped with a replacement CSR part whether a defective part must be returned to Hewlett Packard Enterprise. In cases where it is required to return the defective part to Hewlett Packard Enterprise, you must ship the defective part back to Hewlett Packard Enterprise within a defined period of time, normally five (5) business days. The defective part must be returned with the associated documentation in the provided shipping material. Failure to return the defective part may result in Hewlett Packard Enterprise billing you for the replacement. With a customer self repair, Hewlett Packard Enterprise will pay all shipping and part return costs and determine the courier/carrier to be used.

For more information about the Hewlett Packard Enterprise CSR program, contact your local service provider.

Parts only warranty service

Your Hewlett Packard Enterprise Limited Warranty may include a parts only warranty service. Under the terms of parts only warranty service, Hewlett Packard Enterprise will provide replacement parts free of charge.

For parts only warranty service, CSR part replacement is mandatory. If you request Hewlett Packard Enterprise to replace these parts, you will be charged for the travel and labor costs of this service.

Réparation par le client (CSR)

Les produits Hewlett Packard Enterprise comportent de nombreuses pièces CSR (Customer Self Repair = réparation par le client) afin de minimiser les délais de réparation et faciliter le remplacement des pièces défectueuses. Si pendant la période de diagnostic, Hewlett Packard Enterprise (ou ses partenaires ou mainteneurs agréés) détermine que la réparation peut être effectuée à l'aide d'une pièce CSR, Hewlett Packard Enterprise vous l'envoie directement. Il existe deux catégories de pièces CSR :

- **Obligatoire**—Pièces pour lesquelles la réparation par le client est obligatoire. Si vous demandez à Hewlett Packard Enterprise de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.
- **Facultatif**—Pièces pour lesquelles la réparation par le client est facultative. Ces pièces sont également conçues pour permettre au client d'effectuer lui-même la réparation. Toutefois, si vous demandez à Hewlett Packard Enterprise de remplacer ces pièces, l'intervention peut ou non vous être facturée, selon le type de garantie applicable à votre produit.

REMARQUE: Certaines pièces Hewlett Packard Enterprise ne sont pas conçues pour permettre au client d'effectuer lui-même la réparation. Pour que la garantie puisse s'appliquer, Hewlett Packard Enterprise exige que le remplacement de la pièce soit effectué par un Mainteneur Agréé. Ces pièces sont identifiées par la mention "Non" dans le Catalogue illustré.

Les pièces CSR sont livrées le jour ouvré suivant, dans la limite des stocks disponibles et selon votre situation géographique. Si votre situation géographique le permet et que vous demandez une livraison le jour même ou dans les 4 heures, celle-ci vous sera facturée. Pour toute assistance, appelez le Centre d'assistance Hewlett Packard Enterprise pour qu'un technicien vous aide au téléphone Dans les documents envoyés avec la pièce de rechange CSR, Hewlett Packard Enterprise précise s'il est nécessaire de lui retourner la pièce défectueuse. Si c'est le cas, vous devez le faire dans le délai indiqué, généralement cinq (5) jours ouvrés. La pièce et sa documentation doivent être retournées dans l'emballage fourni. Si vous ne retournez pas la pièce défectueuse, Hewlett Packard Enterprise se réserve le droit de vous facturer les coûts de remplacement. Dans le cas d'une pièce CSR, Hewlett Packard Enterprise supporte l'ensemble des frais d'expédition et de retour, et détermine la société de courses ou le transporteur à utiliser.

Pour plus d'informations sur le programme CSR de Hewlett Packard Enterprise, contactez votre Mainteneur Agrée local.

Service de garantie "pièces seules"

Votre garantie limitée Hewlett Packard Enterprise peut inclure un service de garantie "pièces seules". Dans ce cas, les pièces de rechange fournies par Hewlett Packard Enterprise ne sont pas facturées.

Dans le cadre de ce service, la réparation des pièces CSR par le client est obligatoire. Si vous demandez à Hewlett Packard Enterprise de

remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.

Riparazione da parte del cliente

Per abbreviare i tempi di riparazione e garantire una maggiore flessibilità nella sostituzione di parti difettose, i prodotti Hewlett Packard Enterprise sono realizzati con numerosi componenti che possono essere riparati direttamente dal cliente (CSR, Customer Self Repair). Se in fase di diagnostica Hewlett Packard Enterprise (o un centro di servizi o di assistenza Hewlett Packard Enterprise) identifica il guasto come riparabile mediante un ricambio CSR, Hewlett Packard Enterprise lo spedirà direttamente al cliente per la sostituzione. Vi sono due categorie di parti CSR:

- **Obbligatorie**—Parti che devono essere necessariamente riparate dal cliente. Se il cliente ne affida la riparazione ad Hewlett Packard Enterprise, deve sostenere le spese di spedizione e di manodopera per il servizio.
- **Opzionali**—Parti la cui riparazione da parte del cliente è facoltativa. Si tratta comunque di componenti progettati per questo scopo. Se tuttavia il cliente ne richiede la sostituzione ad Hewlett Packard Enterprise, potrebbe dover sostenere spese addizionali a seconda del tipo di garanzia previsto per il prodotto.

NOTA: alcuni componenti Hewlett Packard Enterprise non sono progettati per la riparazione da parte del cliente. Per rispettare la garanzia, Hewlett Packard Enterprise richiede che queste parti siano sostituite da un centro di assistenza autorizzato. Tali parti sono identificate da un "No" nel Catalogo illustrato dei componenti.

In base alla disponibilità e alla località geografica, le parti CSR vengono spedite con consegna entro il giorno lavorativo seguente. La consegna nel giorno stesso o entro quattro ore è offerta con un supplemento di costo solo in alcune zone. In caso di necessità si può richiedere l'assistenza telefonica di un addetto del centro di supporto tecnico Hewlett Packard Enterprise. Nel materiale fornito con una parte di ricambio CSR, Hewlett Packard Enterprise specifica se il cliente deve restituire dei component. Qualora sia richiesta la resa ad Hewlett Packard Enterprise del componente difettoso, lo si deve spedire ad Hewlett Packard Enterprise entro un determinato periodo di tempo, generalmente cinque (5) giorni lavorativi. Il componente difettoso deve essere restituito con la documentazione associata nell'imballo di spedizione fornito. La mancata restituzione del componente può comportare la fatturazione del ricambio da parte di Hewlett Packard Enterprise. Nel caso di riparazione da parte del cliente, Hewlett Packard Enterprise sostiene tutte le spese di spedizione e resa e sceglie il corriere/vettore da utilizzare.

Per ulteriori informazioni sul programma CSR di Hewlett Packard Enterprise, contattare il centro di assistenza di zona.

Servizio di garanzia per i soli componenti

La garanzia limitata Hewlett Packard Enterprise può includere un servizio di garanzia per i soli componenti. Nei termini di garanzia del servizio per i soli componenti, Hewlett Packard Enterprise fornirà gratuitamente le parti di ricambio.

Per il servizio di garanzia per i soli componenti è obbligatoria la formula CSR che prevede la riparazione da parte del cliente. Se il cliente invece richiede la sostituzione ad Hewlett Packard Enterprise dovrà sostenere le spese di spedizione e di manodopera per il servizio.

Customer Self Repair

Hewlett Packard Enterprise Produkte enthalten viele CSR-Teile (Customer Self Repair), um Reparaturzeiten zu minimieren und höhere Flexibilität beim Austausch defekter Bauteile zu ermöglichen. Wenn Hewlett Packard Enterprise (oder ein Hewlett Packard Enterprise Servicepartner) bei der Diagnose feststellt, dass das Produkt mithilfe eines CSR-Teils repariert werden kann, sendet Ihnen Hewlett Packard Enterprise dieses Bauteil zum Austausch direkt zu. CSR-Teile werden in zwei Kategorien unterteilt:

- **Zwingend**—Teile, für die das Customer Self Repair-Verfahren zwingend vorgegeben ist. Wenn Sie den Austausch dieser Teile von Hewlett Packard Enterprise vornehmen lassen, werden Ihnen die Anfahrt- und Arbeitskosten für diesen Service berechnet.
- **Optional**—Teile, für die das Customer Self Repair-Verfahren optional ist. Diese Teile sind auch für Customer Self Repair ausgelegt. Wenn Sie jedoch den Austausch dieser Teile von Hewlett Packard Enterprise vornehmen lassen möchten, können bei diesem Service je nach den für Ihr Produkt vorgesehenen Garantiebedingungen zusätzliche Kosten anfallen.

HINWEIS: Einige Hewlett Packard Enterprise Teile sind nicht für Customer Self Repair ausgelegt. Um den Garantieanspruch des Kunden zu erfüllen, muss das Teil von einem Hewlett Packard Enterprise Servicepartner ersetzt werden. Im illustrierten Teilekatalog sind diese Teile mit „No“ bzw. „Nein“ gekennzeichnet.

CSR-Teile werden abhängig von der Verfügbarkeit und vom Lieferziel am folgenden Geschäftstag geliefert. Für bestimmte Standorte ist eine Lieferung am selben Tag oder innerhalb von vier Stunden gegen einen Aufpreis verfügbar. Wenn Sie Hilfe benötigen, können Sie das Hewlett Packard Enterprise Support Center anrufen und sich von einem Mitarbeiter per Telefon helfen lassen. Den Materialien von Hewlett Packard Enterprise, die mit einem CSR-Ersatzteil geliefert werden, können Sie entnehmen, ob das defekte Teil an Hewlett Packard Enterprise zurückgeschickt werden muss. Wenn es erforderlich ist, das defekte Teil an Hewlett Packard Enterprise zurückzuschicken, müssen Sie dies innerhalb eines vorgegebenen Zeitraums tun, in der Regel innerhalb von fünf (5) Geschäftstagen. Das defekte Teil muss mit der zugehörigen Dokumentation in der Verpackung zurückgeschickt werden, die im Lieferumfang enthalten ist. Wenn Sie das defekte Teil nicht zurückschicken, kann Hewlett Packard Enterprise Ihnen das Ersatzteil in Rechnung stellen. Im Falle von Customer Self Repair kommt Hewlett Packard Enterprise für alle Kosten für die Lieferung und Rücksendung auf und bestimmt den Kurier-/Frachtdienst.

Weitere Informationen über das Hewlett Packard Enterprise Customer Self Repair Programm erhalten Sie von Ihrem Servicepartner vor Ort.

Parts-only Warranty Service (Garantieservice ausschließlich für Teile)

Ihre Hewlett Packard Enterprise Garantie umfasst möglicherweise einen Parts-only Warranty Service (Garantieservice ausschließlich für Teile). Gemäß den Bestimmungen des Parts-only Warranty Service stellt Hewlett Packard Enterprise Ersatzteile kostenlos zur Verfügung.

Für den Parts-only Warranty Service ist das CSR-Verfahren zwingend vorgegeben. Wenn Sie den Austausch dieser Teile von Hewlett Packard Enterprise vornehmen lassen, werden Ihnen die Anfahrt- und Arbeitskosten für diesen Service berechnet.

Reparaciones del propio cliente

Los productos de Hewlett Packard Enterprise incluyen muchos componentes que el propio usuario puede reemplazar (Customer Self Repair, CSR) para minimizar el tiempo de reparación y ofrecer una mayor flexibilidad a la hora de realizar sustituciones de componentes defectuosos. Si, durante la fase de diagnóstico, Hewlett Packard Enterprise (o los proveedores o socios de servicio de Hewlett Packard Enterprise) identifica que una reparación puede llevarse a cabo mediante el uso de un componente CSR, Hewlett Packard Enterprise le enviará dicho componente directamente para que realice su sustitución. Los componentes CSR se clasifican en dos categorías:

- **Obligatorio**—Componentes cuya reparación por parte del usuario es obligatoria. Si solicita a Hewlett Packard Enterprise que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.
- **Opcional**—Componentes cuya reparación por parte del usuario es opcional. Estos componentes también están diseñados para que puedan ser reparados por el usuario. Sin embargo, si precisa que Hewlett Packard Enterprise realice su sustitución, puede o no conllevar costes adicionales, dependiendo del tipo de servicio de garantía correspondiente al producto.

NOTA: Algunos componentes de Hewlett Packard Enterprise no están diseñados para que puedan ser reparados por el usuario. Para que el usuario haga valer su garantía, Hewlett Packard Enterprise pone como condición que un proveedor de servicios autorizado realice la sustitución de estos componentes. Dichos componentes se identifican con la palabra "No" en el catálogo ilustrado de componentes.

Según la disponibilidad y la situación geográfica, los componentes CSR se enviarán para que lleguen a su destino al siguiente día laborable. Si la situación geográfica lo permite, se puede solicitar la entrega en el mismo día o en cuatro horas con un coste adicional. Si precisa asistencia técnica, puede llamar al Centro de asistencia técnica de Hewlett Packard Enterprise y recibirá ayuda telefónica por parte de un técnico. Con el envío de materiales para la sustitución de componentes CSR, Hewlett Packard Enterprise especificará si los componentes defectuosos deberán devolverse a Hewlett Packard Enterprise. En aquellos casos en los que sea necesario devolver algún componente a Hewlett Packard Enterprise, deberá hacerlo en el periodo de tiempo especificado, normalmente cinco días laborables. Los componentes defectuosos deberán devolverse con toda la documentación relacionada y con el embalaje de envío. Si no enviara el componente defectuoso requerido, Hewlett Packard Enterprise podrá cobrarle por el de sustitución. En el caso de todas sustituciones que lleve a cabo el cliente, Hewlett Packard Enterprise se hará cargo de todos los gastos de envío y devolución de componentes y escogerá la empresa de transporte que se utilice para dicho servicio.

Para obtener más información acerca del programa de Reparaciones del propio cliente de Hewlett Packard Enterprise, póngase en contacto con su proveedor de servicios local.

Servicio de garantía exclusivo de componentes

La garantía limitada de Hewlett Packard Enterprise puede que incluya un servicio de garantía exclusivo de componentes. Según las condiciones de este servicio exclusivo de componentes, Hewlett Packard Enterprise le facilitará los componentes de repuesto sin cargo adicional alguno.

Para este servicio de garantía exclusivo de componentes, es obligatoria la sustitución de componentes por parte del usuario (CSR). Si solicita a Hewlett Packard Enterprise que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.

Customer Self Repair

Veel onderdelen in Hewlett Packard Enterprise producten zijn door de klant zelf te repareren, waardoor de reparatieduur tot een minimum beperkt kan blijven en de flexibiliteit in het vervangen van defecte onderdelen groter is. Deze onderdelen worden CSR-onderdelen (Customer Self Repair) genoemd. Als Hewlett Packard Enterprise (of een Hewlett Packard Enterprise Service Partner) bij de diagnose vaststelt dat de reparatie kan worden uitgevoerd met een CSR-onderdeel, verzendt Hewlett Packard Enterprise dat onderdeel rechtstreeks naar u, zodat u het defecte onderdeel daarmee kunt vervangen. Er zijn twee categorieën CSR-onderdelen:

- **Verplicht**—Onderdelen waarvoor reparatie door de klant verplicht is. Als u Hewlett Packard Enterprise verzoekt deze onderdelen voor u te vervangen, worden u voor deze service reiskosten en arbeidsloon in rekening gebracht.
- **Optioneel**—Onderdelen waarvoor reparatie door de klant optioneel is. Ook deze onderdelen zijn ontworpen voor reparatie door de klant. Als u echter Hewlett Packard Enterprise verzoekt deze onderdelen voor u te vervangen, kunnen daarvoor extra kosten in rekening worden gebracht, afhankelijk van het type garantieservice voor het product.

OPMERKING: Sommige Hewlett Packard Enterprise onderdelen zijn niet ontwikkeld voor reparatie door de klant. In verband met de garantievoorwaarden moet het onderdeel door een geautoriseerde Service Partner worden vervangen. Deze onderdelen worden in de geïllustreerde onderdelencatalogus aangemerkt met "Nee".

Afhankelijk van de leverbaarheid en de locatie worden CSR-onderdelen verzonden voor levering op de eerstvolgende werkdag. Levering op dezelfde dag of binnen vier uur kan tegen meerkosten worden aangeboden, indien dit mogelijk is gezien de locatie. Indien assistentie is gewenst, belt u het Hewlett Packard Enterprise Support Center om via de telefoon ondersteuning van een technicus te ontvangen. Hewlett Packard Enterprise vermeldt in de documentatie bij het vervangende CSR-onderdeel of het defecte onderdeel aan Hewlett

Packard Enterprise moet worden geretourneerd. Als het defecte onderdeel aan Hewlett Packard Enterprise moet worden teruggezonden, moet u het defecte onderdeel binnen een bepaalde periode, gewoonlijk vijf (5) werkdagen, retourneren aan Hewlett Packard Enterprise. Het defecte onderdeel moet met de bijbehorende documentatie worden geretourneerd in het meegeleverde verpakkingsmateriaal. Als u het defecte onderdeel niet terugzendt, kan Hewlett Packard Enterprise u voor het vervangende onderdeel kosten in rekening brengen. Bij reparatie door de klant betaalt Hewlett Packard Enterprise alle verzendkosten voor het vervangende en geretourneerde onderdeel en kiest Hewlett Packard Enterprise zelf welke koerier/transportonderneming hiervoor wordt gebruikt.

Neem contact op met een Service Partner voor meer informatie over het Customer Self Repair programma van Hewlett Packard Enterprise.

Garantieservice "Parts Only"

Het is mogelijk dat de Hewlett Packard Enterprise garantie alleen de garantieservice "Parts Only" omvat. Volgens de bepalingen van de Parts Only garantieservice zal Hewlett Packard Enterprise kosteloos vervangende onderdelen ter beschikking stellen.

Voor de Parts Only garantieservice is vervanging door CSR-onderdelen verplicht. Als u Hewlett Packard Enterprise verzoekt deze onderdelen voor u te vervangen, worden u voor deze service reiskosten en arbeidsloon in rekening gebracht

Reparo feito pelo cliente

Os produtos da Hewlett Packard Enterprise são projetados com muitas peças para reparo feito pelo cliente (CSR) de modo a minimizar o tempo de reparo e permitir maior flexibilidade na substituição de peças com defeito. Se, durante o período de diagnóstico, a Hewlett Packard Enterprise (ou fornecedores/parceiros da Hewlett Packard Enterprise) concluir que o reparo pode ser efetuado pelo uso de uma peça CSR, a Hewlett Packard Enterprise enviará a peça diretamente ao cliente. Há duas categorias de peças CSR:

- **Obrigatória**—Peças cujo reparo feito pelo cliente é obrigatório. Se desejar que a Hewlett Packard Enterprise substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.
- **Opcional**—Peças cujo reparo feito pelo cliente é opcional. Essas peças também são projetadas para o reparo feito pelo cliente. No entanto, se desejar que a Hewlett Packard Enterprise as substitua, pode haver ou não a cobrança de taxa adicional, dependendo do tipo de serviço de garantia destinado ao produto.

OBSERVAÇÃO: Algumas peças da Hewlett Packard Enterprise não são projetadas para o reparo feito pelo cliente. A fim de cumprir a garantia do cliente, a Hewlett Packard Enterprise exige que um técnico autorizado substitua a peça. Essas peças estão identificadas com a marca "No" (Não), no catálogo de peças ilustrado.

Conforme a disponibilidade e o local geográfico, as peças CSR serão enviadas no primeiro dia útil após o pedido. Onde as condições geográficas permitirem, a entrega no mesmo dia ou em quatro horas pode ser feita mediante uma taxa adicional. Se precisar de auxílio, entre em contato com o Centro de suporte técnico da Hewlett Packard Enterprise para que um técnico o ajude por telefone. A Hewlett Packard Enterprise especifica nos materiais fornecidos com a peça CSR de reposição se a peça com defeito deve ser devolvida à Hewlett Packard Enterprise. Nos casos em que isso for necessário, é preciso enviar a peça com defeito à Hewlett Packard Enterprise, você deverá enviar a peça com defeito de volta para a Hewlett Packard Enterprise dentro do período de tempo definido, normalmente em 5 (cinco) dias úteis. A peça com defeito deve ser enviada com a documentação correspondente no material de transporte fornecido. Caso não o faça, a Hewlett Packard Enterprise poderá cobrar a reposição. Para as peças de reparo feito pelo cliente, a Hewlett Packard Enterprise paga todas as despesas de transporte e de devolução da peça e determina a transportadora/serviço postal a ser utilizado.

Para obter mais informações sobre o programa de reparo feito pelo cliente da Hewlett Packard Enterprise, entre em contato com o fornecedor de serviços local.

Serviço de garantia apenas para peças

A garantia limitada da Hewlett Packard Enterprise pode incluir um serviço de garantia apenas para peças. Segundo os termos do serviço de garantia apenas para peças, a Hewlett Packard Enterprise fornece as peças de reposição sem cobrar nenhuma taxa.

No caso desse serviço, a substituição de peças CSR é obrigatória. Se desejar que a Hewlett Packard Enterprise substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

カスタマーセルフリペア

修理時間を短縮し、故障部品の交換における高い柔軟性を確保するために、Hewlett Packard Enterprise製品には多数のカスタマーセルフリペア（CSR）部品があります。診断の際に、CSR部品を使用すれば修理ができるとHewlett Packard Enterprise（Hewlett Packard EnterpriseまたはHewlett Packard Enterprise正規保守代理店）が判断した場合、Hewlett Packard Enterpriseはその部品を直接、お客様に発送し、お客様に交換していただきます。CSR部品には以下の2種類があります。

- **必須** - カスタマーセルフリペアが必須の部品。当該部品について、もしもお客様がHewlett Packard Enterpriseに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費がお客様に請求されます。
- **任意** - カスタマーセルフリペアが任意である部品。この部品もカスタマーセルフリペア用です。当該部品について、もしもお客様がHewlett Packard Enterpriseに交換作業を依頼される場合には、お買い上げの製品に適用される保証サービス内容の範囲内においては、別途費用を負担していただくことなく保証サービスを受けることができます。

注：Hewlett Packard Enterprise製品の一部の部品は、カスタマーセルフリペアの対象外です。製品の保証を継続するためには、Hewlett Packard EnterpriseまたはHewlett Packard Enterprise正規保守代理店による交換作業が必須となります。部品カタログには、当該部品がカスタマーセルフリペア除外品である旨が記載されています。

部品供給が可能な場合、地域によっては、CSR部品を翌営業日に届くように発送します。また、地域によっては、追加費用を負担いただくことにより同日または4時間以内に届くように発送することも可能な場合があります。サポートが必要なときは、Hewlett Packard Enterpriseサポートセンターに電話していただければ、技術者が電話でアドバイスします。交換用のCSR部品または同梱物には、故障部品をHewlett Packard Enterpriseに返送する必要があるかどうかが表示されています。故障部品をHewlett Packard Enterpriseに返送する必要がある場合は、指定期限内（通常は5営業日以内）に故障部品をHewlett Packard Enterpriseに返送してください。故障部品を返送する場合は、届いた時の梱包箱に関連書類とともに入れてください。故障部品を返送しない場合、Hewlett Packard Enterpriseから部品費用が請求されます。カスタマーセルフリペアの際には、Hewlett Packard Enterpriseは送料および部品返送費を全額負担し、使用する宅配便会社や運送会社を指定します。

部品のみ保証サービス

Hewlett Packard Enterprise保証サービスには、部品のみ保証サービスが適用される場合があります。このサービスでは、交換部品は無償で提供されます。

部品のみ保証サービスにおいては、CSR部品をお客様により交換作業していただくことが必須になります。当該部品について、もしもお客様がHewlett Packard Enterpriseに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費がお客様のご負担となります。

客户自行维修

Hewlett Packard Enterprise 产品提供许多客户自行维修 (CSR) 部件，以尽可能缩短维修时间和在更换缺陷部件方面提供更大的灵活性。如果在诊断期间 Hewlett Packard Enterprise（或Hewlett Packard Enterprise 服务提供商或服务合作伙伴）确定可以通过使用 CSR 部件完成维修，Hewlett Packard Enterprise 将直接把该部件发送给您进行更换。有两类 CSR 部件：

- **强制性的** — 要求客户必须自行维修的部件。如果您请求 Hewlett Packard Enterprise 更换这些部件，则必须为该服务支付差旅费和人工费用。
- **可选的** — 客户可以选择是否自行维修的部件。这些部件也是为客户自行维修设计的。不过，如果您要求 Hewlett Packard Enterprise 为您更换这些部件，则根据为您的产品指定的保修服务类型，Hewlett Packard Enterprise 可能收取或不再收取任何附加费用。

注：某些 Hewlett Packard Enterprise 部件的设计并未考虑客户自行维修。为了满足客户保修的需要，Hewlett Packard Enterprise 要求授权服务提供商更换相关部件。这些部件在部件图解目录中标记为“否”。

CSR 部件将在下一个工作日发运（取决于备货情况和允许的地理范围）。在允许的地理范围内，可在当天或四小时内发运，但要收取额外费用。如果需要帮助，您可以致电 Hewlett Packard Enterprise 技术支持中心，将会有技术人员通过电话为您提供帮助。Hewlett Packard Enterprise 会在随更换的 CSR 部件发运的材料中指明是否必须将有缺陷的部件返还给 Hewlett Packard Enterprise。如果要求您将有缺陷的部件返还给 Hewlett Packard Enterprise，那么您必须在规定的期限内（通常是五 (5) 个工作日）将缺陷部件发给 Hewlett Packard Enterprise。有缺陷的部件必须随所提供的发运材料中的相关文件一起返还。如果未能送还有缺陷的部件，Hewlett Packard Enterprise 可能会要求您支付更换费用。客户自行维修时，Hewlett Packard Enterprise 将承担所有相关运输和部件返回费用，并指定快递商/承运商。

有关 Hewlett Packard Enterprise 客户自行维修计划的详细信息，请与您当地的服务提供商联系。

仅部件保修服务

您的 Hewlett Packard Enterprise 有限保修服务可能涉及仅部件保修服务。根据仅部件保修服务条款的规定，Hewlett Packard Enterprise 将免费提供更换的部件。

仅部件保修服务要求进行 CSR 部件更换。如果您请求 Hewlett Packard Enterprise 更换这些部件，则必须为该服务支付差旅费和人工费用。

客戶自行維修

Hewlett Packard Enterprise 產品設計了許多「客戶自行維修」(CSR) 的零件以減少維修時間，並且使得更換瑕疵零件時能有更大的彈性。如果在診斷期間，Hewlett Packard Enterprise (或 Hewlett Packard Enterprise 服務供應商或維修夥伴) 辨認出此項維修工作可以藉由使用 CSR 零件來完成，則 Hewlett Packard Enterprise 將直接寄送該零件給您作更換。CSR 零件分為兩種類別：

- **強制的** — 客戶自行維修所使用的零件是強制性的。如果您要求 Hewlett Packard Enterprise 更換這些零件，Hewlett Packard Enterprise 將會向您收取此服務所需的外出費用與勞動成本。
- **選購的** — 客戶自行維修所使用的零件是選購的。這些零件也設計用於客戶自行維修之用。不過，如果您要求 Hewlett Packard Enterprise 為您更換，則可能需要也可能不需要負擔額外的費用，端視針對此產品指定的保固服務類型而定。

備註：某些 Hewlett Packard Enterprise 零件沒有消費者可自行維修的設計。為符合客戶保固，Hewlett Packard Enterprise 需要授權的服務供應商更換零件。這些零件在圖示的零件目錄中，被標示為「否」。

基於材料取得及環境允許的情況下，CSR 零件將於下一個工作日以快遞寄送。在環境的允許下當天或四小時內送達，則可能需要額外的費用。若您需要協助，可致電 Hewlett Packard Enterprise 支援中心，會有一位技術人員透過電話來協助您。不論損壞的零件是否必須退回，Hewlett Packard Enterprise 皆會在與 CSR 替換零件一起運送的材料中註明。若要將損壞的零件退回 Hewlett Packard Enterprise，您必須在指定的一段時間內 (通常為五 (5) 個工作天)，將損壞的零件寄回 Hewlett Packard Enterprise。損壞的零件必須與寄送資料中隨附的相關技術文件一併退還。如果無法退還損壞的零件，Hewlett Packard Enterprise 可能要向您收取替換費用。針對客戶自行維修情形，Hewlett Packard Enterprise 將負責所有運費及零件退還費用，並指定使用何家快遞/貨運公司。

如需 Hewlett Packard Enterprise 的 CSR 方案詳細資訊，請連絡您當地的服務供應商。

僅限零件的保固服務

您的「Hewlett Packard Enterprise 有限保固」可能包含僅限零件的保固服務。在僅限零件的保固服務情況下，Hewlett Packard Enterprise 將免費提供替換零件。

針對僅限零件的保固服務，CSR 零件替換是強制性的。如果您要求 Hewlett Packard Enterprise 更換這些零件，Hewlett Packard Enterprise 將會向您收取此服務所需的外出費用與勞動成本。

고객 셀프 수리

Hewlett Packard Enterprise 제품은 수리 시간을 최소화하고 결함이 있는 부품 교체 시 더욱 융통성을 발휘할 수 있도록 하기 위해 고객 셀프 수리(CSR) 부품을 다량 사용하여 설계되었습니다. 진단 기간 동안 Hewlett Packard Enterprise(또는 Hewlett Packard Enterprise 서비스 공급업체 또는 서비스 협력업체)에서 CSR 부품을 사용하여 수리가 가능하다고 판단되면 Hewlett Packard Enterprise는 해당 부품을 바로 사용자에게 보내어 사용자가 교체할 수 있도록 합니다. CSR 부품에는 두 가지 종류가 있습니다.

- **필수** - 고객 셀프 수리가 의무 사항인 필수 부품. 사용자가 Hewlett Packard Enterprise에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.
- **선택 사항** - 고객 셀프 수리가 선택 사항인 부품. 이 부품들도 고객 셀프 수리가 가능하도록 설계되었습니다. 하지만 사용자가 Hewlett Packard Enterprise에 이 부품의 교체를 요청할 경우 사용자가 구입한 제품에 해당하는 보증 서비스 유형에 따라 추가 비용 없이 교체가 가능할 수 있습니다.

참고: 일부 Hewlett Packard Enterprise 부품은 고객 셀프 수리가 불가능하도록 설계되었습니다. Hewlett Packard Enterprise는 만족스러운 고객 보증을 위해 공인 서비스 제공업체를 통해 부품을 교체하도록 하고 있습니다. 이러한 부품들은 Illustrated Parts Catalog에 "No"라고 표시되어 있습니다.

CSR 부품은 재고 상태와 지리적 조건이 허용하는 경우 다음 영업일 납품이 가능하도록 배송이 이루어집니다. 지리적 조건이 허용하는 경우 추가 비용이 청구되는 조건으로 당일 또는 4시간 배송이 가능할 수도 있습니다. 도움이 필요하시면 Hewlett Packard Enterprise Support Center로 전화하십시오. 전문 기술자가 전화로 도움을 줄 것입니다. Hewlett Packard Enterprise는 결함이 발생한 부품을 Hewlett Packard Enterprise로 반환해야 하는지 여부를 CSR 교체 부품과 함께 배송된 자료에 지정합니다. 결함이 발생한 부품을 Hewlett Packard Enterprise로 반환해야 하는 경우에는 지정된 기간 내(통상 영업일 기준 5일)에 Hewlett Packard Enterprise로 반환해야 합니다. 이때 결함이 발생한 부품은 제공된 포장 재료에 넣어 관련 설명서와 함께 반환해야 합니다. 결함이 발생한 부품을 반환하지 않는 경우 Hewlett Packard Enterprise가 교체 부품에 대해 비용을 청구할 수 있습니다. 고객 셀프 수리의 경우, Hewlett Packard Enterprise는 모든 운송 및 부품 반환 비용을 부담하며 이용할 운송업체 및 택배 서비스를 결정합니다.

Hewlett Packard Enterprise CSR 프로그램에 대한 자세한 내용은 가까운 서비스 제공업체에 문의하십시오.

부품 제공 보증 서비스

Hewlett Packard Enterprise 제한 보증에는 부품 제공 보증 서비스가 포함될 수 있습니다. 이러한 경우 Hewlett Packard Enterprise는 부품 제공 보증 서비스의 조건에 따라 교체 부품만을 무료로 제공합니다.

부품 제공 보증 서비스 제공 시 CSR 부품 교체는 의무 사항입니다. 사용자가 Hewlett Packard Enterprise에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.

Removal and replacement procedures

This chapter provides detailed instructions on how to remove and replace component spare parts.

Safety considerations

Before performing service procedures, review all the safety information.

- Electrostatic discharge
- Symbols on equipment
- Rack warnings and cautions
- Server warnings and cautions

Electrostatic discharge

Be aware of the precautions you must follow when setting up the system or handling components. A discharge of static electricity from a finger or other conductor may damage system boards or other static-sensitive devices. This type of damage may reduce the life expectancy of the system or component.

To prevent electrostatic damage:

- Avoid hand contact by transporting and storing products in static-safe containers.
- Keep electrostatic-sensitive parts in their containers until they arrive at static-free workstations.
- Place parts on a grounded surface before removing them from their containers.
- Avoid touching pins, leads, or circuitry.
- Always be properly grounded when touching a static-sensitive component or assembly. Use one or more of the following methods when handling or installing electrostatic-sensitive parts:
  - Use a wrist strap connected by a ground cord to a grounded workstation or computer chassis. Wrist straps are flexible straps with a minimum of 1 megohm ±10 percent resistance in the ground cords. To provide proper ground, wear the strap snug against the skin.
  - Use heel straps, toe straps, or boot straps at standing workstations. Wear the straps on both feet when standing on conductive floors or dissipating floor mats.
  - Use conductive field service tools.
  - Use a portable field service kit with a folding static-dissipating work mat.

  If you do not have any of the suggested equipment for proper grounding, have an authorized reseller install the part.

For more information on static electricity or assistance with product installation, contact an authorized reseller.

Symbols on equipment

The following symbols may be placed on equipment to indicate the presence of potentially hazardous conditions:

This symbol in conjunction with any of the following symbols indicates the presence of a potential hazard. The potential for injury exists if warnings are not observed. Consult your documentation for specific details.

該符號與以下任意符號組合使用，指示存在潛在的危險。如果不遵守警告，可能會造成人身傷害。詳細信息請參閱相關文檔。

This symbol indicates the presence of hazardous energy circuits or electric shock hazards. Refer all servicing to qualified personnel.

> ⚠ **WARNING:**
>
> To reduce the risk of injury from electric shock hazards, do not open this enclosure. Refer all maintenance, upgrades, and servicing to qualified personnel.

此符號表明存在危險電路或觸電的危險。所有維修工作應由具有相關資格的人員來完成。
警告：為了減少觸電造成人身傷害的危險，請不要打開此外殼。所有維護、升級和維修工作都應由具有相關資格的人員來完成。

This symbol indicates the presence of electric shock hazards. The area contains no user or field-serviceable parts. Do not open for any reason.

> ⚠ **WARNING:**
>
> To reduce risk of injury from electric shock hazards, do not open this enclosure.

此符號表明存在觸電的危險。在這一區域內沒有用戶可以現場維修的部件。一定不要打開。警告：為了減少觸電造成人身傷害的危險，請不要打開此外殼。

This symbol on an RJ-45 receptacle indicates a Network Interface Connection.

> ⚠ **WARNING:**
>
> To reduce risk of electric shock, fire, or damage to the equipment, do not plug telephone or telecommunications connectors into this receptacle.

RJ-45 插孔上的該符號指示網絡接口連接。
警告：為了減少觸電、火災或設備損壞的危險，不要將電話或電信連接設備插入此插孔。

This symbol indicates the presence of a hot surface or hot component. If this surface is contacted, the potential for injury exists.

⚠ WARNING:

To reduce the risk of injury from a hot component, allow the surface to cool before touching.

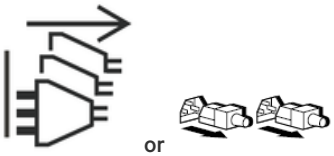
此符號表明表面或組件過熱。如果觸摸此表面，可能會造成人身傷害。警告：為了減少因組件過熱而造成人身傷害的危險，應等到表面降溫後再觸摸。

This symbol indicates the presence of a moving fan blade. If the spinning blades are contacted, the potential for injury exists.

⚠ WARNING:

Hazardous moving parts. Keep away from moving fan blades. To reduce the risk of injury from a hot component, allow the surface to cool before touching.

此符號表明存在運動風扇葉片的危險。如果觸摸旋轉葉片，可能會造成人身傷害。警告：危險的運動部件。請遠離運動風扇刀片。為減少被高溫組件燙傷的危險，應在表面冷卻之後再接觸。



These symbols on power supplies or systems indicate that the equipment is supplied by multiple sources of power.

⚠ WARNING:

To reduce the risk of injury from electric shock, remove all power cords to completely disconnect power from the system.

電源或系統上的這些符號表明設備由多個電源供電。
警告：為了減少觸電造成人身傷害的危險，應拔下所有電源線插頭，完全斷開系統的電源。

This symbol indicates that the component exceeds the recommended weight for one individual to handle safely.

⚠ WARNING:

To reduce the risk of personal injury or damage to the equipment, observe local occupational health and safety requirements and guidelines for manual material handling.

此符號表明組件的重量超出了建議值，一個人無法安全取放。
警告：為了減少人身傷害或設備損壞的危險，應遵守當地有關人工取放物品的職業保健與安全規定及準則。

A discharge of static electricity from a finger or other conductor may damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

手指或其它導體所釋放的靜電可能損壞主板或其它對靜電敏感的設備。為防止發生損壞，請遵守防靜電預防措施。

This symbol indicates the presence of a laser device in the product that may exceed Class 1 limits. Refer to the product documentation for more information.

此符號表明在可能會超出 1 類限制的產品中存在激光設備。有關詳細信息，請參閱產品文檔。

This symbol indicates the presence of moving parts inside the product that may present a pinch point if improperly contacted.

> ⚠ **WARNING:**
>
> Hazardous moving parts. Do not insert any tools or any part of your body into the product while it is operating or in any openings.

Rack warnings and cautions

WARNING:

When all components are removed, the server weighs 12 kg (26.46 lb). When all components are installed, the server can weigh up to 18 kg (39.68 lb).

Before configuring your rack solution, be sure to check the rack manufacturer weight limits and specifications. Failure to do so can result in physical injury or damage to the equipment and the facility.

WARNING:

The server is heavy. To reduce the risk of personal injury or damage to the equipment, do the following:

- Observe local occupational health and safety requirements and guidelines for manual material handling.
- Get help to lift and stabilize the product during installation or removal, especially when the product is not fastened to the rails. The server weighs more than 12 kg (26.46 lb), so at least two people must lift the server into the rack together. An additional person may be required to help align the server if the server is installed higher than chest level.
- Use caution when installing the server in or removing the server from the rack.
- Adequately stabilized the rack before extending a component outside the rack. Extend only one component at a time. A rack may become unstable if more than one component is extended.
- Do not stack anything on top of rail-mounted component or use it as a work surface when extended from the rack.

WARNING:

To reduce the risk of personal injury or damage to the equipment, be sure that:

- The rack has anti-tip measures in place. Such measures include floor-bolting, anti-tip feet, ballast, or a combination as specified by the rack manufacturer and applicable codes.
- The leveling jacks (feet) are extended to the floor.
- The full weight of the rack rests on the leveling jacks (feet).
- The stabilizing feet are attached to the rack if it is a single-rack installation.
- The racks are coupled together in multiple rack installations.

WARNING:

To reduce the risk of personal injury or equipment damage when unloading a rack:

- At least two people are needed to safely unload the rack from the pallet. An empty 42U rack can weigh as much as 115 kg (253 lb), can stand more than 2.1 m (7 ft) tall, and might become unstable when being moved on its casters.
- Never stand in front of the rack when it is rolling down the ramp from the pallet. Always handle the rack from both sides.

CAUTION:

Always plan the rack installation so that the heaviest item is on the bottom of the rack. Install the heaviest item first, and continue to populate the rack from the bottom to the top.

CAUTION:

Before installing the server in a rack, be sure to properly scope the limitations of the rack. Before proceeding with the installation, consider the following:

- You must fully understand the static and dynamic load carrying capacity of the rack and be sure that it can accommodate the weight of the server.

- Be sure sufficient clearance exists for cabling, installation and removal of the server, and movement of the rack doors.

Server warnings and cautions

WARNING:

To reduce the risk of personal injury, electric shock, or damage to the equipment, disconnect the power cord to remove power from the server. Pressing the Power On/Standby button does not shut off system power completely. Portions of the power supply and some internal circuitry remain active until AC power is removed.

WARNING: To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

WARNING:

To reduce the risk of fire or burns after removing the energy pack:

- Do not disassemble, crush, or puncture the energy pack.
- Do not short external contacts.
- Do not dispose of the energy pack in fire or water.
- Do not expose the energy pack to low air pressure as it might lead to explosion or leakage of flammable liquid or gas.
- Do not expose the energy pack to temperatures higher than 60°C (140°F).

After power is disconnected, battery voltage might still be present for 1s to 160s.

CAUTION:

Protect the server from power fluctuations and temporary interruptions with a regulating UPS. This device protects the hardware from damage caused by power surges and voltage spikes and keeps the server in operation during a power failure.

CAUTION:

To prevent damage to electrical components, properly ground the server before beginning any installation, removal, or replacement procedure. Improper grounding can cause electrostatic discharge.

CAUTION:

To avoid data loss, Hewlett Packard Enterprise recommends that you back up all server data before installing or removing a hardware option, or performing a server maintenance or troubleshooting procedure.

CAUTION: Do not operate the server for long periods with the access panel open or removed. Operating the server in this manner results in improper airflow and improper cooling that can lead to thermal damage.

Preparation procedures

To access components and perform certain upgrade, maintenance, or service procedure, you must perform one or more of the procedures described in this section.

Prerequisites

Before powering down the server for an upgrade, maintenance, or service procedure, perform a backup of critical server data and programs.

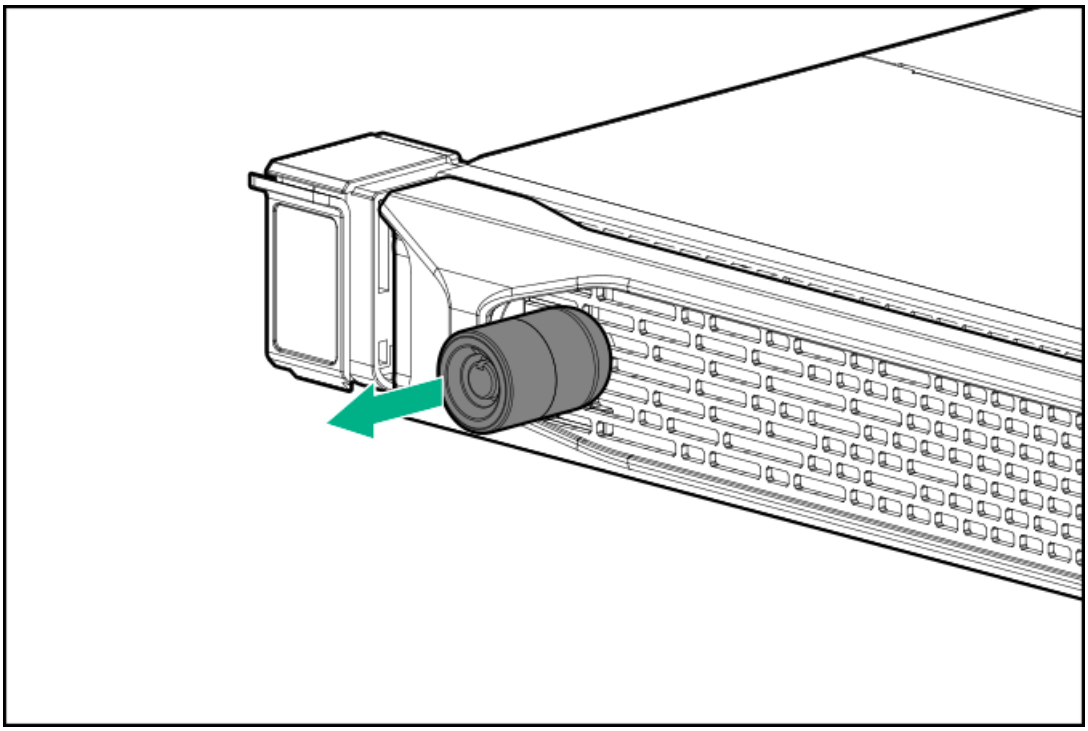
Remove the front bezel

If you are using the virtual power button in iLO to power the server on/off, you do not need to remove the front bezel. Remove the front bezel only if you need to access the front panel components.

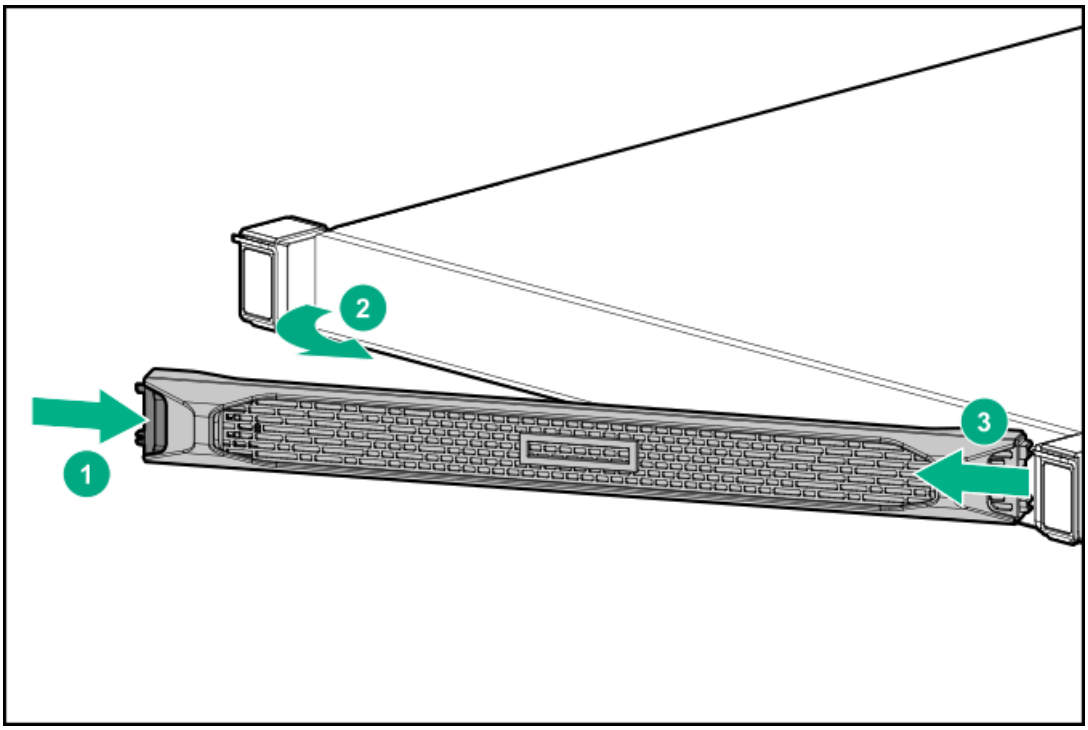
Procedure

1. If installed, remove the Kensington security lock.

   For more information, see the lock documentation.



2. Press the bezel release latch (callout 1), and then pivot the bezel open (callout 2).
3. Release the right side of the bezel from the front panel.



Power down the server

Before powering down the server for any upgrade or maintenance procedures, perform a backup of critical server data and programs.

IMPORTANT:
When the server is in standby mode, auxiliary power is still being provided to the system.

To power down the server, use one of the following methods:

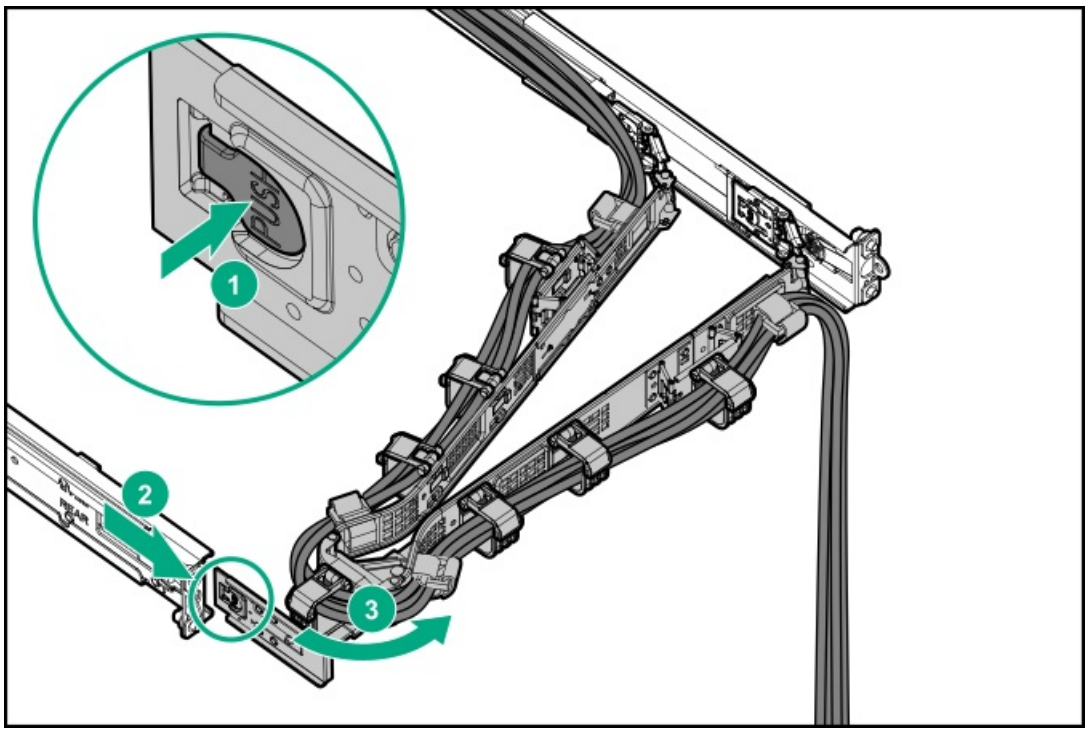
- Press and release the Power On/Standby button.
  This method initiates a controlled shutdown of applications and the OS before the server enters standby mode.
- Press and hold the Power On/Standby button for more than 4 seconds to force the server to enter standby mode.
  This method forces the server to enter standby mode without properly exiting applications and the OS. If an application stops responding, you can use this method to force a shutdown.
- Use a virtual power button selection through iLO 5.
  This method initiates a controlled remote shutdown of applications and the OS before the server enters standby mode.

Before proceeding, verify that the server is in standby mode by observing that the system power LED is amber.

Release the cable management arm

Procedure

Release the cable management arm, and then swing the arm away from the rack.



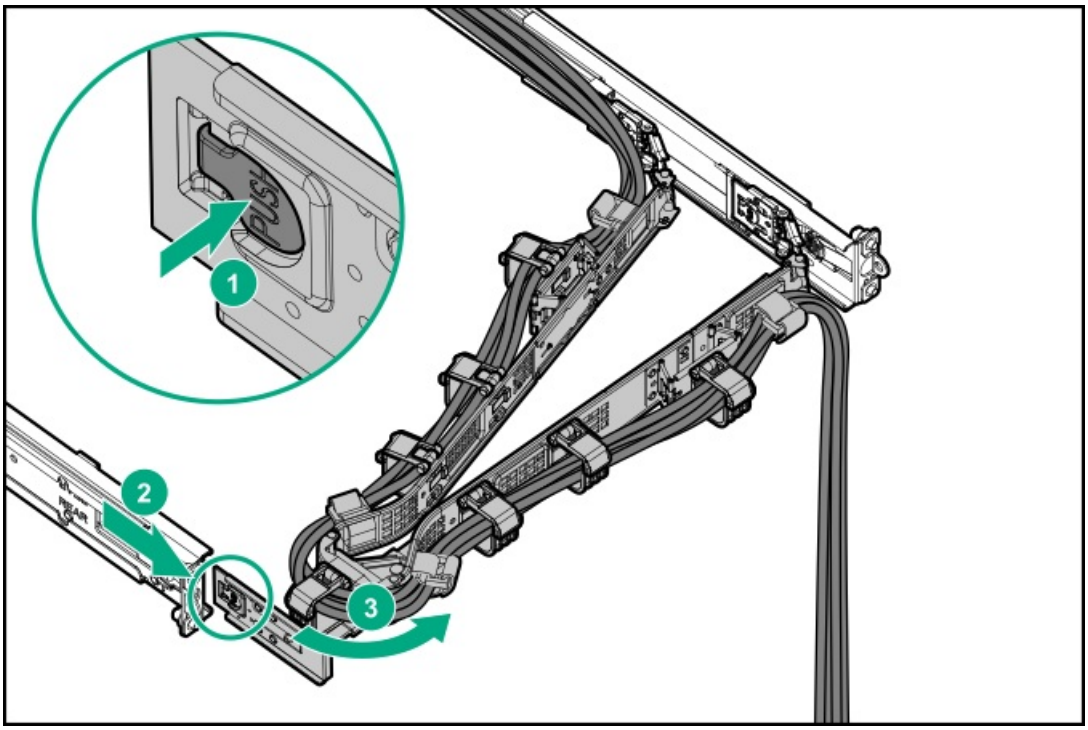
Remove the server from the rack

Prerequisites

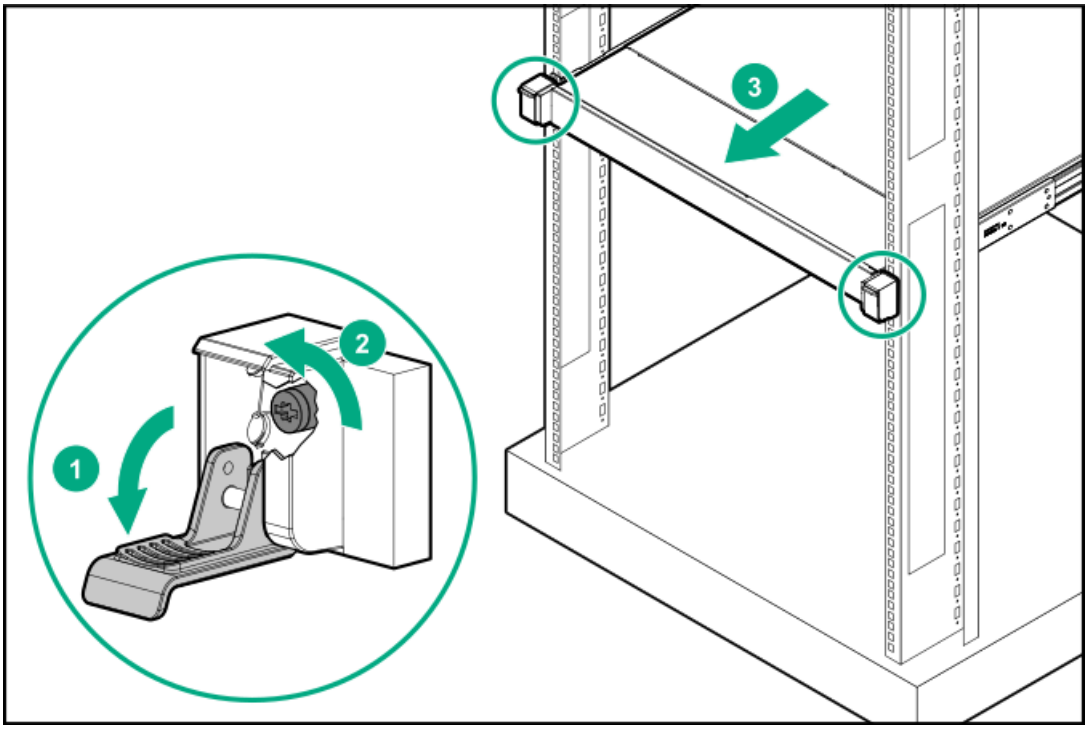
- Before you perform this procedure, review the:
  - Rack warnings and cautions
  - Server warnings and cautions
- A fully populated server is heavy. Hewlett Packard Enterprise recommends removing the external chassis components before removing the server from the rack.
- Before you perform this procedure, make sure that you have a T-25 Torx screwdriver available.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.

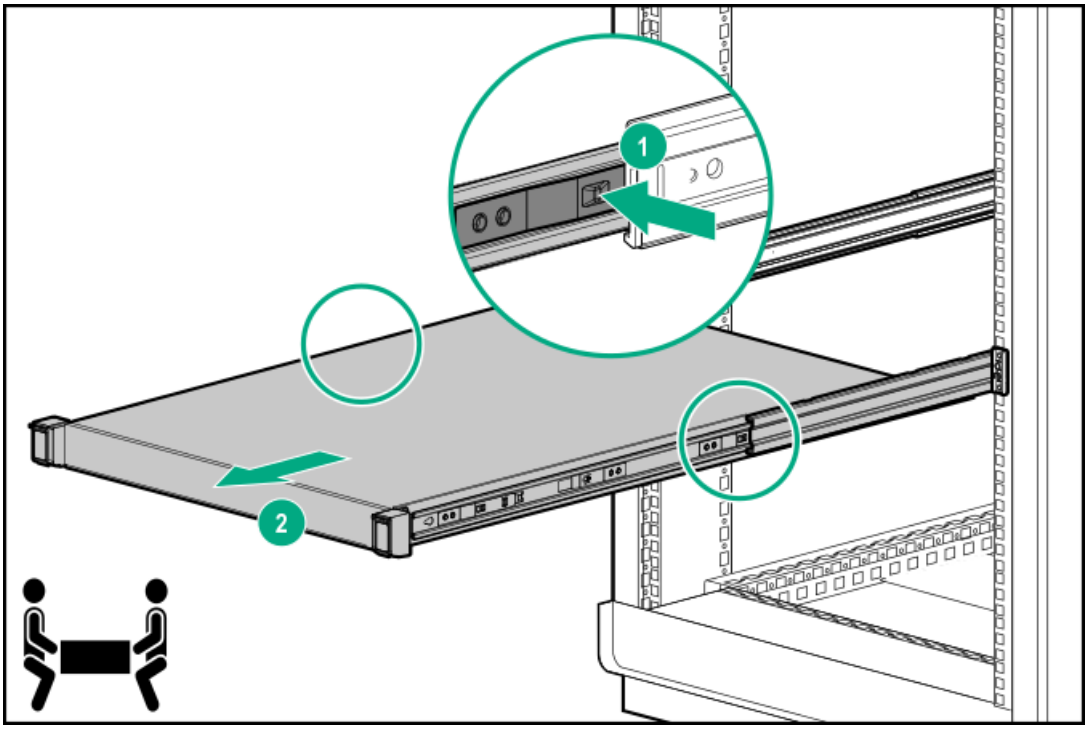


4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Extend the server from the rack:
   a. Open the chassis ear latch (callout 1).
   b. If necessary, use a T-25 Torx screwdriver to loosen the shipping screws (callout 2).
   c. Slide the server out of the rack until the server rail-release latches are engaged (callout 3).



⚠ **WARNING:** To reduce the risk of personal injury, be careful when pressing the server rail-release latches and sliding the server into the rack. The sliding rails could pinch your fingers.

7. Remove the server from the rack:
   a. Press and hold the server rail-release latches (callout 1).
   b. Pull the server from the rack (callout 2).

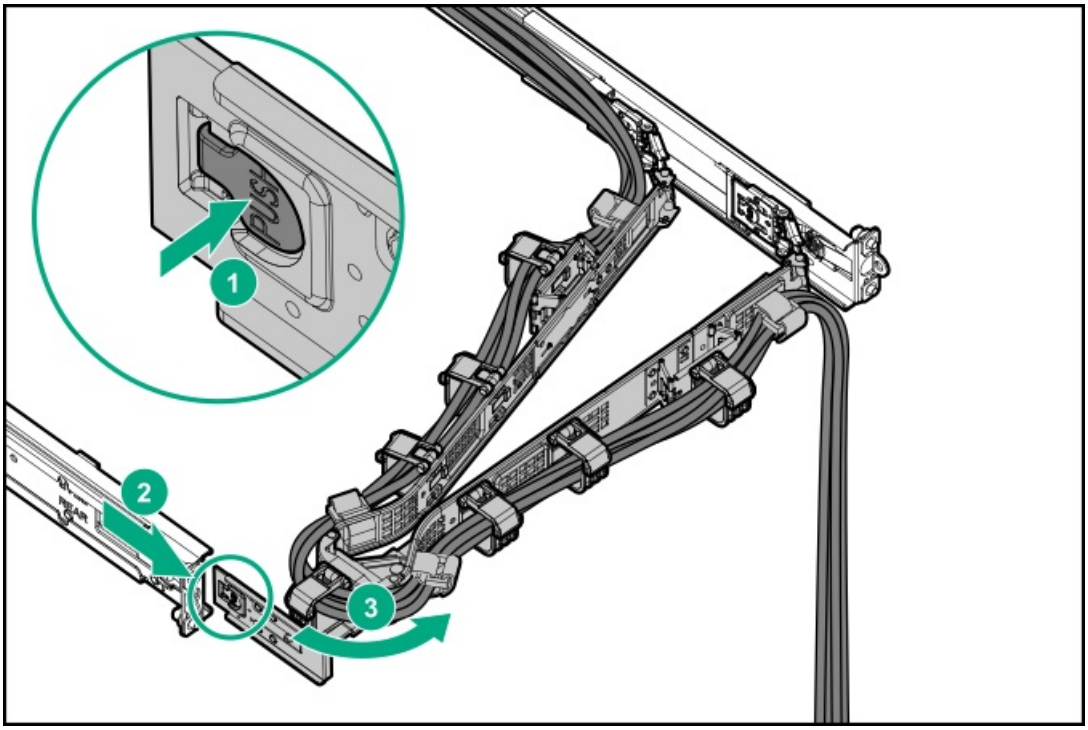


8. Place the server on a flat, level work surface.

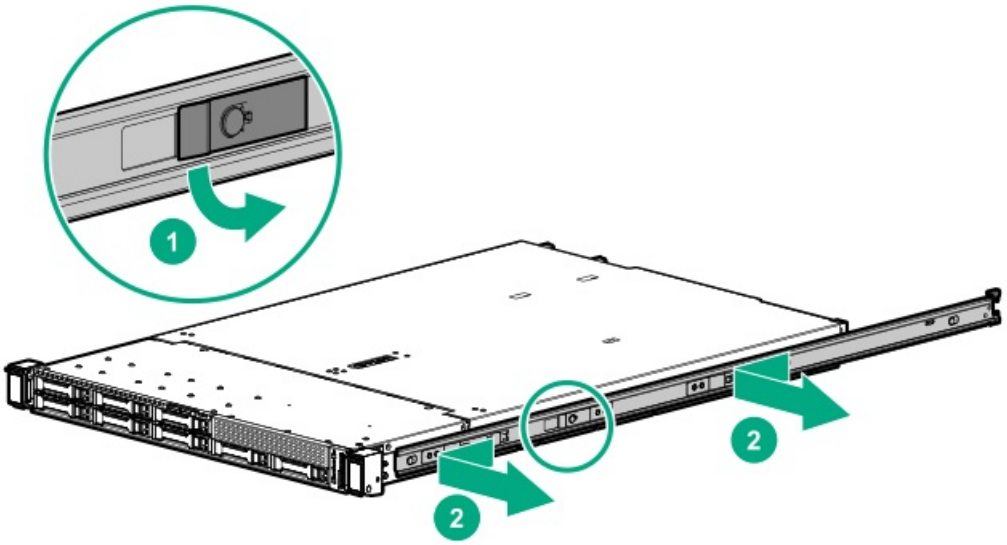
Remove the rack sliding rails

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the rack sliding rails:
   a. Pull and hold the release latch (callout 1).
   b. Slide the rail towards the front panel and pull it from the server (callout 2).



c. Repeat steps a and b to remove the other rail.

Remove the access panel

WARNING: To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

CAUTION:

To prevent damage to electrical components, properly ground the server before beginning any installation, removal, or replacement procedure. Improper grounding can cause electrostatic discharge.

CAUTION:

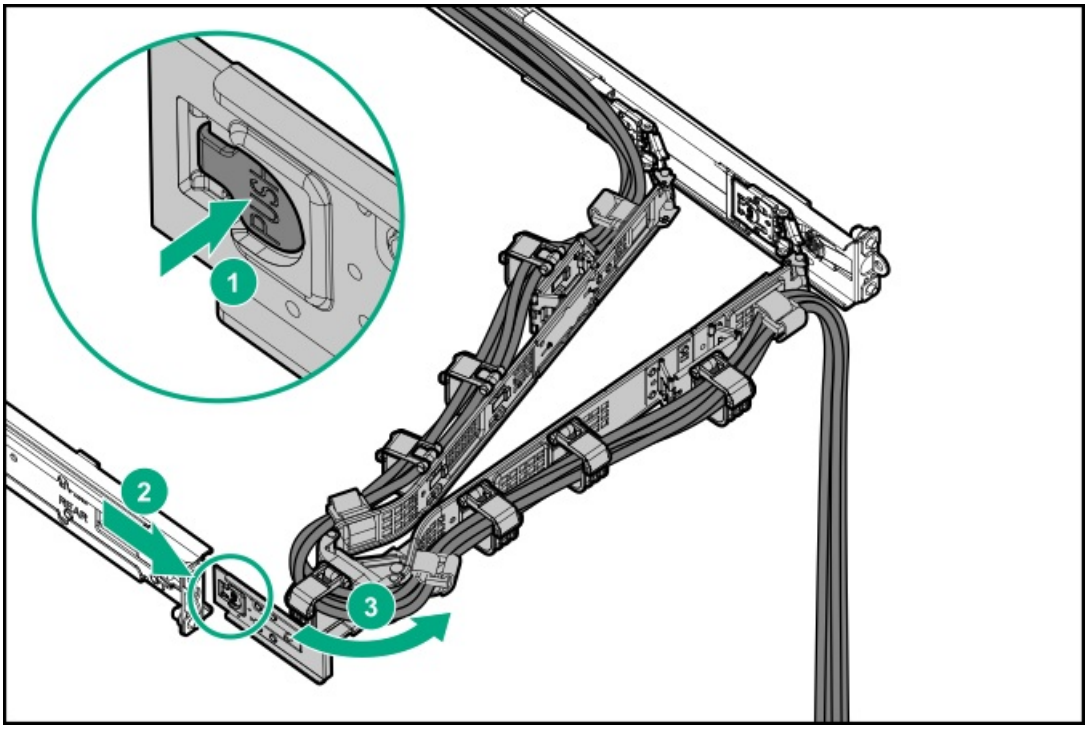
Do not operate the server for long periods with the access panel open or removed. Operating the server in this manner results in improper airflow and improper cooling that can lead to thermal damage.

Prerequisites

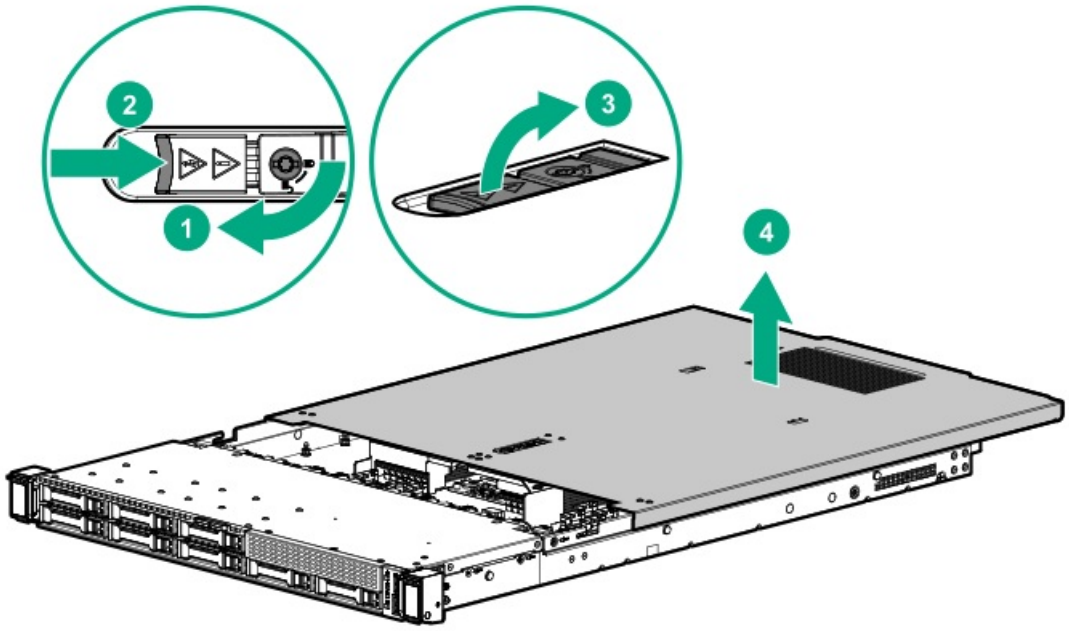
Before you perform this procedure, make sure that you have a T-15 Torx screwdriver available.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel:
   a. If necessary, unlock the access panel latch (callout 1).
   b. To disengage the access panel from the chassis, press the release button and pull up the latch (callouts 2 and 3).
   c. Lift the access panel (callout 4).


2
1
3
4

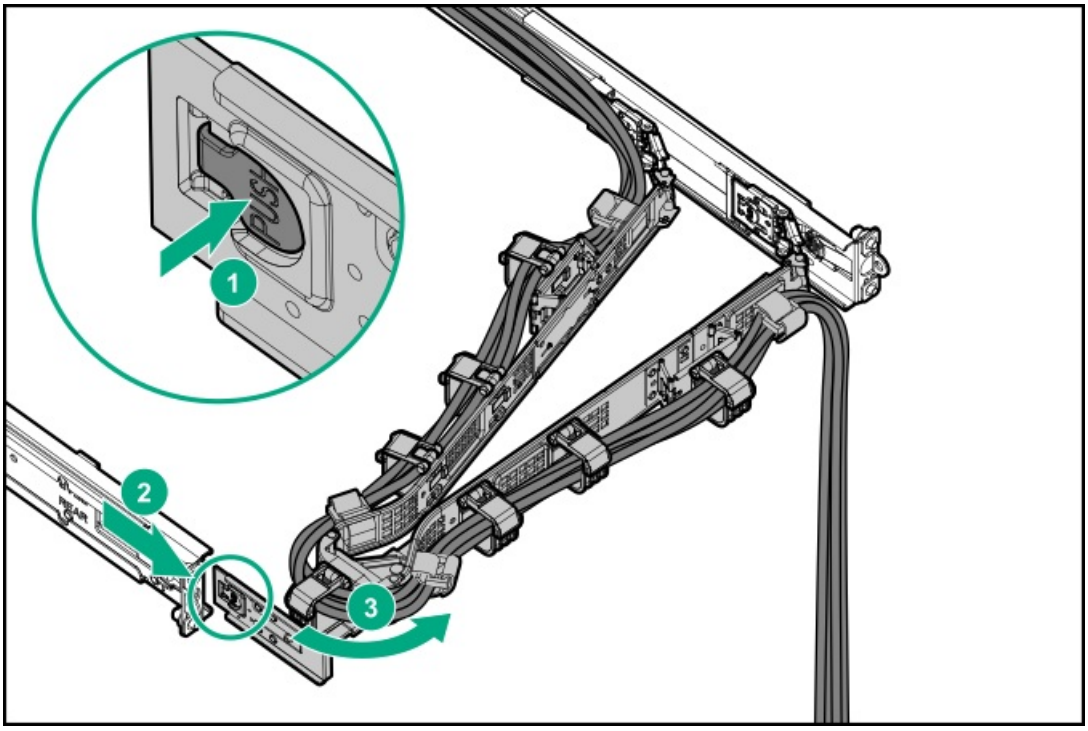
Remove the front drive cage

Prerequisites

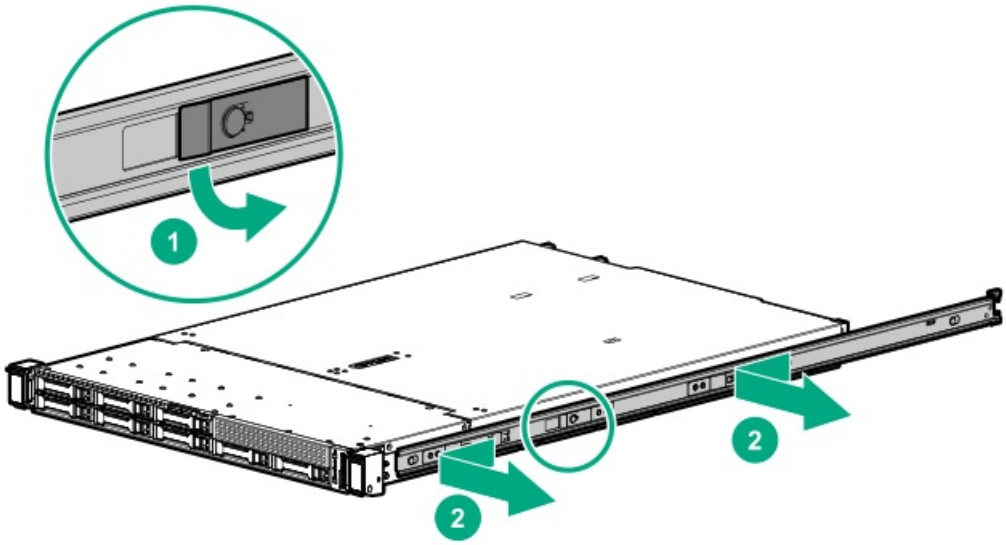
Before you perform this procedure, make sure that you have a T-10 Torx screwdriver available.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.

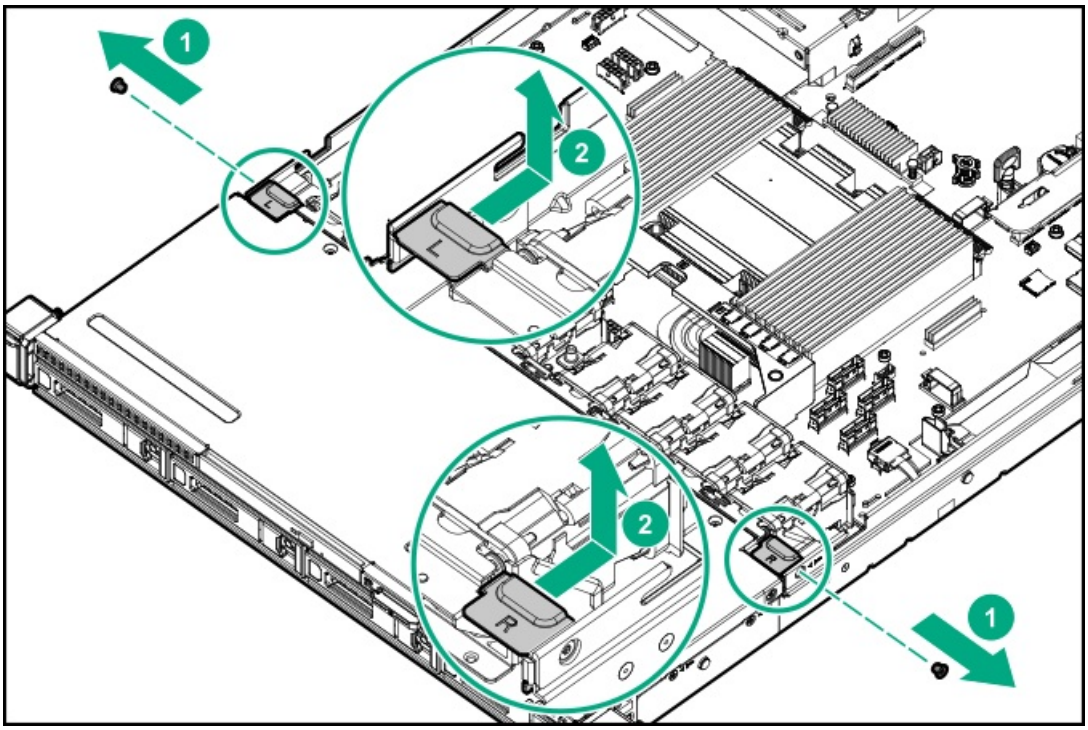


4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove the rack sliding rails.

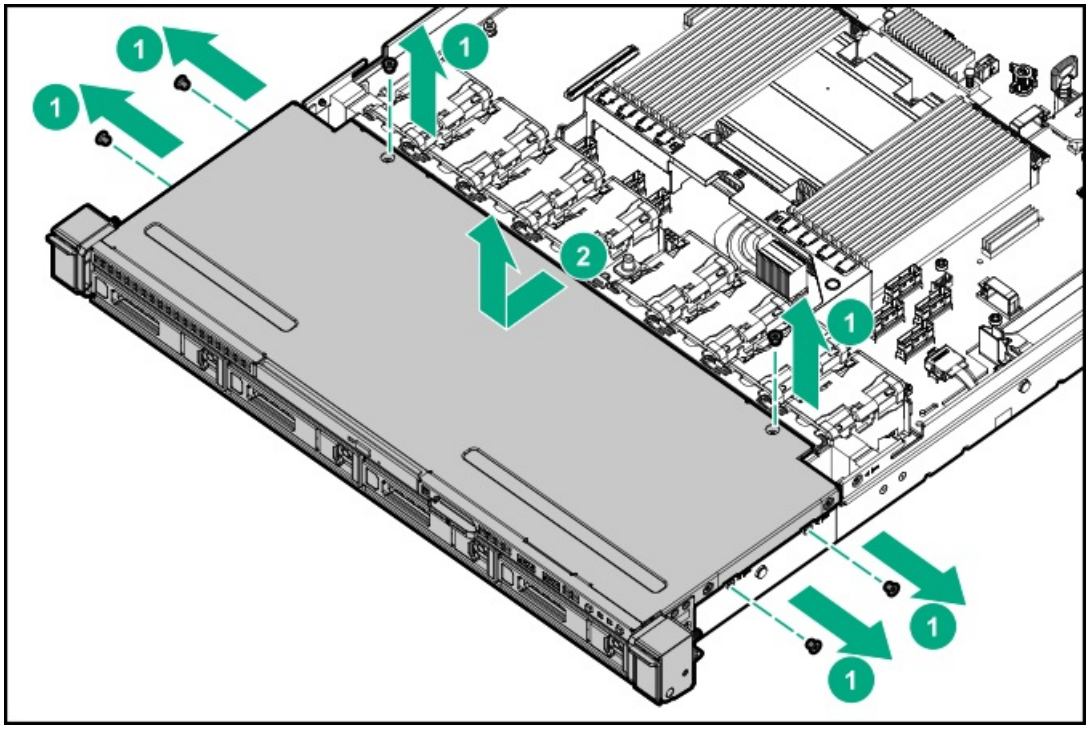


10. Disconnect the following cables from their system board and controller connectors:
    - Drive power cable
    - Storage controller cable

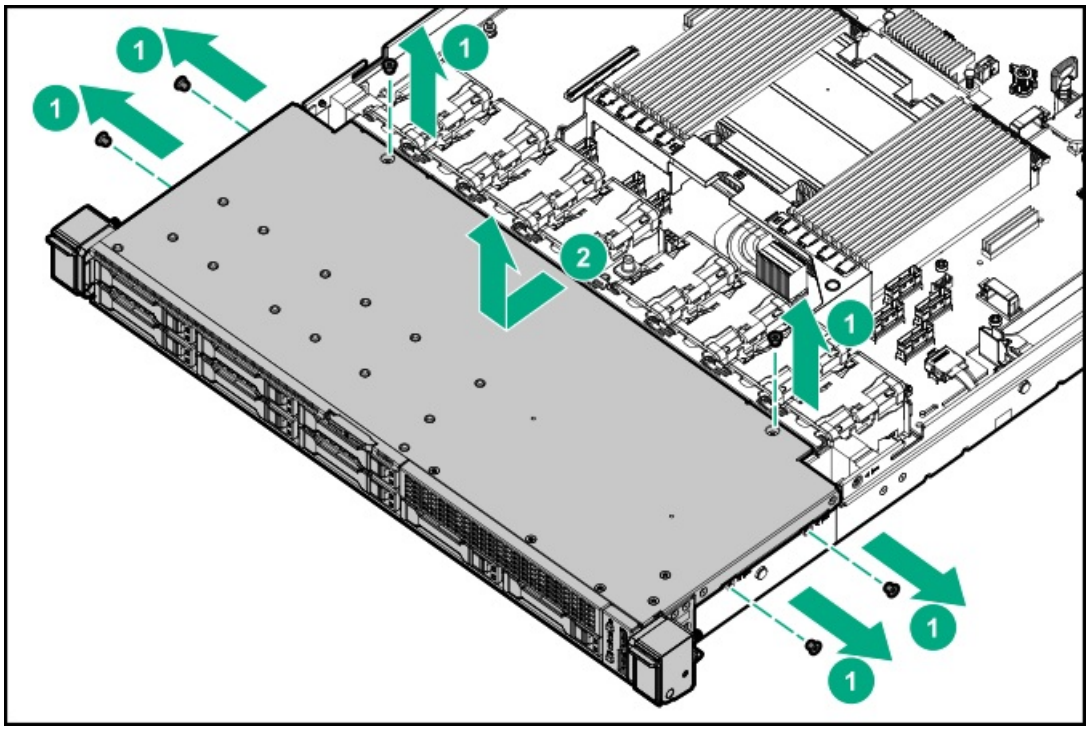
      Make sure to release the controller cables from the cable tie/clip securing them.
    - Front I/O cable
11. Remove the fan wall brackets.



12. Release the disconnected cables from the foams on both sides of the fan wall.
13. Remove the front drive cage:
    a. Remove the drive cage screws (callout 1).
    b. Slide the drive cage forward, and then lift it from the base pan of the chassis (callout 2).
    - LFF drive cage



- SFF drive cage

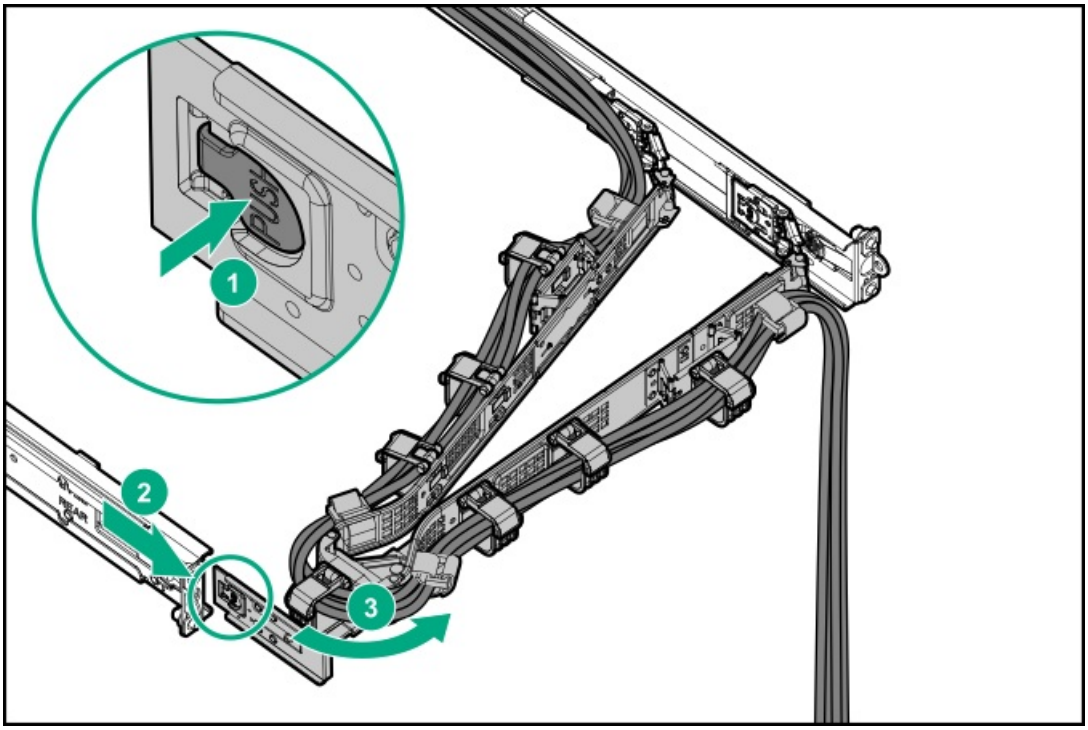


Remove the air baffle

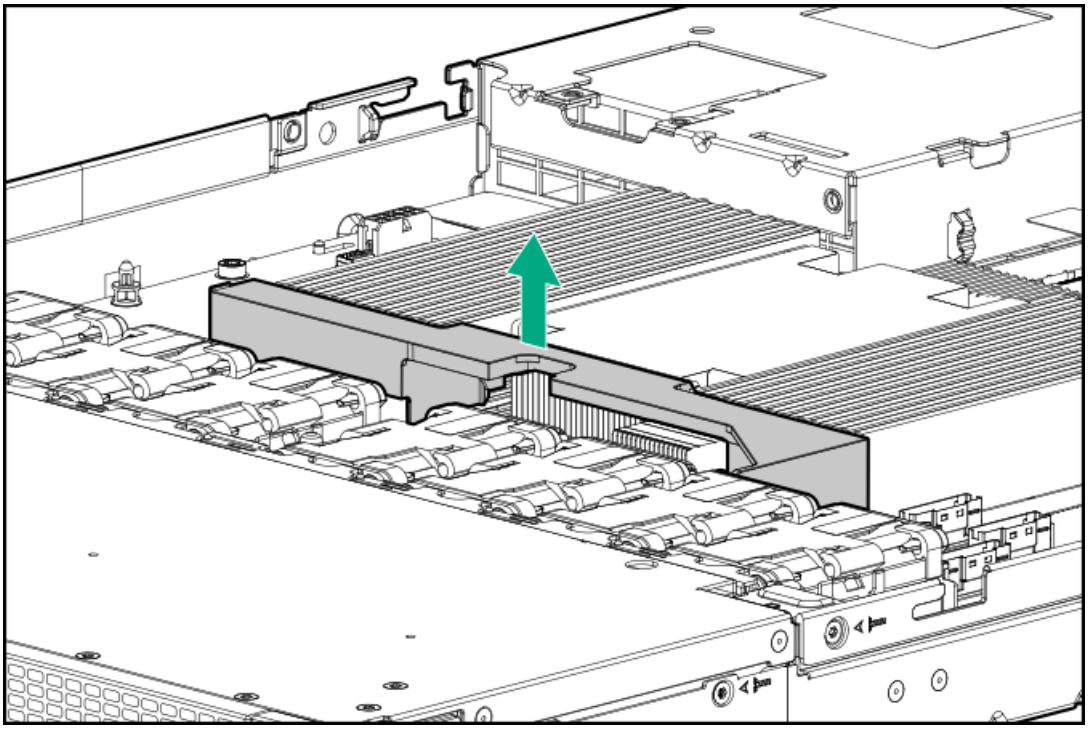
CAUTION: For proper cooling, do not operate the server without the access panel, baffles, expansion slot covers, or blanks installed. If the server supports hot-plug components, minimize the amount of time the access panel is open.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove the air baffle.

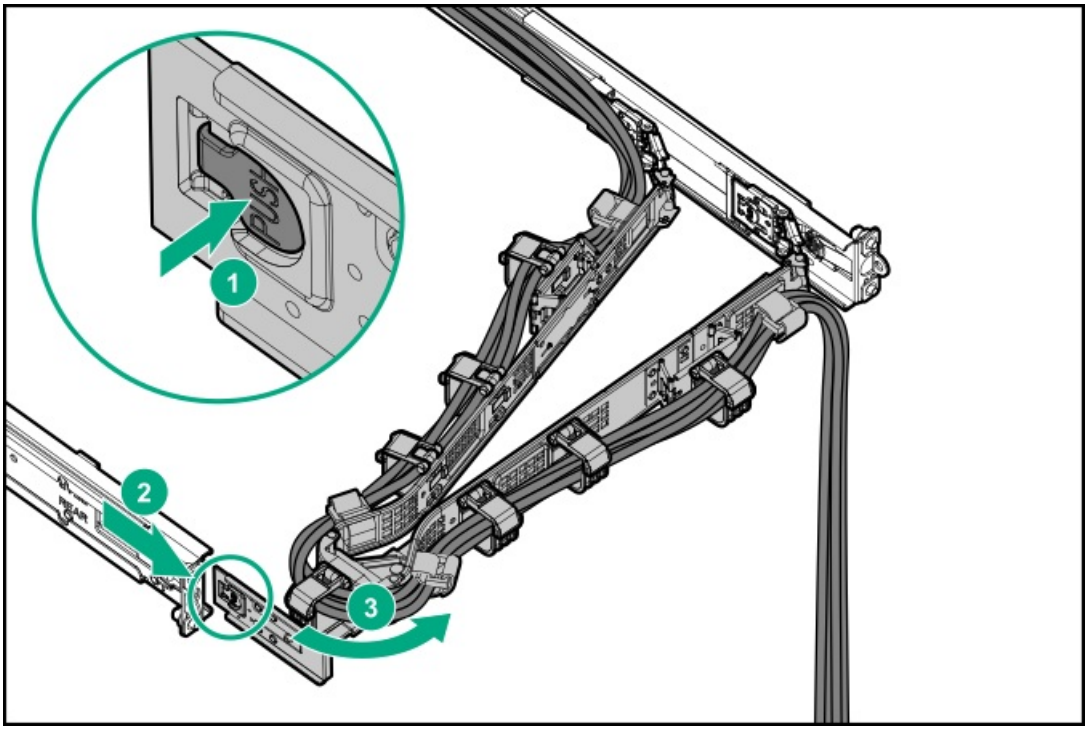


Remove the riser cage

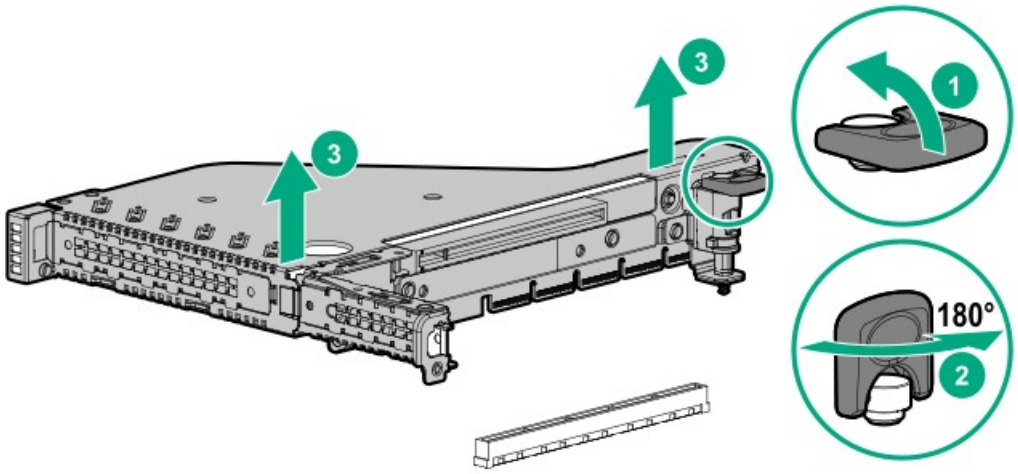
> ⚠ **WARNING:** To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

Procedure

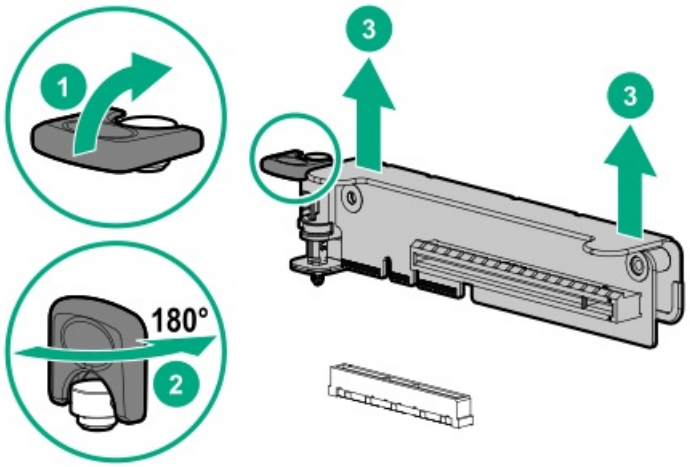
1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. If an expansion card with internal cables is installed on the riser, disconnect the cables from the card.
10. Release the half-turn spring latch (callouts 1 and 2), and then lift the riser cage off the system board (callout 3).
    - Primary riser cage



- Secondary riser cage



Power up the server

To power up the server, use one of the following methods:

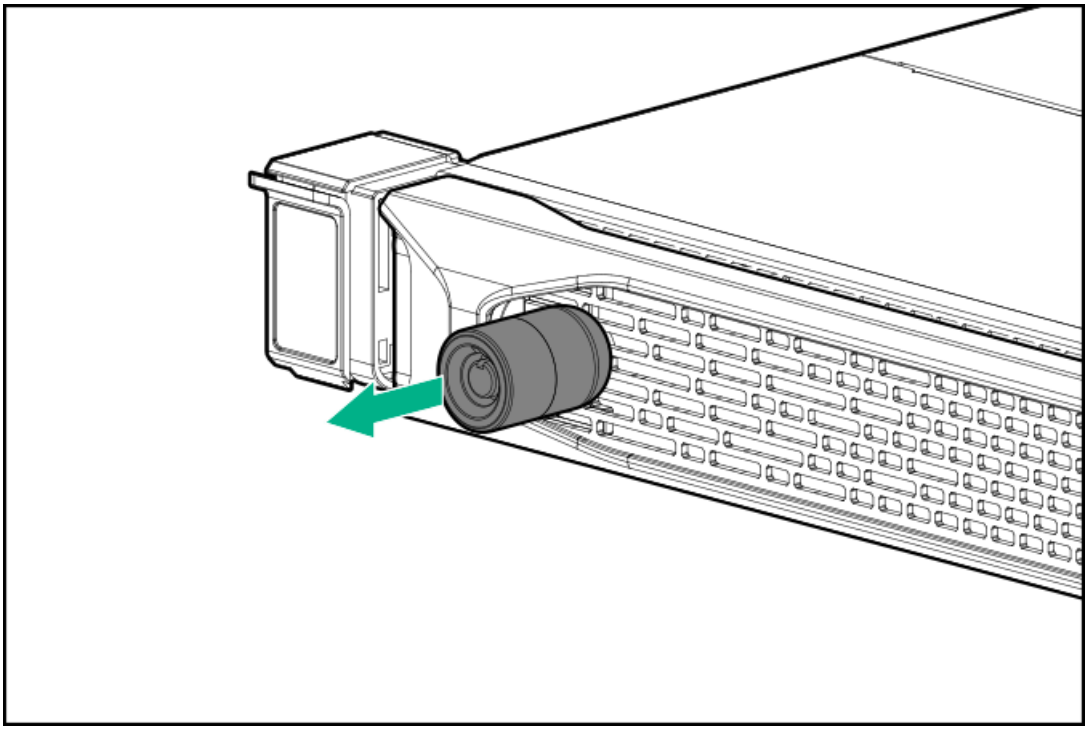
- Press the Power On/Standby button.
- Use the virtual power button through iLO 5.

Removing and replacing the front bezel

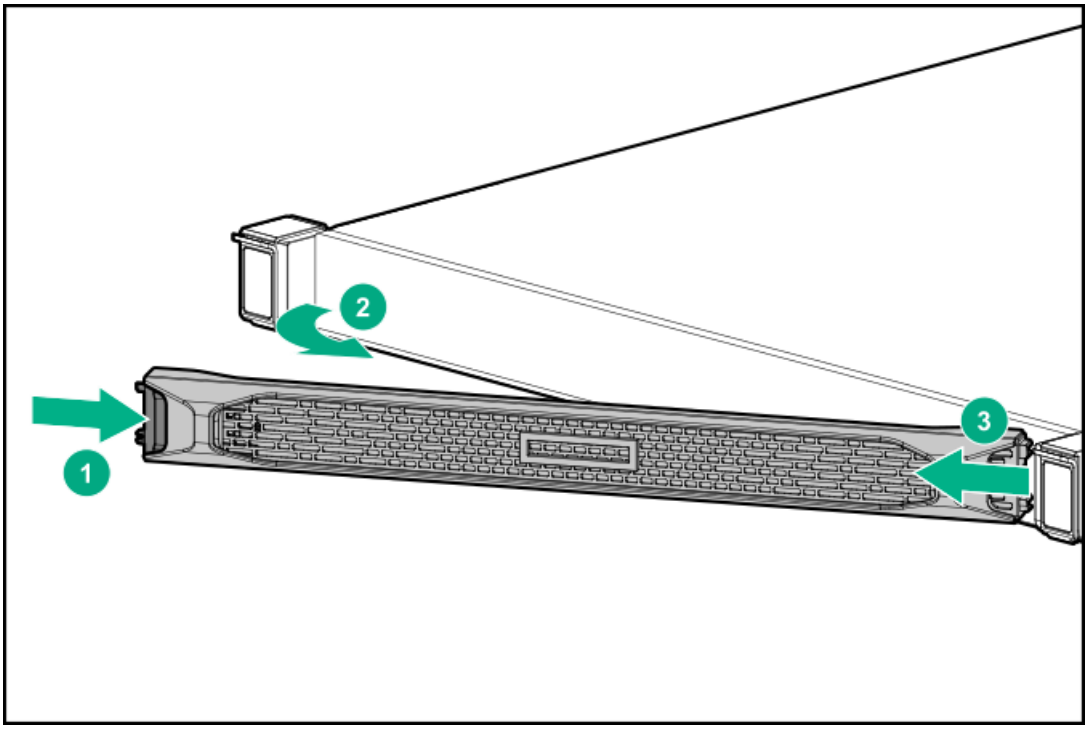
Procedure

1. If installed, remove the Kensington security lock.

   For more information, see the lock documentation.



2. Press the bezel release latch (callout 1), and then pivot the bezel open (callout 2).
3. Release the right side of the bezel from the front panel.



To replace the component, reverse the removal procedure.

Removing and replacing a hot-plug SAS, SATA or NVMe drive

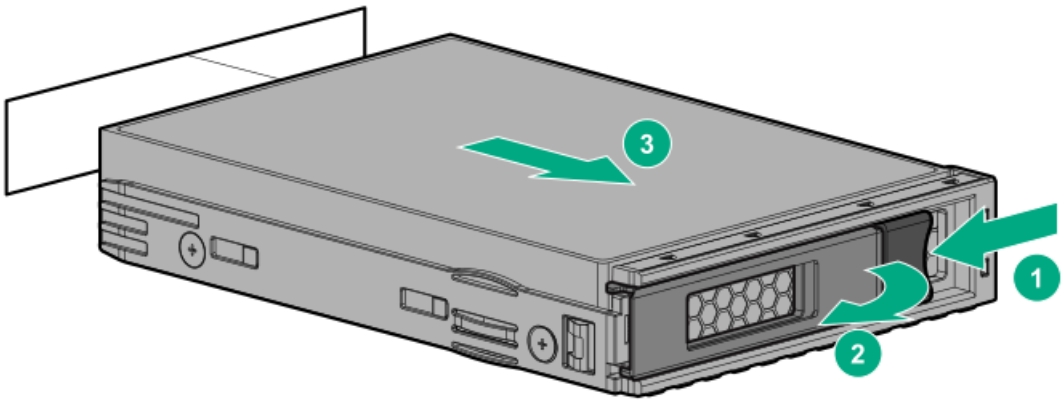
CAUTION:

A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

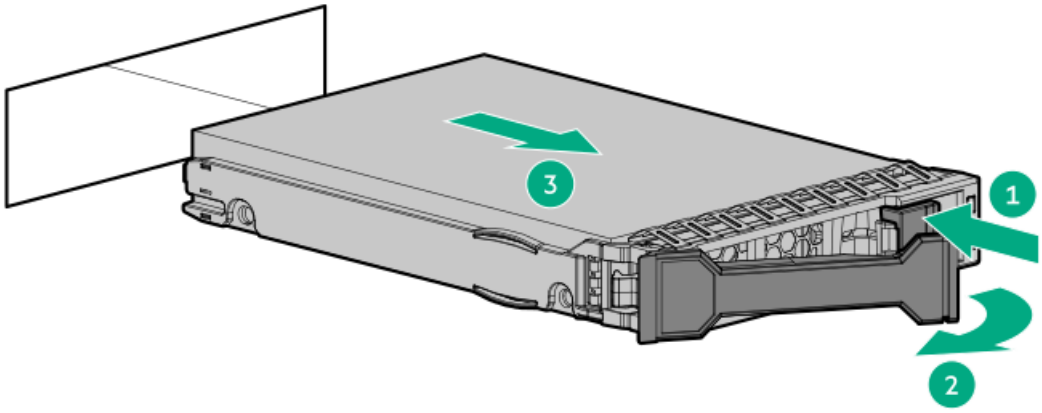
CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

Procedure

1. Back up all server data on the drive.
2. If installed, remove the front bezel.
3. Observe the drive LED status and determine if the drive can be removed.
4. Remove the drive.
   - LFF drive



   - SFF drive



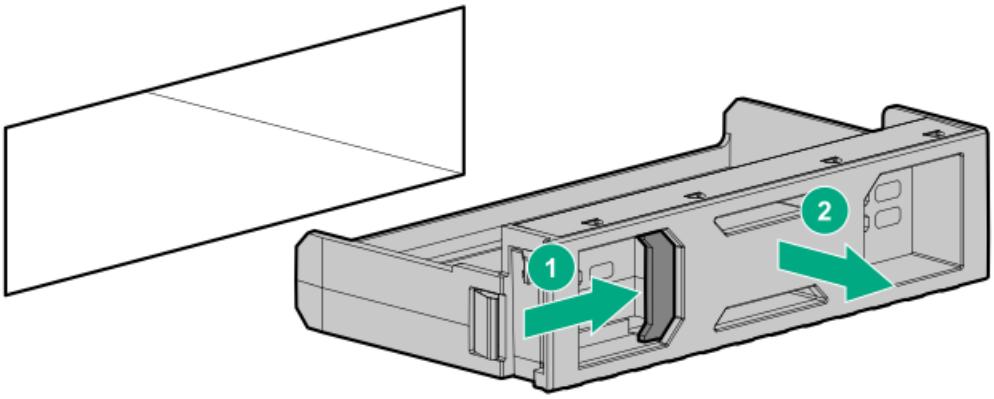
To replace the component, reverse the removal procedure.

Removing and replacing a drive blank

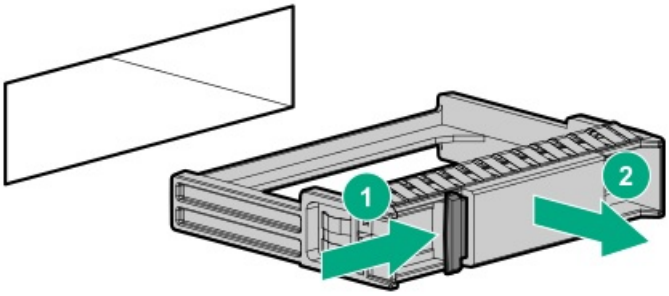
CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

Procedure

1. If installed, remove the front bezel.
2. Remove the drive blank.
   - LFF drive blank



   - SFF drive blank



To replace the component, reverse the removal procedure.

Removing and replacing the optical drive blank

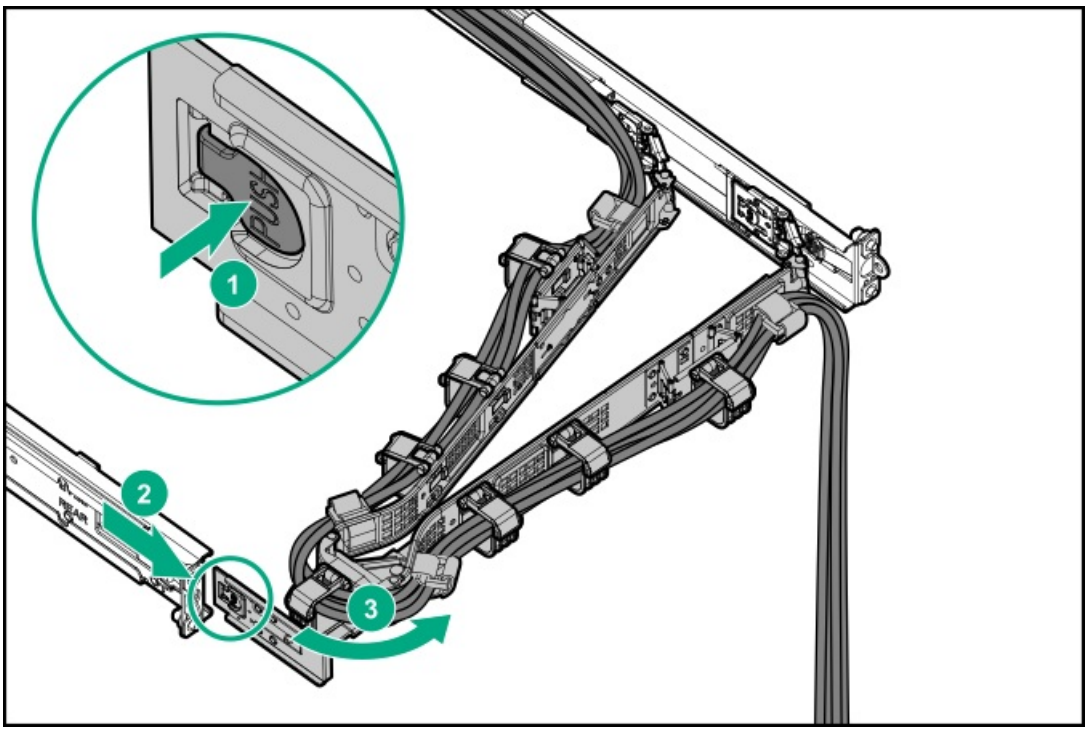
This procedure is only applicable in the LFF drive chassis.

Prerequisites

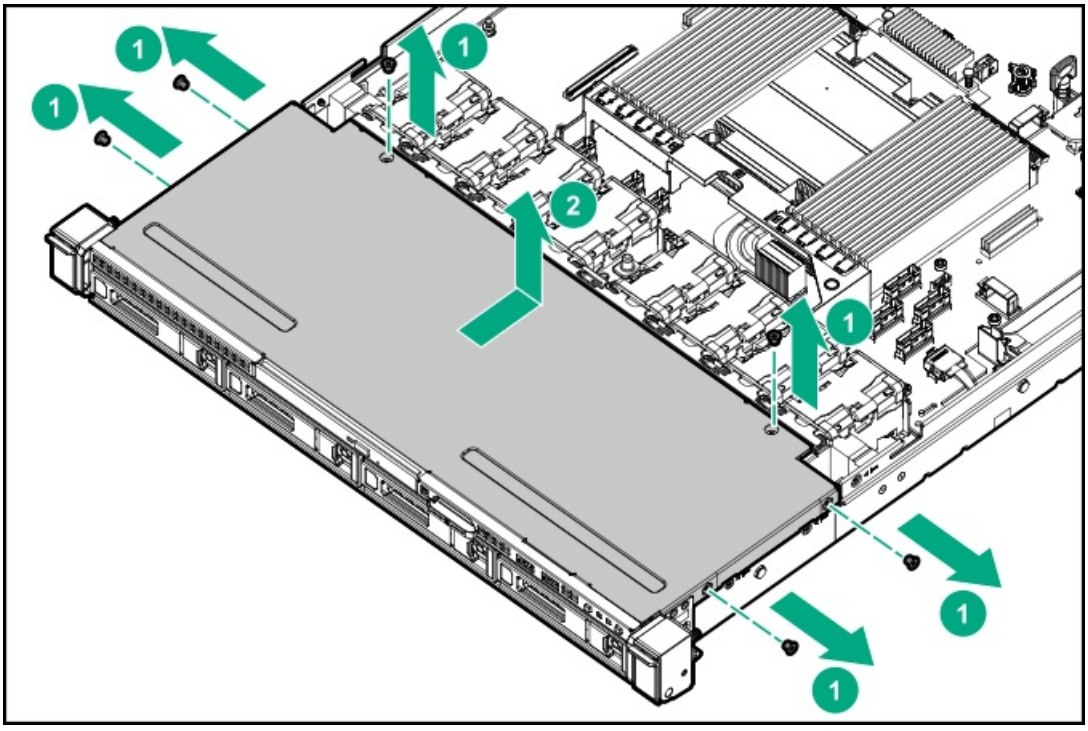
Before you perform this procedure, make sure that you have a T-10 Torx screwdriver available.

Procedure

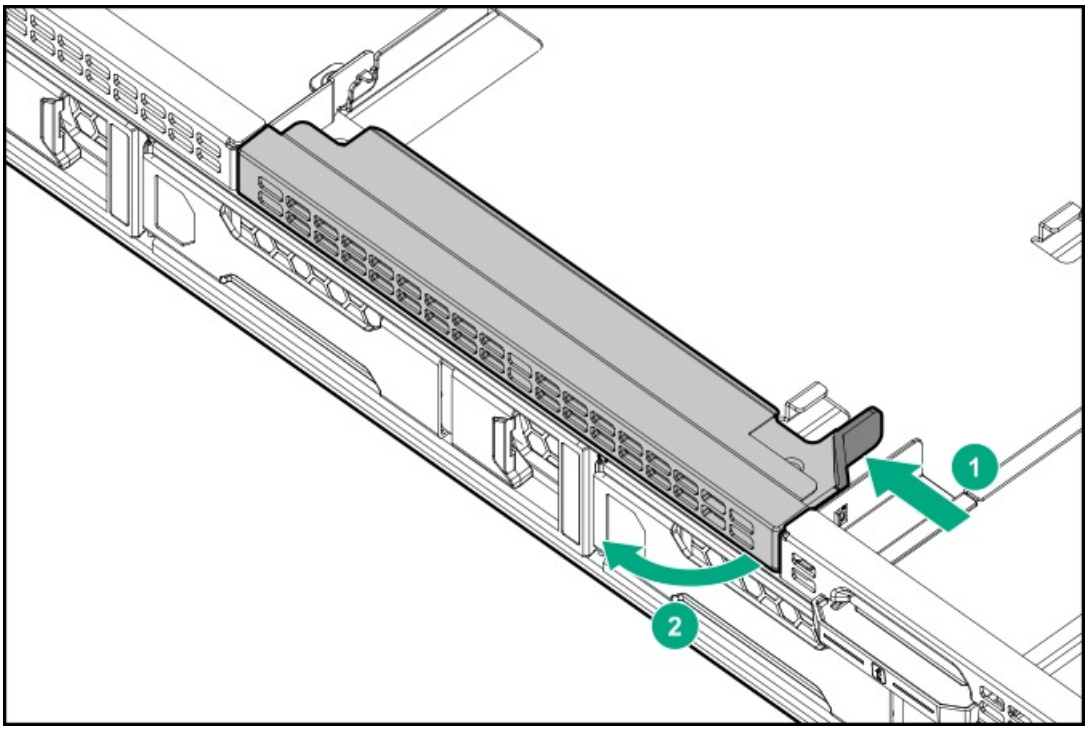
1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the front drive cage cover.



9. Remove the optical drive blank.



To replace the component, reverse the removal procedure.

Removing and replacing the universal media bay blank

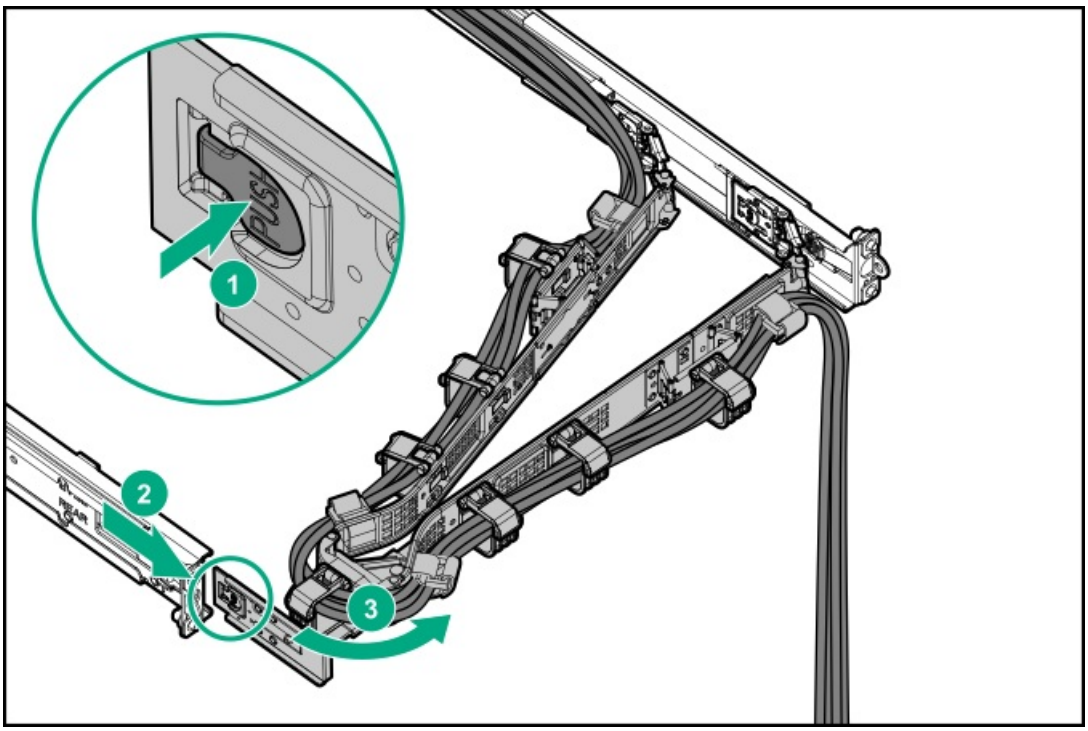
This procedure is only applicable in the SFF drive chassis.

Prerequisites

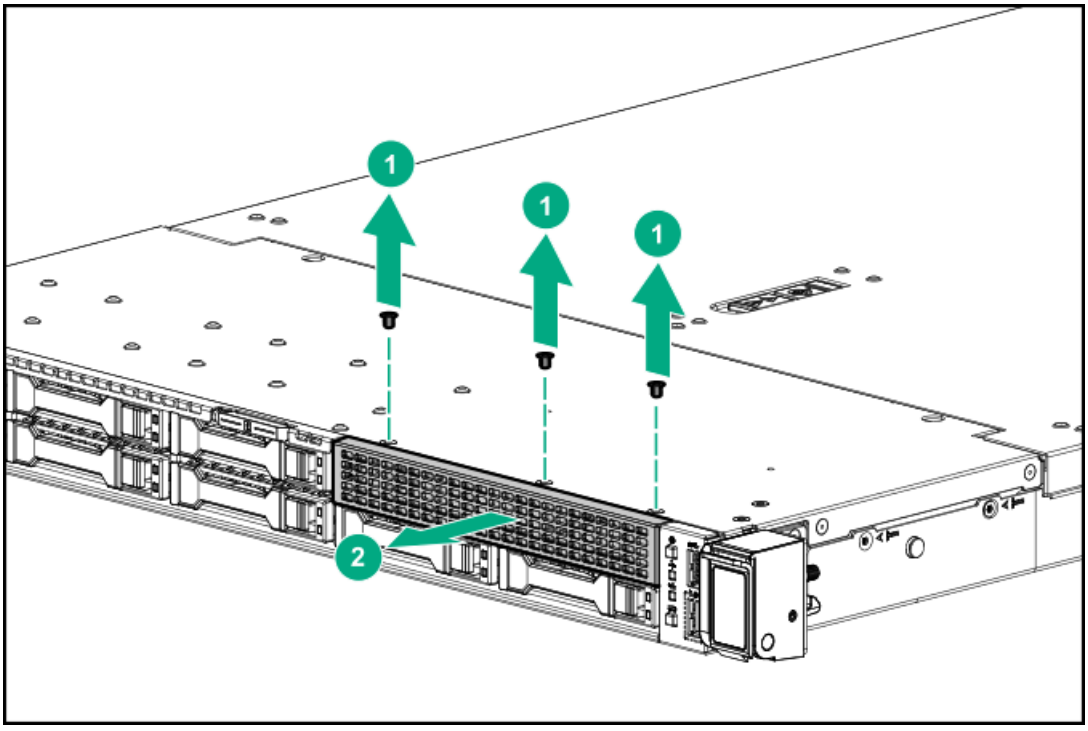
Before you perform this procedure, make sure that you have a T-10 Torx screwdriver available.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the universal media bay blank.



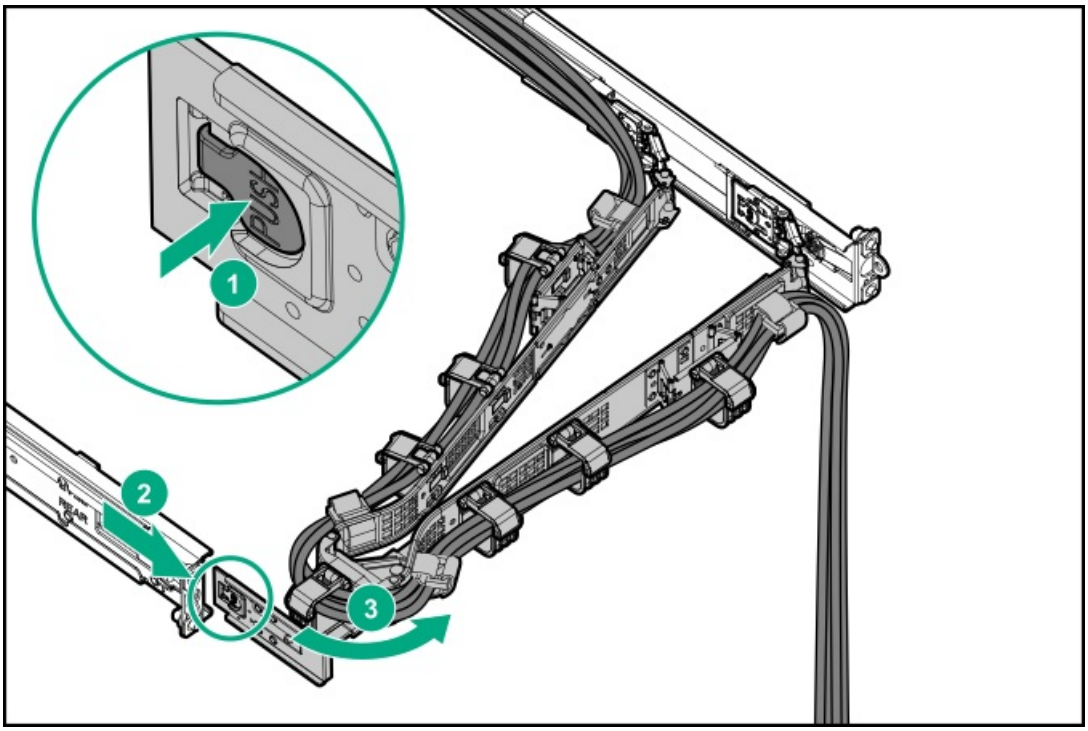
To replace the component, reverse the removal procedure.

Removing and replacing the cable management arm

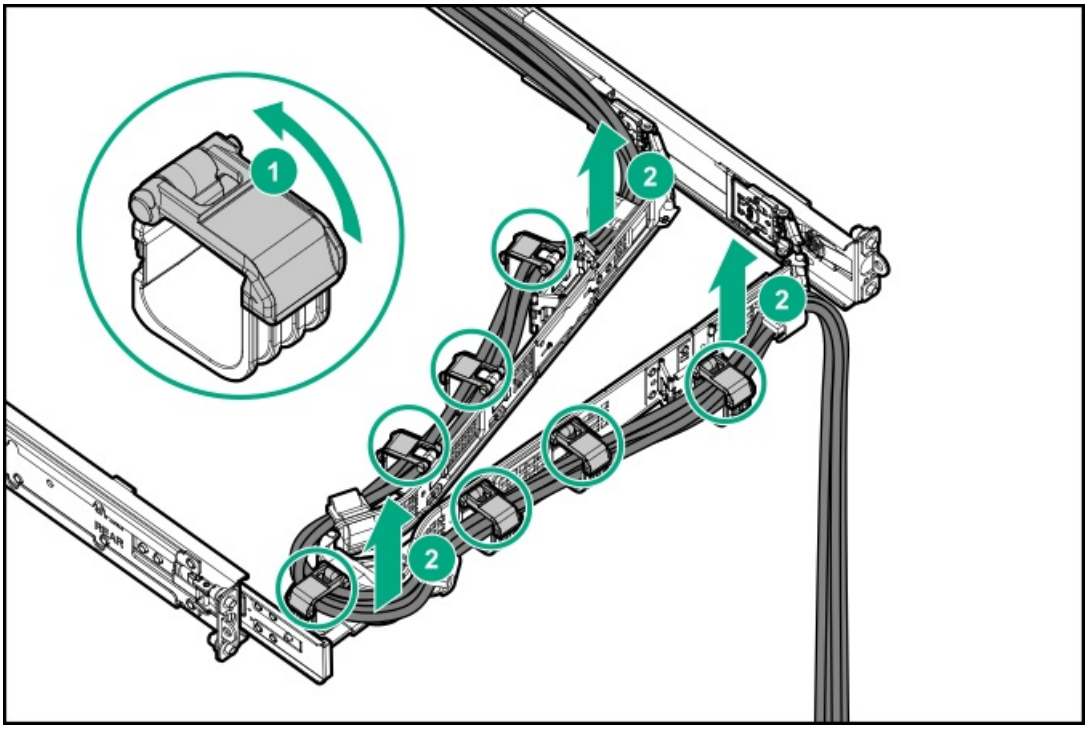
> **CAUTION:**
> Support the CMA during the removal and replacement procedures. Do not allow the CMA to hang by its own weight during the procedure.

Procedure

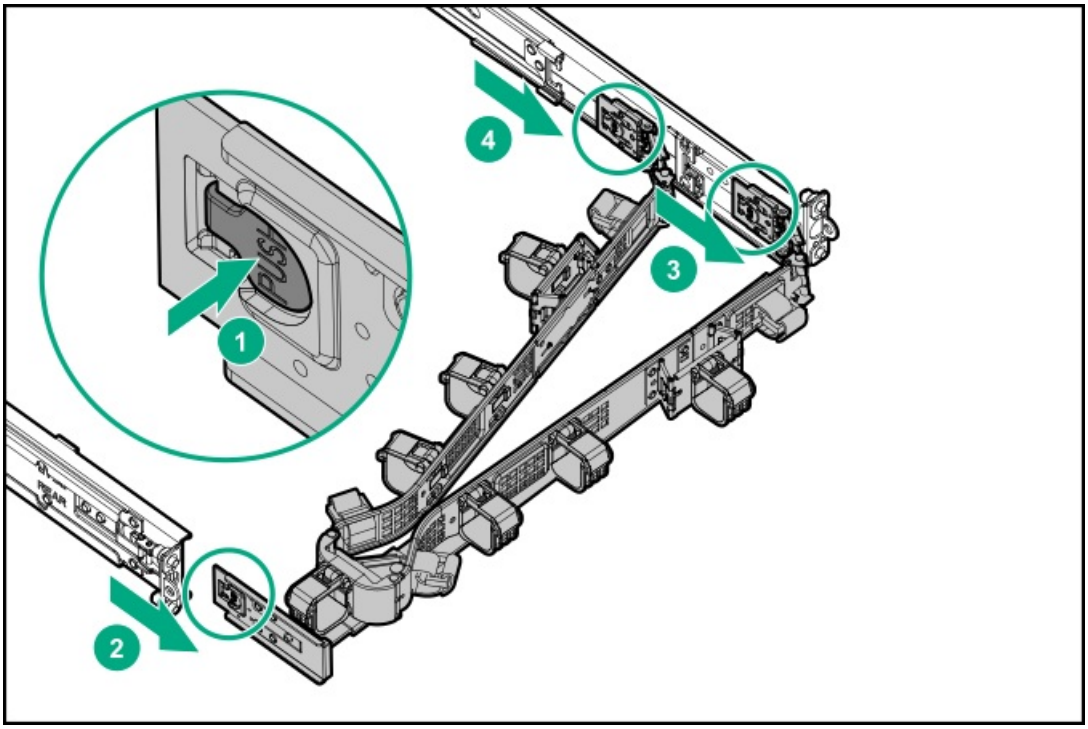
1. Release the cable management arm and then swing the arm away from the rack.



2. Open the cable clamps and remove the cables routed through the CMA.



3. Remove the cable management arm:
   a. Release the CMA stop bracket (callouts 1 and 2).
   b. Release the CMA mounting brackets (callouts 3 and 4).



To replace the component, reverse the removal procedure.

Flexible Slot power supply replacement

Depending on the configuration and the regional location where the server was purchased, the server can be configured with one of the supported power supplies.

Power supply warnings and cautions

⚠ **WARNING:**
To reduce the risk of electric shock or damage to the equipment:

- Do not disable the power cord grounding plug. The grounding plug is an important safety feature.
- Plug the power cord into a grounded (earthed) electrical outlet that is easily accessible at all times.
- Unplug the power cord from the power supply to disconnect power to the equipment.
- Do not route the power cord where it can be walked on or pinched by items placed against it. Pay particular attention to the plug, electrical outlet, and the point where the cord extends from the server.

⚠ **WARNING:** To reduce the risk of injury from electric shock hazards, do not open power supplies. Refer all maintenance, upgrades, and servicing to qualified personnel

⚠ **CAUTION:** Mixing different types of power supplies in the same server might:

- Limit or disable some power supply features including support for power redundancy.
- Cause the system to become unstable and might shut down.

To ensure access to all available features, all power supplies in the same server should have the same output and efficiency ratings. Verify that all power supplies have the same part number and label color.

DC power supply warnings and cautions

⚠ **WARNING:** To reduce the risk of electric shock or energy hazards:

- This equipment must be installed by trained service personnel.
- Connect the equipment to a reliably grounded secondary circuit source. A secondary circuit has no direct connection to a primary circuit and derives its power from a transformer, converter, or equivalent isolation device.
- The branch circuit overcurrent protection must be rated 27 A.

⚠ **WARNING:** To reduce the risk of electric shock, be sure that the cable grounding kit is properly installed and connected to a suitable protective earth terminal before connecting the power source to the rack.

⚠ **CAUTION:** This equipment is designed to permit the connection of the earthed conductor of the DC supply circuit to the earthing conductor at the equipment. If this connection is made, all the following must be met:

- This equipment must be connected directly to the DC supply system earthing electrode conductor or to a bonding jumper from an earthing terminal bar or bus to which the DC supply system earthing electrode conductor is connected.
- This equipment must be located in the same immediate area (such as adjacent cabinets) as any other equipment that has a connection between the earthed conductor of the same DC supply circuit and the earthing conductor, and also the point of earthing of the DC system. The DC system must be earthed elsewhere.
- The DC supply source is to be located within the same premises as the equipment.
- Switching or disconnecting devices must not be in the earthed circuit conductor between the DC source and the point of connection of the earthing electrode conductor.

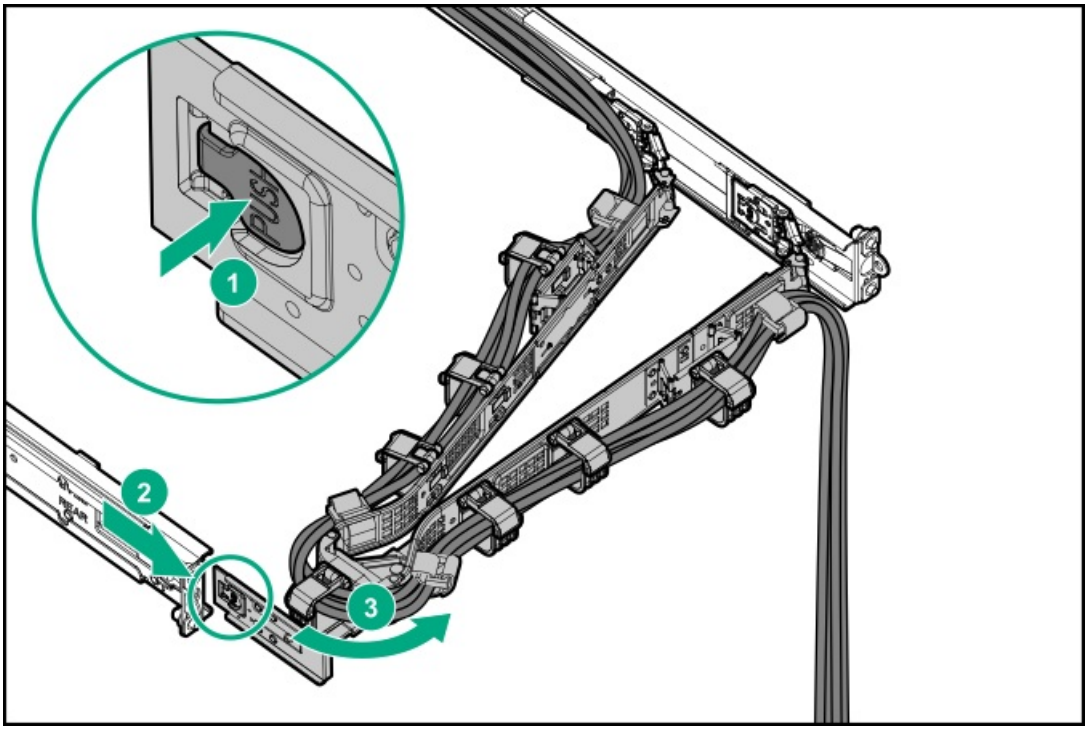
Removing and replacing a Flexible Slot power supply

Prerequisites

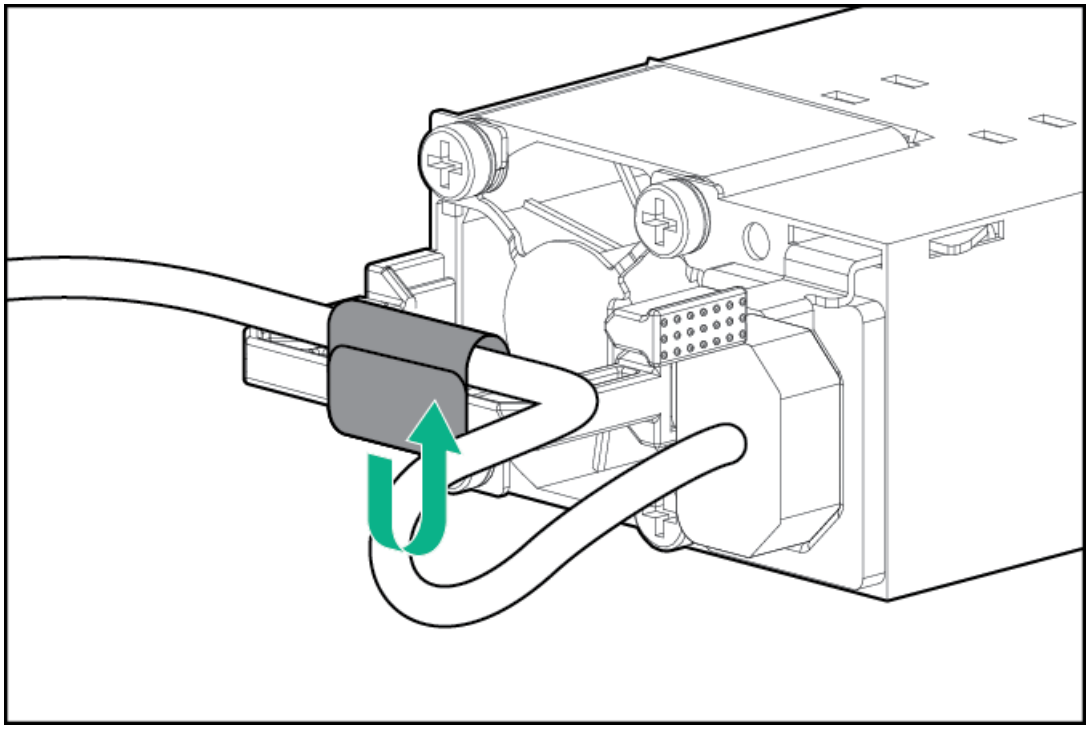
- Before replacing a power supply, review the following:
  - Power supply warnings and cautions
  - DC power supply warnings and cautions
- If you are replacing a DC power supply, make sure that you have a Phillips No.1 screwdriver available.

Procedure

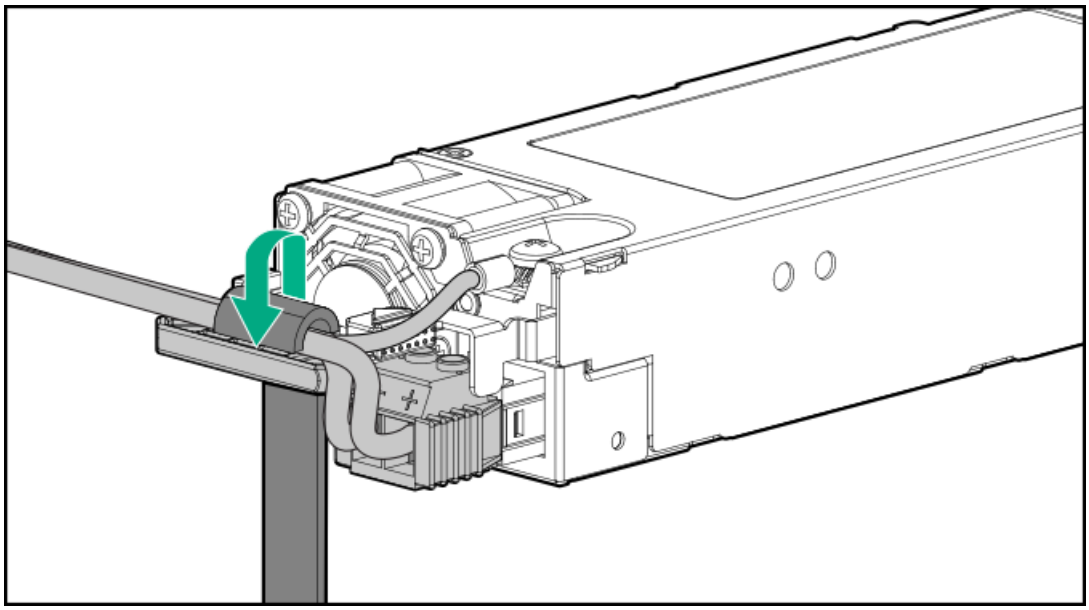
1. If the server is using a single power supply, remove all power from the server:
   a. Back up all server data.
   b. If installed, remove the front bezel.
   c. Power down the server.
2. If installed, release the cable management arm.



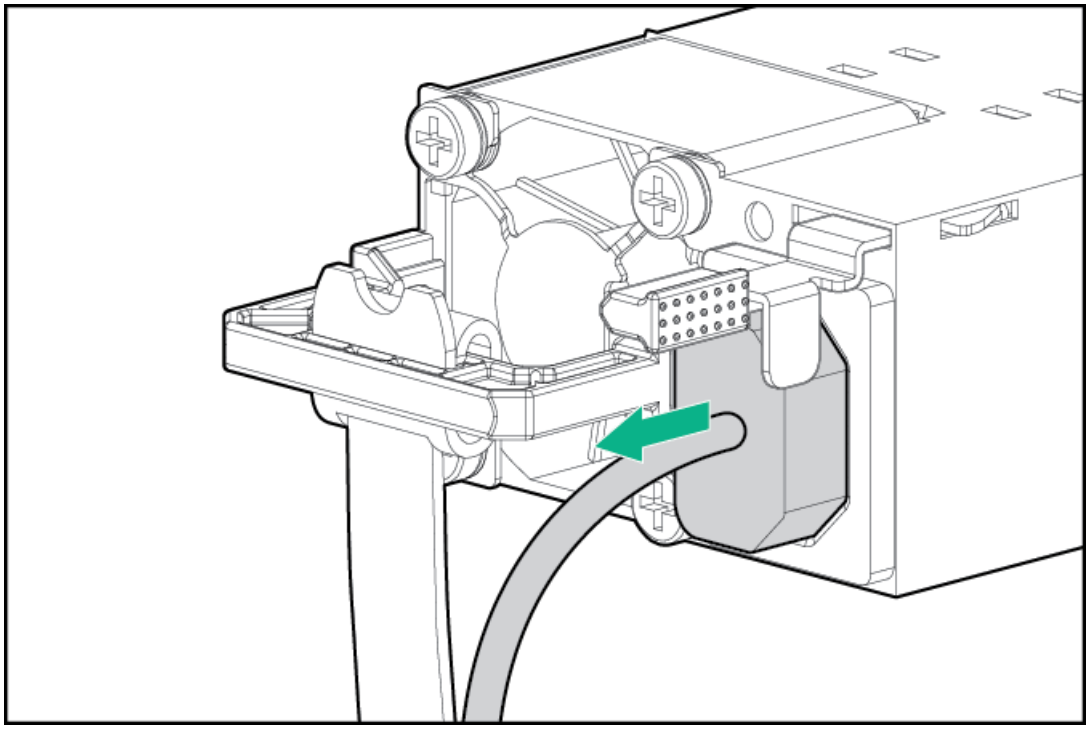
3. Release the power cords, wires, and cables from the strain relief strap.
   - AC power supply



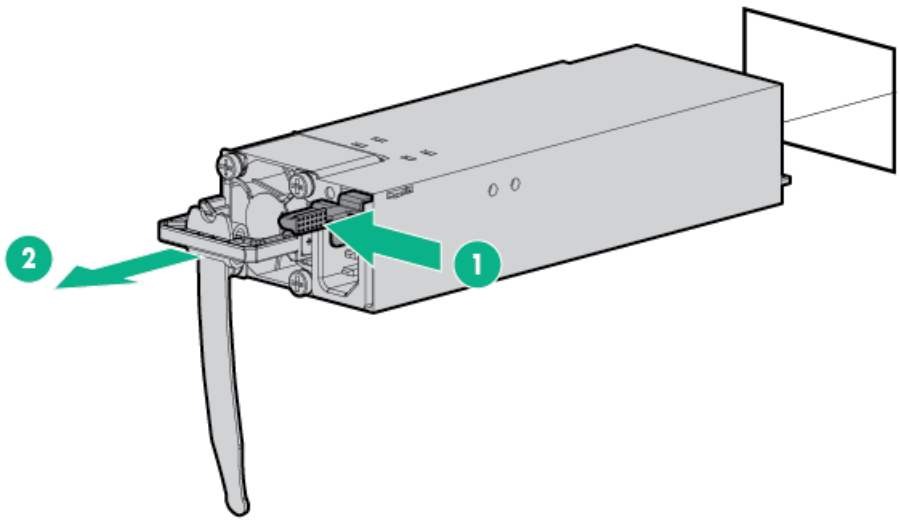
- DC power supply



4. For an AC power supply, do the following:
   a. Disconnect the power cord from the power supply.

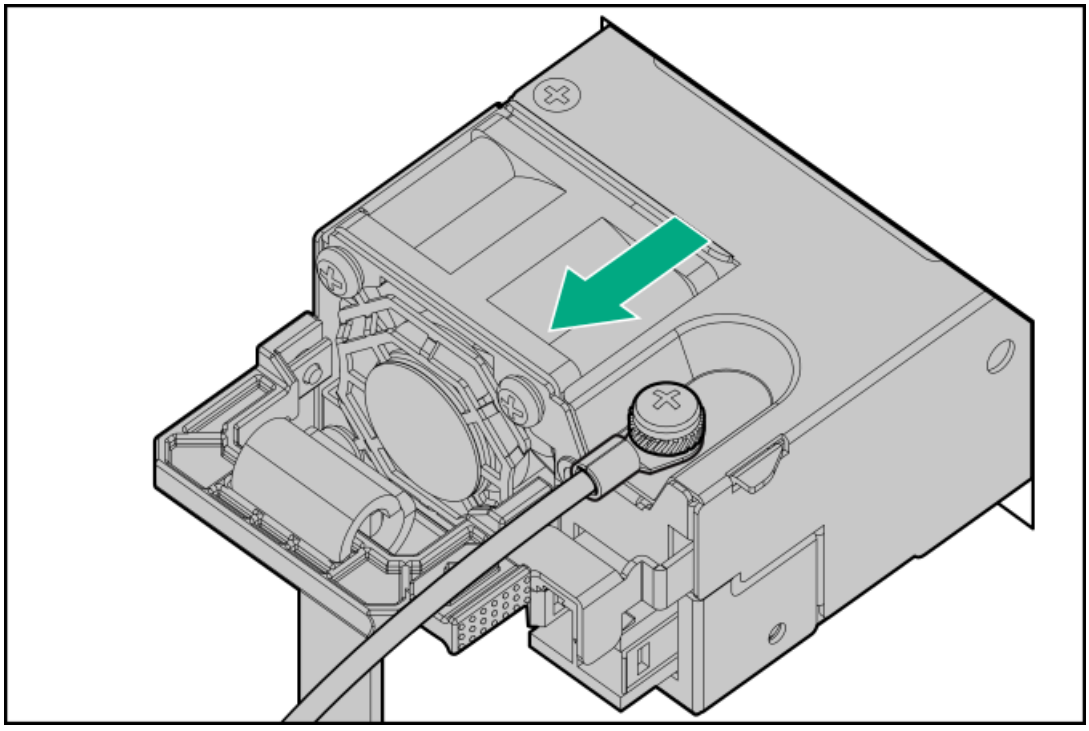


b. Remove the power supply.

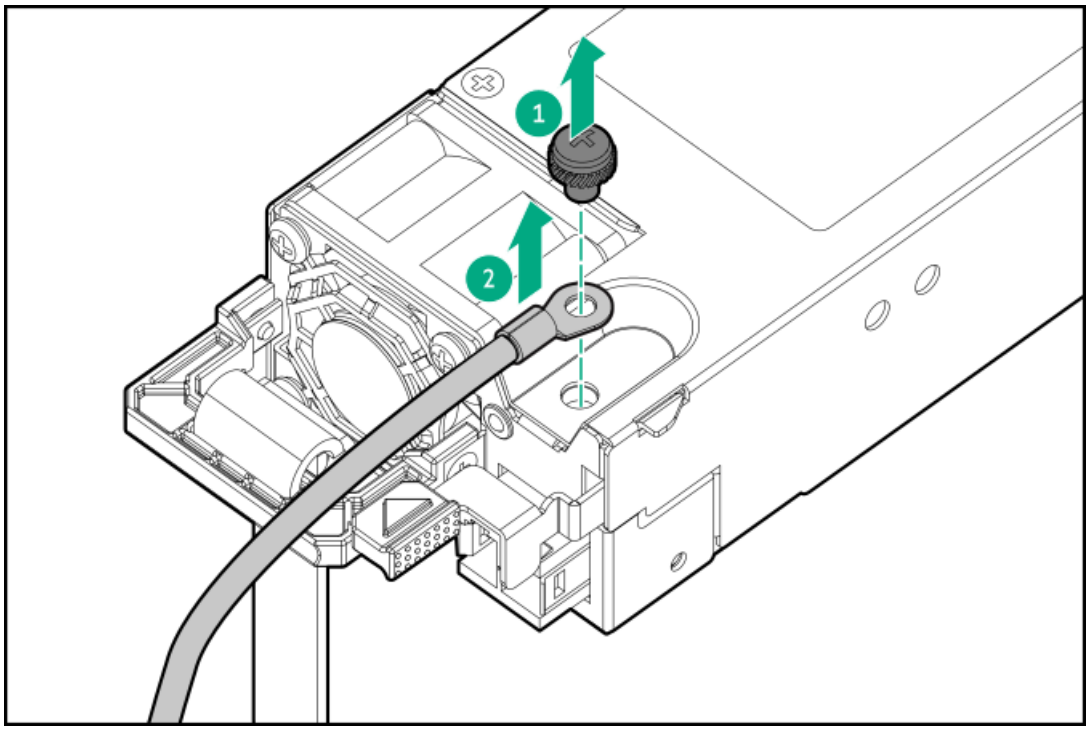


5. For a DC power supply, do the following:

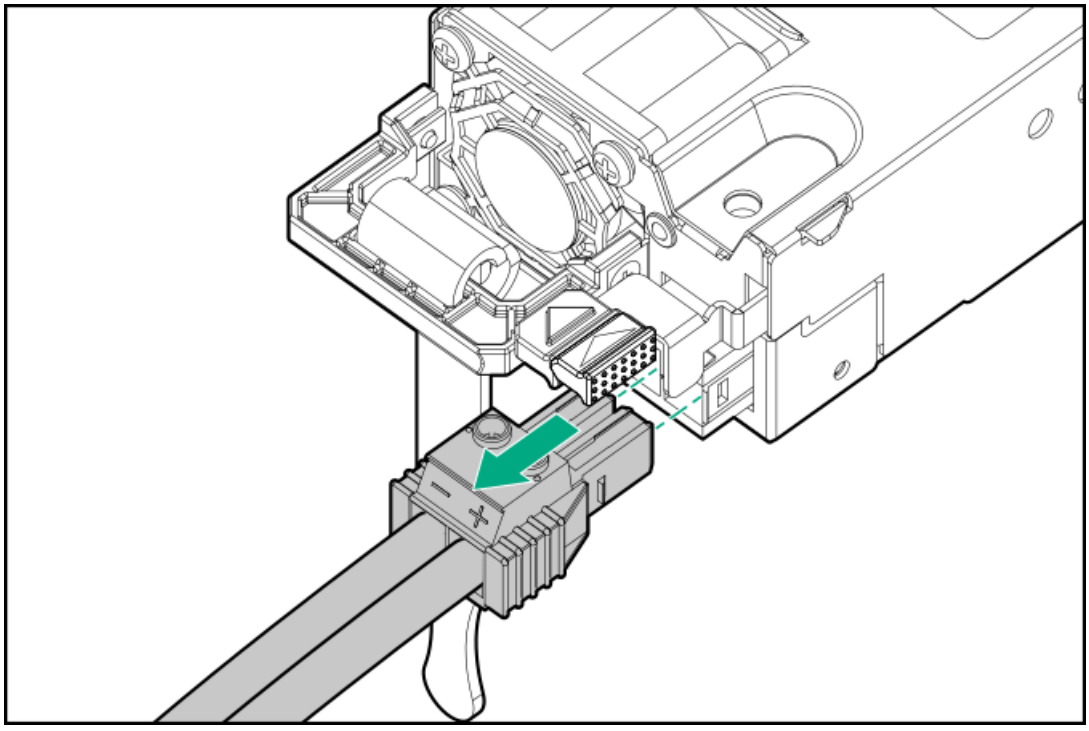
a. Slide the power supply out of the bay just enough to access the ground cable screw.



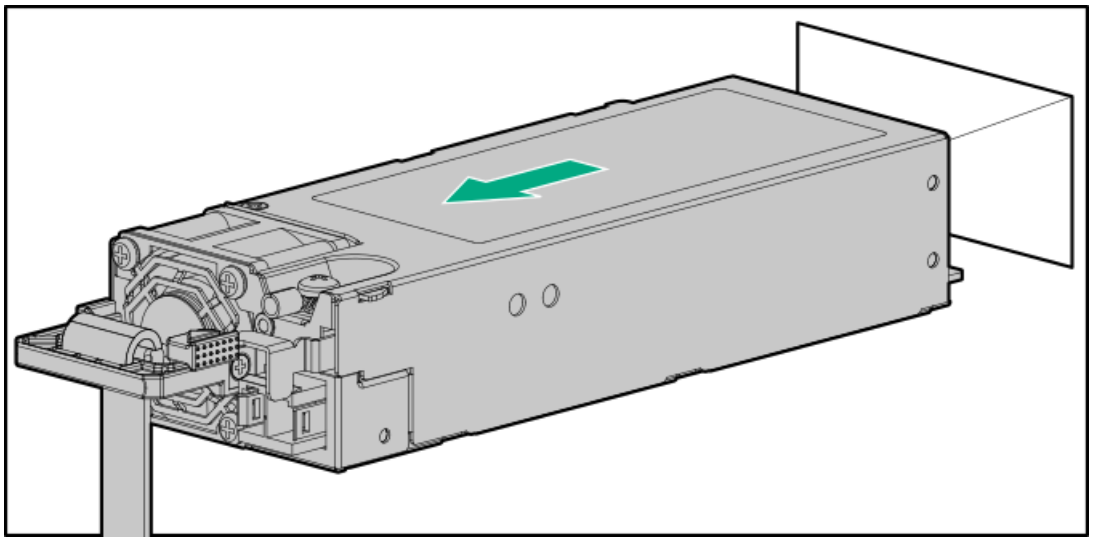
b. Remove the ground (earthed) cable from the power supply.



c. Remove the terminal block connector from the power supply.



d. Remove the power supply.



To replace the component, reverse the removal procedure.

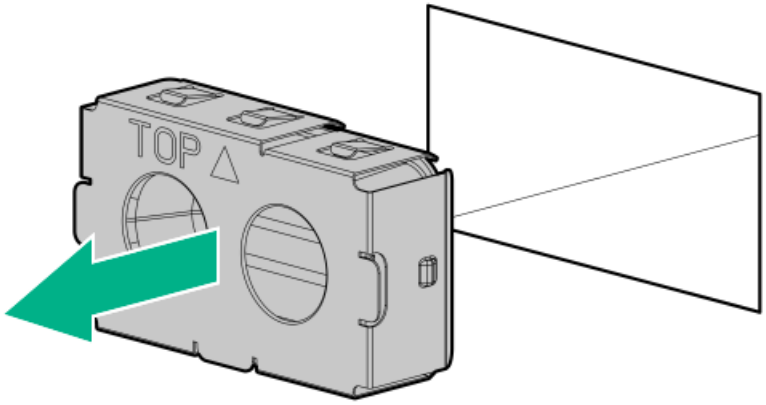
Removing and replacing a power supply blank

WARNING: To reduce the risk of personal injury from hot surfaces, allow the power supply or power supply blank to cool before touching it.

CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

Procedure

Remove the power supply blank from the bay.



To replace the component, reverse the removal procedure.

Transceiver replacement

- Transceiver warnings and cautions
- Removing and replacing a transceiver

Transceiver warnings and cautions

WARNING:

Fiber-optic transceivers and fiber-optic cables connected to transceivers emit laser light that can damage your eyes. To avoid eye injuries, avoid direct eye exposure to the beam from the fiber-optic transceiver or into the ends of fiber-optic cables when they are powered-up.

CAUTION:

The presence of dust in transceiver ports can cause poor cable connectivity. To prevent dust from entering, install a dust plug in an unused transceiver port.

CAUTION:

Supported transceivers can be hot-swapped—removed and installed while the server is powered-on. However, to prevent potential damage to the transceiver or the fiber-optic cable, disconnect the cable from the transceiver before hot-swapping it.

CAUTION:

Do not remove and install transceivers more often than is necessary. Doing so can shorten the useful life of the transceiver.

IMPORTANT:

When you replace a transceiver with another of a different type, the server might retain selected port-specific configuration settings that were configured for the replaced transceiver. Be sure to validate or reconfigure port settings as required.

Removing and replacing a transceiver

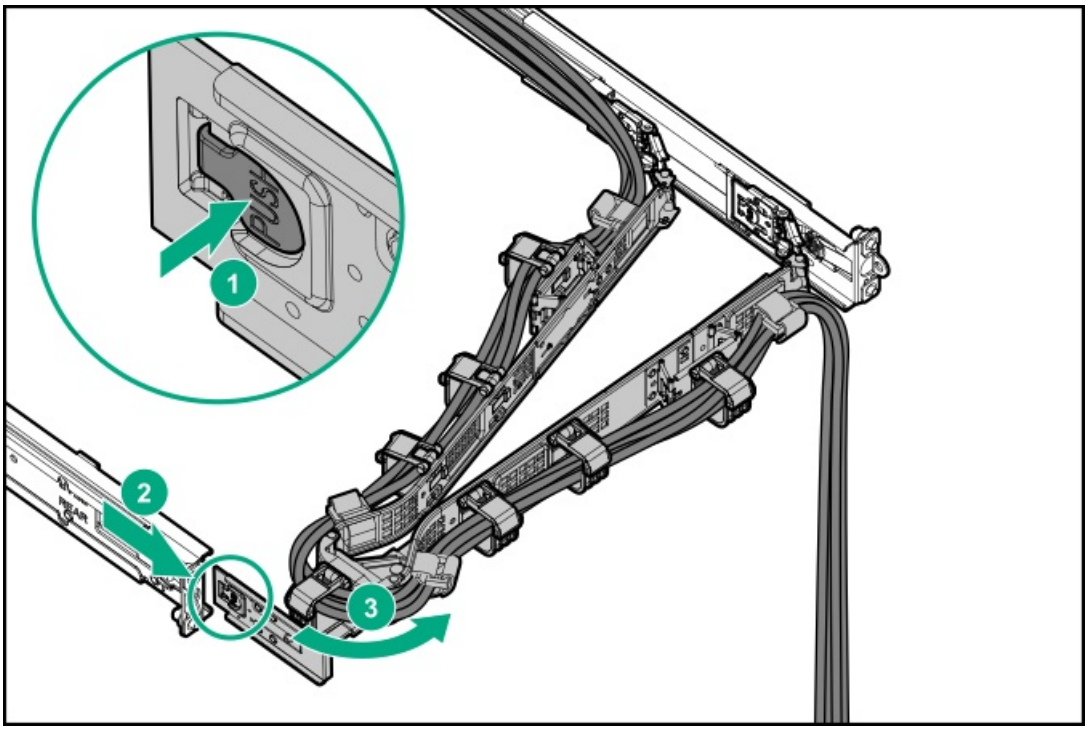
Prerequisites

Before replacing a transceiver, review the following:

- Transceiver warnings and cautions
- Transceiver documentation for specific operational and cabling requirements

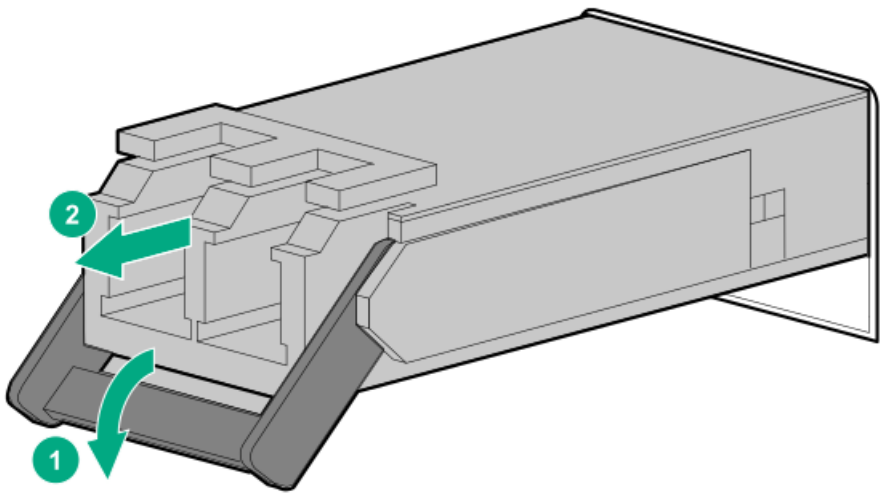
Procedure

1. If installed, release the cable management arm.



2. Disconnect the network cable from the transceiver.
3. Slide the transceiver out of the network adapter port.

   See the transceiver documentation for model-specific release mechanism for removing the transceiver.



To replace the component, reverse the removal procedure.

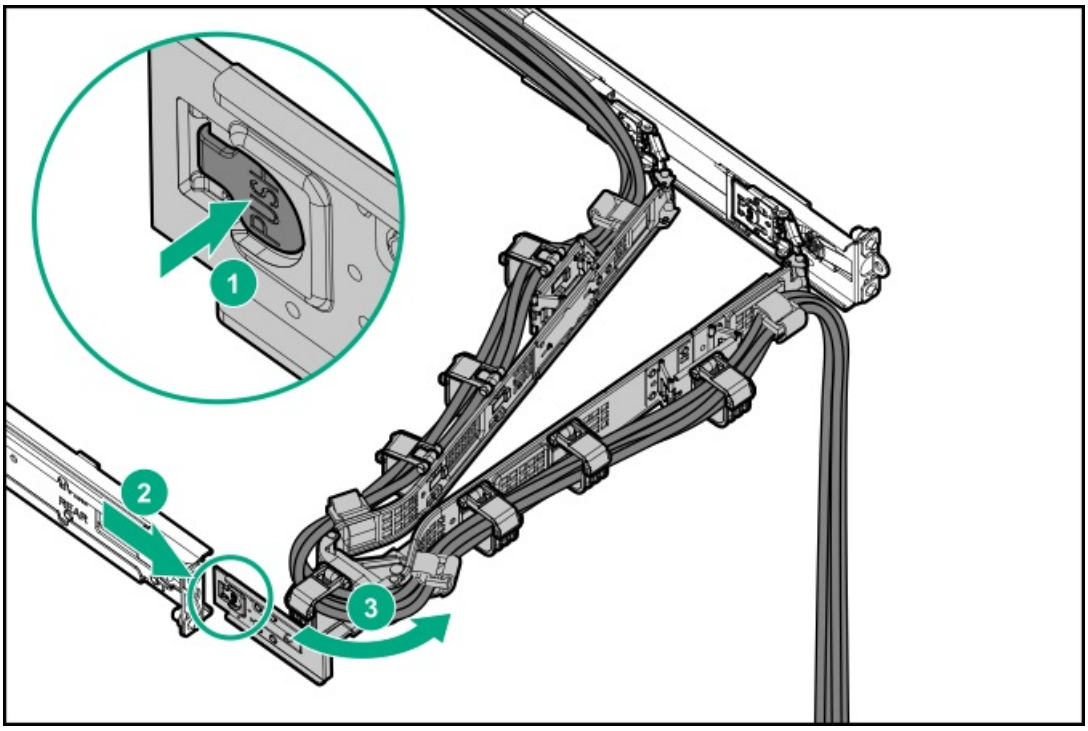
Removing and replacing the chassis ears

Prerequisites

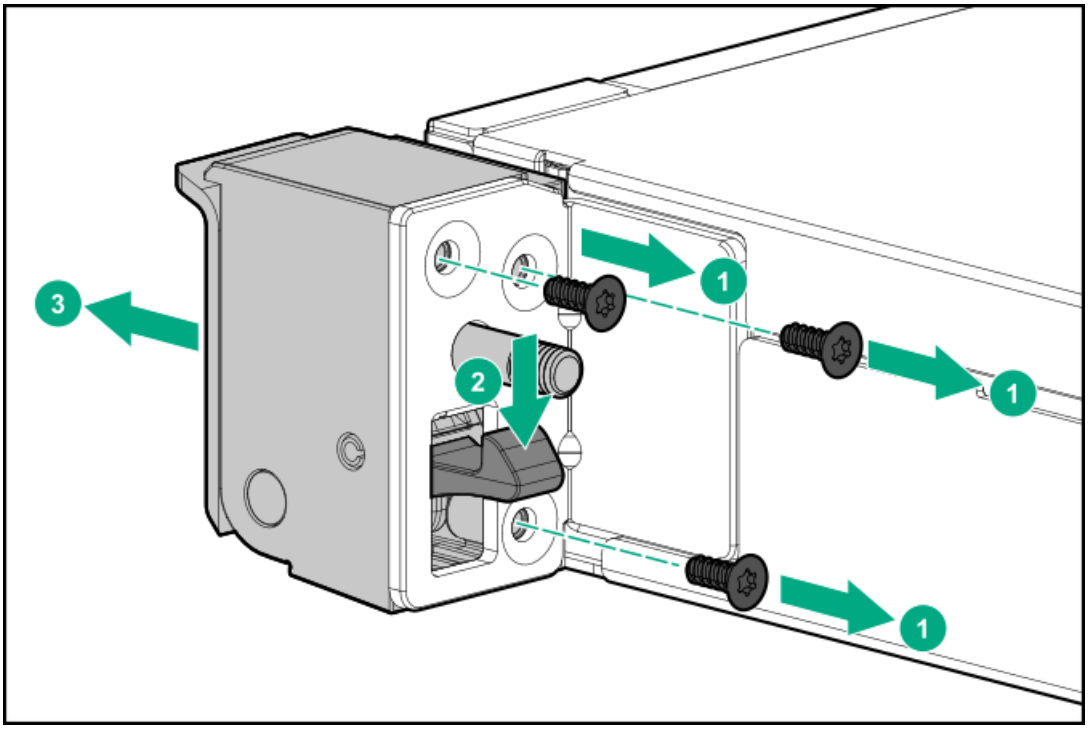
Before you perform this procedure, make sure that you have a T-10 Torx screwdriver available.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



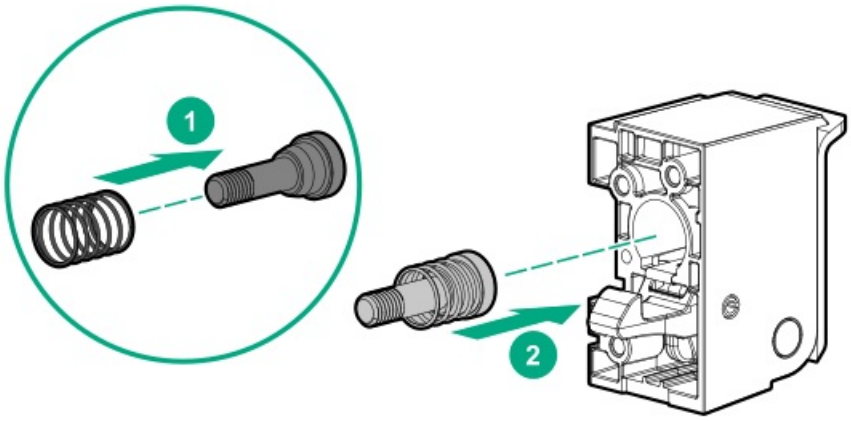
4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the chassis ear:
   a. Remove the screws (callout 1).
   b. Press and hold the release latch, and then pull the ear from the drive cage (callouts 2 and 3).



To replace the component, reverse the removal procedure.

Before installing the new chassis ear, do the following:

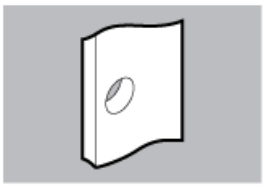
- Install the spring-loaded T-25 screw in the chassis ear.



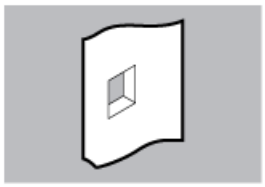
- The chassis ear spare ships with a set of server model number and drive configuration labels. Select the label that matches your system and attach them to the replacement chassis ear.

Removing and replacing the rack rails

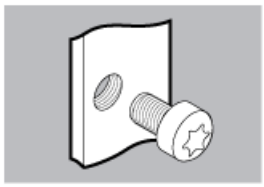
The illustrations used in this procedure show an icon on the upper right corner of the image. This icon indicates whether the action shown in the image is for a round-hole, square-hole, or a threaded-hole rack.



Round-hole rack



Square-hole rack



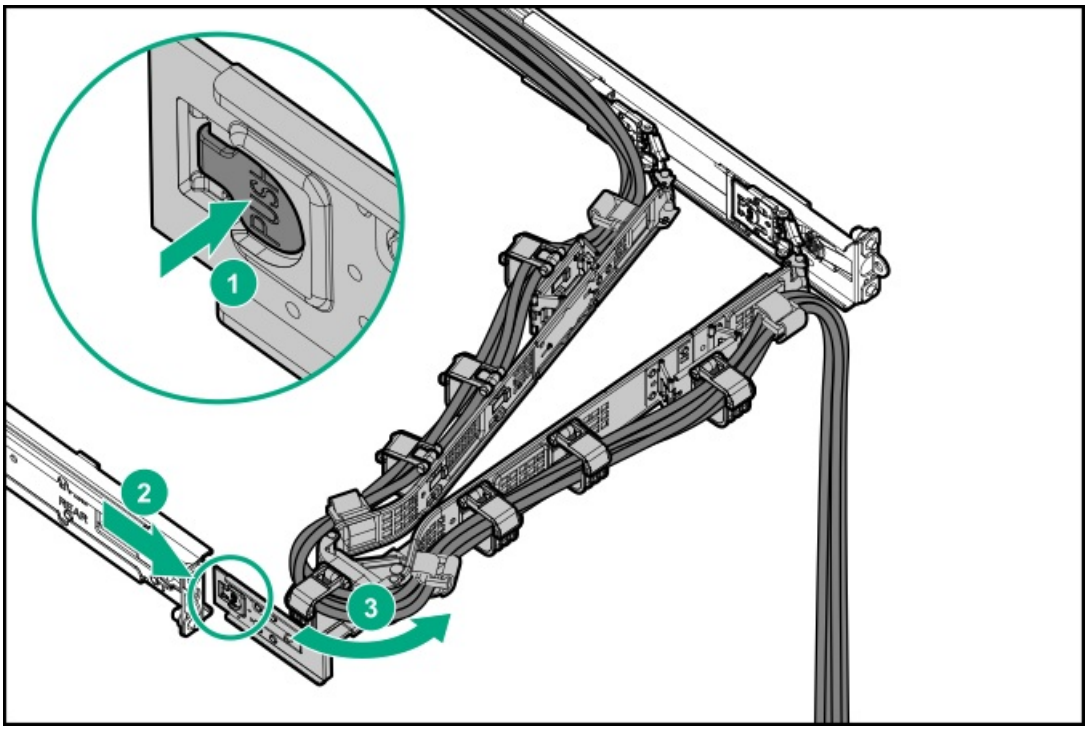
Threaded-hole rack

Prerequisites

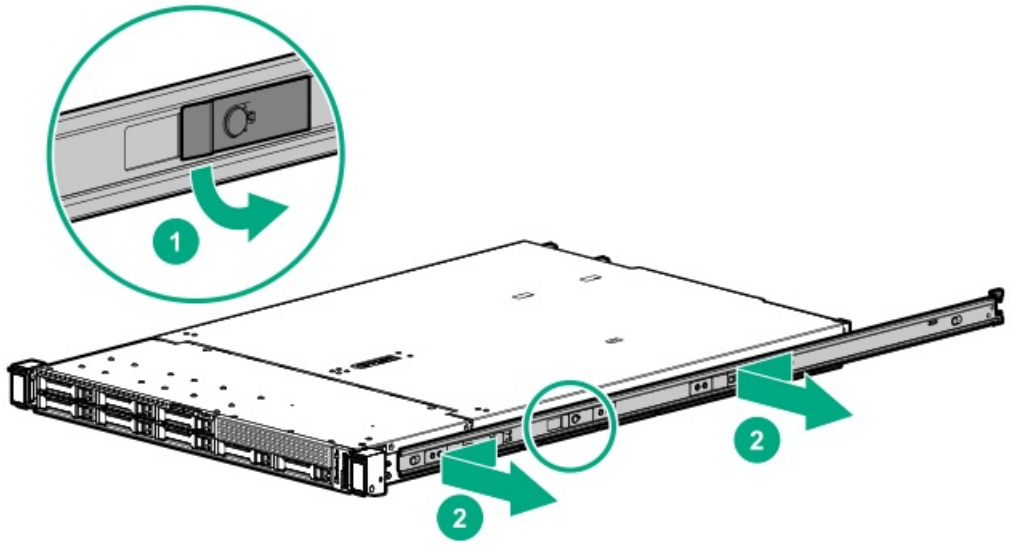
If you are replacing the rack mounting rails from a threaded-hole rack, make sure that you have a T-25 Torx screwdriver available.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



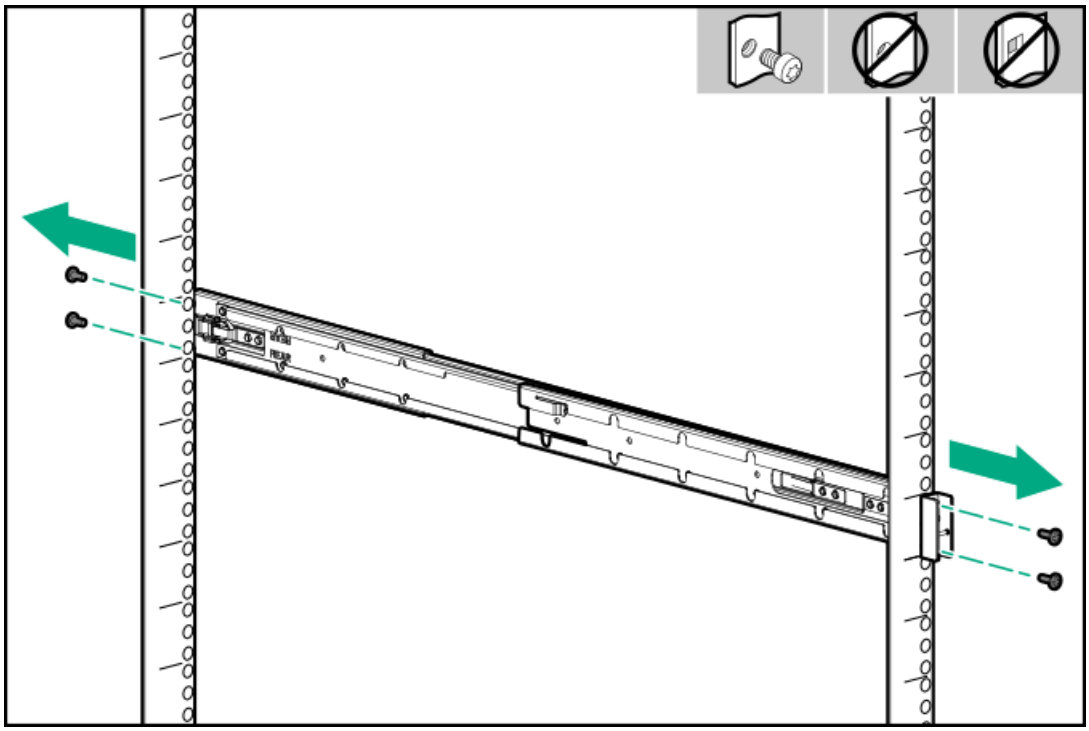
4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. If you are replacing the rack sliding rails, do the following:
   a. Pull and hold the release latch (callout 1).
   b. Slide the rail towards the front panel and pull it from the server (callout 2).



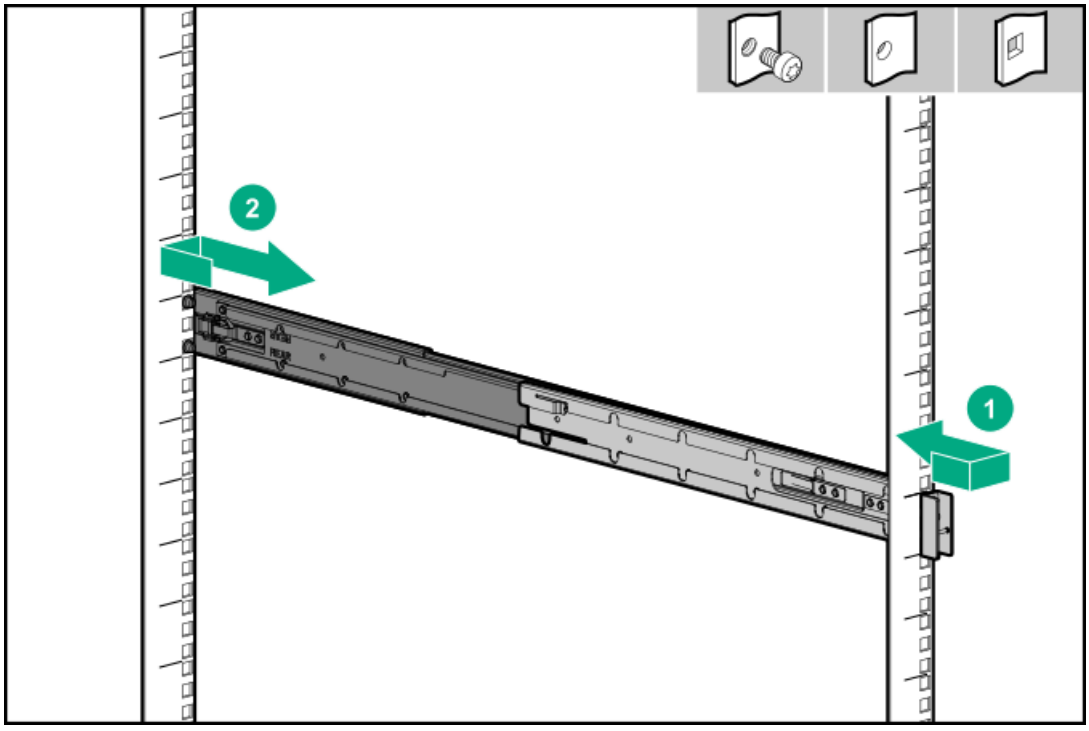
c. Repeat steps a and b to remove the other rail.

9. If you are replacing the rack mounting rails, do the following:

a. In a threaded-hole rack, remove the rail screws.



b. Disengage the rail pins from the rack columns (callouts 1 and 2).



c. Repeat steps a and b to remove the other rack rail.

To replace the component, reverse the removal procedure.

Removing and replacing the access panel

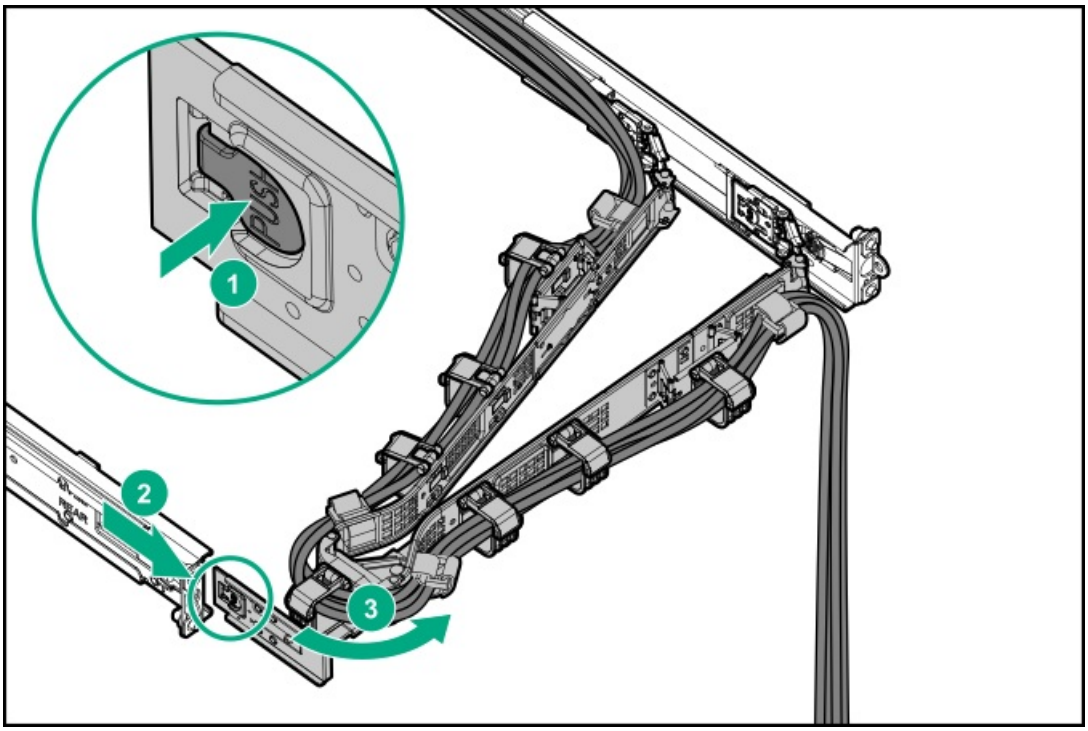
> △ **CAUTION:** Do not operate the server for long periods with the access panel open or removed. Operating the server in this manner results in improper airflow and improper cooling that can lead to thermal damage.

Prerequisites

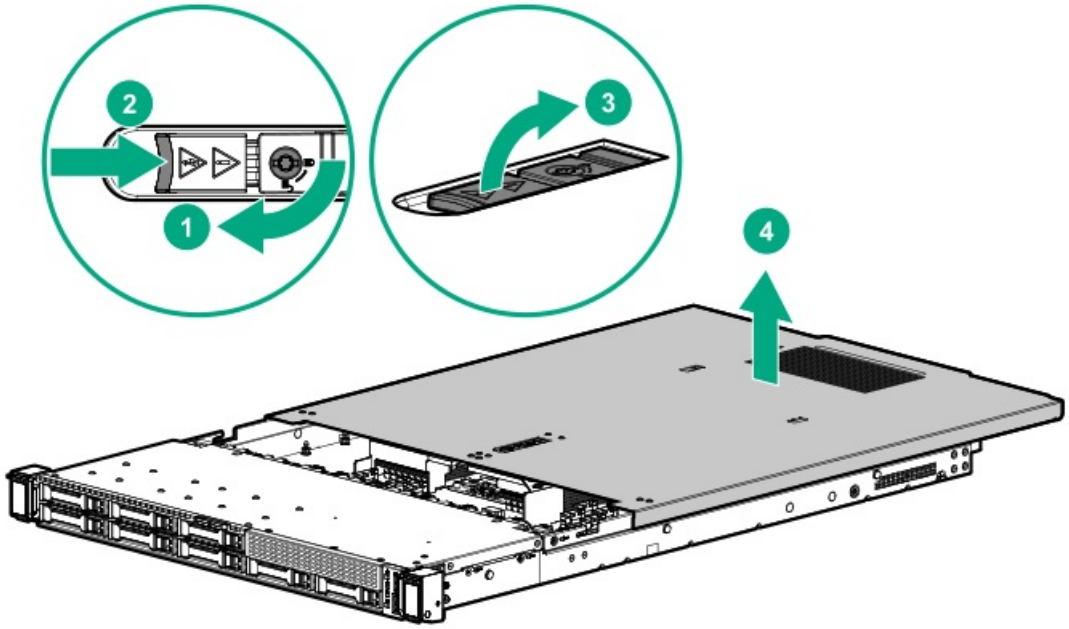
Before you perform this procedure, make sure that you have a T-15 Torx screwdriver available.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel:
   a. If necessary, unlock the access panel latch (callout 1).
   b. To disengage the access panel from the chassis, press the release button and pull up the latch (callout 2 and 3).
   c. Lift the access panel (callout 4).



To replace the component, reverse the removal procedure.

Removing and replacing a fan

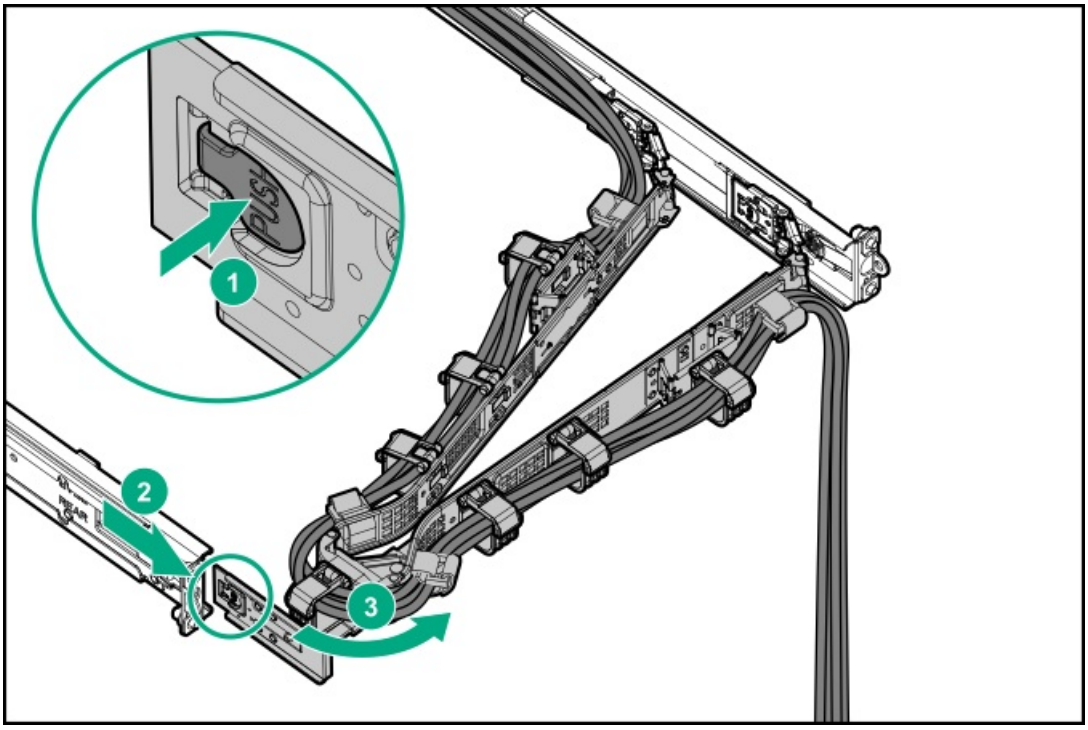
CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

IMPORTANT:

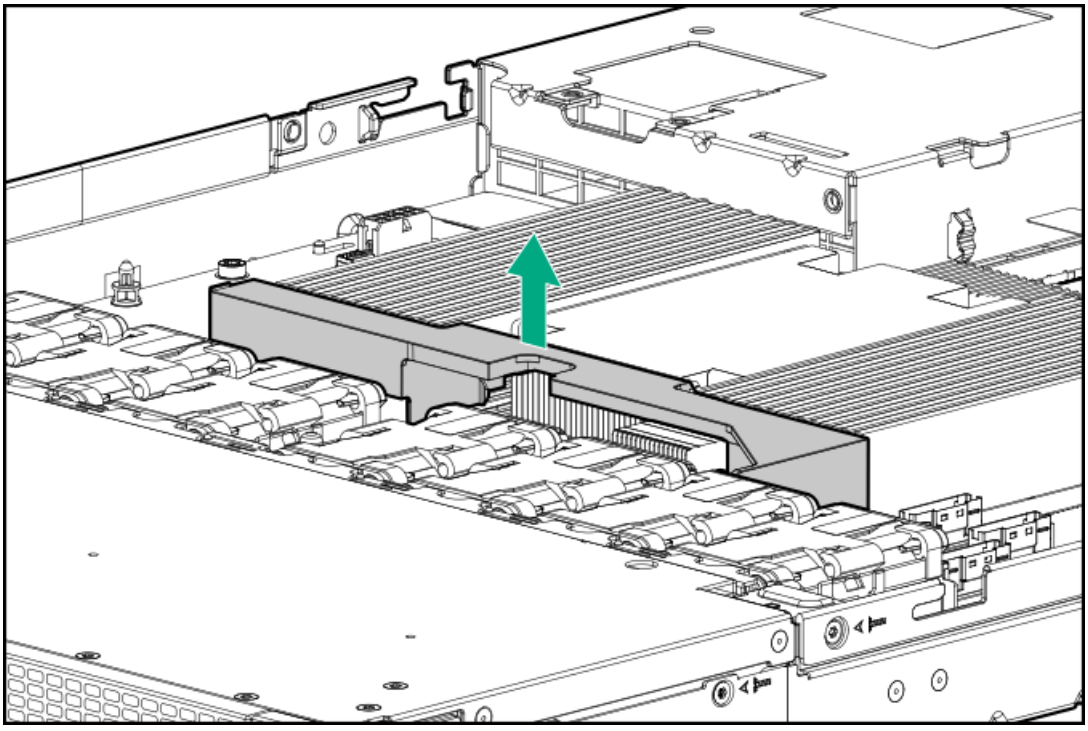
The fan setup can either be standard, single-rotor fans or high-performance, dual-rotor fans. Do not mix fan types in the same server.

Procedure

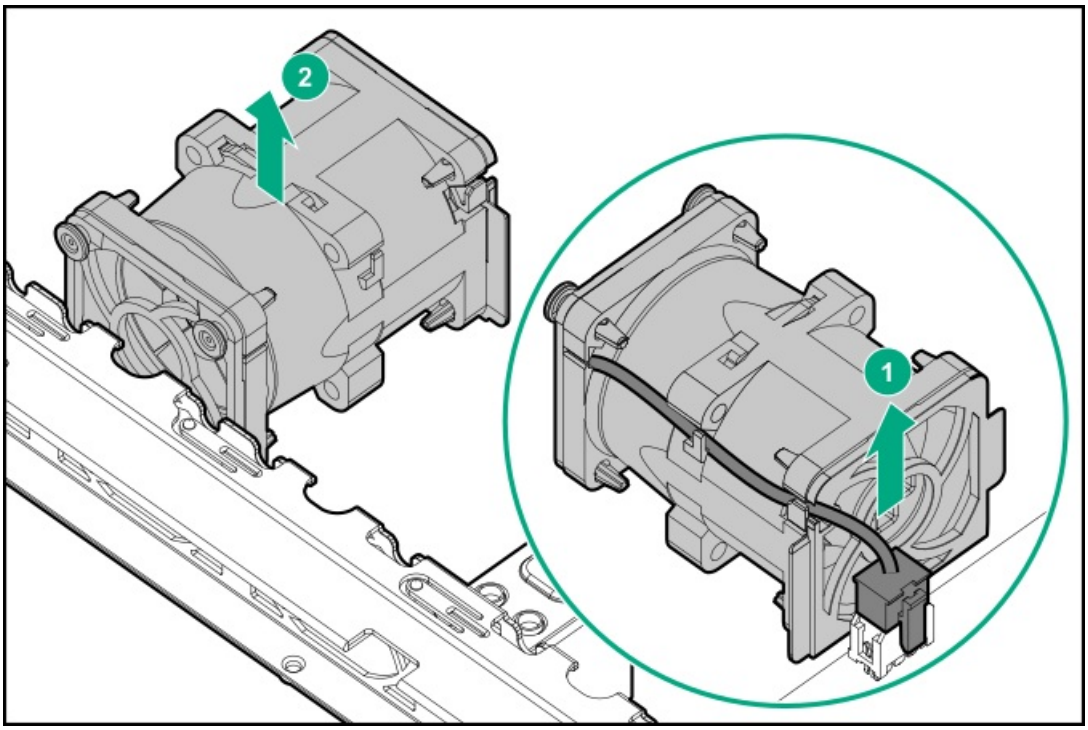
1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove the air baffle.



10. Disconnect the fan cable, and then lift the fan from the server.



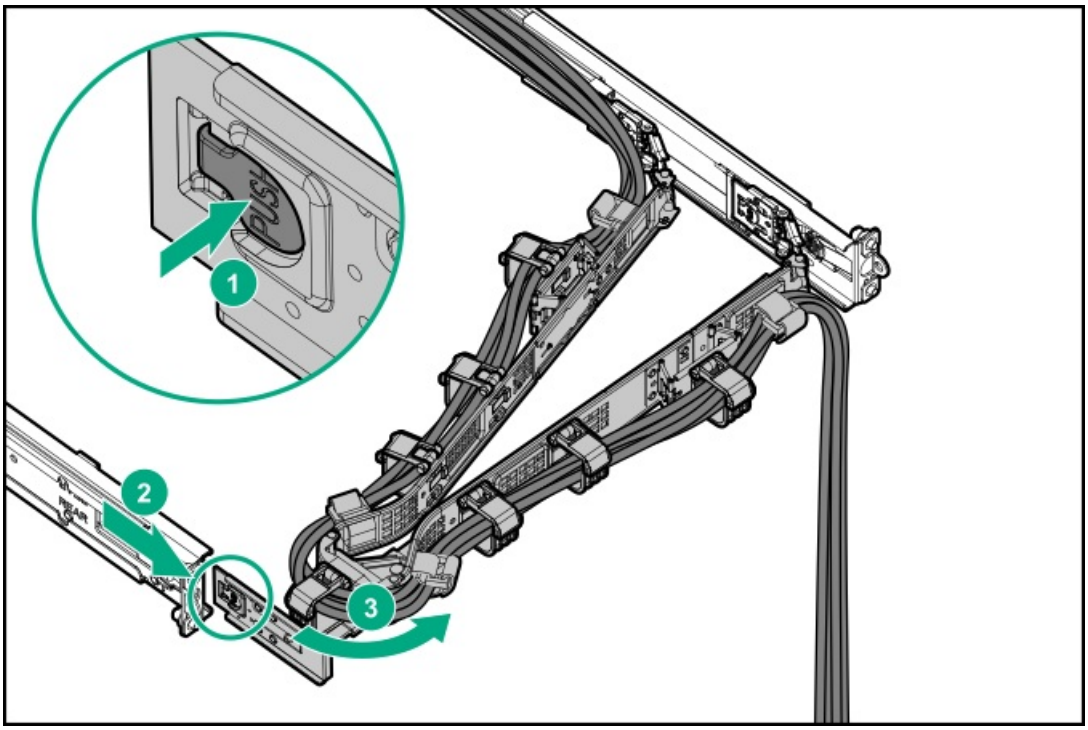
To replace the component, reverse the removal procedure.

Removing and replacing the air baffle

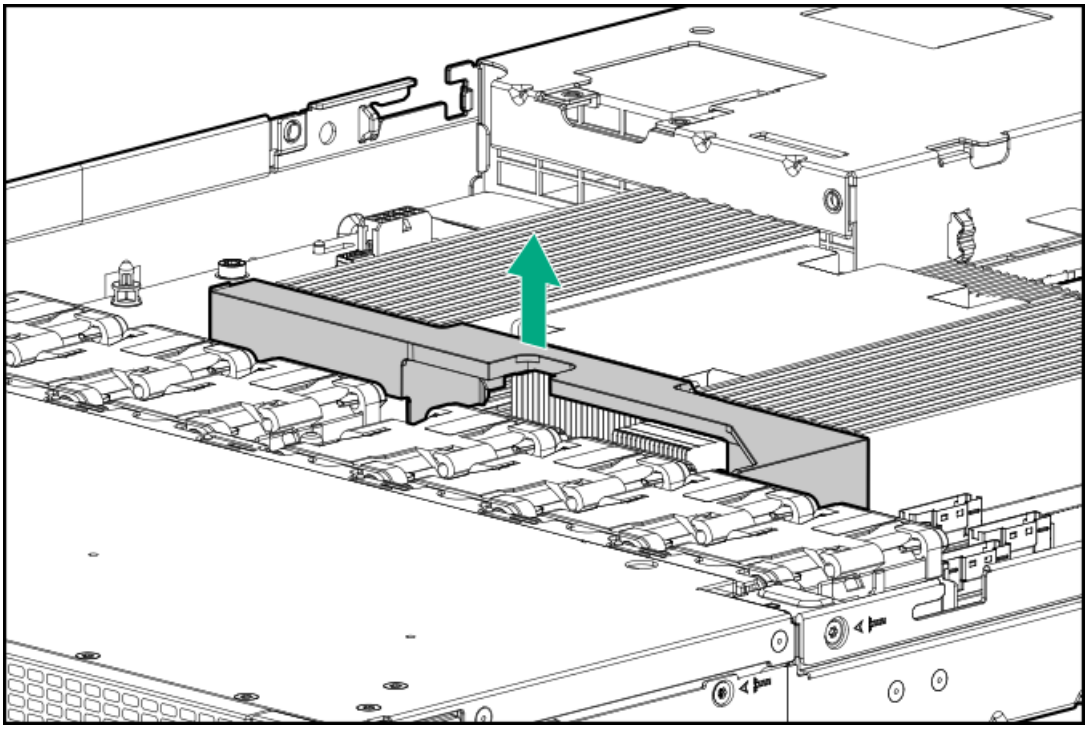
> **CAUTION:** For proper cooling, do not operate the server without the access panel, baffles, expansion slot covers, or blanks installed. If the server supports hot-plug components, minimize the amount of time the access panel is open.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove the air baffle.



To replace the component, reverse the removal procedure.

Drive backplane replacement

- Removing and replacing the 4 LFF drive backplane
- Removing and replacing the 2 SFF drive backplane
- Removing and replacing the 8 SFF drive backplane

Removing and replacing the 4 LFF drive backplane

CAUTION:

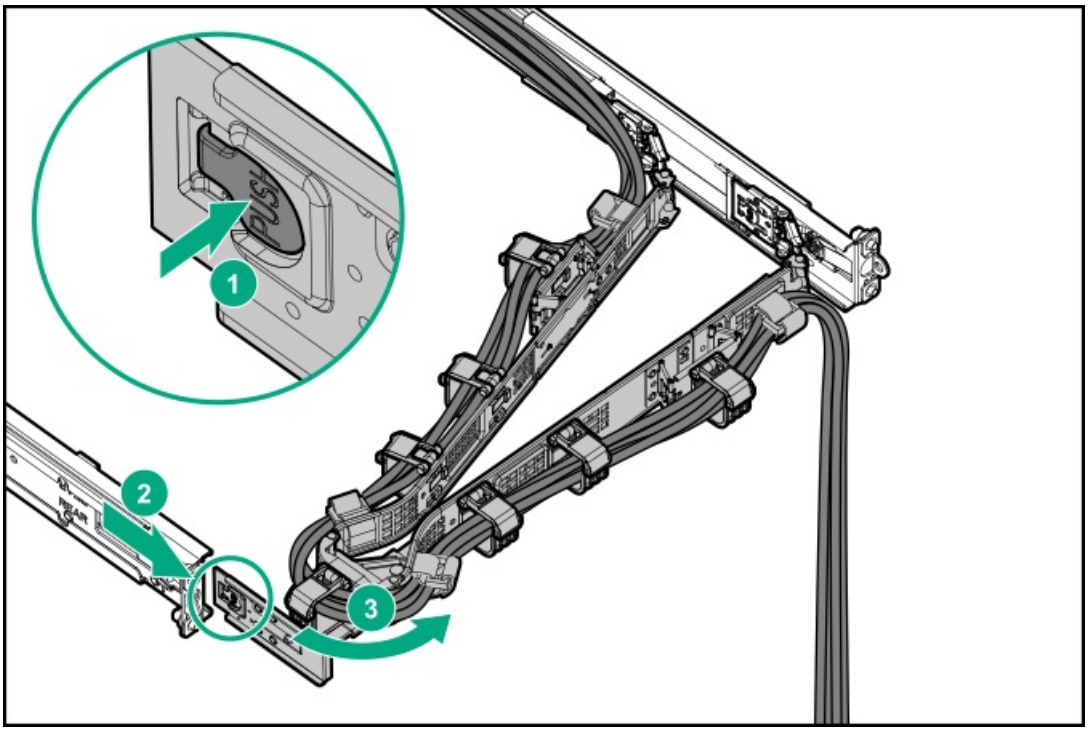
A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

Prerequisites

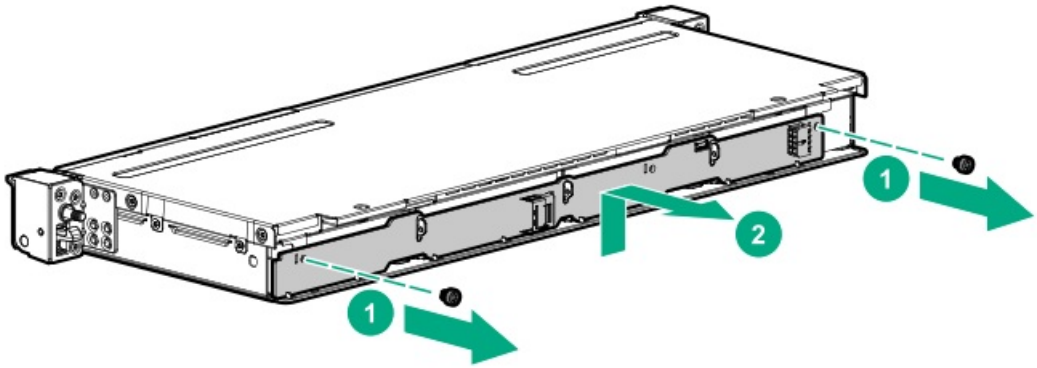
Before you perform this procedure, make sure that you have a T-15 Torx screwdriver available.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove all drives.
10. Remove the front drive cage.
11. Disconnect all cables from the drive backplane.
12. Remove the 4 LFF drive backplane.



To replace the component, reverse the removal procedure.

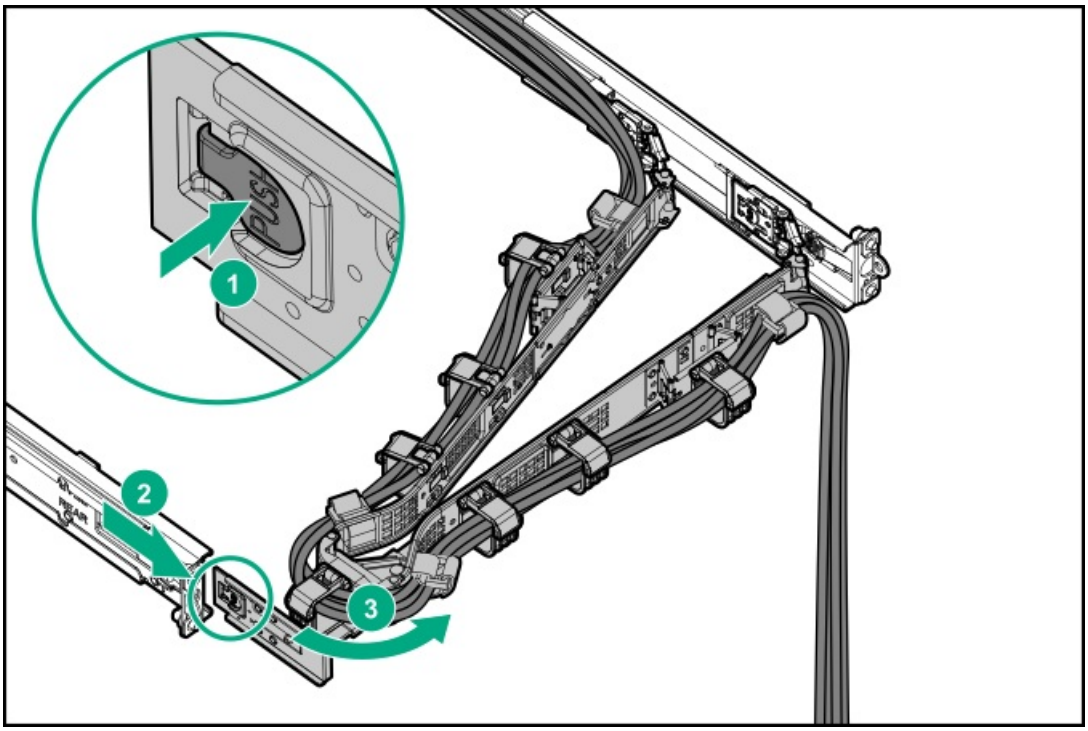
Removing and replacing the 2 SFF drive backplane

CAUTION:

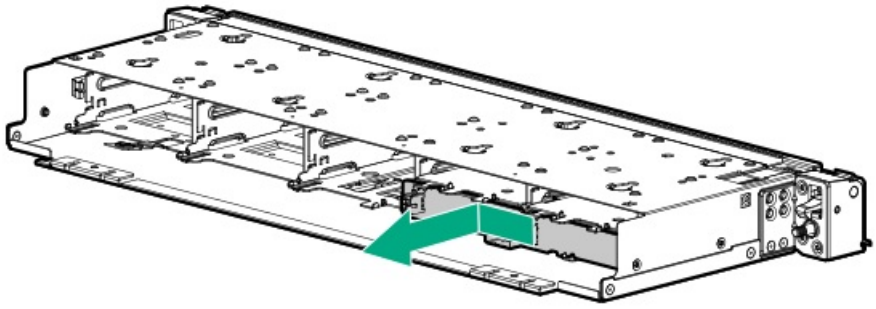
A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove all drives.
10. Remove the front drive cage.
11. Disconnect all cables from the drive backplane.
12. Place the drive cage on a flat, level surface with its bottom side facing up.
13. Remove the 2 SFF drive backplane.



To replace the component, reverse the removal procedure.

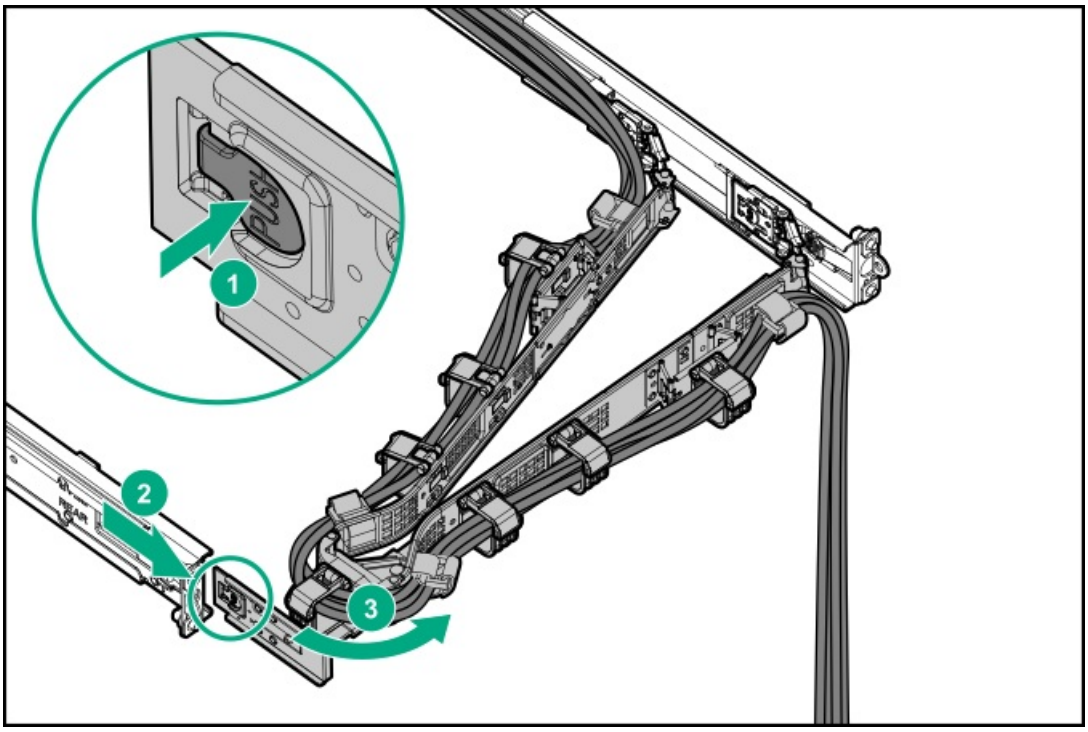
Removing and replacing the 8 SFF drive backplane

CAUTION:

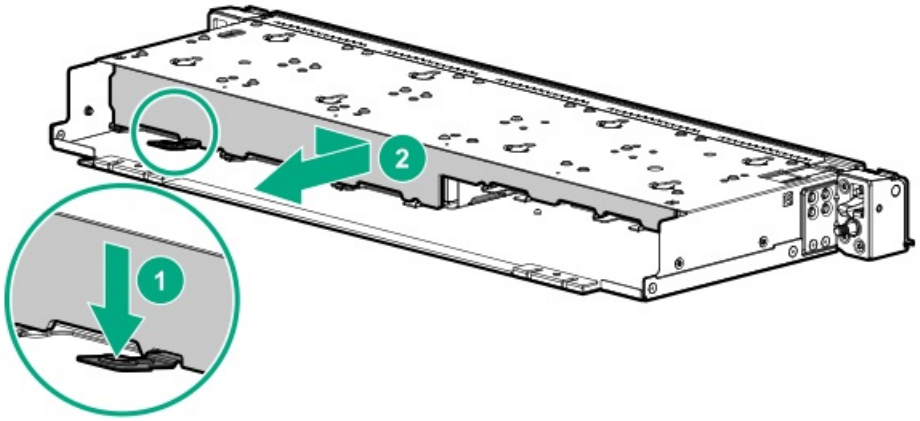
A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove all drives.
10. Remove the front drive cage.
11. Disconnect all cables from the drive backplane.
12. Place the drive cage on a flat, level surface with its bottom side facing up.
13. If installed, remove the 2 SFF drive backplane.
14. Remove the 8 SFF drive backplane.



To replace the component, reverse the removal procedure.

Removing and replacing an optical drive from the LFF drive chassis

CAUTION:

A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

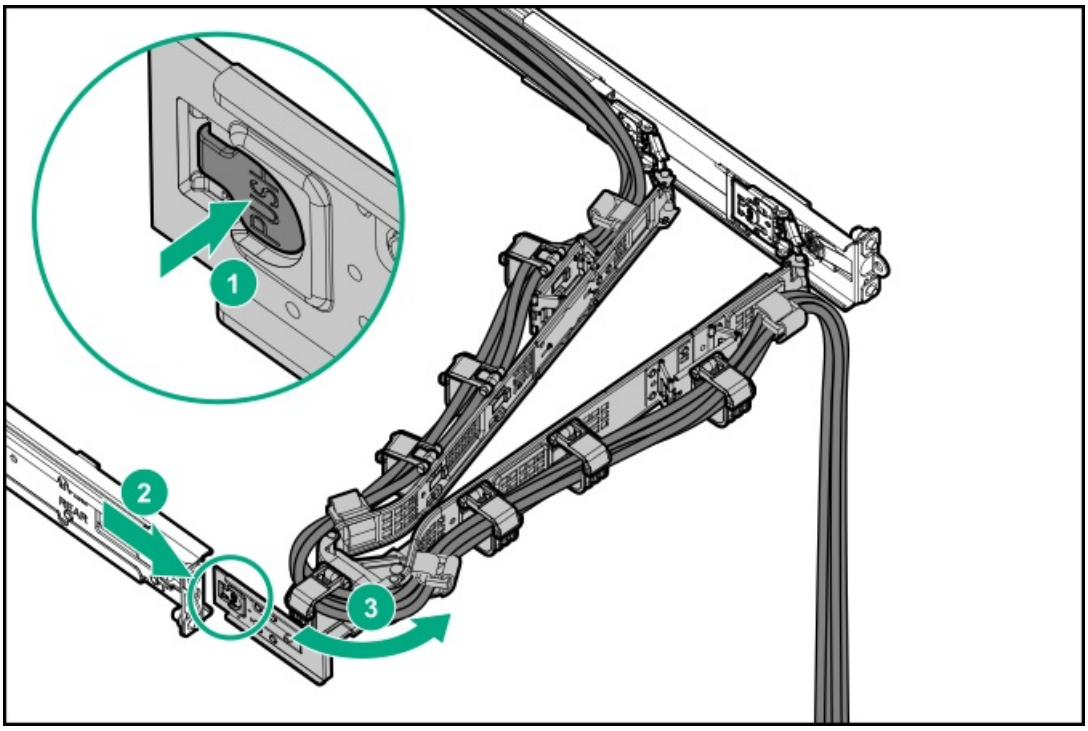
Prerequisites

Before you perform this procedure, make sure that you have the following items available:

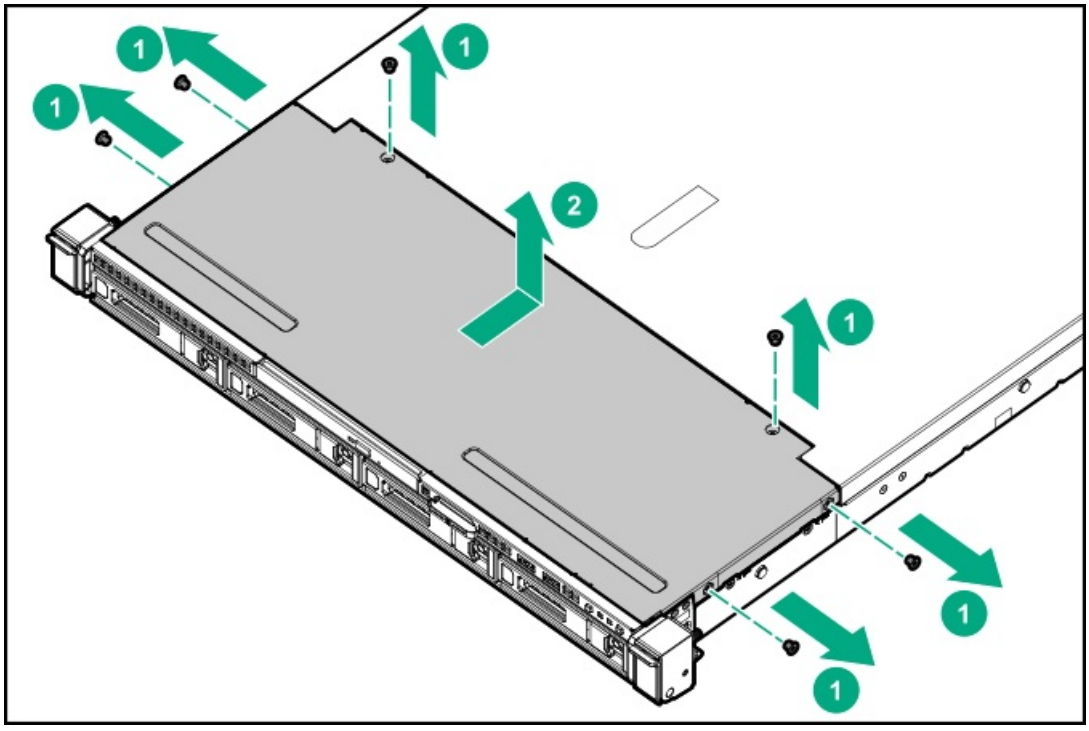
- T-10 Torx screwdriver
- Phillips No. 1 screwdriver

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.

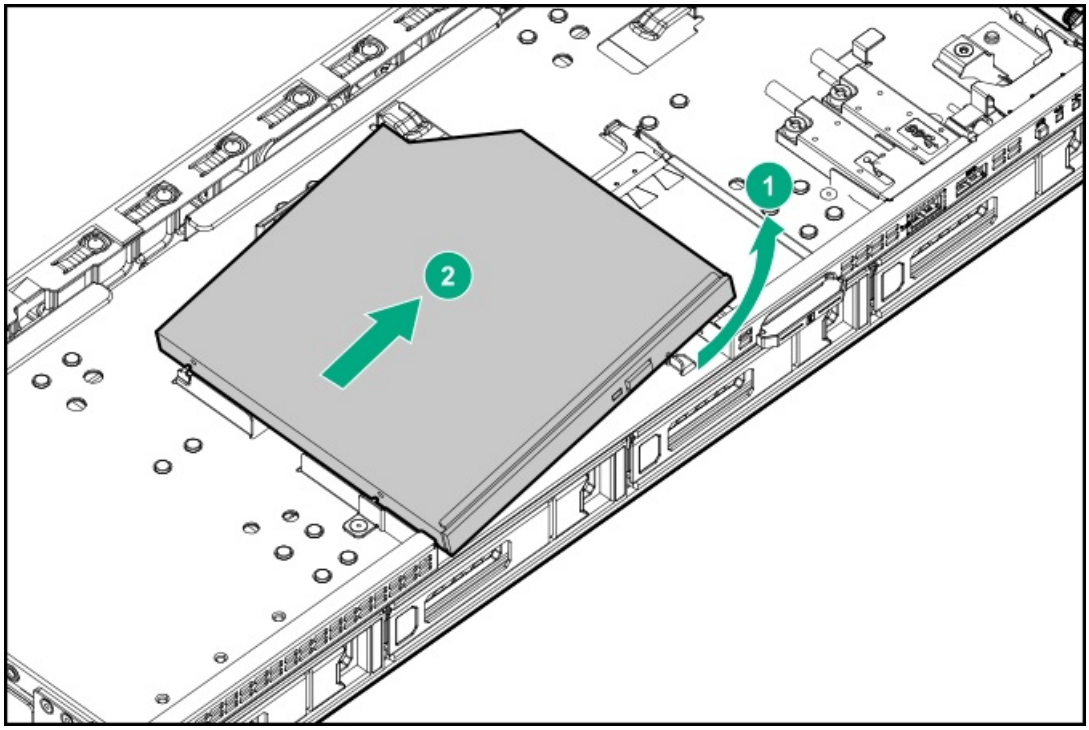


4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. To remove an optical drive from the LFF drive chassis, do the following:
   a. Remove the front drive cage cover.

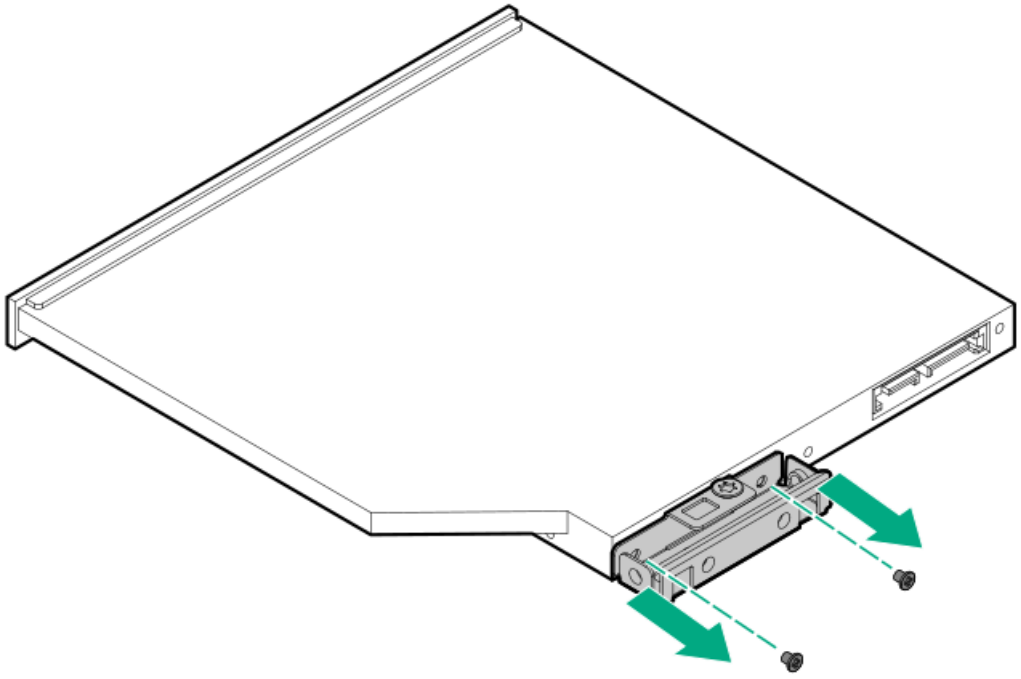


b. Disconnect the optical drive-M.2 SSD splitter cable from the optical drive .

c. Remove the optical drive.



9. Remove the optical drive bracket.



Retain this bracket for use in the new optical drive.

To replace the component, reverse the removal procedure.

Removing and replacing an optical drive from the SFF drive chassis

CAUTION:

A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

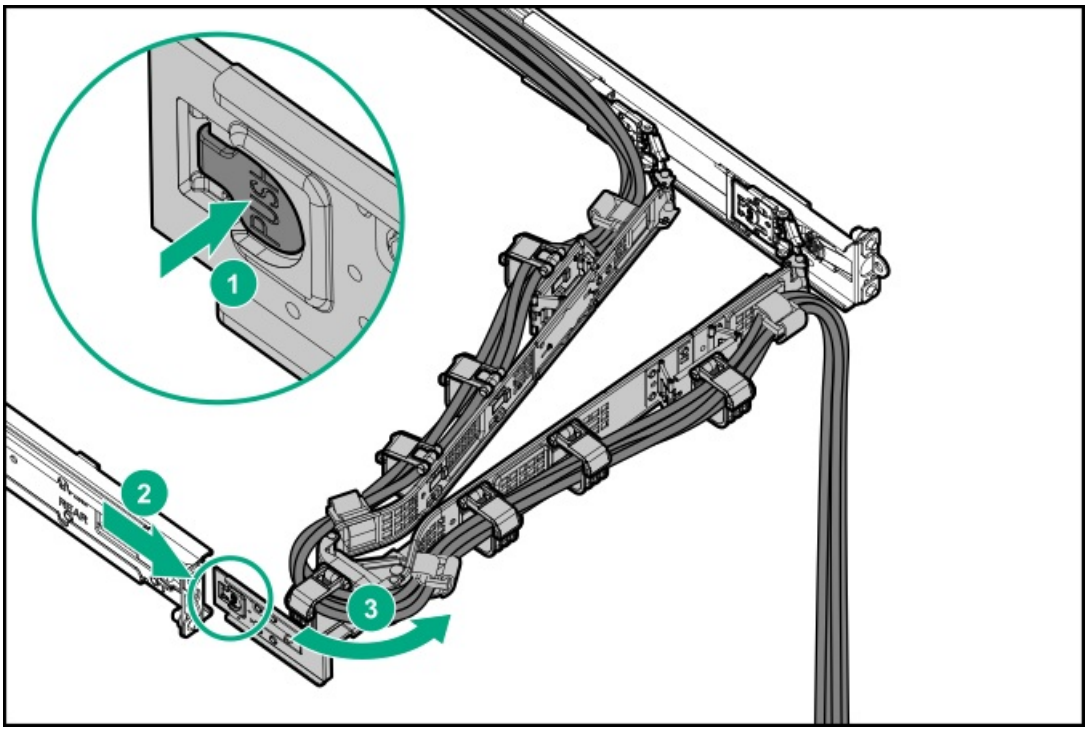
Prerequisites

Before you perform this procedure, make sure that you have the following items available:

- T-10 Torx screwdriver
- T-15 Torx screwdriver
- Phillips No. 1 screwdriver

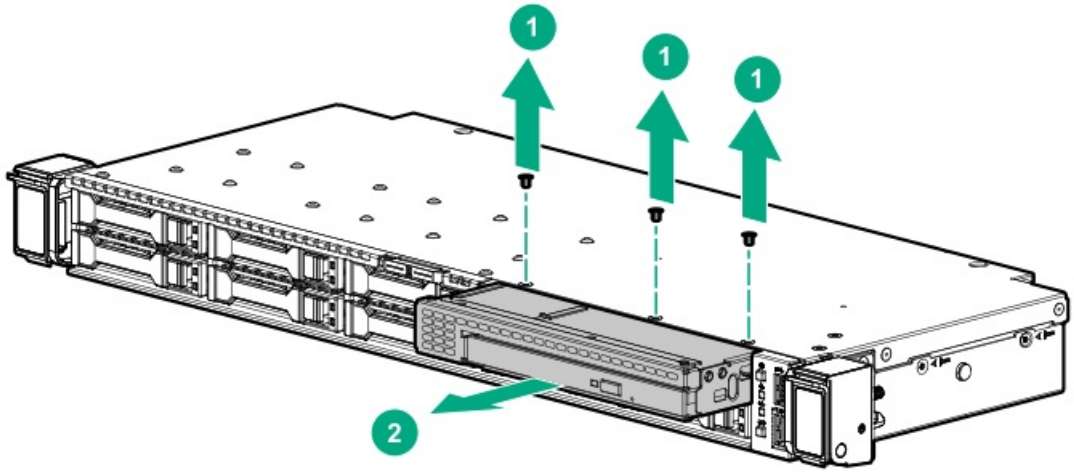
Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



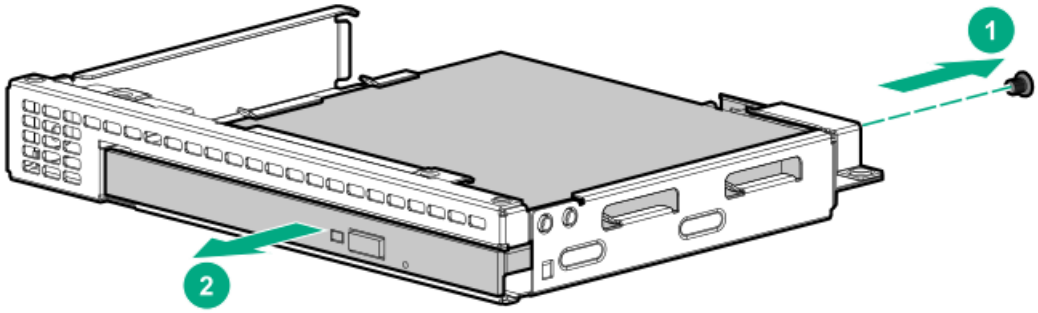
4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. To remove an optical drive from the SFF drive chassis, do the following:
   a. Remove the access panel.
   b. Remove the front drive cage.

c. Remove the optical drive cage assembly.

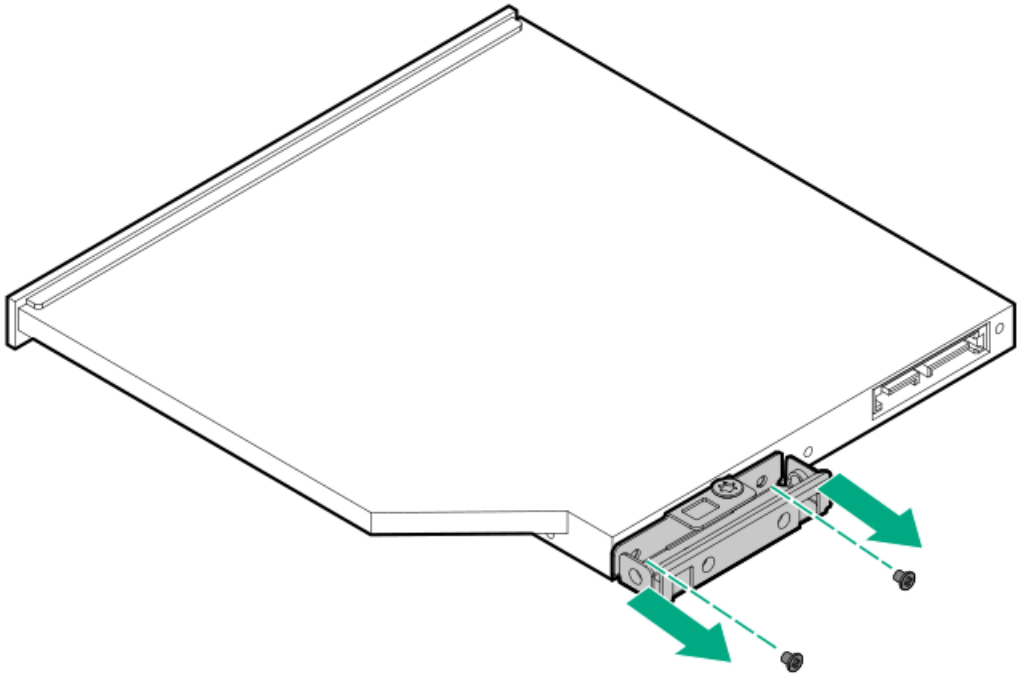


d. Disconnect the optical drive-M.2 SSD splitter cable from optical drive .

e. Remove the optical drive.



9. Remove the optical drive bracket.



Retain this bracket for use in the new optical drive.

To replace the component, reverse the removal procedure.

Removing and replacing a DIMM

CAUTION:

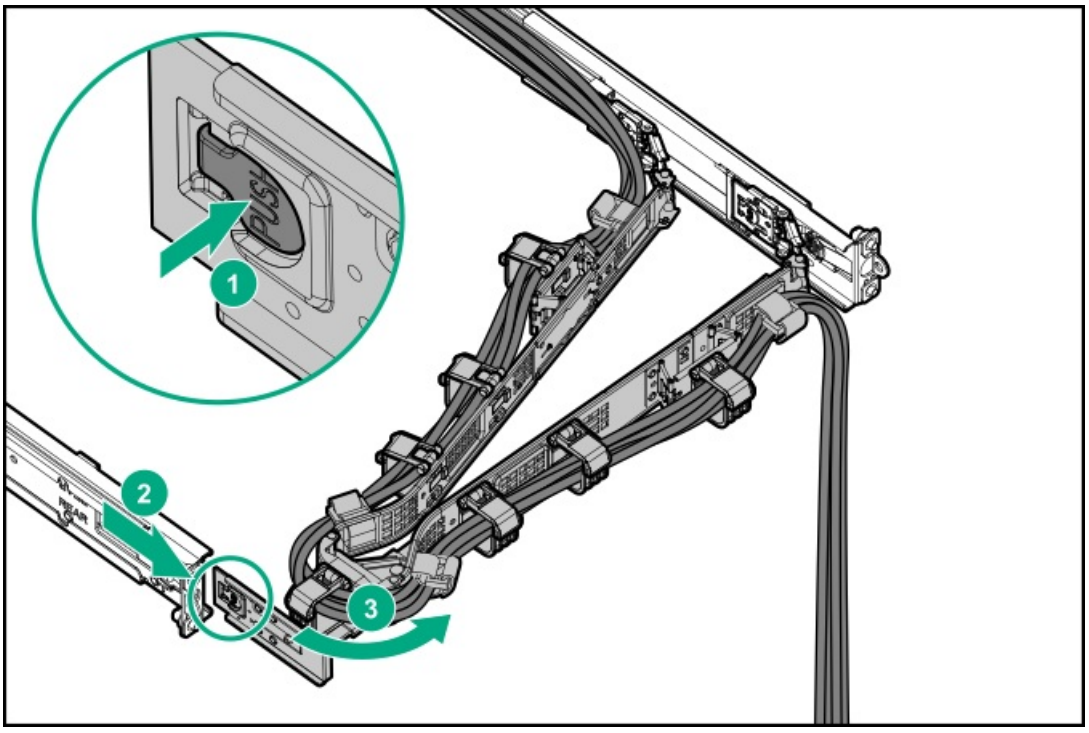
A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

CAUTION:

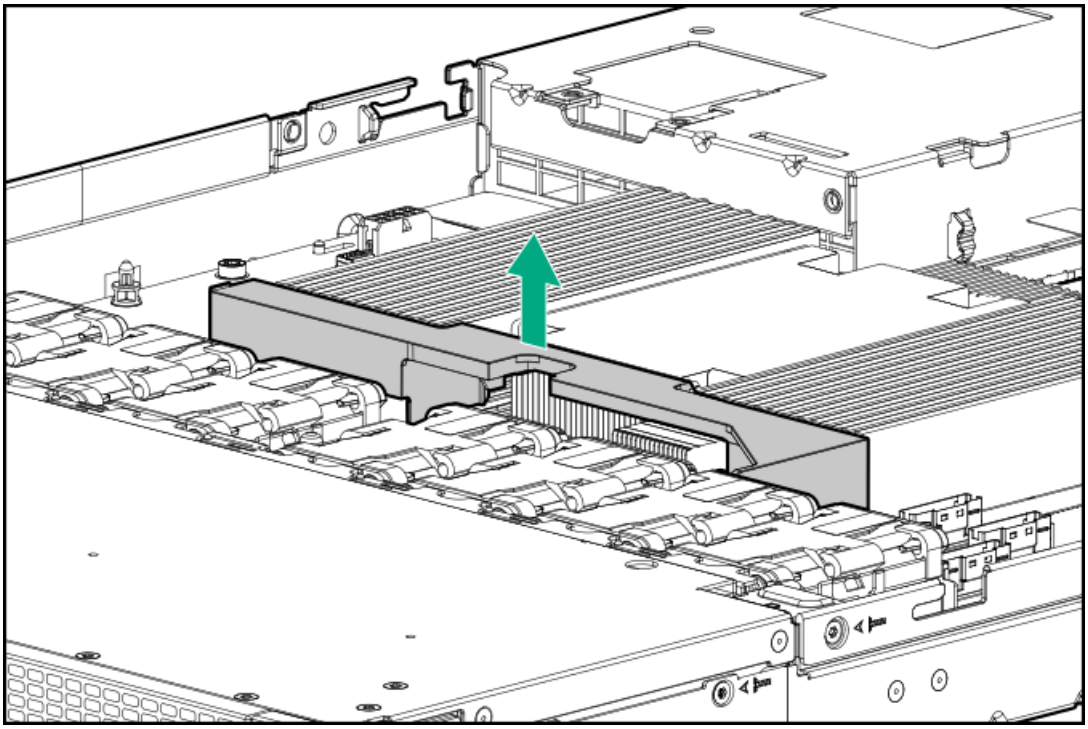
Before replacing a DIMM, expansion card, or other similar PCA components due to a perceived hardware error, make sure first that the component is firmly seated in the slot. Do not bend or flex circuit boards when reseating components.

Procedure

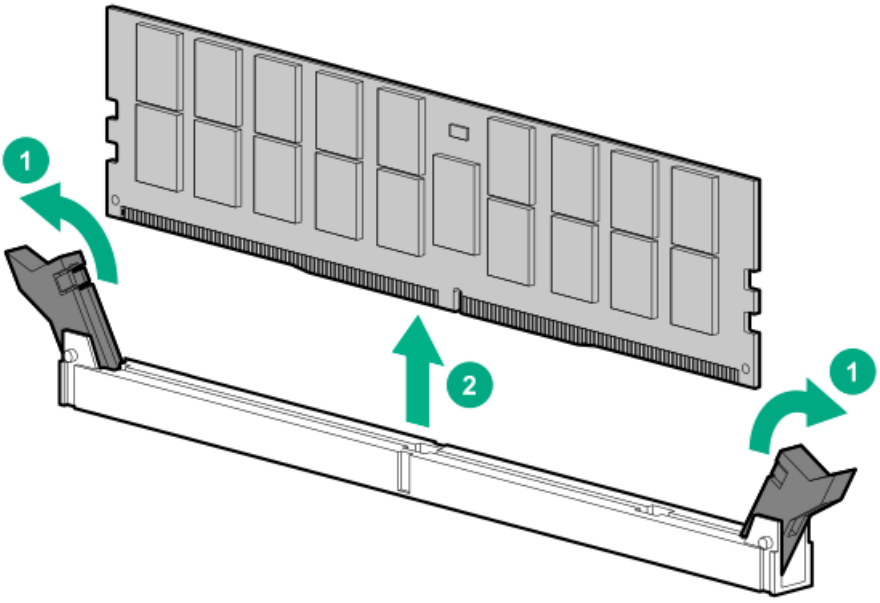
1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove the air baffle.



10. Remove the DIMM.



To replace the component, reverse the removal procedure.

Heatsink replacement

- Removing the heatsink
- Installing the heatsink

Removing the heatsink

WARNING: To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

CAUTION:

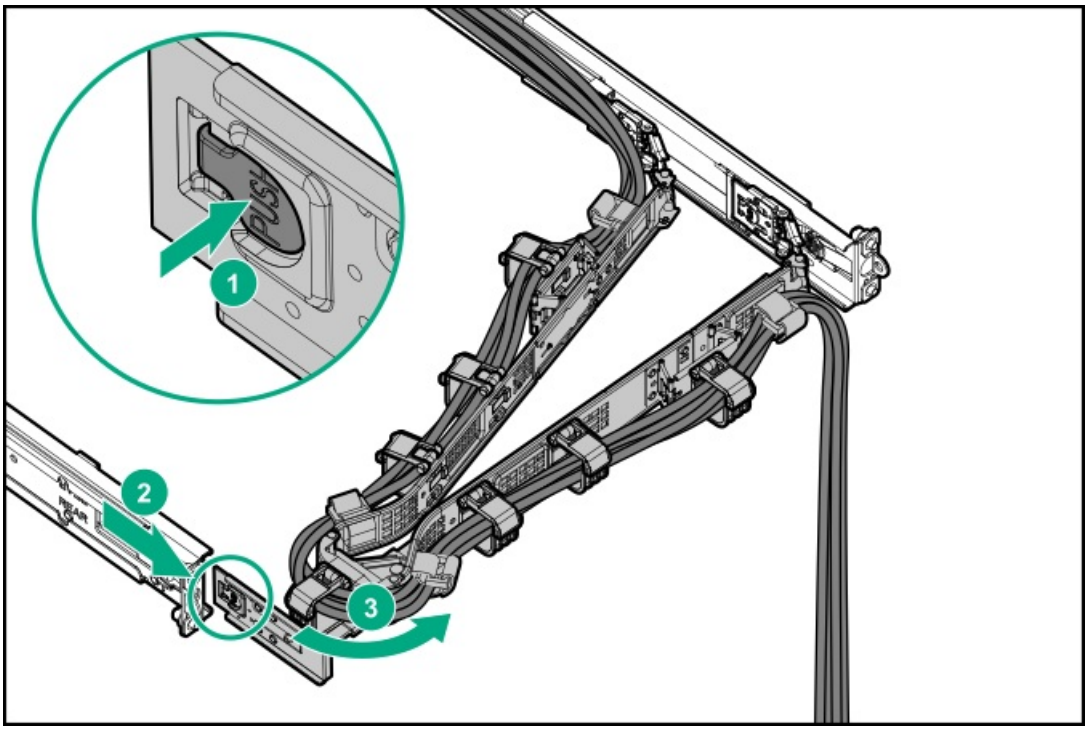
A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

Prerequisites

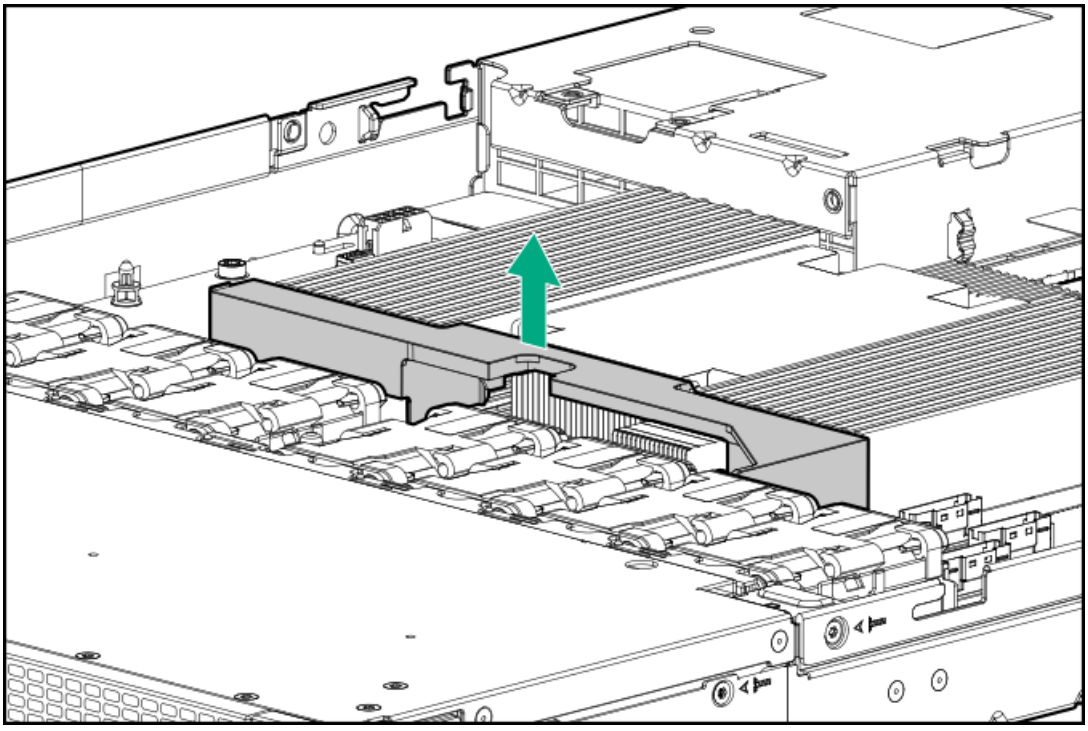
Before you perform this procedure, make sure that you have a T-20 Torx screwdriver available.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove the air baffle.

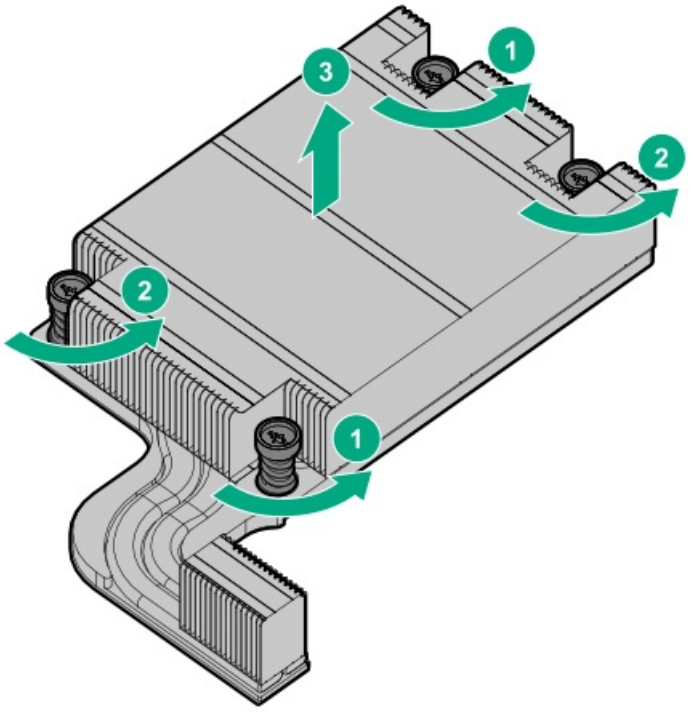


10. Allow the heatsink to cool.
11. Remove the heatsink:

> **CAUTION:**
>
> To prevent mechanical damage or depositing oil on your hands or other contaminant to the heatsink contact surface, hold the heatsink only by the edge of its base plate. Do not touch the heatsink fins.

> **CAUTION:**
>
> Heatsink screws must be tightened and loosened in alternating sequence. Do not overtighten the screws as this might damage the system board or the processor socket.

a. Use a T-20 Torx screwdriver to loosen the captive screws in the sequence specified on the heatsink label.
b. Lift the heatsink away from the system board.



c. Place the heatsink on a flat work surface with its contact side facing up.

Installing the heatsink

> **CAUTION:**
>
> A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

Prerequisites

Before you perform this procedure, make sure that you have the following items available:

- T-20 Torx screwdriver
- Alcohol wipe

Procedure

1. Use an alcohol wipe to remove the existing thermal grease from the processor.

   Allow the alcohol to evaporate before continuing.

2. Remove the thermal interface protective cover from the new heatsink.
3. Install the heatsink:

   > **CAUTION:**
   >
   > To prevent mechanical damage or depositing oil on your hands or other contaminant to the heatsink contact surface, hold the heatsink only by the edge of its base plate. Do not touch the heatsink fins.

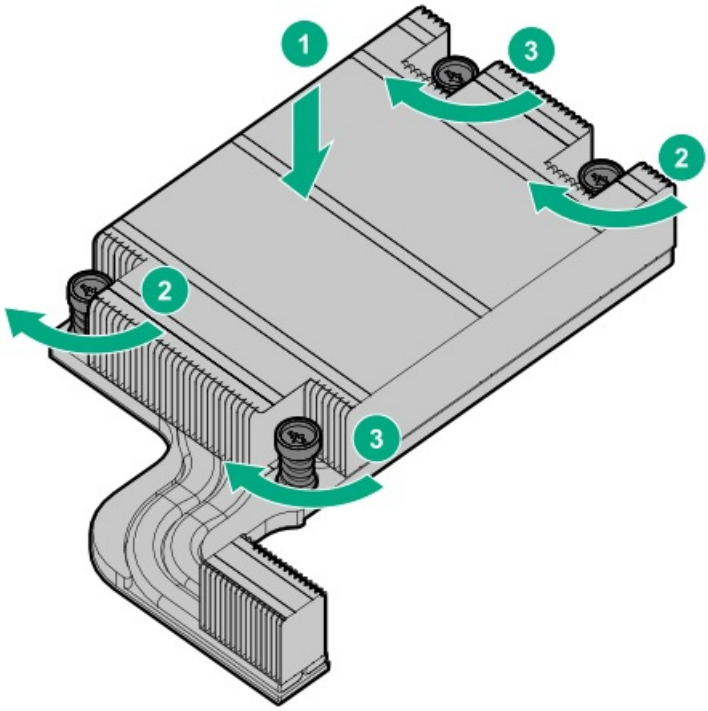
   > **CAUTION:**
   >
   > To prevent thermal failure or component damage, do not move the heatsink once the bottom of its base plate touches the top of the processor. Excessive heatsink movement can cause the thermal grease to smear and become uneven. Voids in the compound can adversely impact the transfer of heat away from the processor.

   > **CAUTION:**
   >
   > Heatsink screws must be tightened and loosened in alternating sequence. Do not overtighten the screws as this might damage the system board or the processor socket.

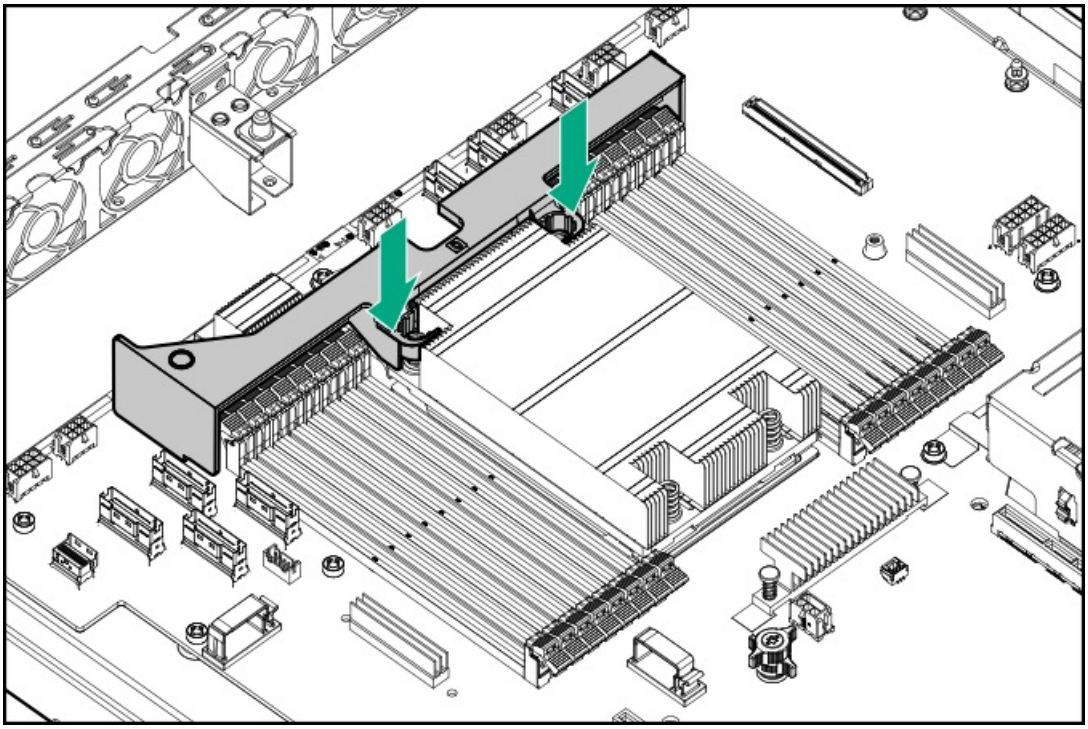
   a. Position the heatsink on top of the processor, ensuring that it is properly seated before securing the screws.

   b. Use a T-20 Torx screwdriver to tighten the captive screws in the sequence specified on the heatsink label.

      When using a torque wrench to tighten the screws, apply a torque of 1.58 N-m (14 lbf-in).



4. Secure the air baffle hooks to the heatsink screws.



5. Install the access panel.
6. Install the server into the rack.
7. Connect all peripheral cables to the server.
8. Connect each power cord to the server.
9. Connect each power cord to the power source.
10. Power up the server.
11. If removed, install the front bezel.

Processor replacement

- Removing the processor
- Installing the processor

Processor cautions

△ **CAUTION:** To avoid damage to the processor or system board, only authorized personnel should attempt to replace or install the processor in this server.

△ **CAUTION:** If installing a processor with a faster speed, update the system ROM before installing the processor.

To download firmware and view installation instructions, see the **Hewlett Packard Enterprise Support Center website**.

△ **CAUTION: THE CONTACTS ARE VERY FRAGILE AND EASILY DAMAGED.** To avoid damage to the socket or processor, do not touch the contacts.

Removing the processor

WARNING: To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

CAUTION:

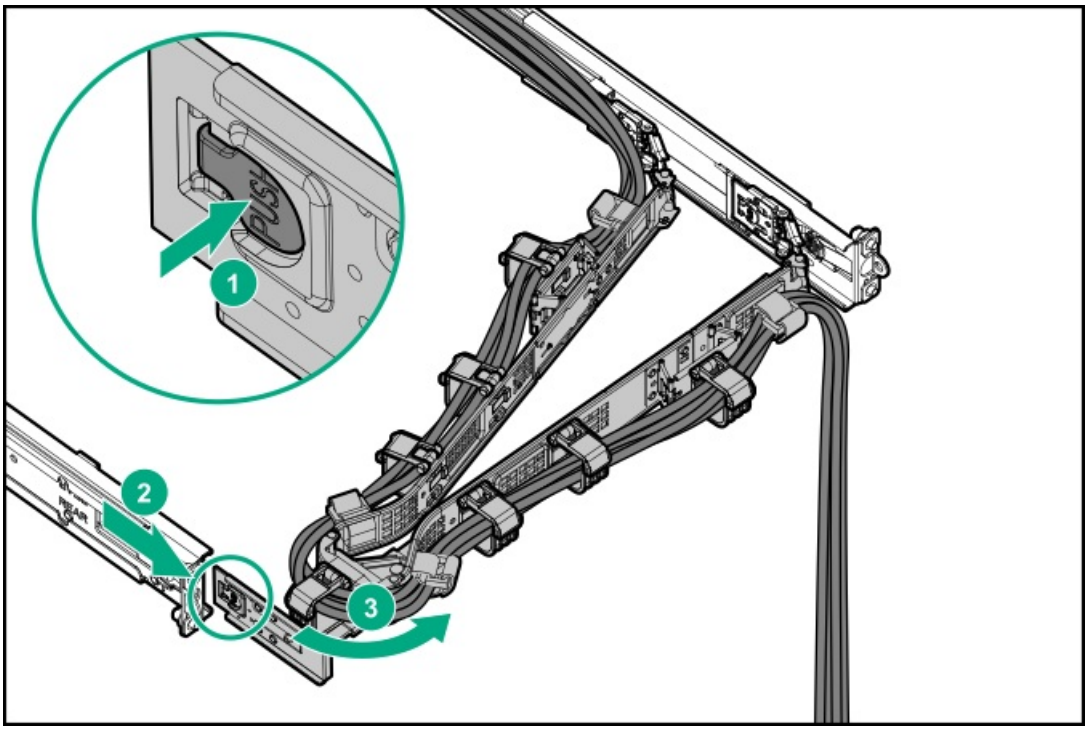
A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

Prerequisites

- Identify the processor and socket components.
- Review the processor cautions.
- Before you perform this procedure, make sure that you have the following items available:
  - T-20 Torx screwdriver
  - Alcohol wipe

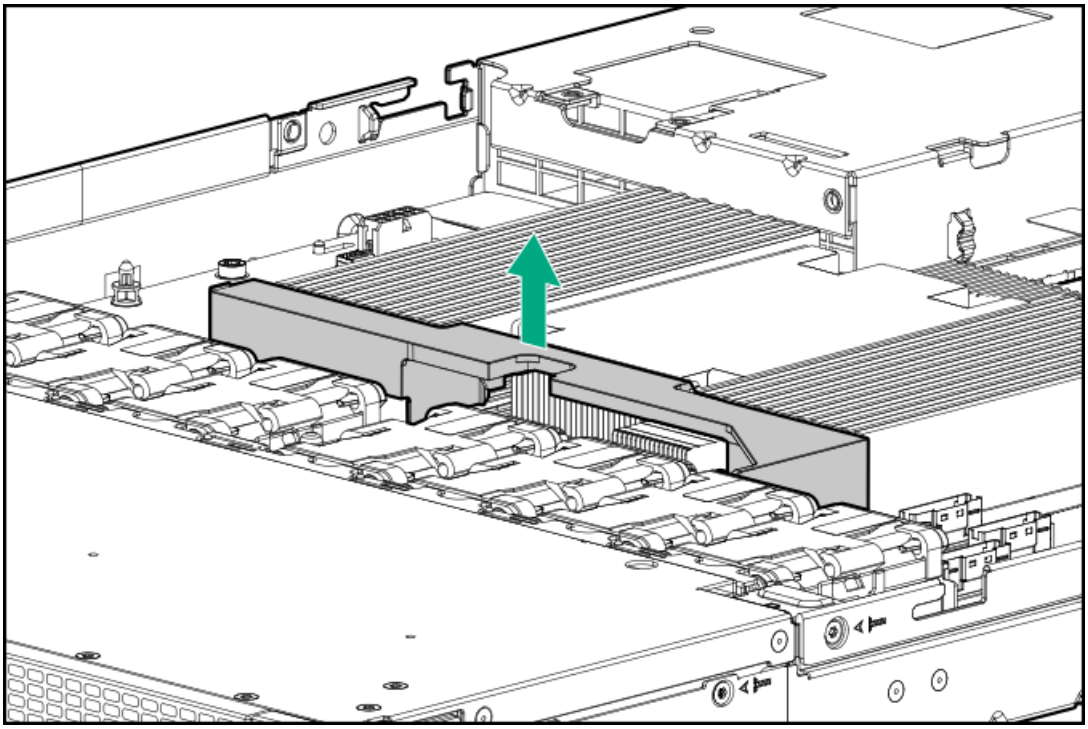
Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.

9. Remove the air baffle.



10. Allow the heatsink to cool.
11. Remove the heatsink:

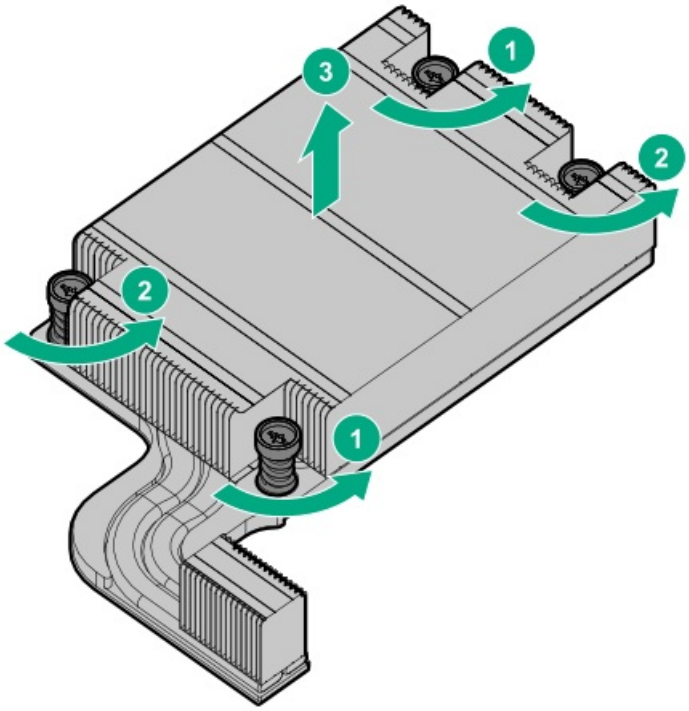
CAUTION:

To prevent mechanical damage or depositing oil on your hands or other contaminant to the heatsink contact surface, hold the heatsink only by the edge of its base plate. Do not touch the heatsink fins.

CAUTION:

Heatsink screws must be tightened and loosened in alternating sequence. Do not overtighten the screws as this might damage the system board or the processor socket.

a. Use a T-20 Torx screwdriver to loosen the captive screws in the sequence specified on the heatsink label.
b. Lift the heatsink away from the system board.

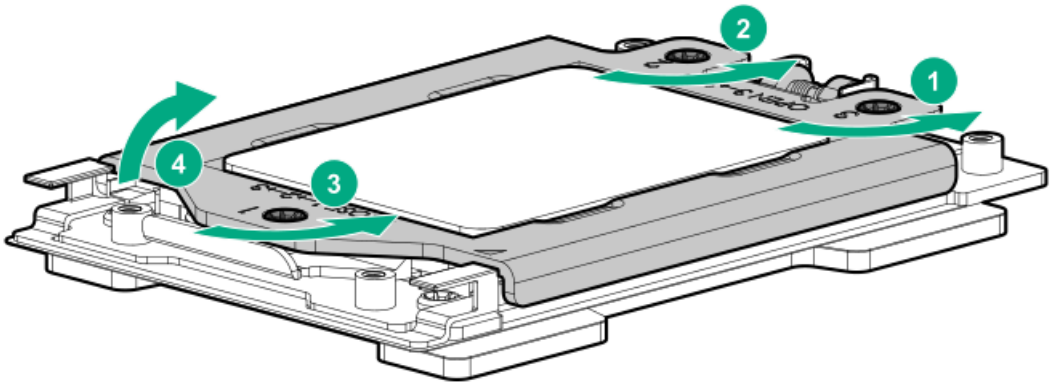


c. Place the heatsink on a flat work surface with its contact side facing up.

12. Use an alcohol wipe to remove the existing thermal grease from the heatsink and processor.

    Allow the alcohol to evaporate before continuing.

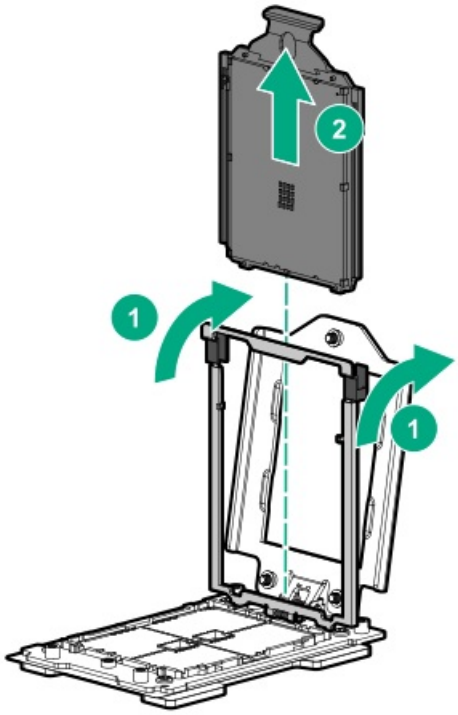
13. Use a T-20 Torx screwdriver to loosen the three captive screws in the sequence shown in the following image, and then pivot the force frame upward.



14. Remove the processor:

    a. Hold the lift tabs near the front end of the rail frame, and then pivot the rail frame to the vertical position.

    b. Slide the processor out of the rail frame.


2
1
1

Installing the processor

CAUTION:

A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

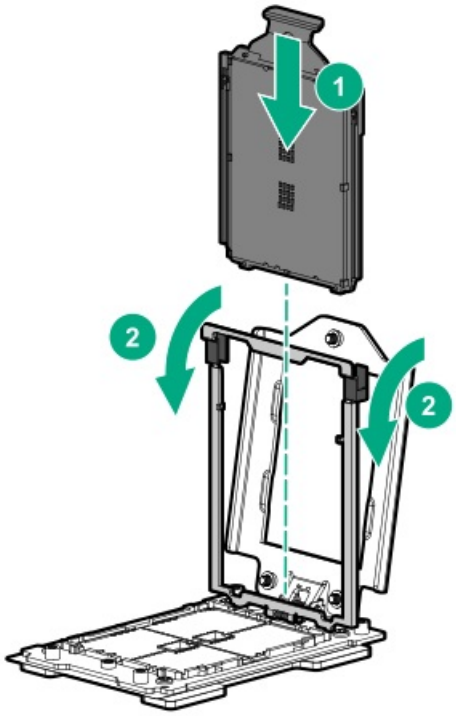
Prerequisites

- Identify the processor and socket components.
- Review the processor cautions.
- Before you perform this procedure, make sure that you have the following items available:
  - T-20 Torx screwdriver
  - Thermal grease (spare part number: 777298-001)

Procedure

1. Install the new processor:
   a. Hold the processor by its carrier handle and slide the processor into the rail frame until it engages with a click sound.
   b. Hold the lift tabs near the front end of the rail frame and pivot the rail frame to the closed position.

      A click sound indicates that the rail frame is properly engaged.



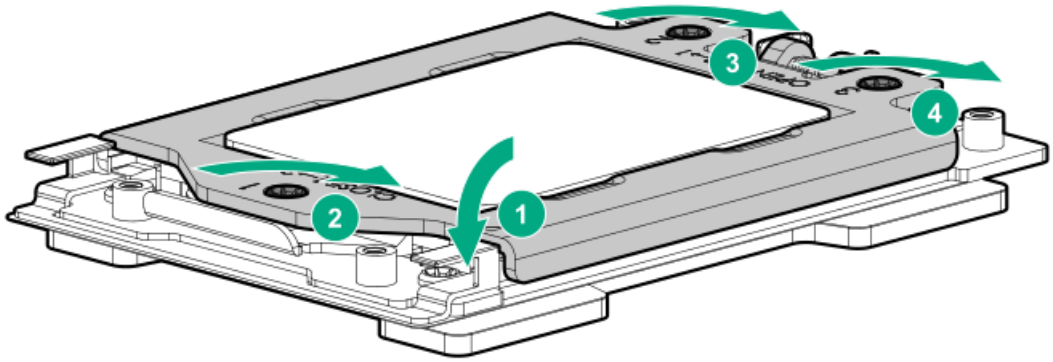
2. Close the force frame:

CAUTION:

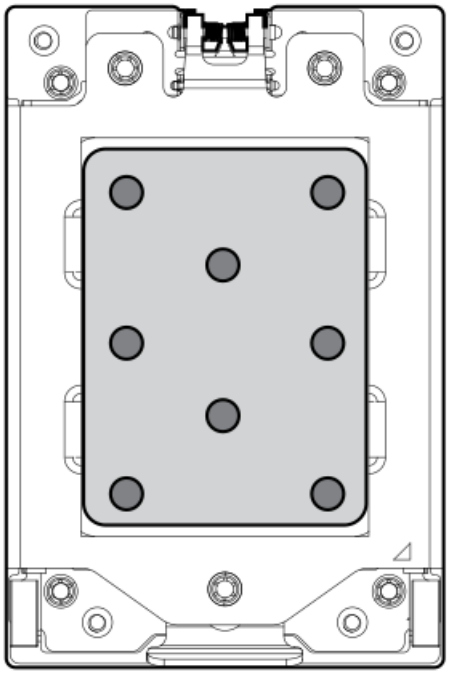
Do not overtighten the screws as this might damage the system board or the processor socket.

   a. Pivot the spring loaded force frame downward and hold it down (callout 1).
   b. Use a T-20 Torx screwdriver to tighten the captive screws in the sequence shown in the following image (callouts 2–4).

      When using a torque wrench to tighten the screws, apply a torque of 1.58 N-m (14 lbf-in).



3. Apply new thermal grease to the processor in the pattern shown in the following image. Use the full contents of the thermal grease syringe.



4. Install the heatsink:

> **CAUTION:**
>
> To prevent mechanical damage or depositing oil on your hands or other contaminant to the heatsink contact surface, hold the heatsink only by the edge of its base plate. Do not touch the heatsink fins.

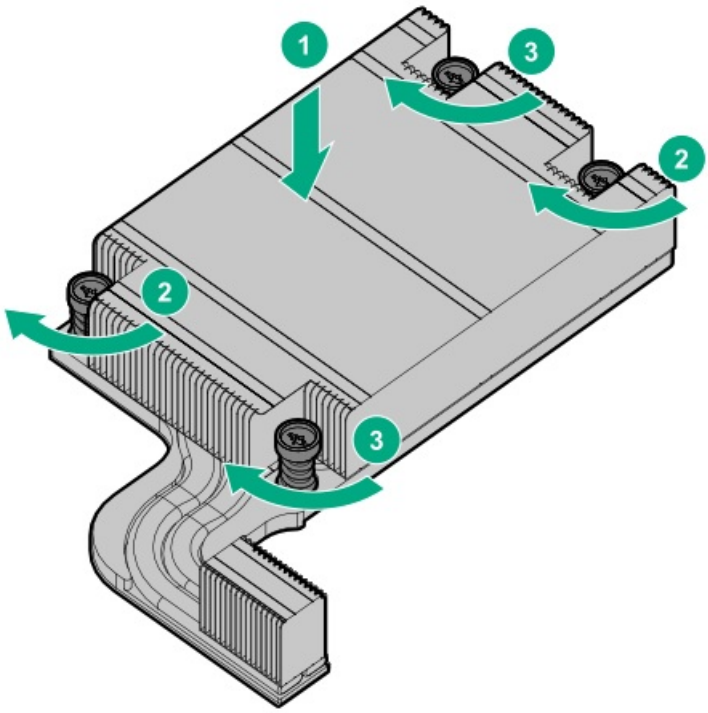
> **CAUTION:**
>
> To prevent thermal failure or component damage, do not move the heatsink once the bottom of its base plate touches the top of the processor. Excessive heatsink movement can cause the thermal grease to smear and become uneven. Voids in the compound can adversely impact the transfer of heat away from the processor.

> **CAUTION:**
>
> Heatsink screws must be tightened and loosened in alternating sequence. Do not overtighten the screws as this might damage the system board or the processor socket.

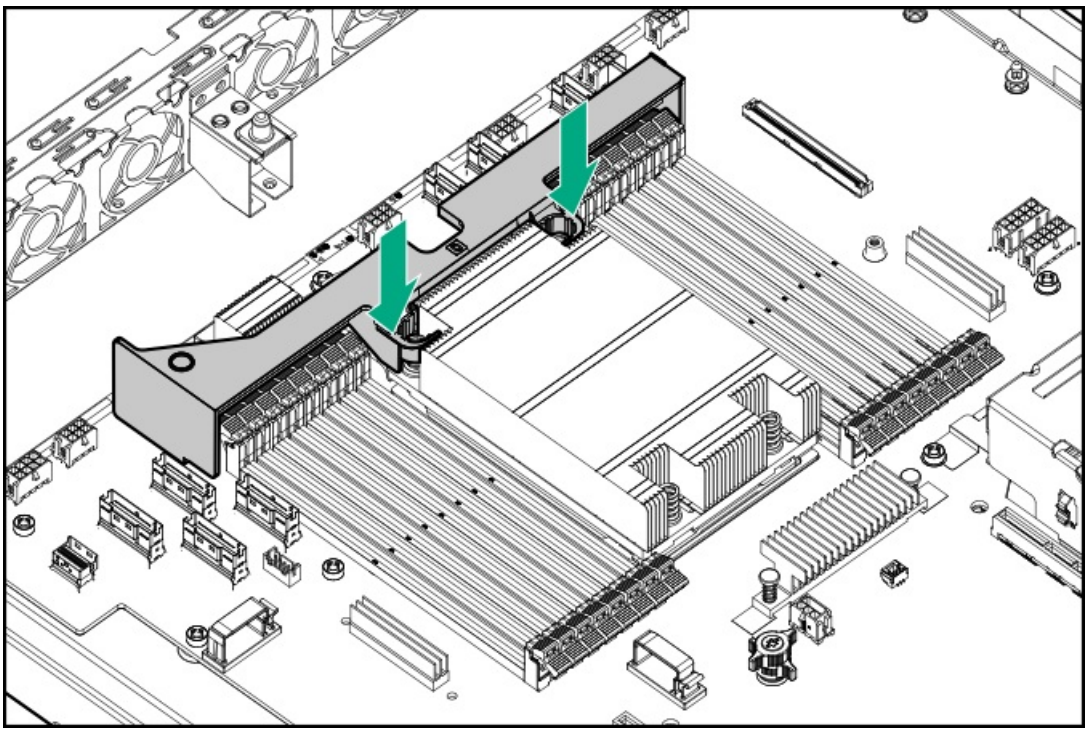
a. Position the heatsink on top of the processor, ensuring that it is properly seated before securing the screws.

b. Use a T-20 Torx screwdriver to tighten the captive screws in the sequence specified on the heatsink label.

   When using a torque wrench to tighten the screws, apply a torque of 1.58 N-m (14 lbf-in).



5. Secure the air baffle hooks to the heatsink screws.



6. Install the access panel.
7. Install the server into the rack.
8. Connect all peripheral cables to the server.
9. Connect each power cord to the server.
10. Connect each power cord to the power source.
11. Power up the server.
12. If removed, install the front bezel.

Removing and replacing an expansion card

CAUTION:

A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all PCI slots have either a riser slot blank or an expansion card installed.

CAUTION:

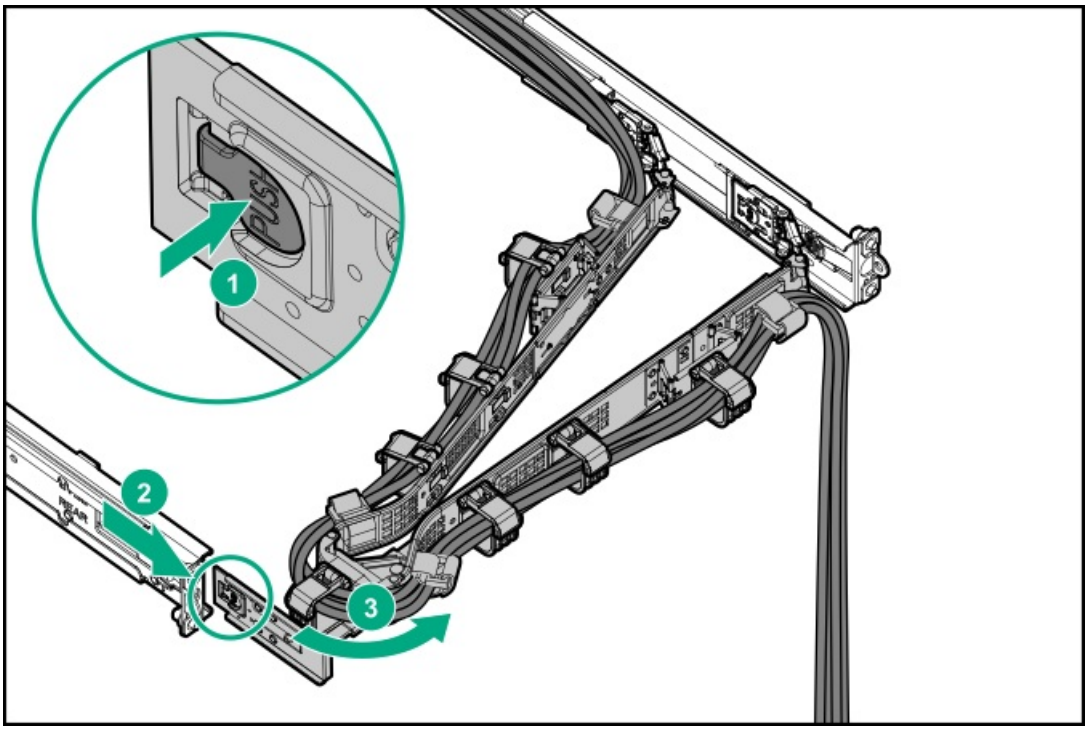
Before replacing a DIMM, expansion card, or other similar PCA components due to a perceived hardware error, make sure first that the component is firmly seated in the slot. Do not bend or flex circuit boards when reseating components.

Prerequisites

Before you perform this procedure, make sure that you have a T-10 Torx screwdriver available.

Procedure

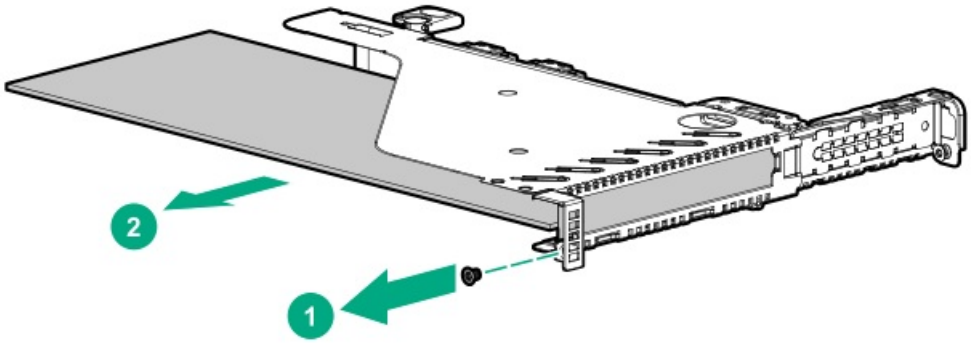
1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



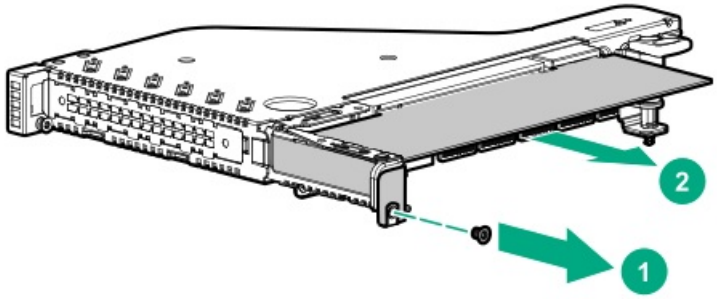
4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Disconnect any internal cables that are connected to the expansion card.
10. To remove an expansion card from the primary riser, do the following:
    a. Remove the primary riser cage

b. Remove the expansion card (callout 2).

- Primary riser slot 1

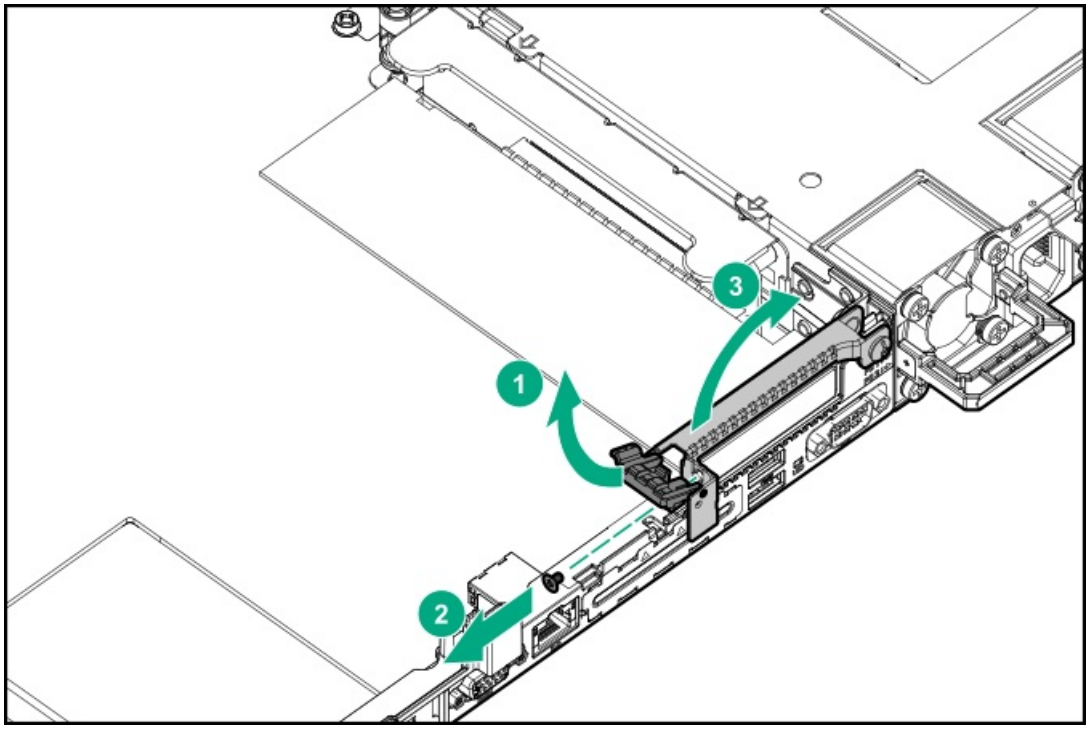


- Primary riser slot 2

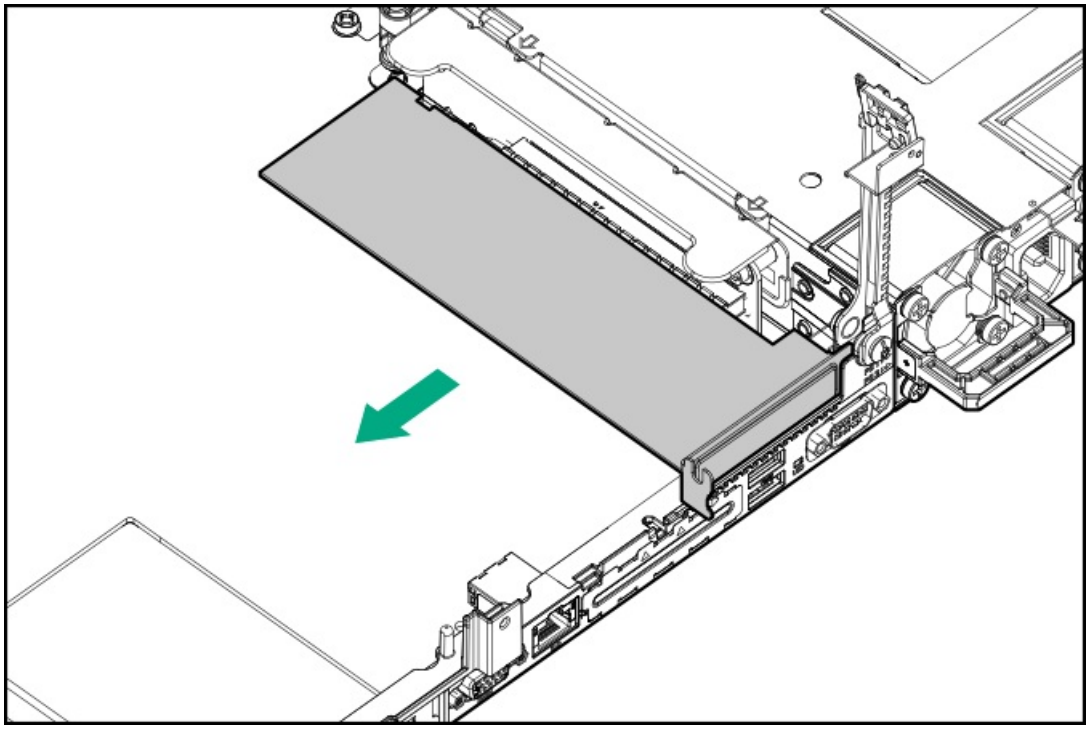


11. To remove a half-height expansion card from the secondary riser, do the following:

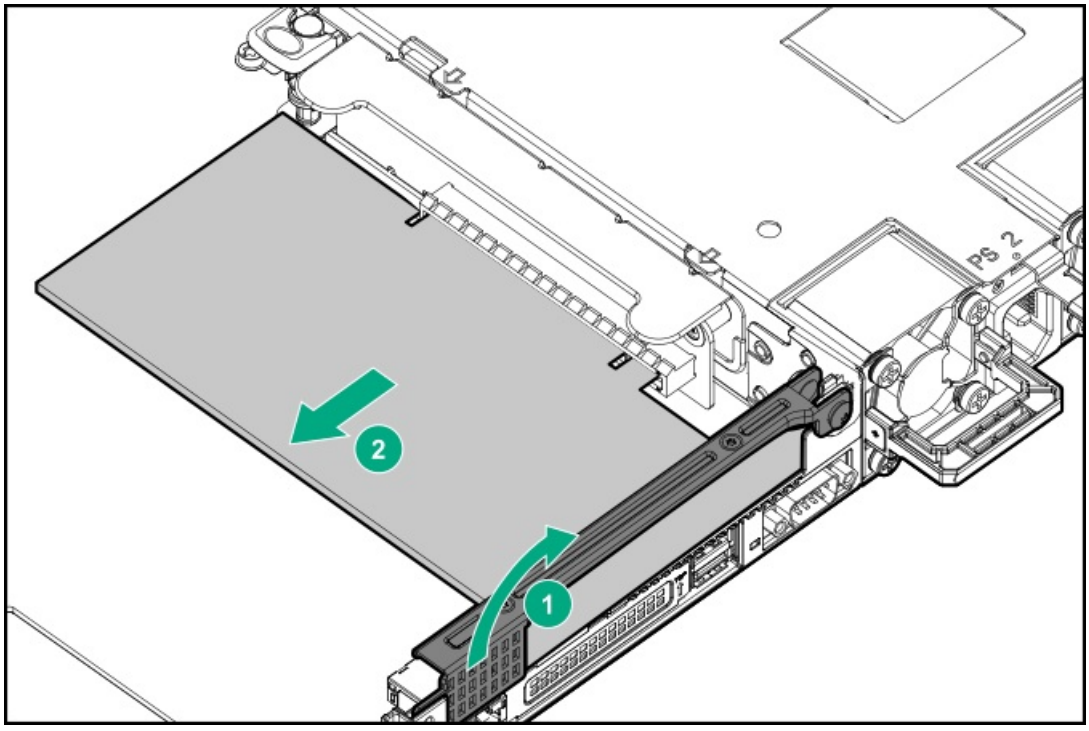
a. Open the retainer bracket.



b. Remove the expansion card.



12. To remove a full-height expansion card from the secondary riser, do the following:
    a. Open retainer bracket (callout 1).
    b. Remove the expansion card (callout 2).



To replace the component, reverse the removal procedure.

Removing and replacing a type-a storage controller

CAUTION:

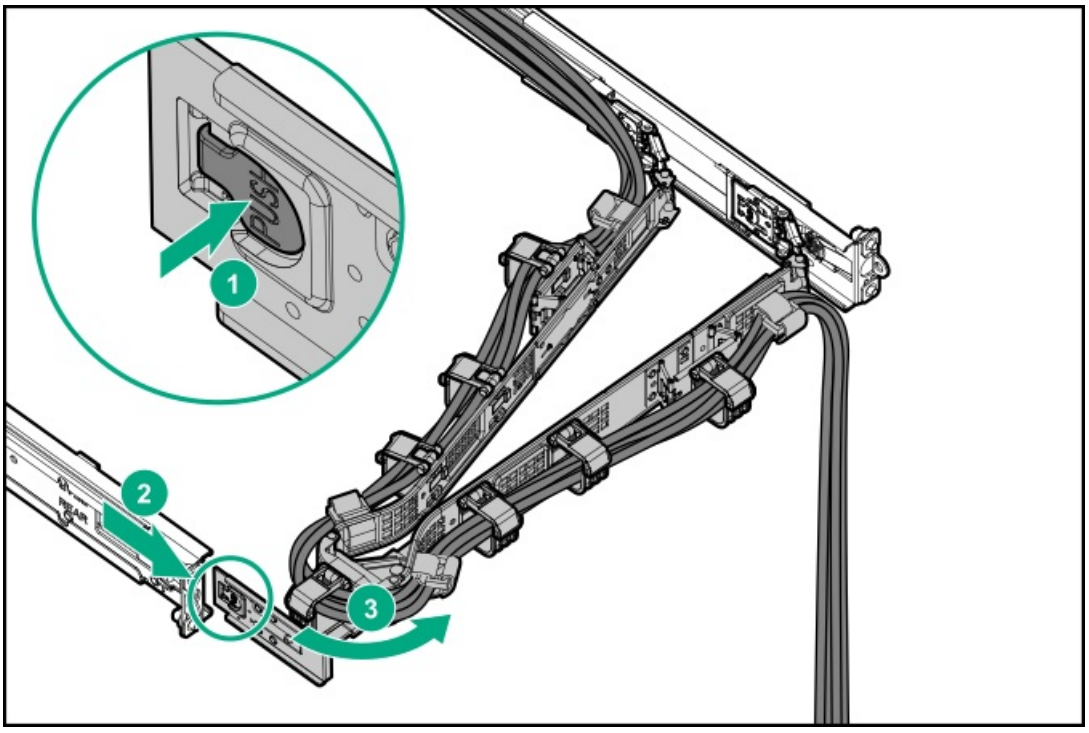
A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

CAUTION:

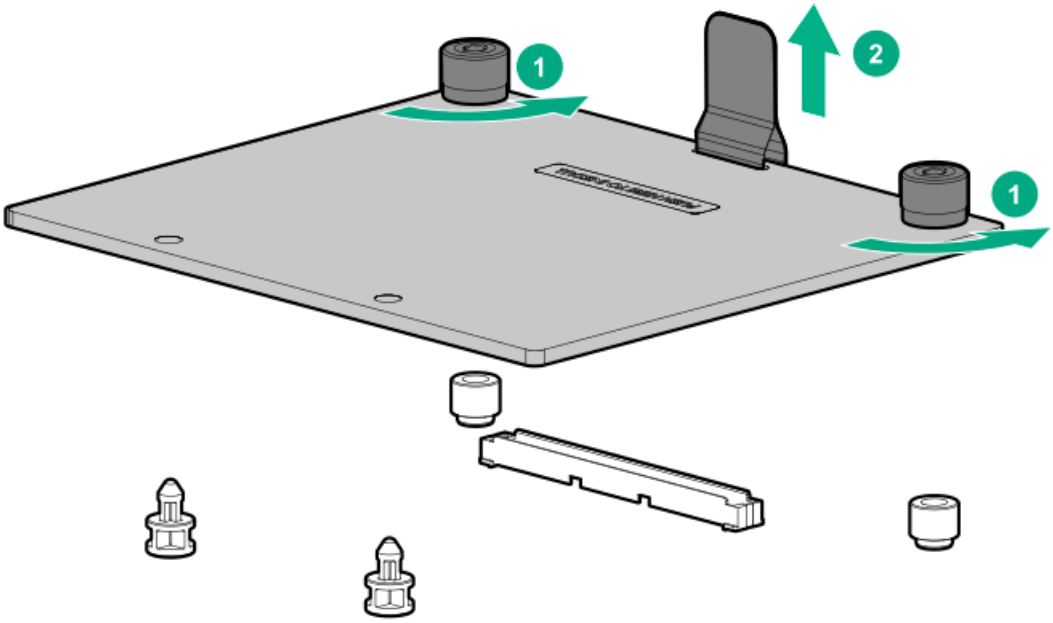
Before replacing a DIMM, expansion card, or other similar PCA components due to a perceived hardware error, make sure first that the component is firmly seated in the slot. Do not bend or flex circuit boards when reseating components.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Disconnect all cables from the type-a storage controller.
10. Remove the type-a storage controller:
    a. Loosen the controller thumbscrews (callout 1).
    b. Use the pull-up tab to release the controller from the system board (callout 2).



To replace the component, reverse the removal procedure.

M.2 SATA SSD option replacement

- Removing and replacing the M.2 SATA SSD add-in card
- Removing and replacing an M.2 SATA SSD

Removing and replacing the M.2 SATA SSD add-in card

CAUTION:

A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all PCI slots have either a riser slot blank or an expansion card installed.

CAUTION:

Before replacing a DIMM, expansion card, or other similar PCA components due to a perceived hardware error, make sure first that the component is firmly seated in the slot. Do not bend or flex circuit boards when reseating components.

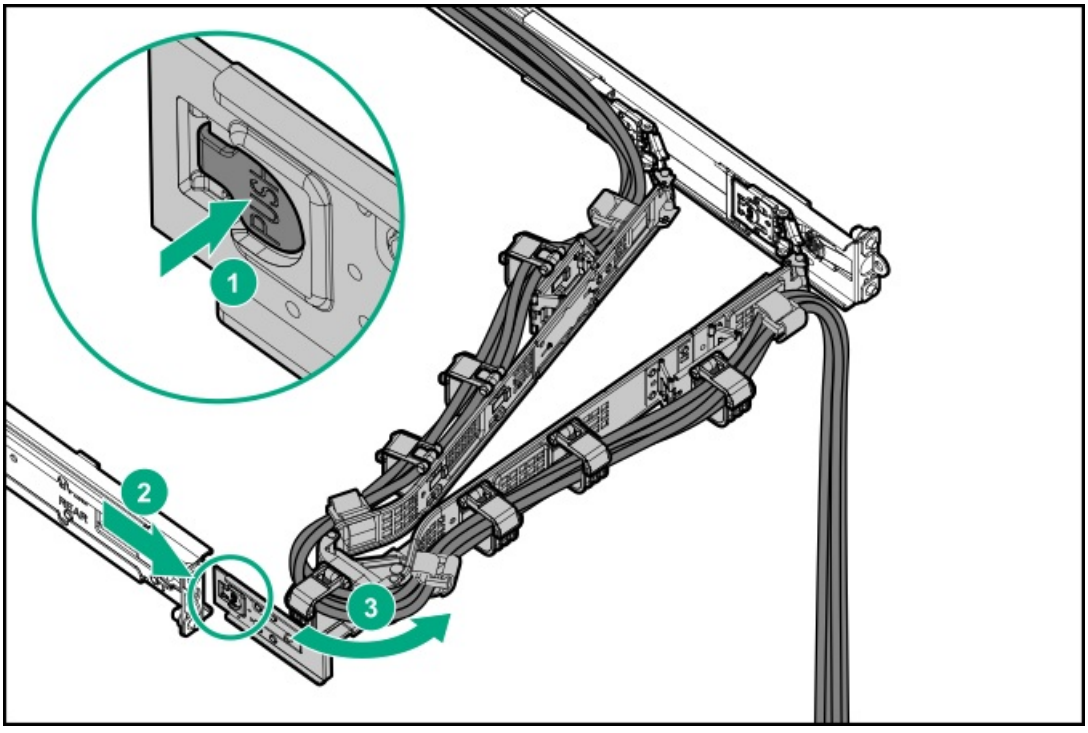
Prerequisites

Before you perform this procedure, make sure that you have the following items available:

- T-10 Torx screwdriver
- Phillips No. 1 screwdriver

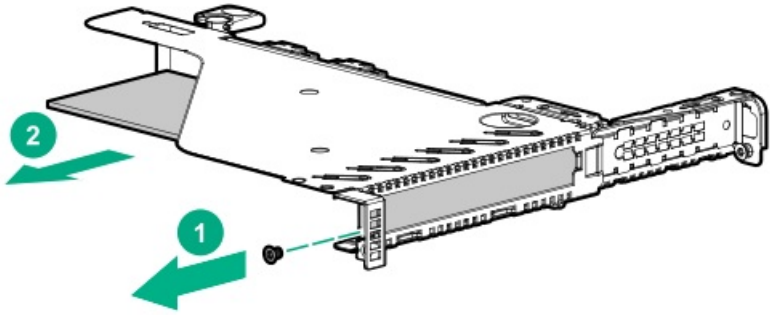
Procedure

1. Back up all server data.
2. If installed, remove the front bezel.
3. Power down the server.
4. If installed, release the cable management arm.

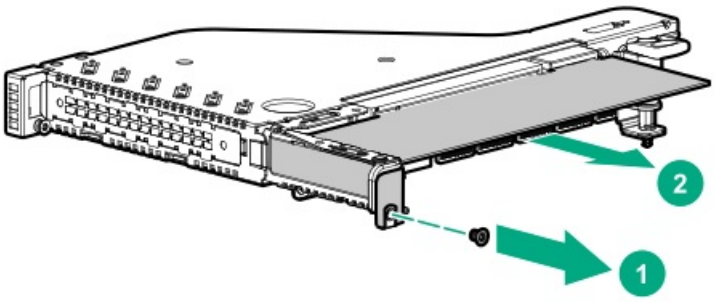


5. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
6. Disconnect all peripheral cables from the server.
7. Remove the server from the rack.
8. Place the server on a flat, level work surface.
9. Remove the access panel.

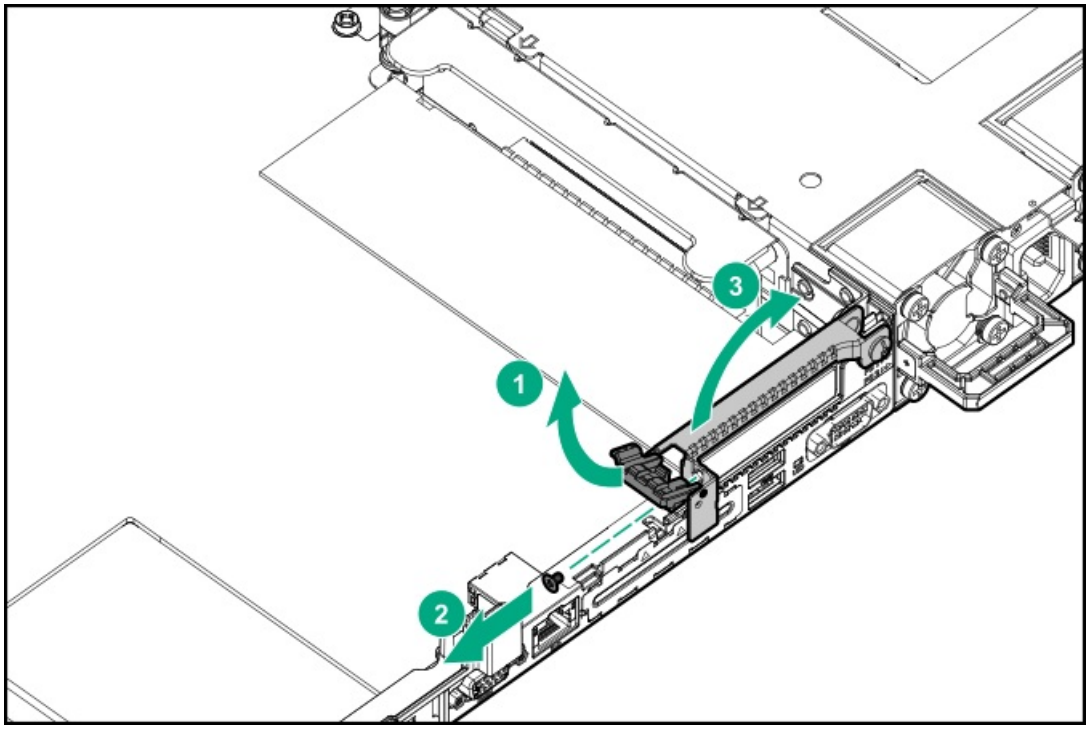
10. Disconnect the optical drive-M.2 SSD SATA splitter cable from the add-in card. .
11. To remove the M.2 SATA SSD add-in card from the primary riser, do the following:
    a. Remove the primary riser cage.
    b. Remove the add-in card.
        - Primary riser slot 1



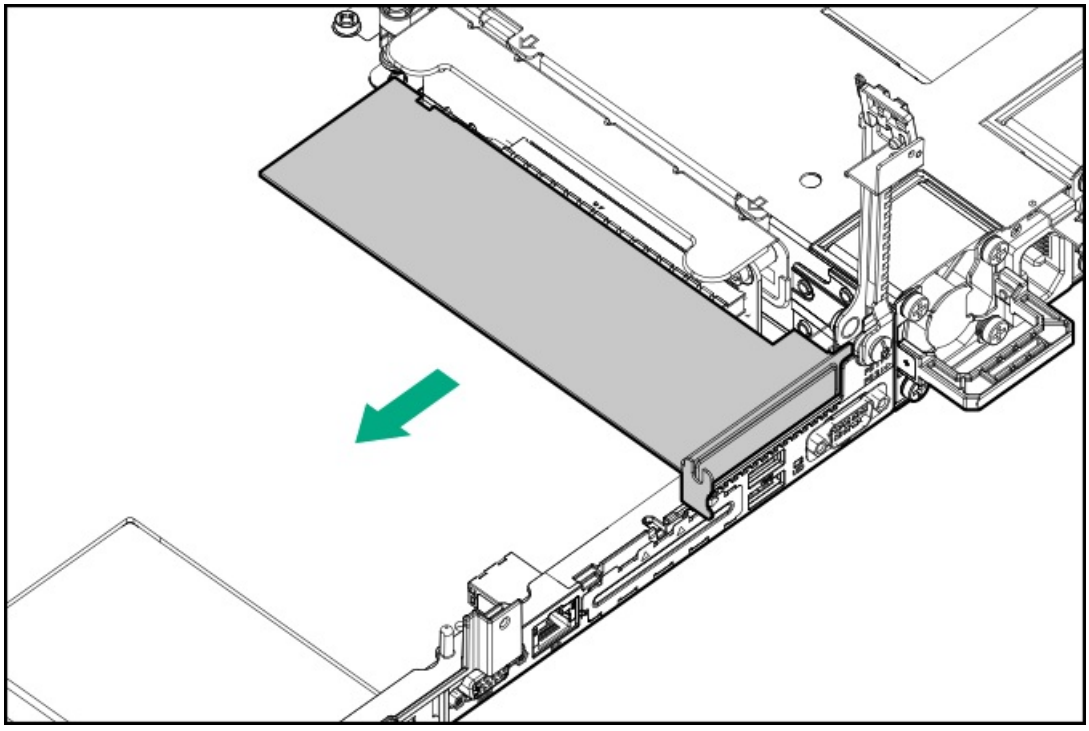
        - Primary riser slot 2



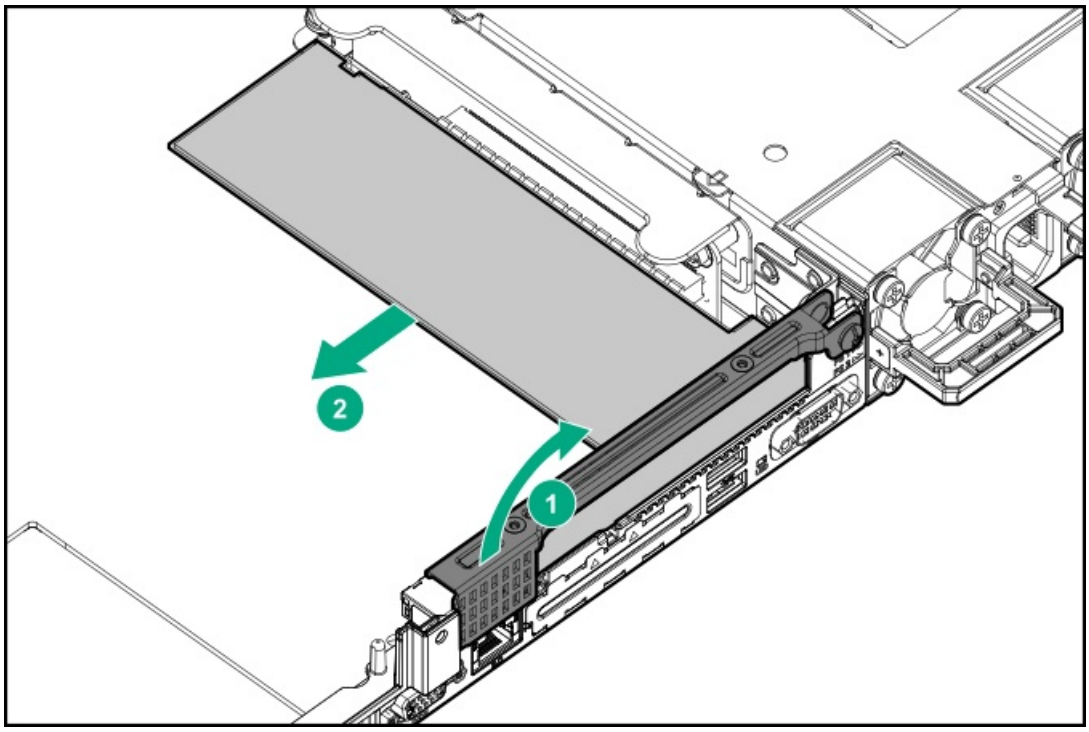
12. To remove the M.2 SATA SSD add-in card with a low-profile bracket from the secondary riser, do the following:
    a. Open the retainer bracket.



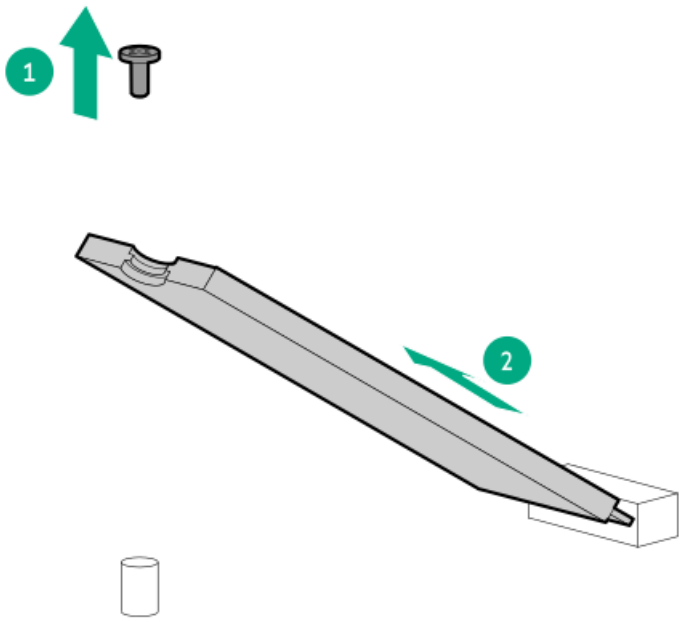
    b. Remove the add-in card.



13. To remove the M.2 SATA SSD add-in card with a full-height bracket from the secondary riser, do the following:
    a. Open the retainer bracket (callout 1).
    b. Remove the add-in card (callout 2).



14. Remove the M.2 SATA SSDs from the add-in card.



Retain these SSDs for installation onto the new add-in card.

To replace the component, reverse the removal procedure.

Removing and replacing an M.2 SATA SSD

CAUTION:

A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

CAUTION:

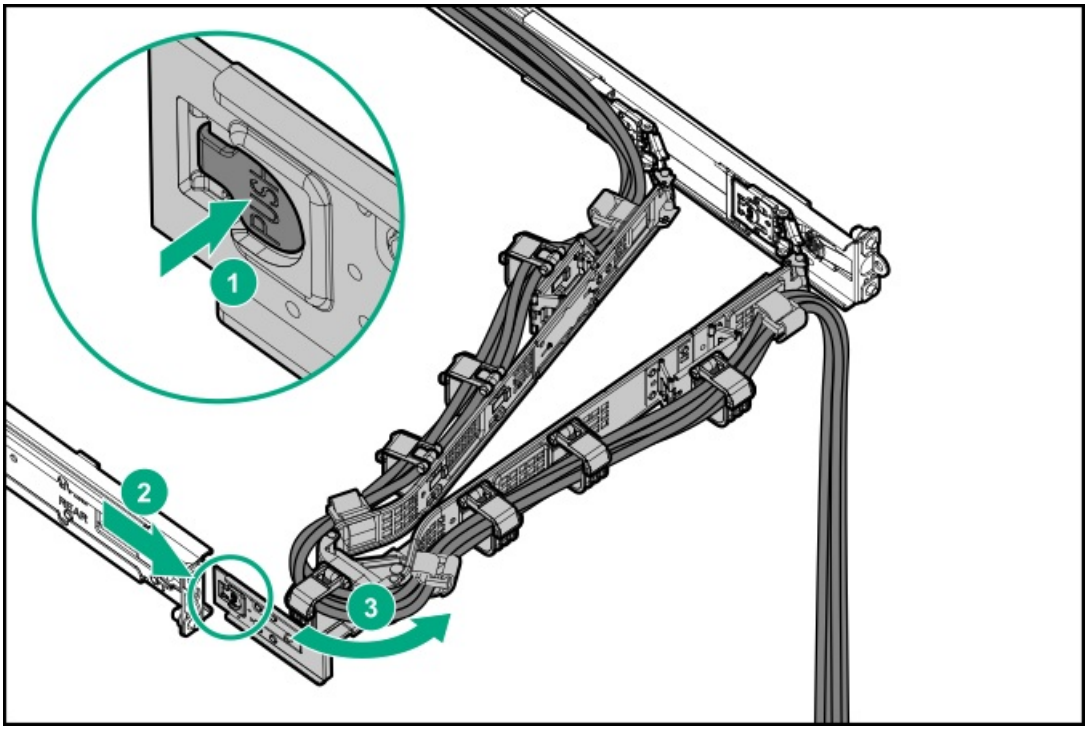
Before replacing a DIMM, expansion card, or other similar PCA components due to a perceived hardware error, make sure first that the component is firmly seated in the slot. Do not bend or flex circuit boards when reseating components.

Prerequisites

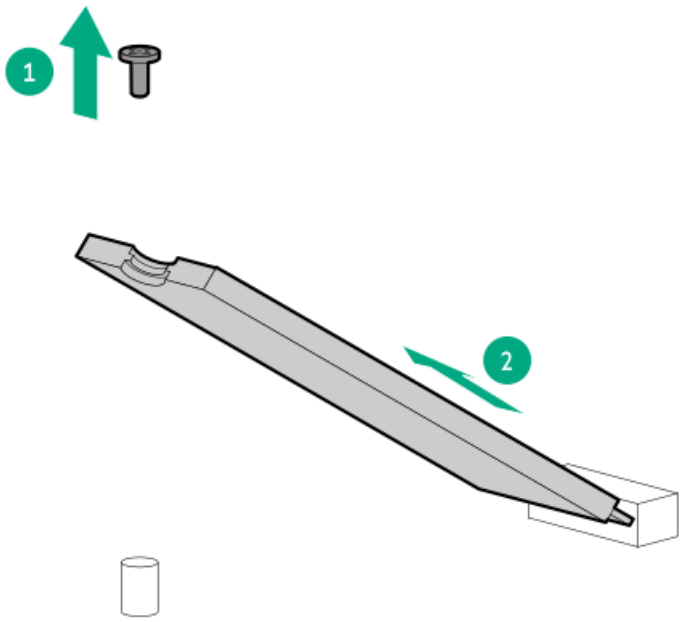
Before you perform this procedure, make sure that you have a Phillips No. 1 screwdriver available.

Procedure

1. Back up all server data.
2. If installed, remove the front bezel.
3. Power down the server.
4. If installed, release the cable management arm.



5. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
6. Disconnect all peripheral cables from the server.
7. Remove the server from the rack.
8. Place the server on a flat, level work surface.
9. Remove the access panel.
10. Disconnect the optical drive-M.2 SSD SATA splitter cable from the add-in card..
11. Remove the riser cage.
12. Remove the M.2 SSD add-in card.
13. Remove the M.2 SATA SSD.



To replace the component, reverse the removal procedure.

HPE NS204i-p NVMe OS Boot Device replacement

- Removing and replacing the boot device
- Removing and replacing a boot device drive
- Relocating the M.2 drive retaining latches

Removing and replacing the boot device

CAUTION:

A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all PCI slots have either a riser slot blank or an expansion card installed.

CAUTION:

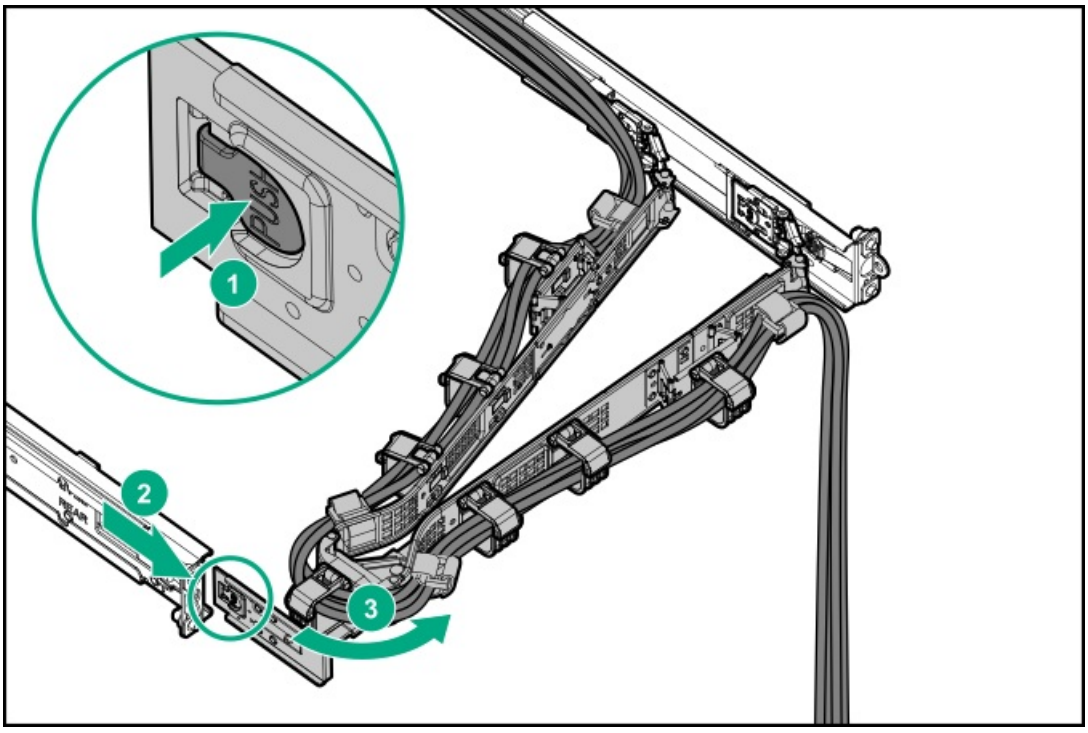
Before replacing a DIMM, expansion card, or other similar PCA components due to a perceived hardware error, make sure first that the component is firmly seated in the slot. Do not bend or flex circuit boards when reseating components.

Prerequisites

Before you perform this procedure, make sure that you have a T-15 Torx screwdriver available.

Procedure

1. Back up all server data.
2. If installed, remove the front bezel.
3. Power down the server.
4. If installed, release the cable management arm.

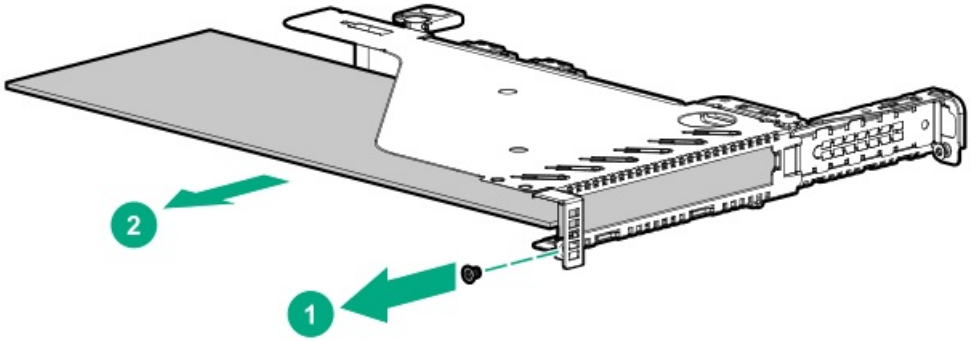


5. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
6. Disconnect all peripheral cables from the server.
7. Remove the server from the rack.
8. Place the server on a flat, level work surface.
9. Remove the access panel.
10. Remove the primary riser cage.
11. To remove the boot device from the primary riser, do the following:

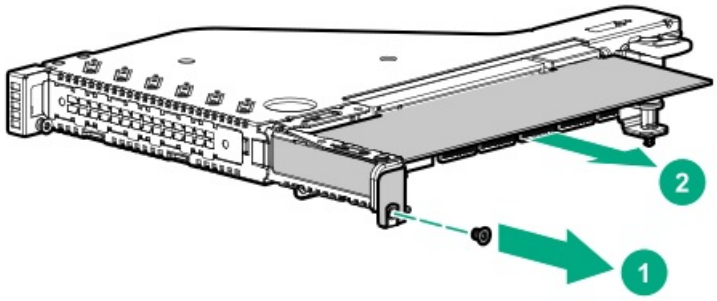
a. Remove the primary riser cage.

b. Remove the boot device.

- Primary riser slot 1

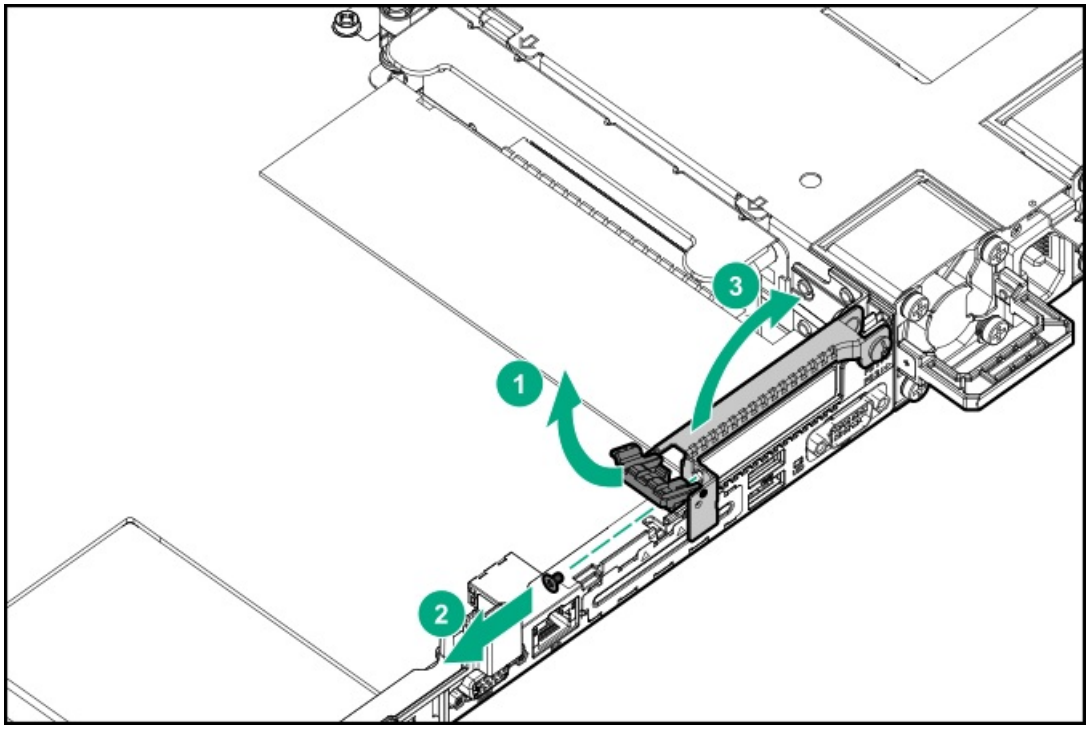


- Primary riser slot 2

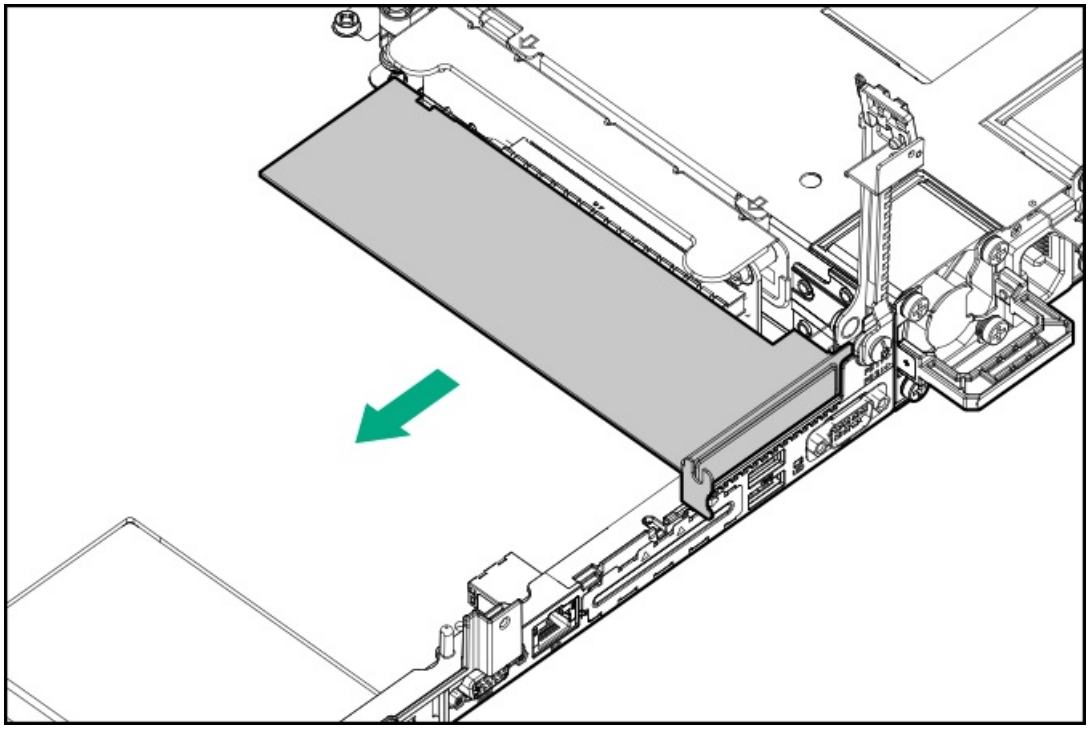


12. To remove the boot device with a low-profile bracket from the secondary riser, do the following:

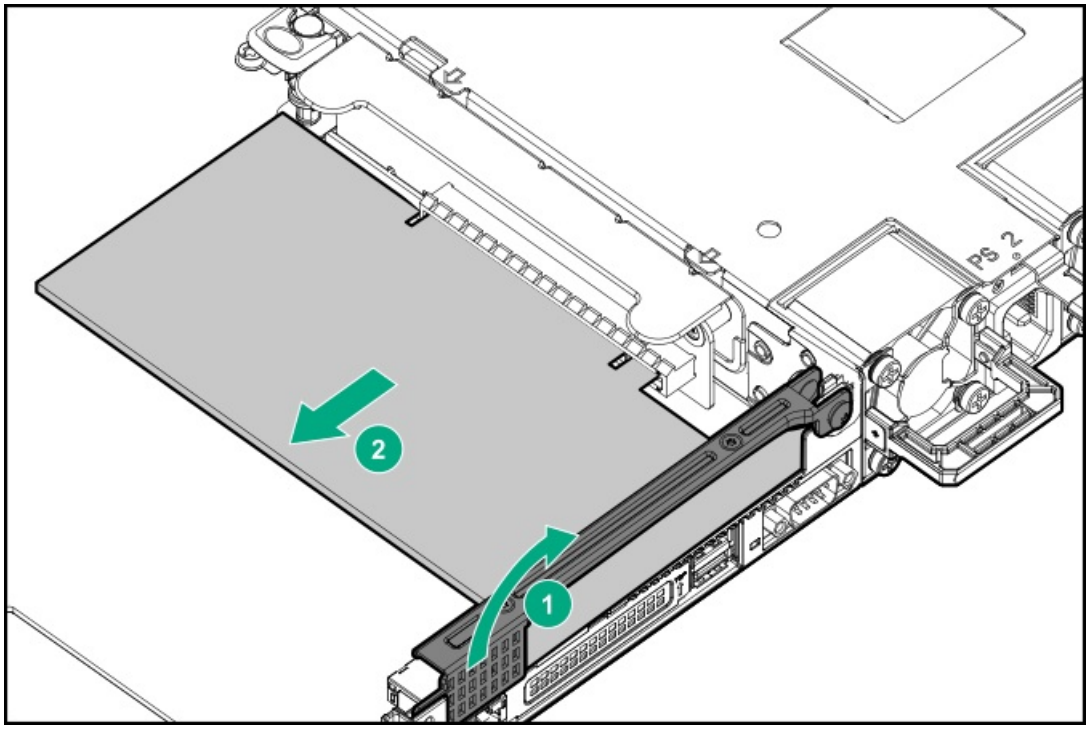
a. Open the retainer bracket.



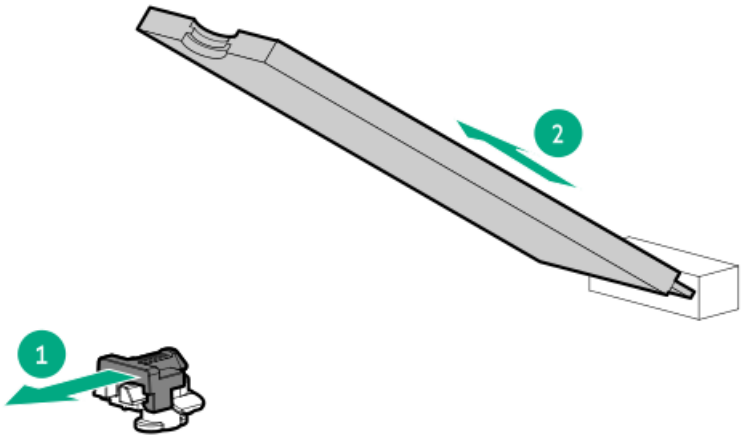
b. Remove the boot device.



13. To remove the boot device with a full-height bracket from the secondary riser, do the following:
    a. Open retainer bracket (callout 1).
    b. Remove the boot device (callout 2).



14. Remove the M.2 NVMe SSDs from the boot device.



Retain these SSDs for installation onto the new boot device.

To replace the component, reverse the removal procedure.

Removing and replacing a boot device drive

The boot device supports two physical drive sizes:

- 22110 (110 mm)
- 2280 (80 mm)

Two drives of the same physical size, or one of each size, can be installed at the same time. Depending on the replacement drive size, you might need to relocate the M.2 drive retaining latches on the boot device.

CAUTION:

The boot device and the drives installed on the boot device are not hot-pluggable. To remove the boot device, or a drive from the boot device, you must first power down the server.

CAUTION:

A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

CAUTION:

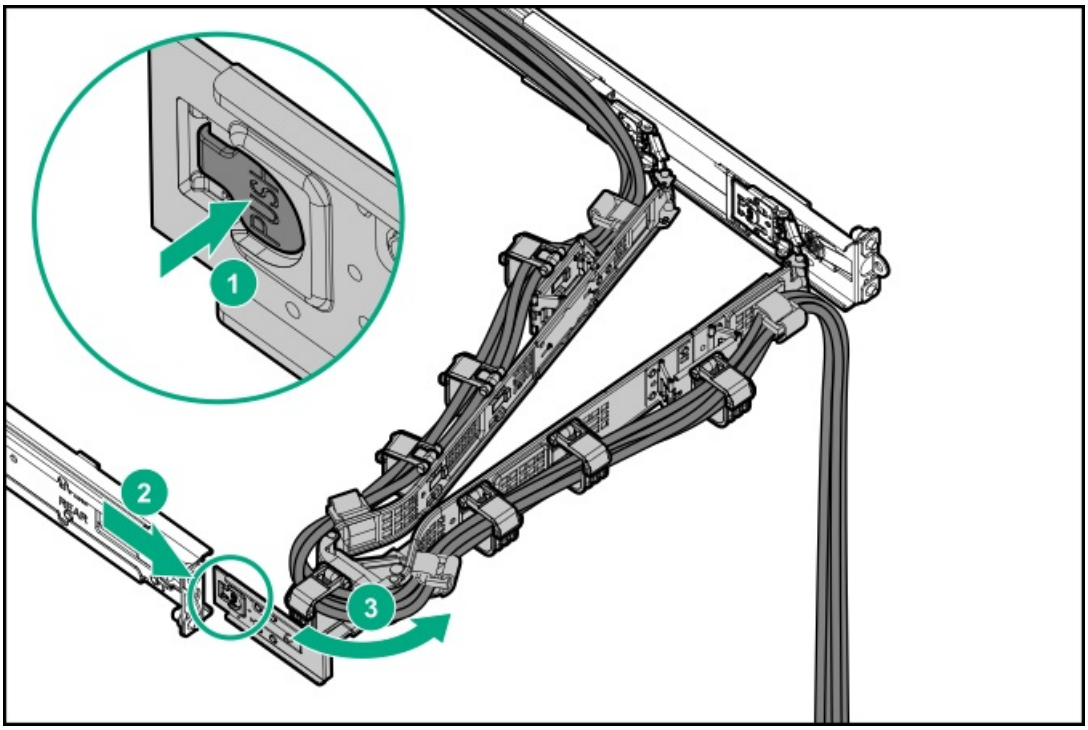
Before replacing a DIMM, expansion card, or other similar PCA components due to a perceived hardware error, make sure first that the component is firmly seated in the slot. Do not bend or flex circuit boards when reseating components.

Prerequisites

Review the boot device drive bay LEDs to identify the failed drive.

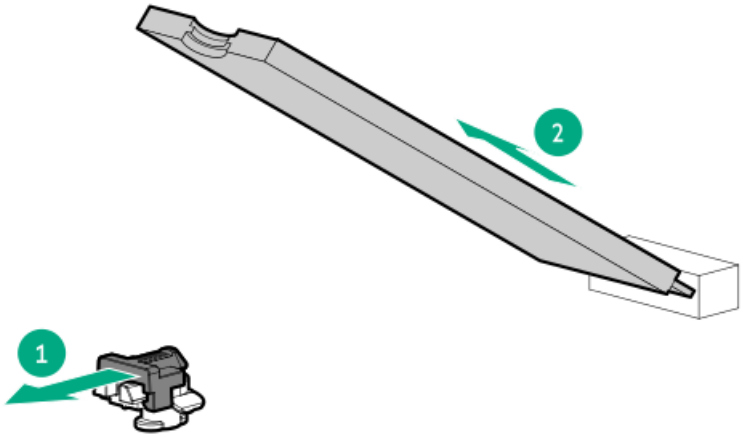
Procedure

1. Back up all server data.
2. If installed, remove the front bezel.
3. Power down the server.
4. If installed, release the cable management arm.



5. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
6. Disconnect all peripheral cables from the server.

7. Remove the server from the rack.
8. Place the server on a flat, level work surface.
9. Remove the access panel.
10. Remove the riser cage.
11. Remove the boot device.
12. Remove the M.2 NVMe SSD from the boot device.

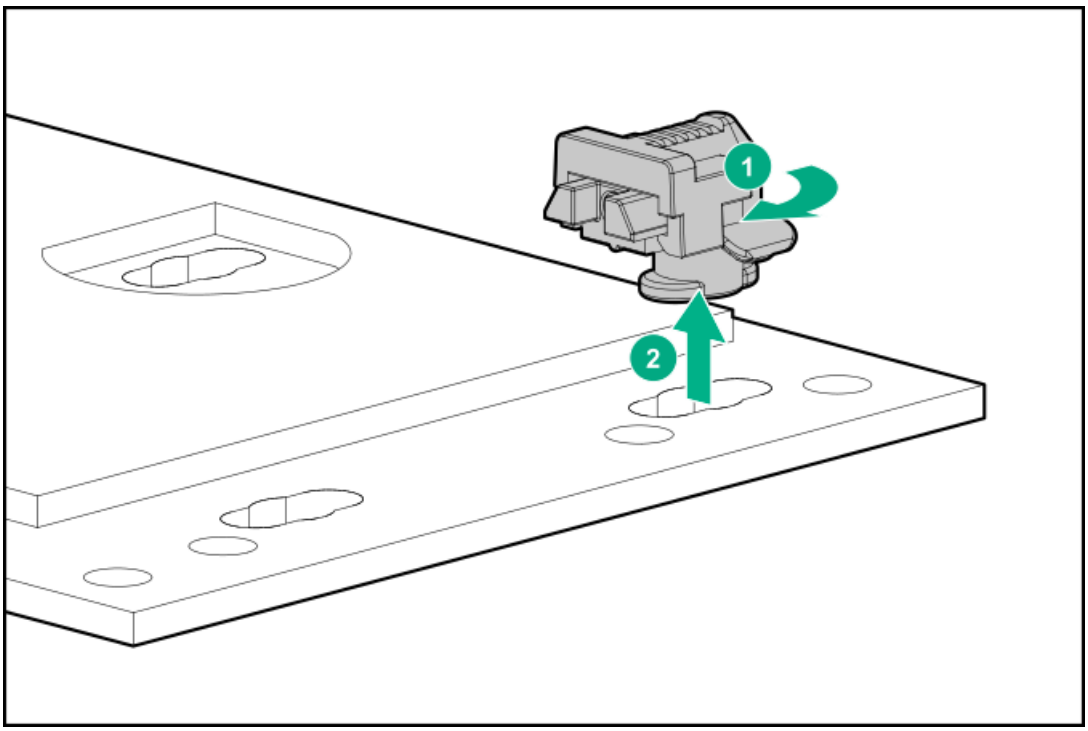


To replace the component, reverse the removal procedure.

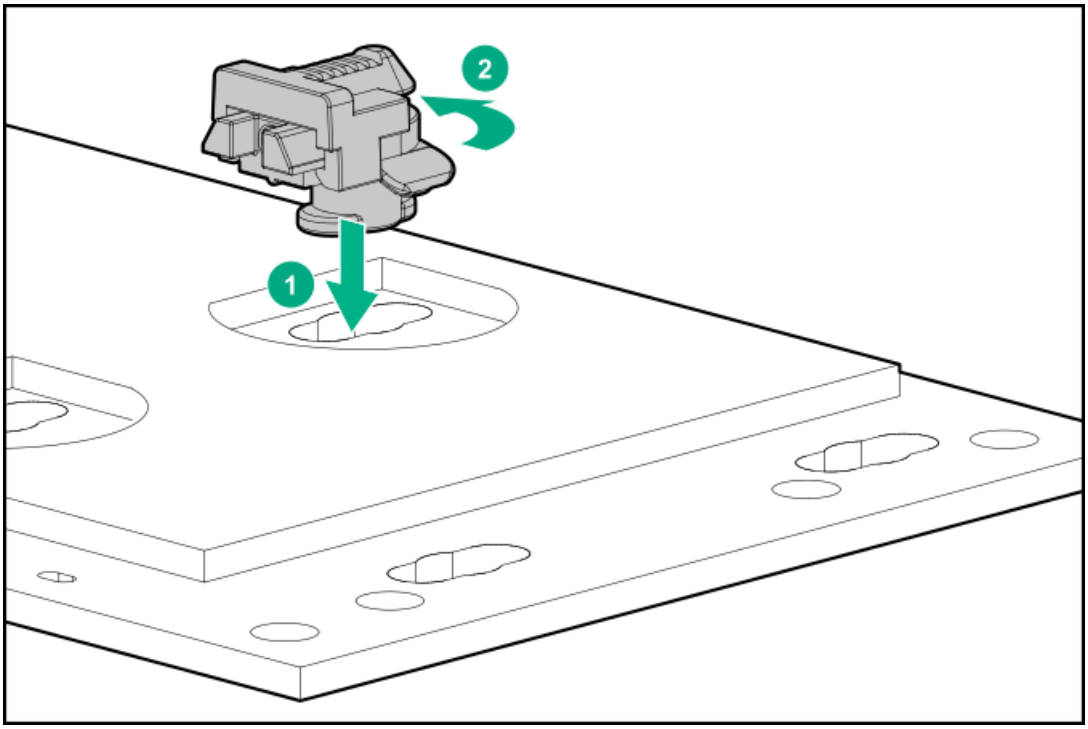
Relocating the M.2 drive retaining latches

Procedure

1. If your spare kit includes an 80 mm replacement drive, remove the retaining latch from its current location.



2. Install the retaining latch at the 80 mm drive location.



Removing and replacing the primary riser board

CAUTION:

A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

CAUTION:

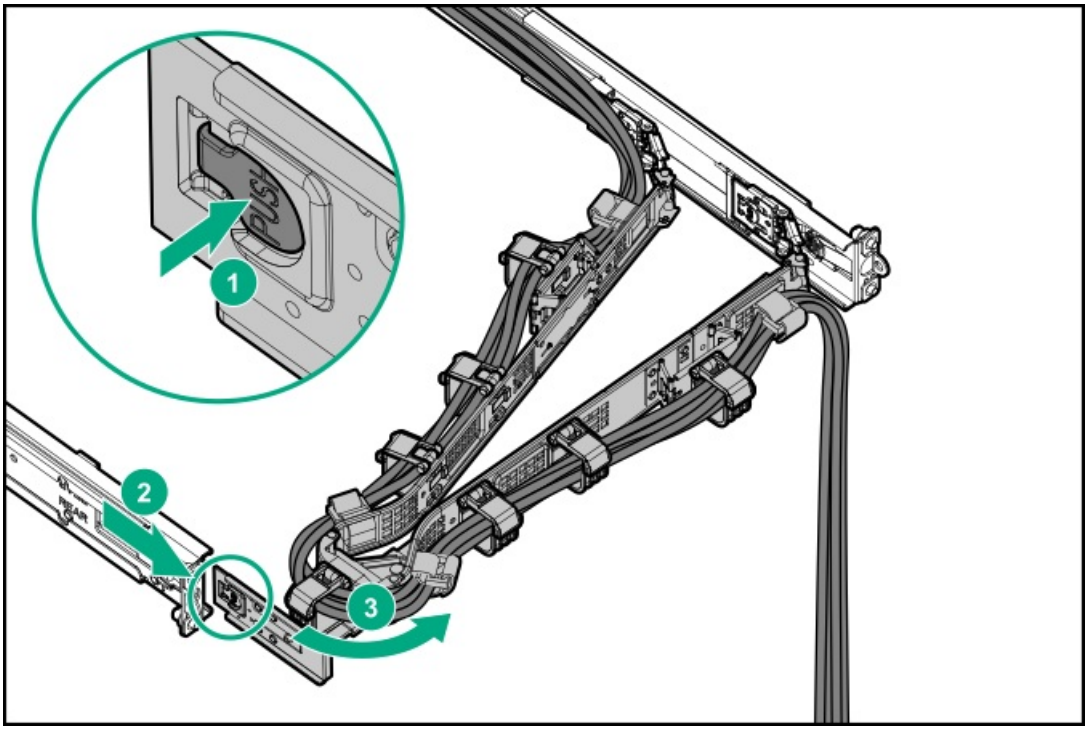
Before replacing a DIMM, expansion card, or other similar PCA components due to a perceived hardware error, make sure first that the component is firmly seated in the slot. Do not bend or flex circuit boards when reseating components.

Prerequisites

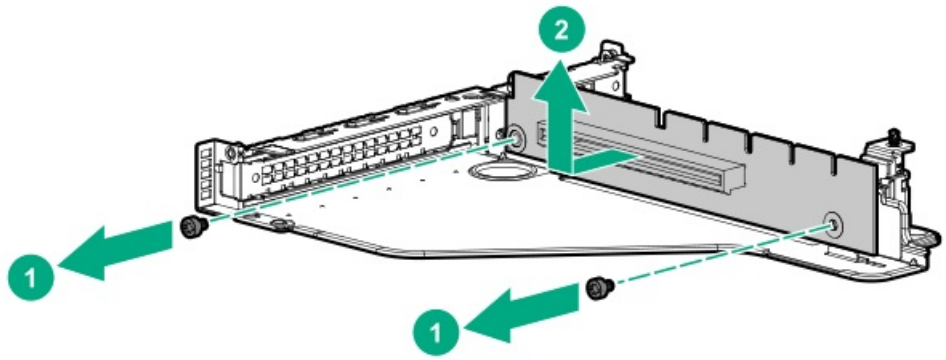
Before you perform this procedure, make sure that you have a T-15 Torx screwdriver available.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove the primary riser cage.
10. If installed, remove any expansion card from the riser.
11. Remove the riser board.



To replace the component, reverse the removal procedure.

Removing and replacing the secondary riser board

CAUTION:

A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

CAUTION:

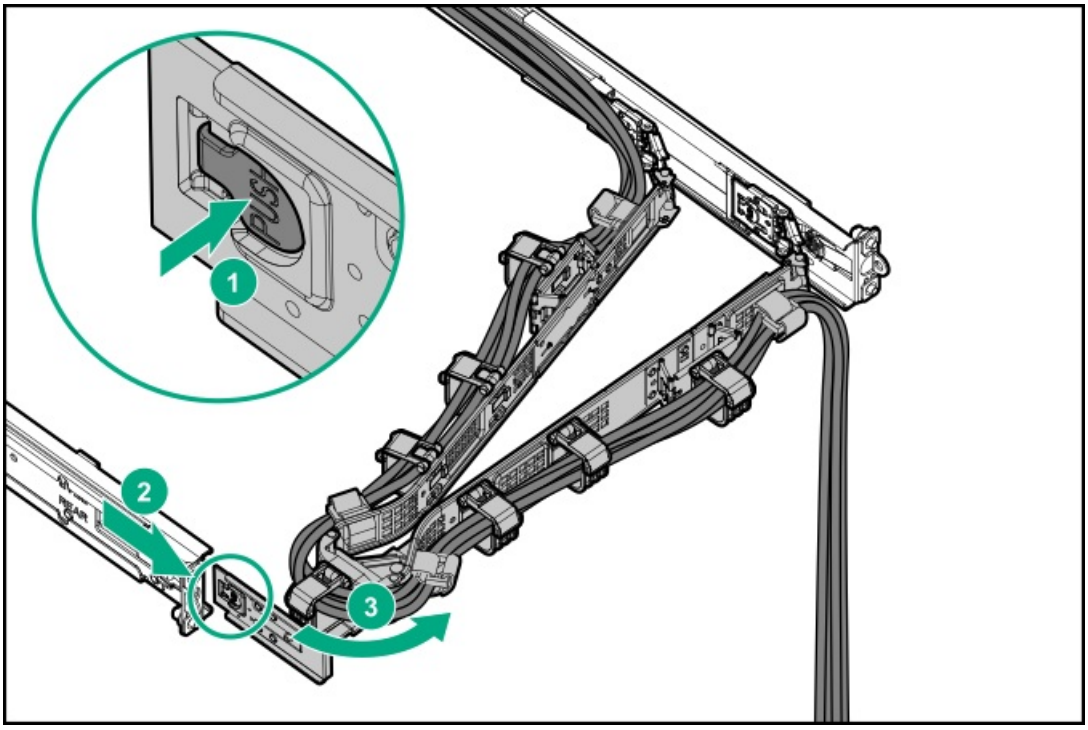
Before replacing a DIMM, expansion card, or other similar PCA components due to a perceived hardware error, make sure first that the component is firmly seated in the slot. Do not bend or flex circuit boards when reseating components.

Prerequisites

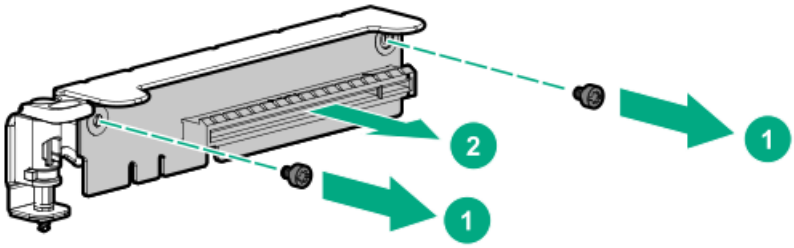
Before you perform this procedure, make sure that you have a T-15 Torx screwdriver available.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



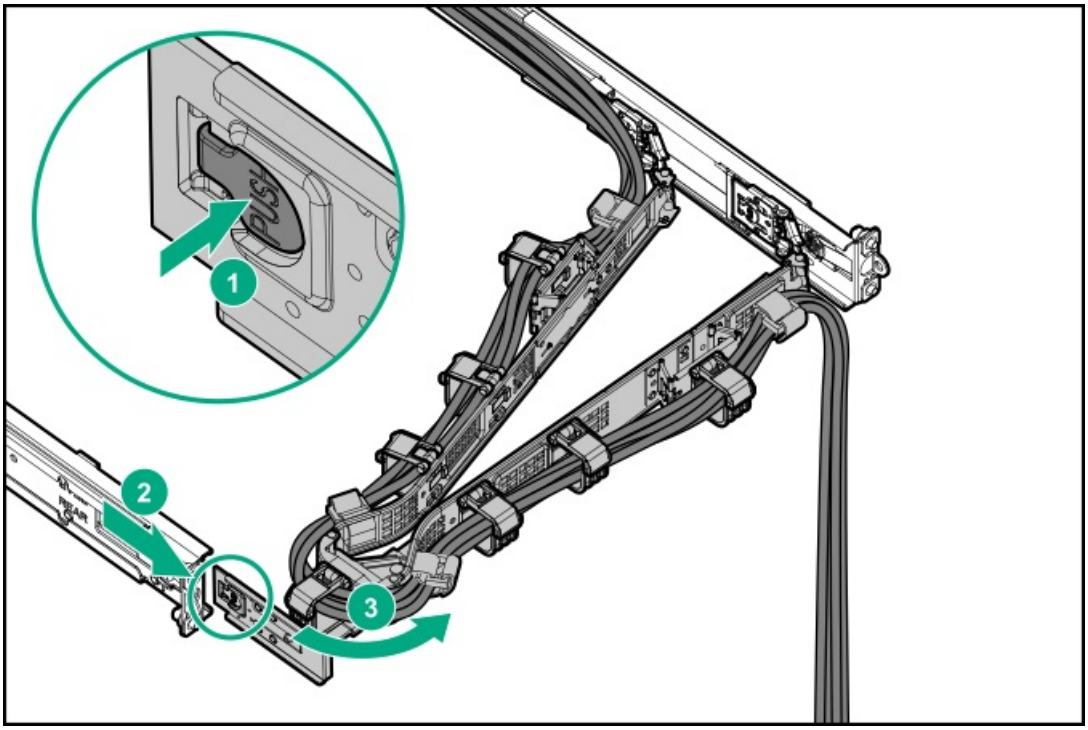
4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove the secondary riser cage.
10. If installed, remove any expansion card from the riser.
11. Remove the riser board.


2
1
1

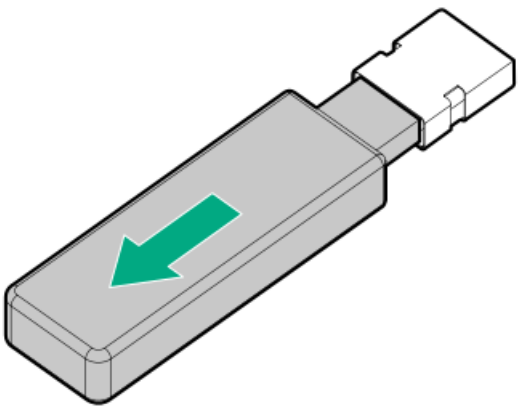
Removing and replacing an internal USB device

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Unplug the USB device from the USB port.

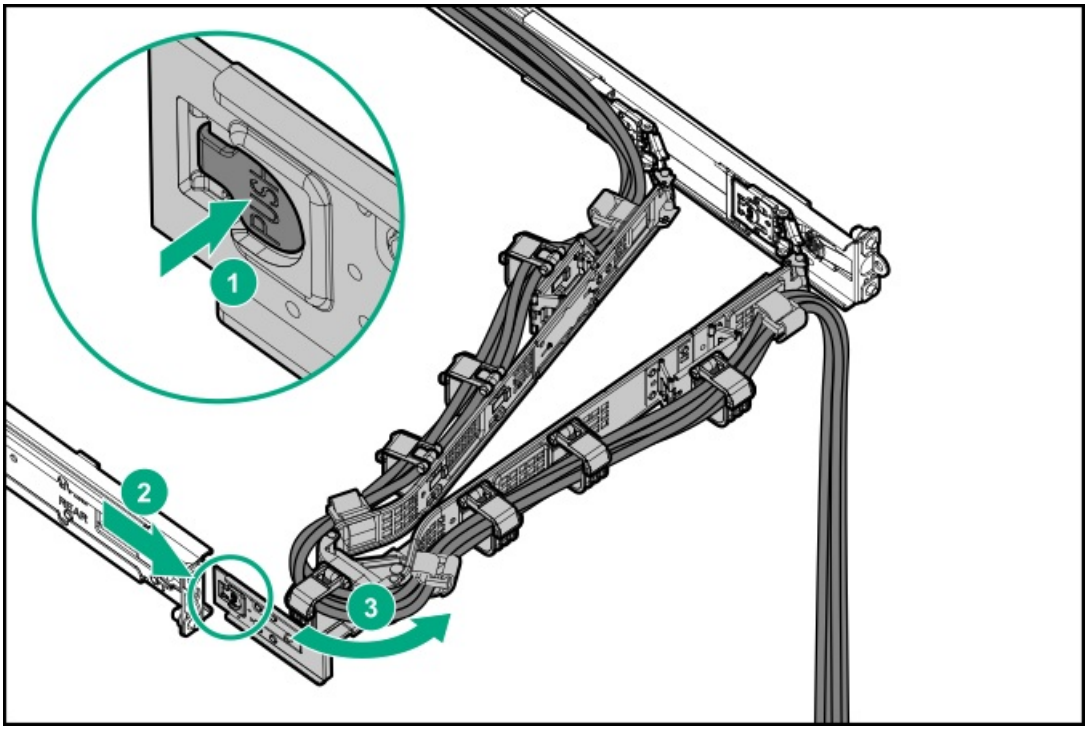


To replace the component, reverse the removal procedure.

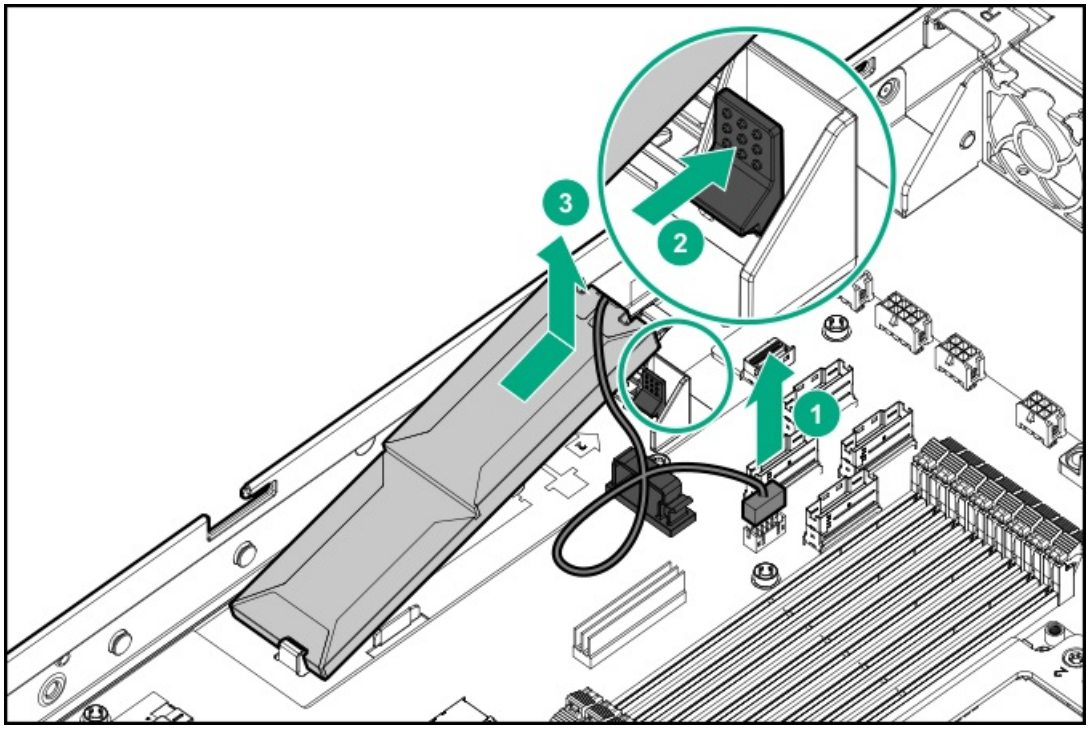
Removing and replacing the energy pack

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove the energy pack:
   a. Release the energy pack cable from the clip and disconnect the cable (callout 1).
   b. Press and hold the release latch (callout 2).
   c. Lift one end of the energy pack and release it from the holder (callout 3).

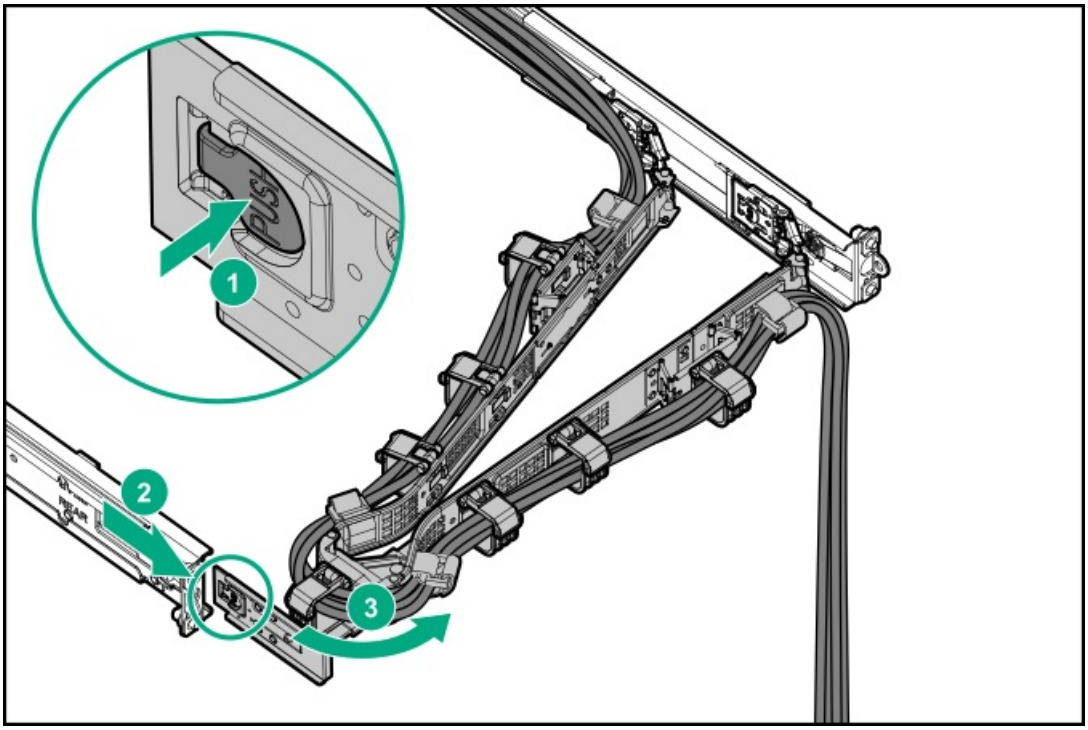


To replace the component, reverse the removal procedure.

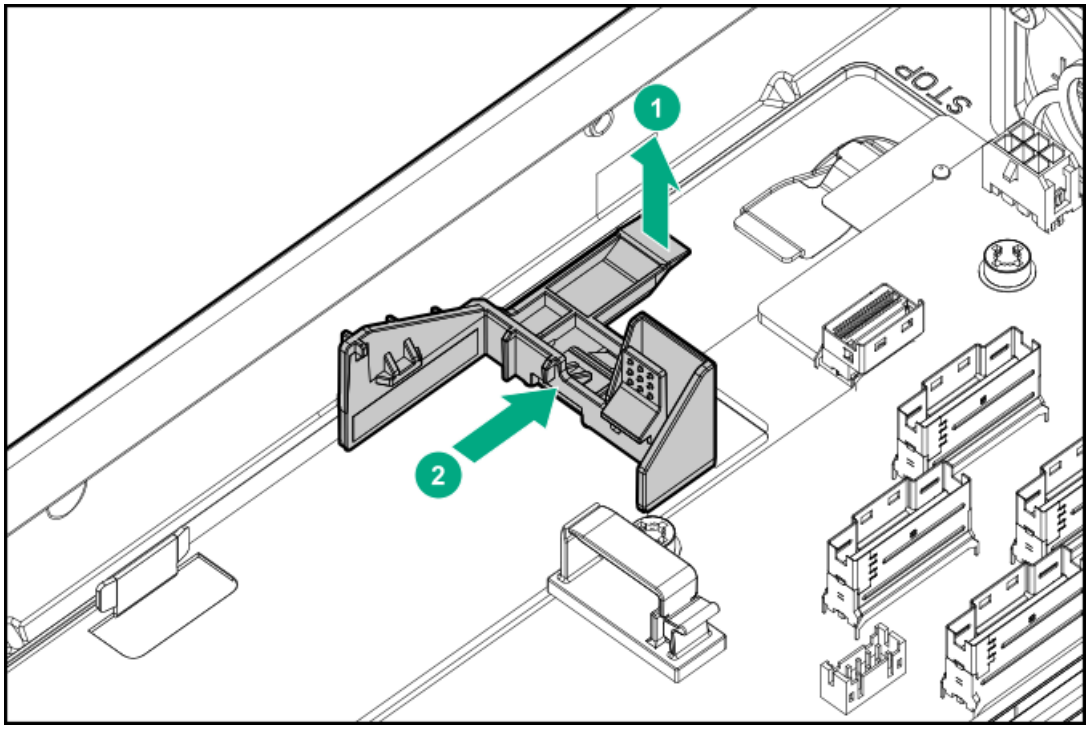
Removing and replacing the energy pack holder

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. If installed, remove the energy pack.
10. Remove the energy pack holder:
    a. Lift and hold the holder release latch (callout 1).
    b. Push the holder towards the front panel to disengage it from the chassis (callout 2).



To replace the component, reverse the removal procedure.

Removing and replacing the front I/O assembly

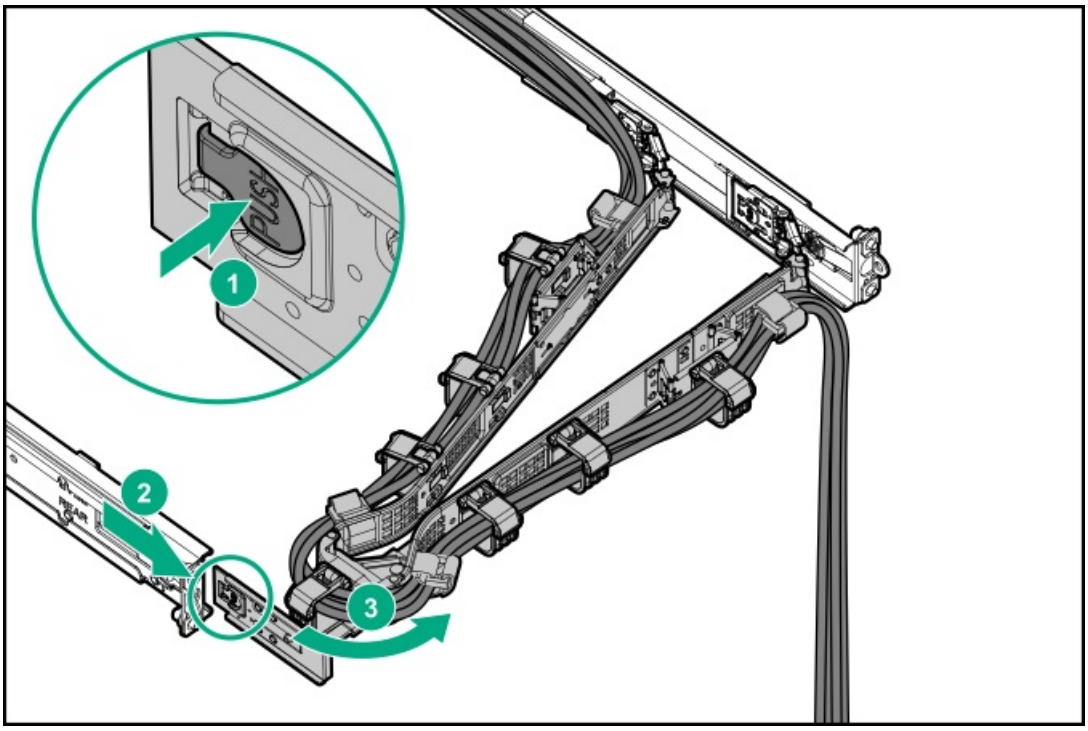
Prerequisites

Before you perform this procedure, make sure that you have the following items available:

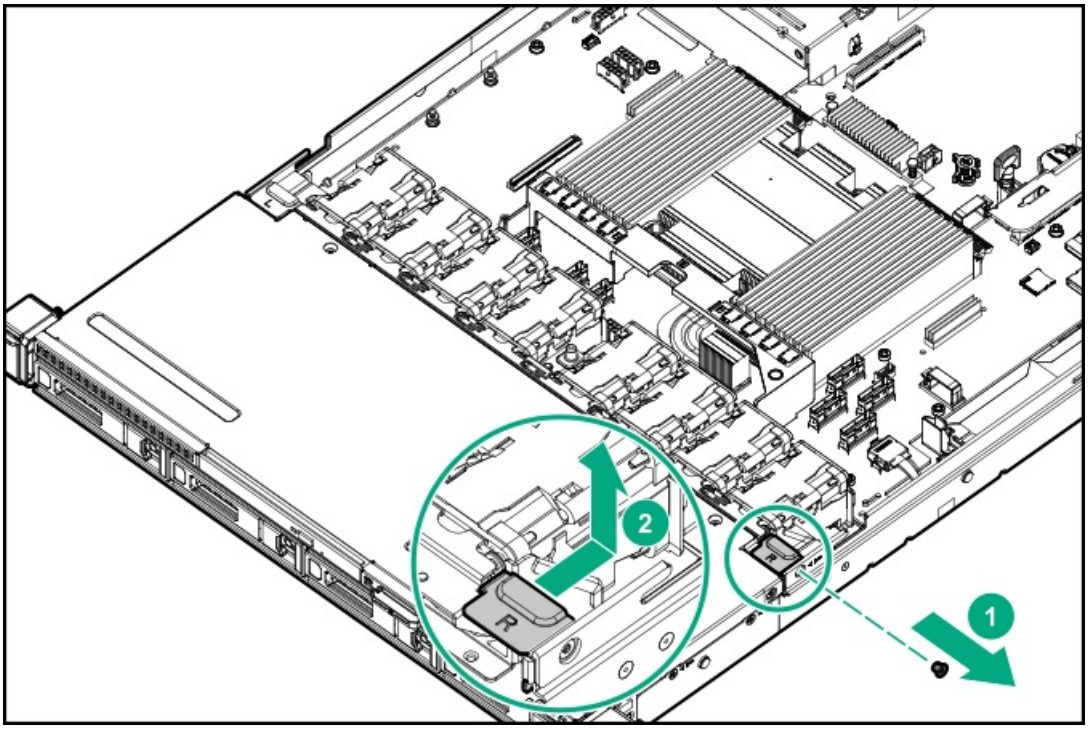
- T-10 Torx screwdriver
- T-15 Torx screwdriver

Procedure

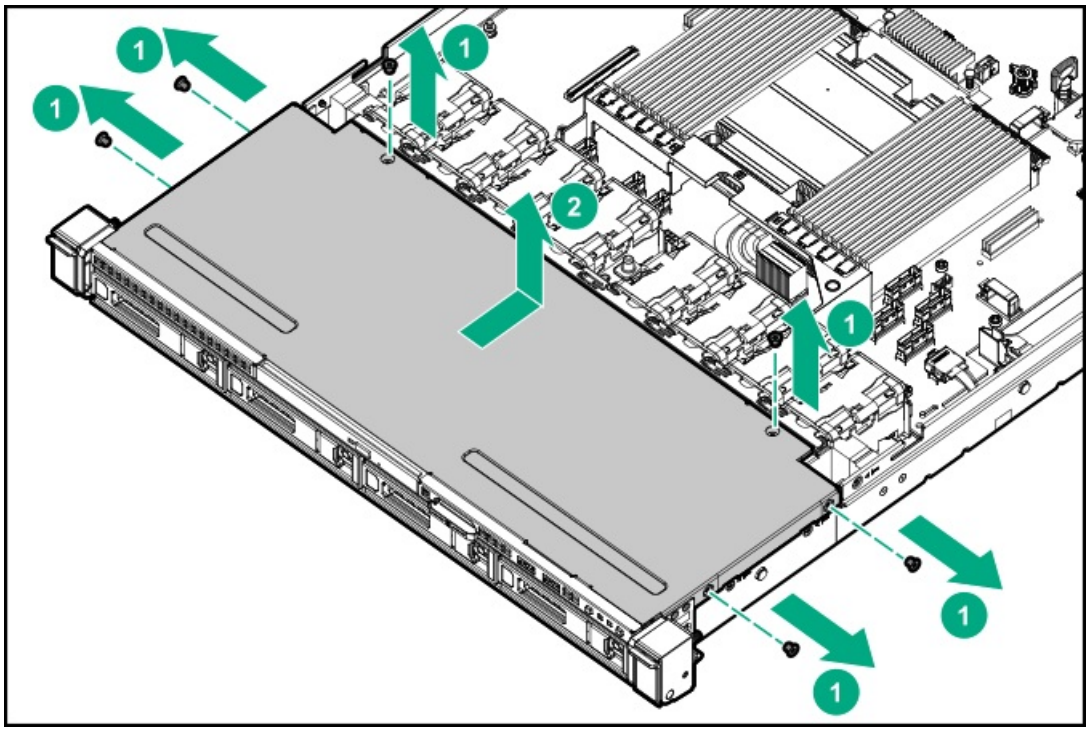
1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



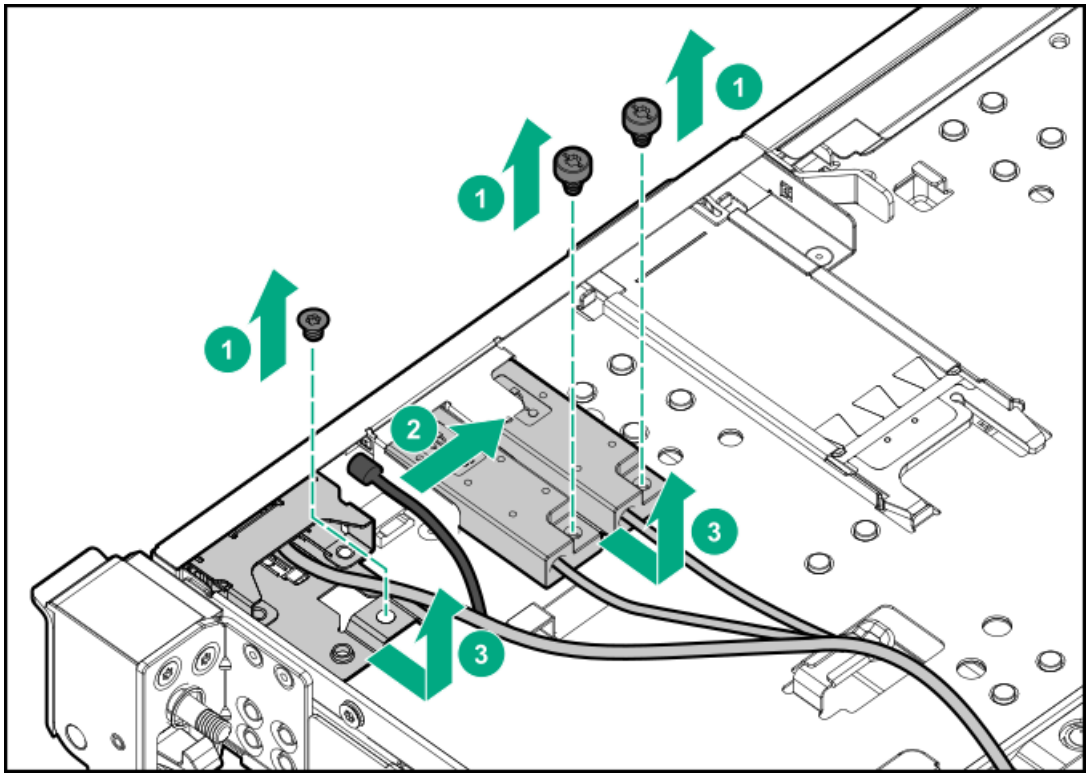
4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove the right fan wall bracket.



10. Release the front I/O cable from the right cable routing foam.
11. To remove the front I/O assembly from the LFF drive chassis, do the following:
    a. Remove the front drive cage cover.

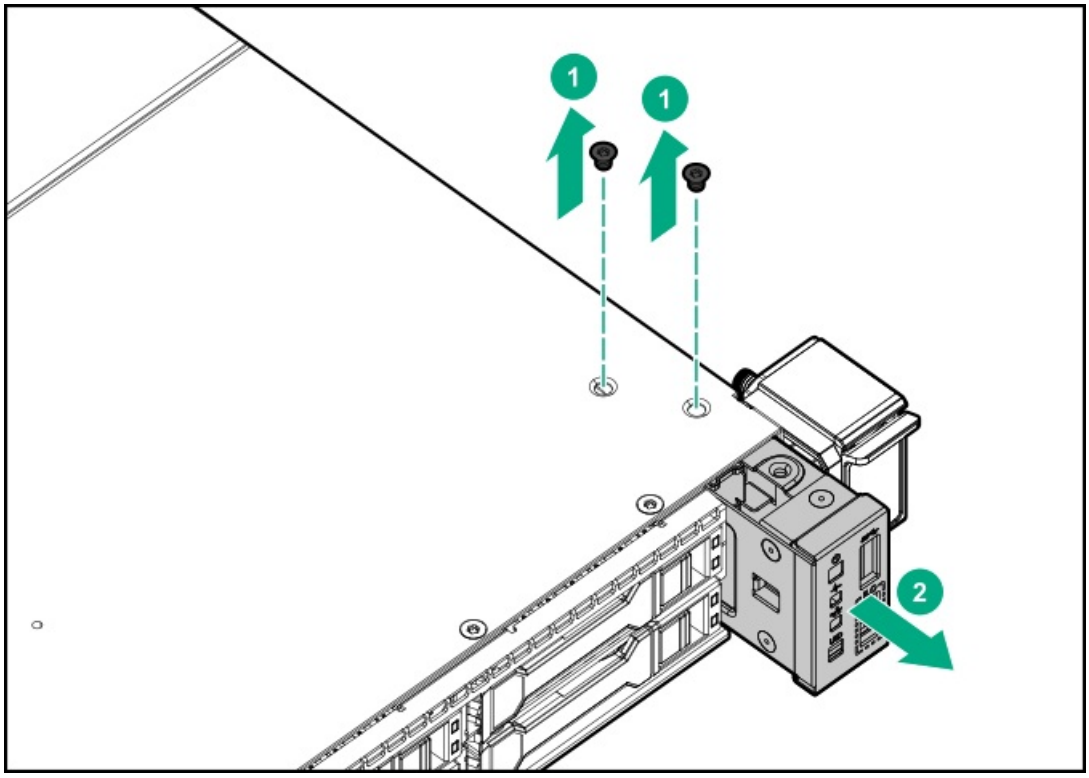


    b. Remove the front I/O assembly screws (callout 1).
    c. Detach the ambient temperature sensor cable (callout 2).
    d. Remove the front I/O assembly (callout 3).

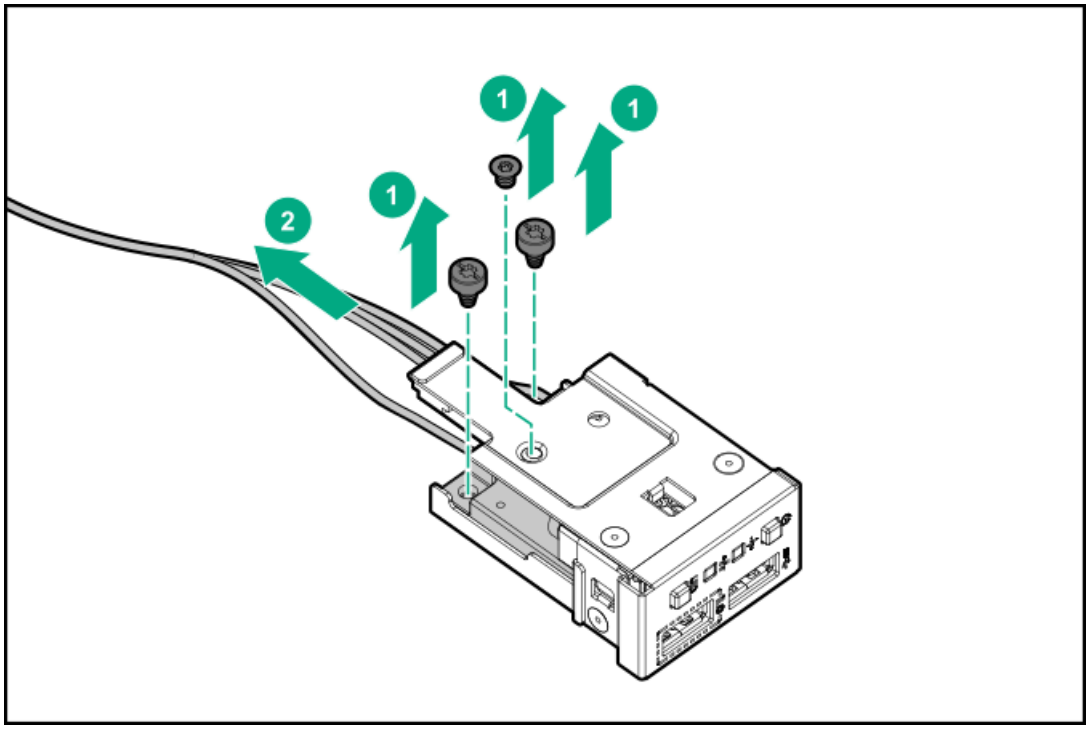


12. To remove the front I/O assembly from the SFF drive chassis, do the following:

    a. Remove the front I/O assembly.



    b. Remove the front I/O cables.

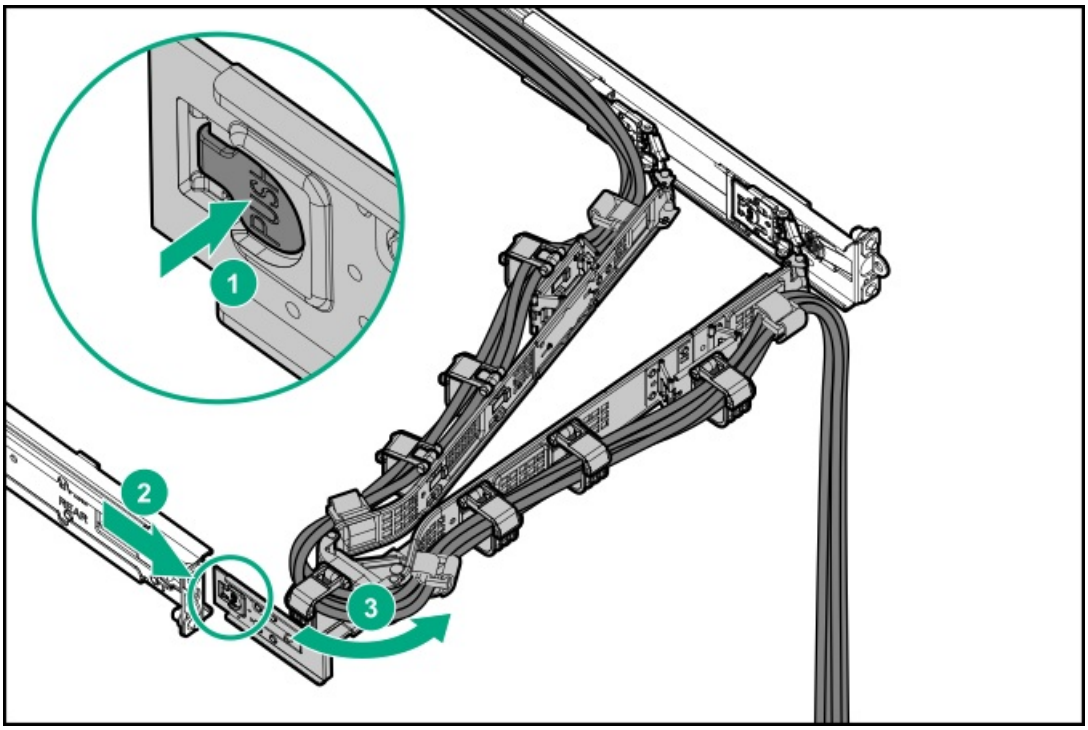


To replace the component, reverse the removal procedure.

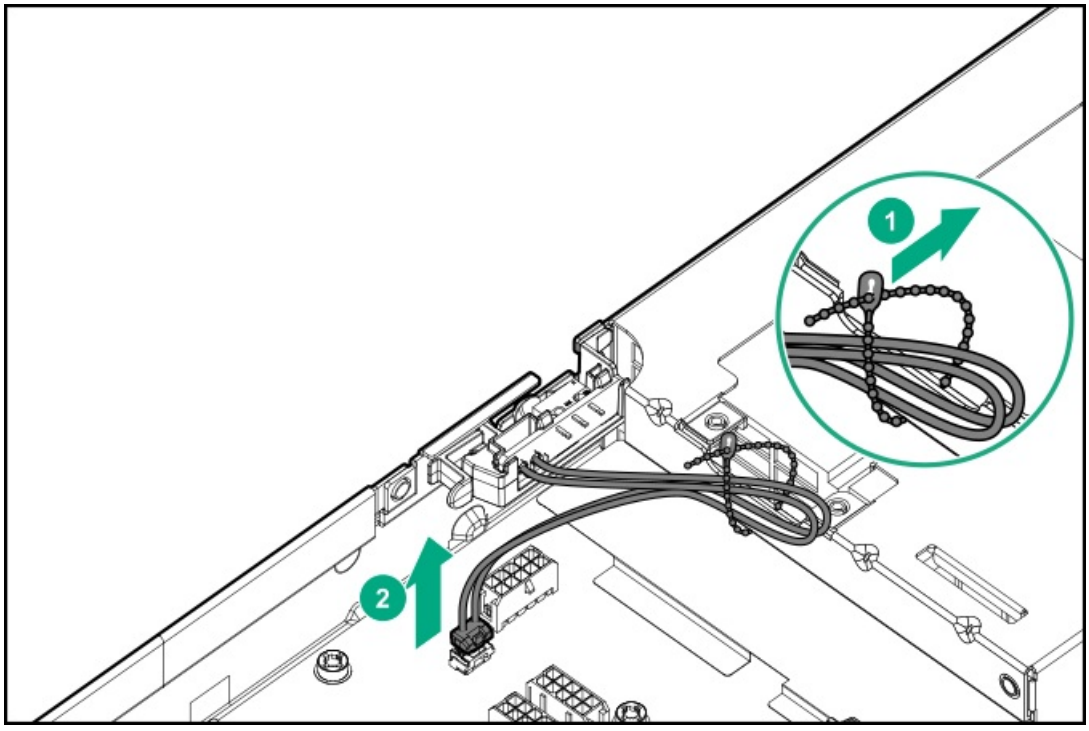
Removing and replacing the chassis intrusion detection switch

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.

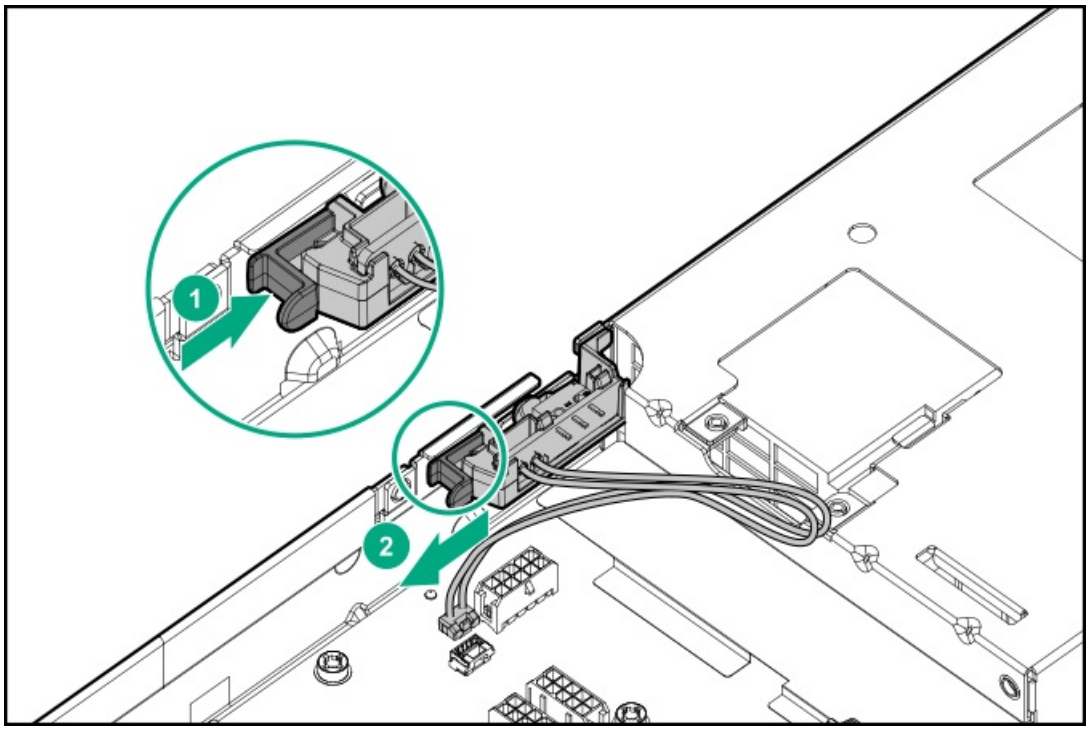


4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the chassis intrusion detection switch:
   a. Release the switch cable from the cable tie (callout 1).
   b. Disconnect the switch cable (callout 2).



c. Press and hold the holder release latch (callout 1).

d. Slide the holder towards the front panel to detach it from the chassis (callout 2).



To replace the component, reverse the removal procedure.

Removing and replacing the OCP NIC 3.0 adapter

CAUTION:

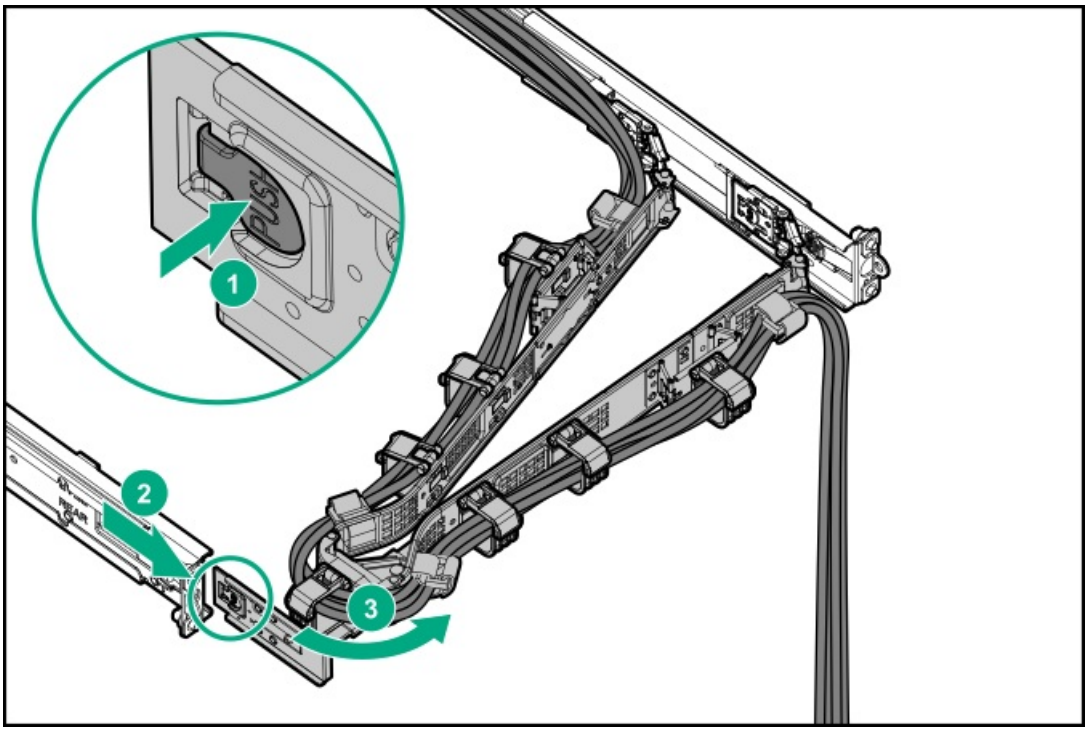
A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

CAUTION:

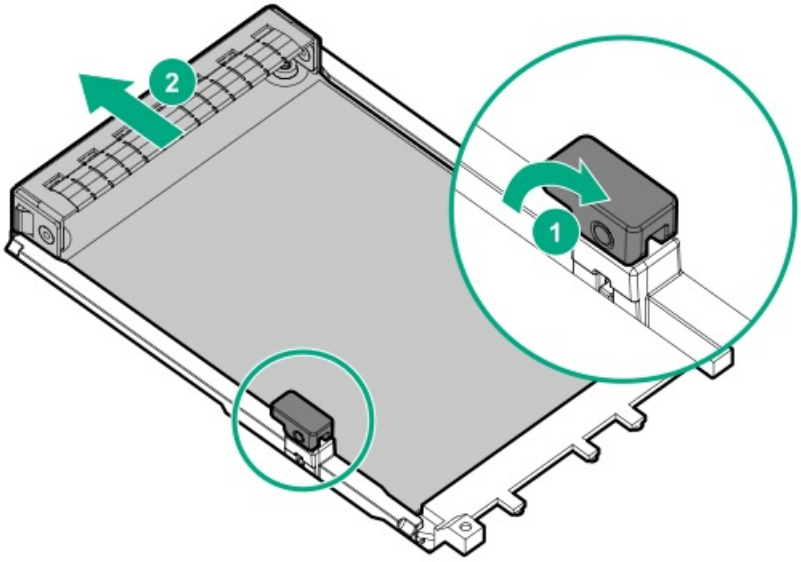
Before replacing a DIMM, expansion card, or other similar PCA components due to a perceived hardware error, make sure first that the component is firmly seated in the slot. Do not bend or flex circuit boards when reseating components.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove the primary riser cage.
10. Remove the OCP NIC 3.0 adapter:
    a. Rotate the locking pin to the open (vertical) position (callout 1).
    b. Pull the OCP 3.0 NIC adapter out of the bay (callout 2).



To replace the component, reverse the removal procedure.

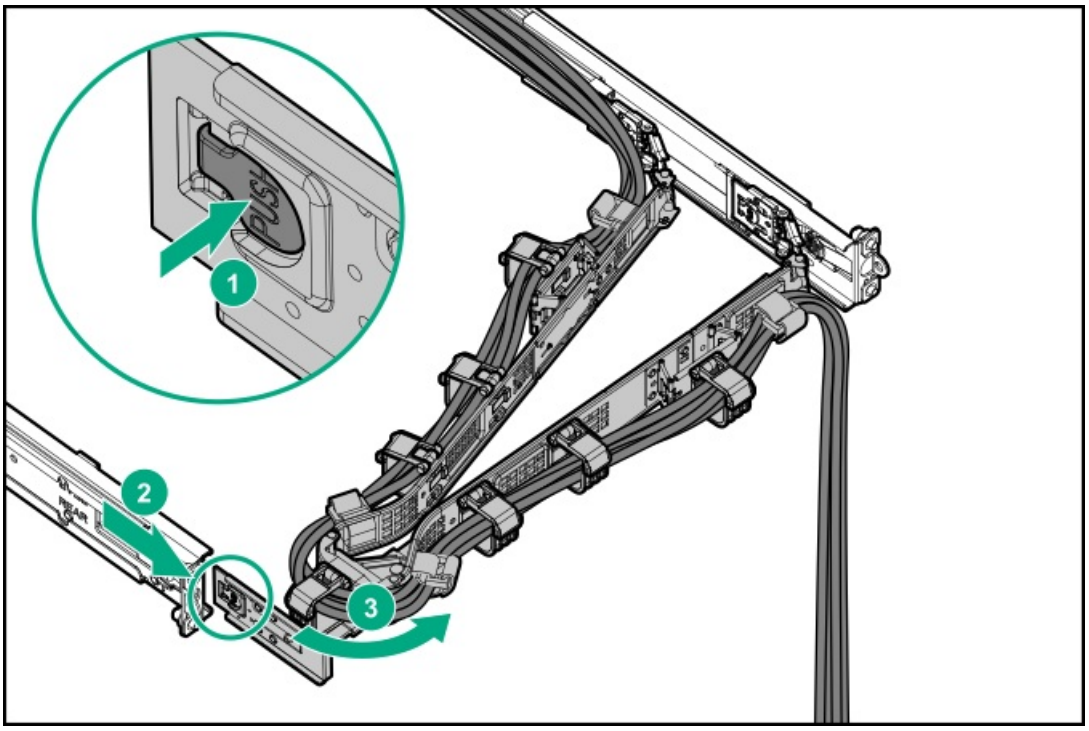
Removing and replacing the serial port cable

Prerequisites

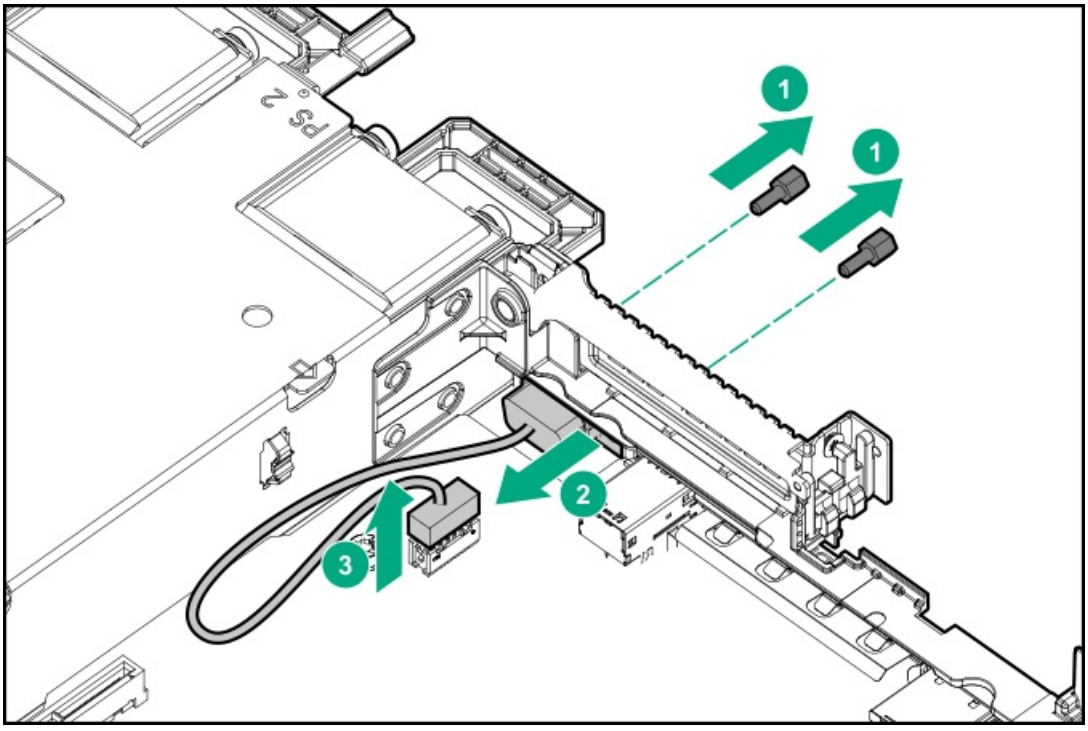
Before you perform this procedure, make sure that you have a hex screwdriver available.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. If installed, remove the expansion card from the secondary riser.
10. Remove the serial port cable.



To replace the component, reverse the removal procedure.

System battery replacement

If the server no longer automatically displays the correct date and time, then replace the battery that provides power to the real-time clock. Under normal use, battery life is 5–10 years.

System battery information

The server contains an internal lithium manganese dioxide, a vanadium pentoxide, or an alkaline battery that provides power to the real-time clock.

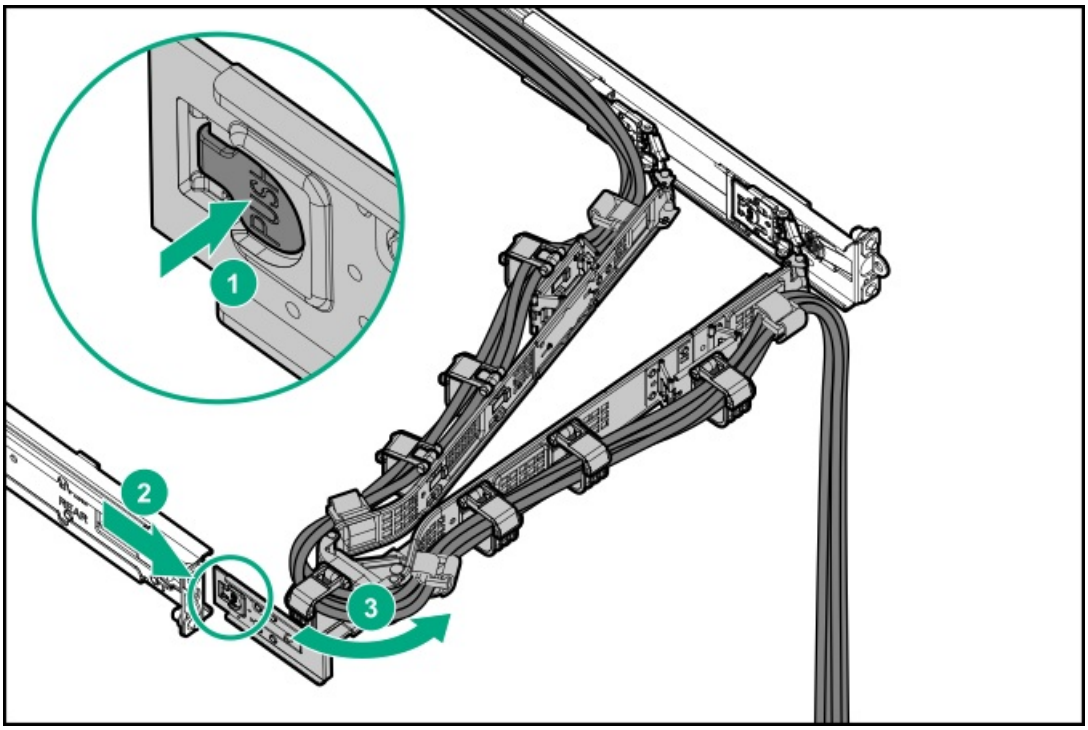
WARNING:
If this battery is not properly handled, a risk of the fire and burns exists. To reduce the risk of personal injury:

- Do not attempt to recharge the battery.
- Do not expose the battery to temperatures higher than 60°C (140°F).
- Do not expose the battery to extremely low air pressure as it might lead to explosion or leakage of flammable liquid or gas.
- Do not disassemble, crush, puncture, short external contacts, or dispose the battery in fire or water.

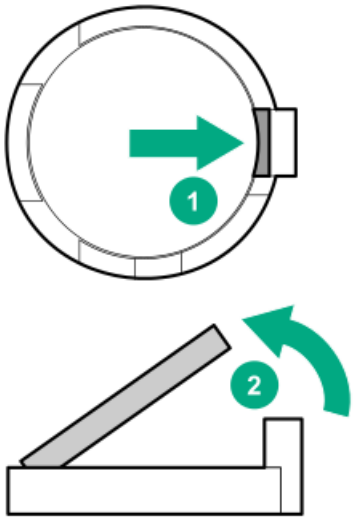
Removing and replacing the system battery

Procedure

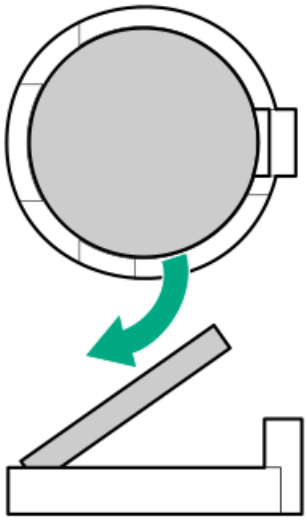
1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. If an expansion card is installed in the riser slot 2, remove the primary riser cage.
10. Locate the battery on the system board.
11. Remove the system battery.



12. Insert the battery with the "+" side facing up on the socket, and then press the battery down to secure it in place.



13. If removed, install the primary riser cage.
14. Install the access panel.
15. Install the server into the rack.
16. Connect all peripheral cables to the server.
17. Connect each power cord to the server.
18. Connect each power cord to the power source.
19. Power up the server.
20. If removed, install the front bezel.
21. Properly dispose of the old battery.

    For more information about battery replacement or proper disposal, contact an authorized reseller or support specialist.

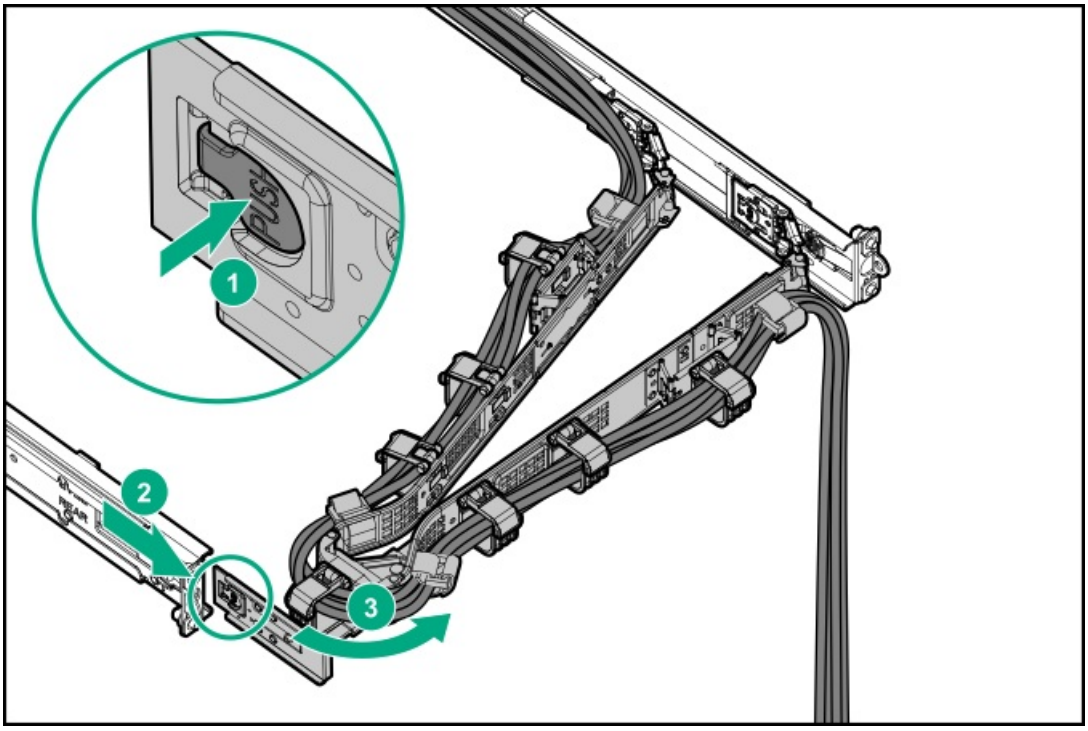
Removing and replacing the low-profile retainer bracket

Prerequisites

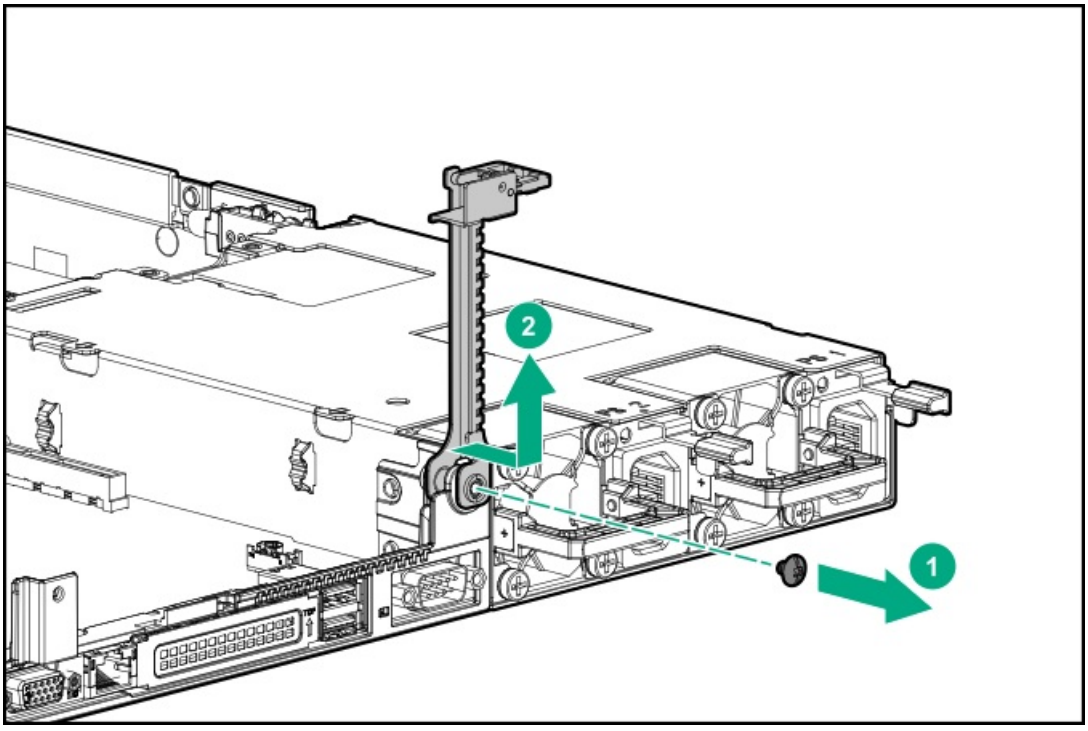
Before you perform this procedure, make sure that you have a T-15 Torx screwdriver available.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. If installed, remove the expansion card from the secondary riser.
10. Remove the low-profile retainer bracket.

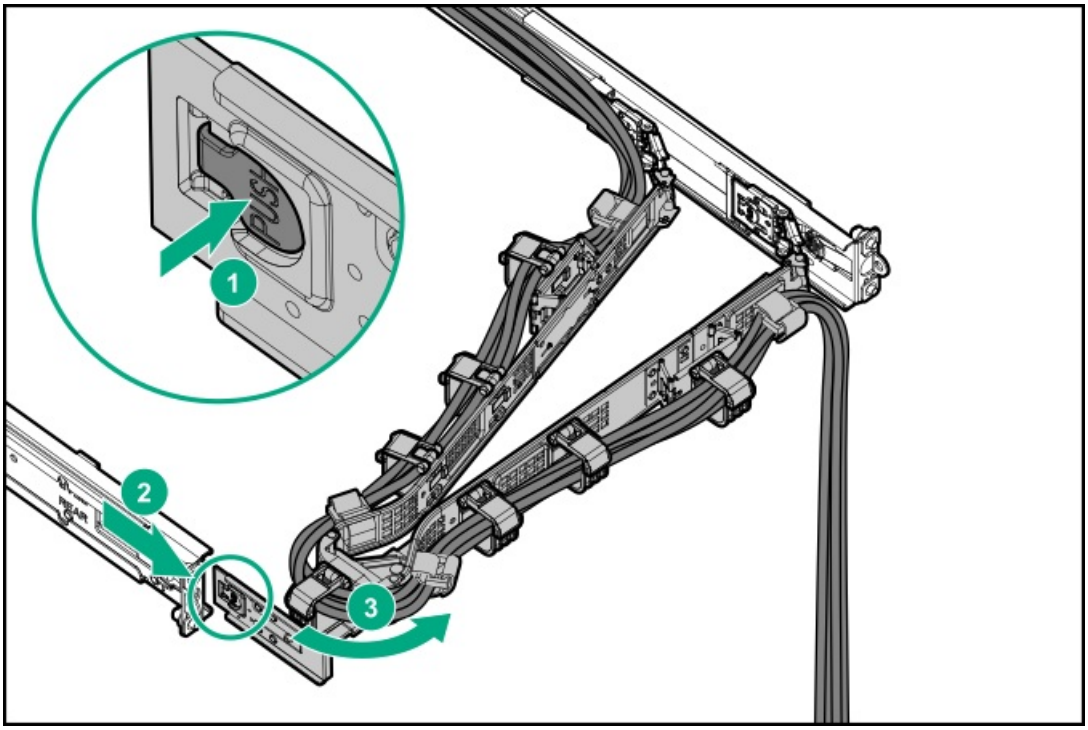


To replace the component, reverse the removal procedure.

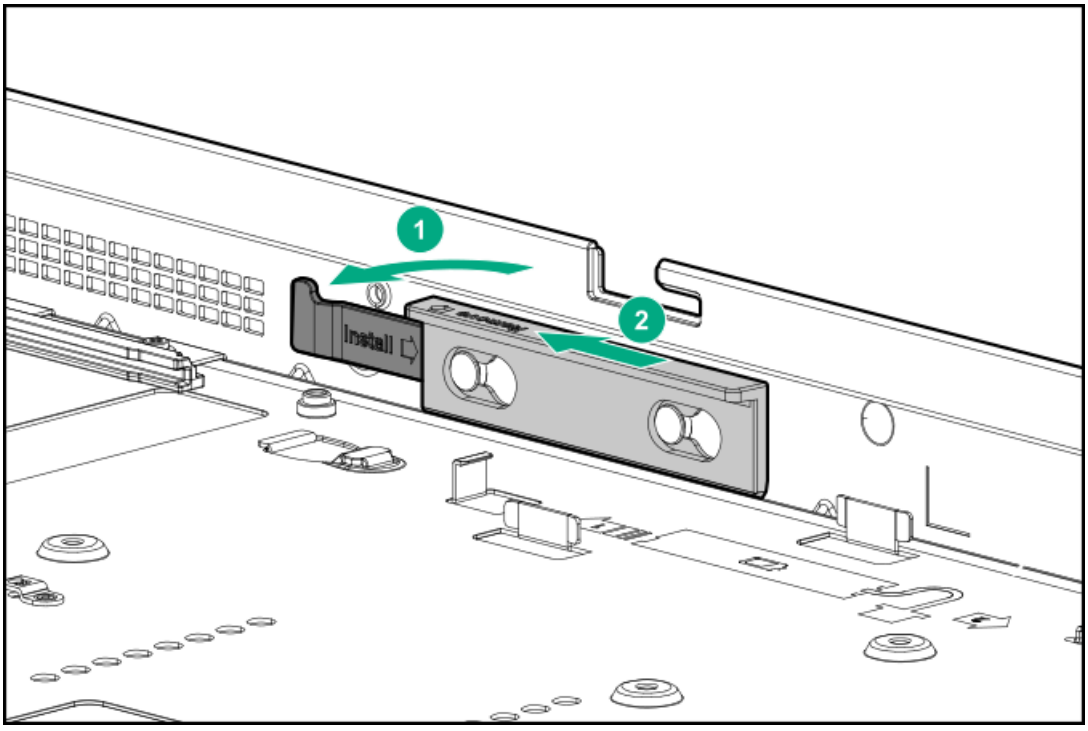
Removing and replacing the full-height card retainer

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. If the expansion card is installed in the primary riser slot 1, remove the primary riser cage.
10. Remove the full-height card retainer:
    a. Pull and hold the release latch (callout 1).
    b. Slide the retainer towards the rear panel to disengage it from the chassis (callout 2).



To replace the component, reverse the removal procedure.

Removing and replacing the OCP NIC adapter blank

CAUTION:

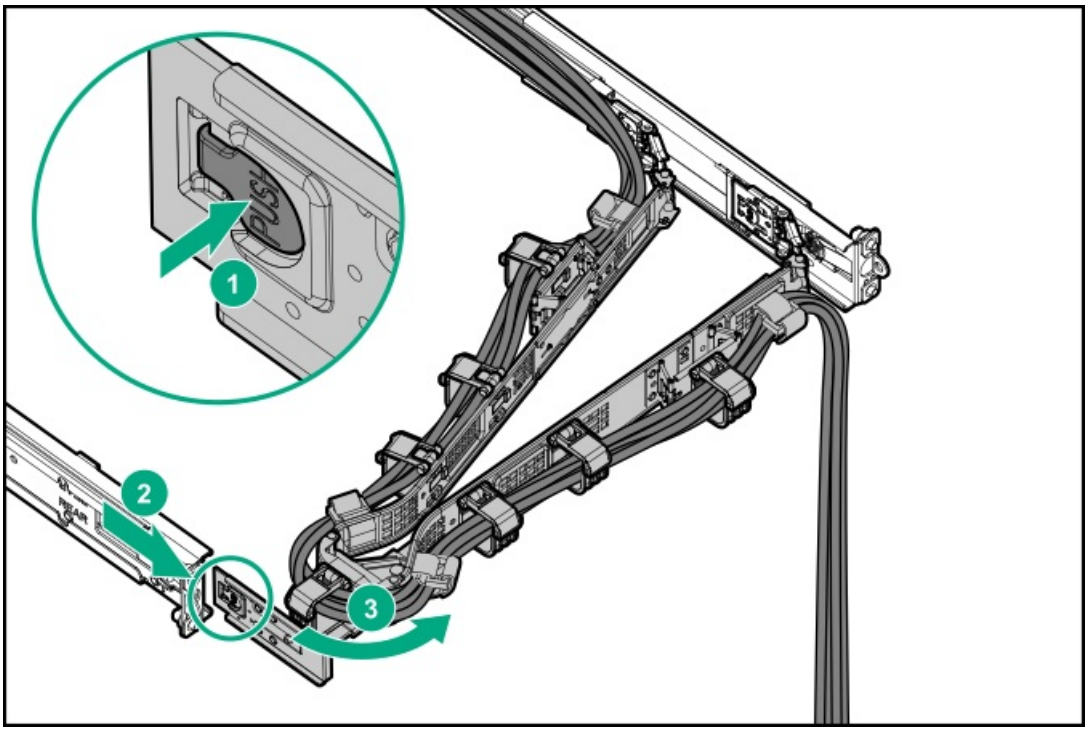
The port blank provides EMI shielding and helps maintain proper thermal status inside the server. Do not operate the server when a port blank is removed without the corresponding I/O port option installed.

Prerequisites

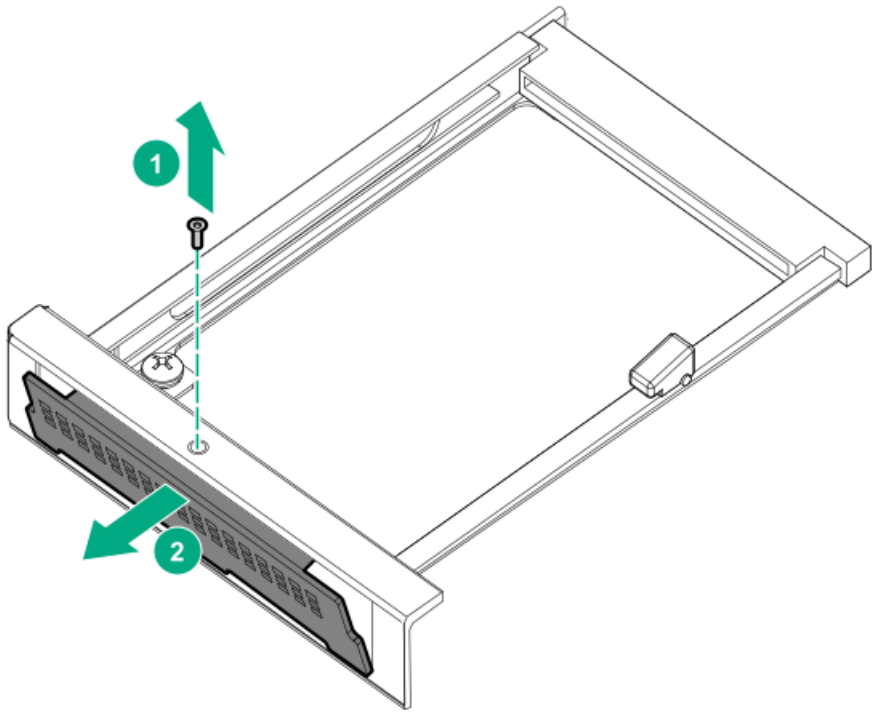
Before you perform this procedure, make sure that you have a Phillips No. 1 screwdriver available.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. Remove the primary riser cage.
10. Remove the OCP 3.0 NIC adapter blank.



To replace the component, reverse the removal procedure.

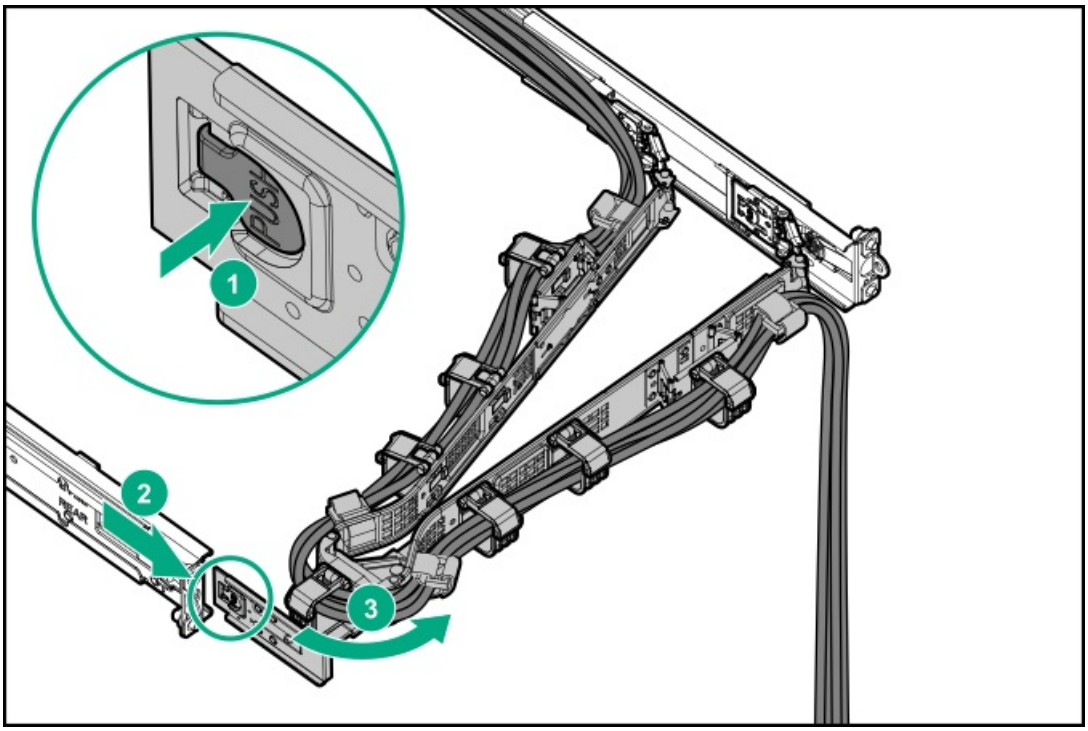
Removing and replacing the serial port blank

CAUTION:

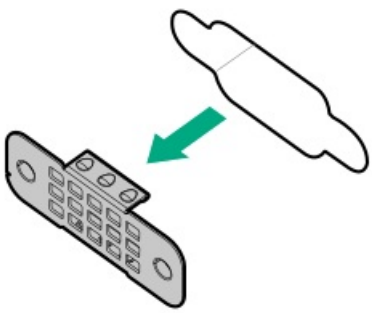
The port blank provides EMI shielding and helps maintain proper thermal status inside the server. Do not operate the server when a port blank is removed without the corresponding I/O port option installed.

Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.



4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove the access panel.
9. If installed, remove the expansion card from the secondary riser.
10. Remove the serial port blank.



To replace the component, reverse the removal procedure.

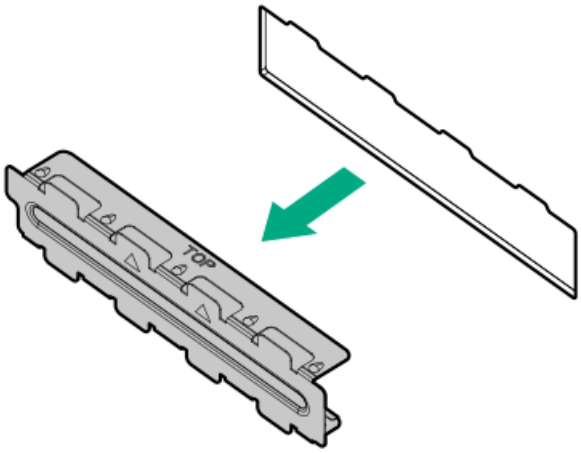
Removing and replacing the quad NIC port blank

CAUTION:

The port blank provides EMI shielding and helps maintain proper thermal status inside the server. Do not operate the server when a port blank is removed without the corresponding I/O port option installed.

Procedure

1. Remove the access panel.
2. Do one of the following:
   - If an expansion card is installed in the primary riser slot 2, remove the primary riser cage.
   - If an expansion card is installed in the secondary riser, remove the expansion card.
3. Remove the quad NIC port blank.



To replace the component, reverse the removal procedure.

System board assembly replacement

- Removing the system board
- Installing the system board
- Re-entering the server serial number and product ID

Removing the system board assembly

CAUTION:

A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

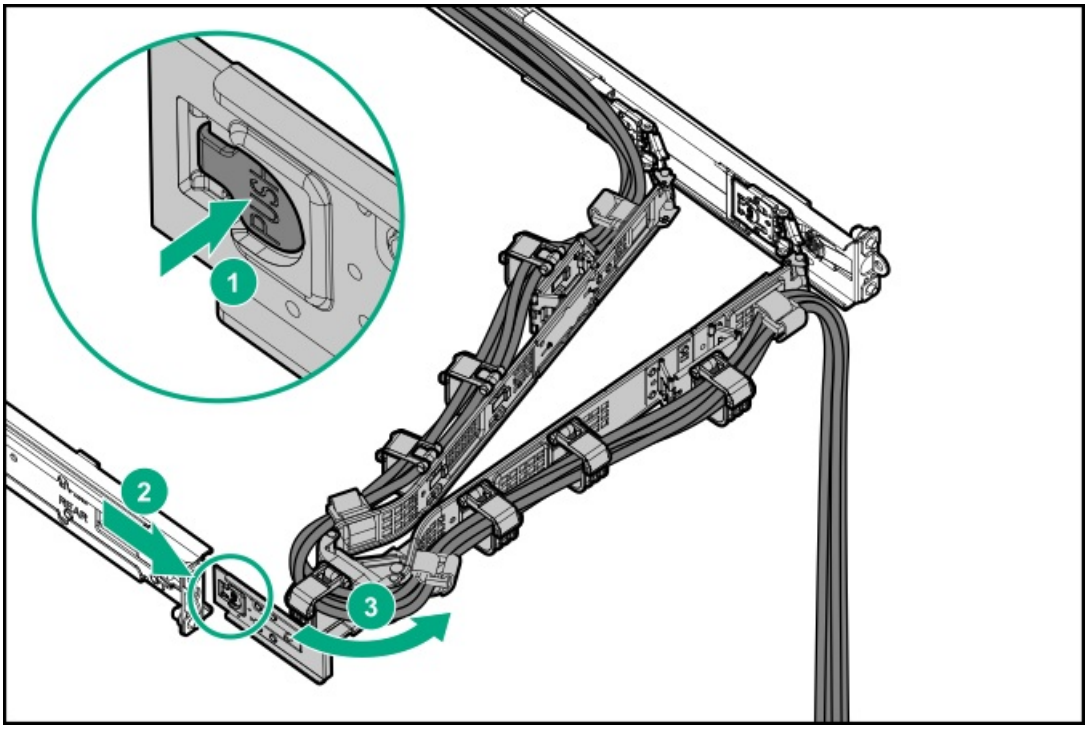
Prerequisites

Before you perform this procedure, make sure that you have the following items available:

- T-15 Torx screwdriver
- T-20 Torx screwdriver
- Hex screwdriver—This tool is required if the serial port cable is installed.
- Alcohol wipe
- System board handle (ships with the system board spare)

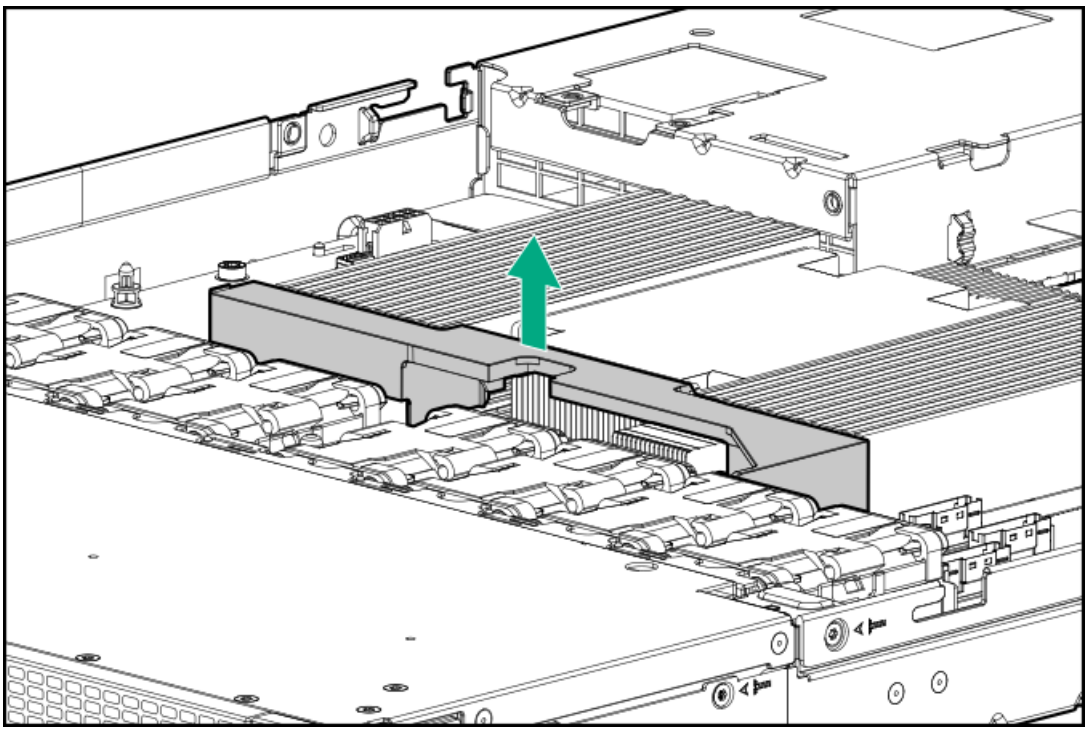
Procedure

1. If installed, remove the front bezel.
2. Power down the server.
3. If installed, release the cable management arm.

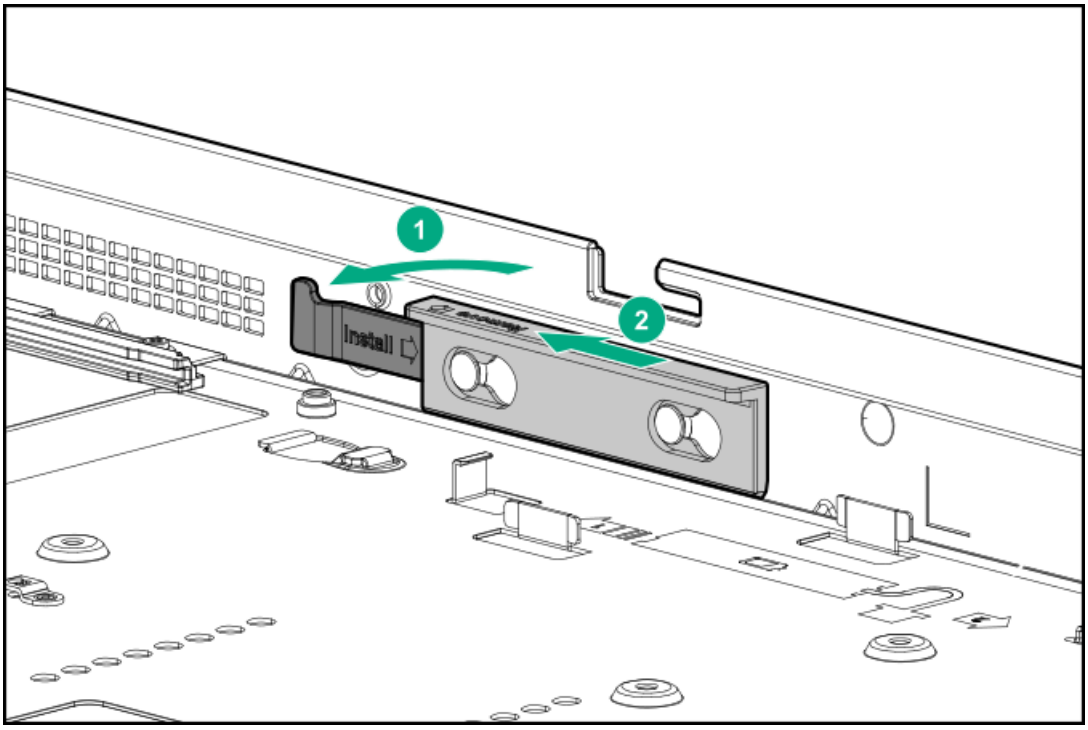


4. Remove all power:
   a. Disconnect each power cord from the power source.
   b. Disconnect each power cord from the server.
5. Disconnect all peripheral cables from the server.
6. Remove the server from the rack.
7. Place the server on a flat, level work surface.
8. Remove all power supplies.
9. Remove the access panel.

10. Remove the air baffle.



11. Disconnect all cables from the expansion cards, riser boards, and the system board.
12. Remove all fans.
13. Remove all DIMMs.
14. Remove all riser cages.
15. Remove the full-height card retainer.



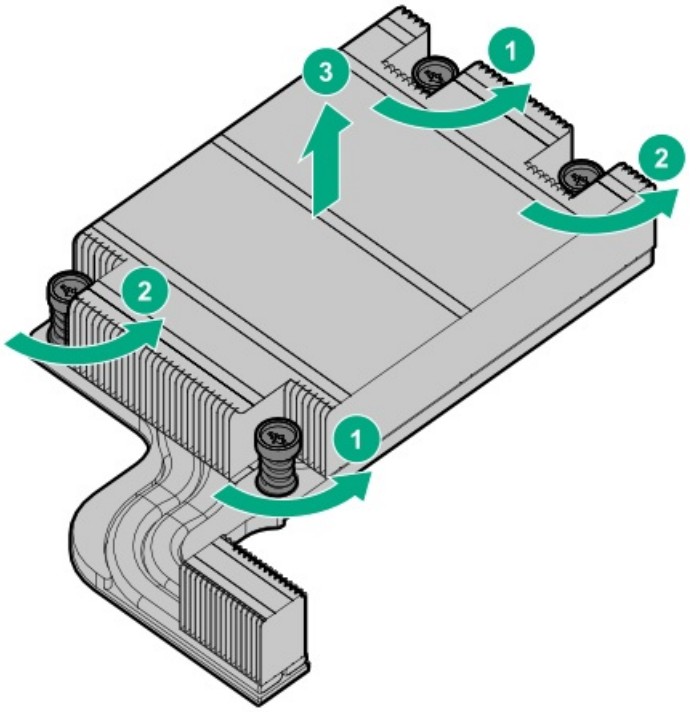
16. If installed, remove the following components:
    - Type-a storage controller
    - Chassis intrusion detection switch
    - Energy pack
    - OCP NIC 3.0 adapter

17. Allow the heatsink to cool.
18. Remove the heatsink:

> **CAUTION:**
>
> To prevent mechanical damage or depositing oil on your hands or other contaminant to the heatsink contact surface, hold the heatsink only by the edge of its base plate. Do not touch the heatsink fins.

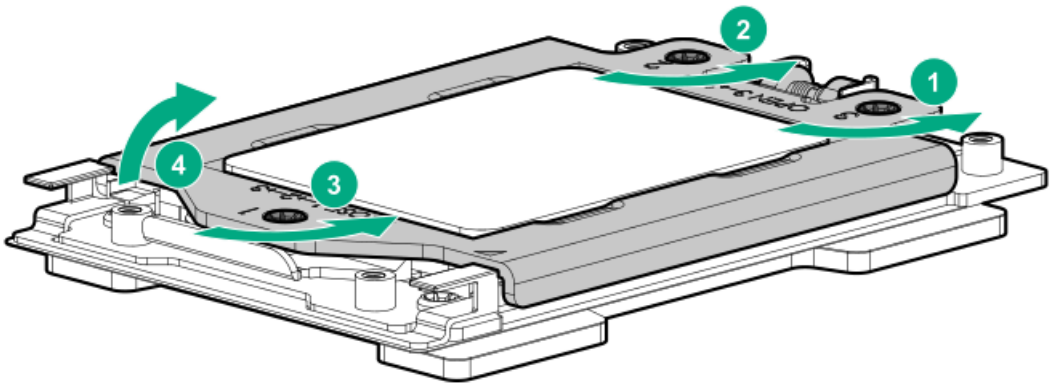
> **CAUTION:**
>
> Heatsink screws must be tightened and loosened in alternating sequence. Do not overtighten the screws as this might damage the system board or the processor socket.

a. Use a T-20 Torx screwdriver to loosen the captive screws in the sequence specified on the heatsink label.
b. Lift the heatsink away from the system board.



c. Place the heatsink on a flat work surface with its contact side facing up.
19. Use an alcohol wipe to remove the existing thermal grease from the heatsink and processor.

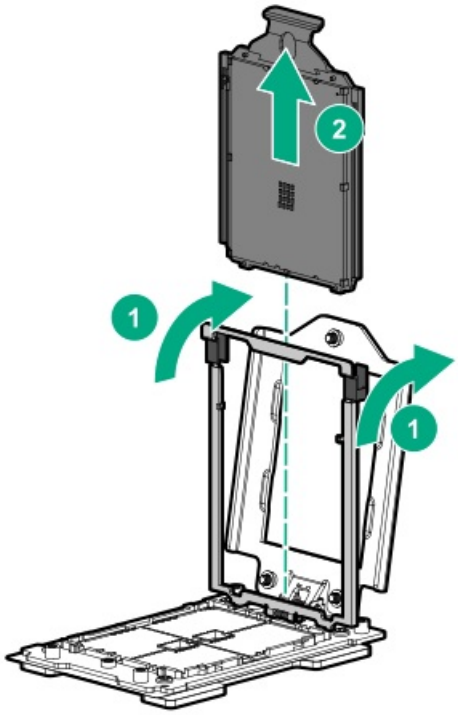
    Allow the alcohol to evaporate before continuing.
20. Use a T-20 Torx screwdriver to loosen the three captive screws in the sequence shown in the following image, and then pivot the force frame upward.



21. Remove the processor:

    a. Hold the lift tabs near the front end of the rail frame, and then pivot the rail frame to the vertical position.

    b. Slide the processor out of the rail frame.

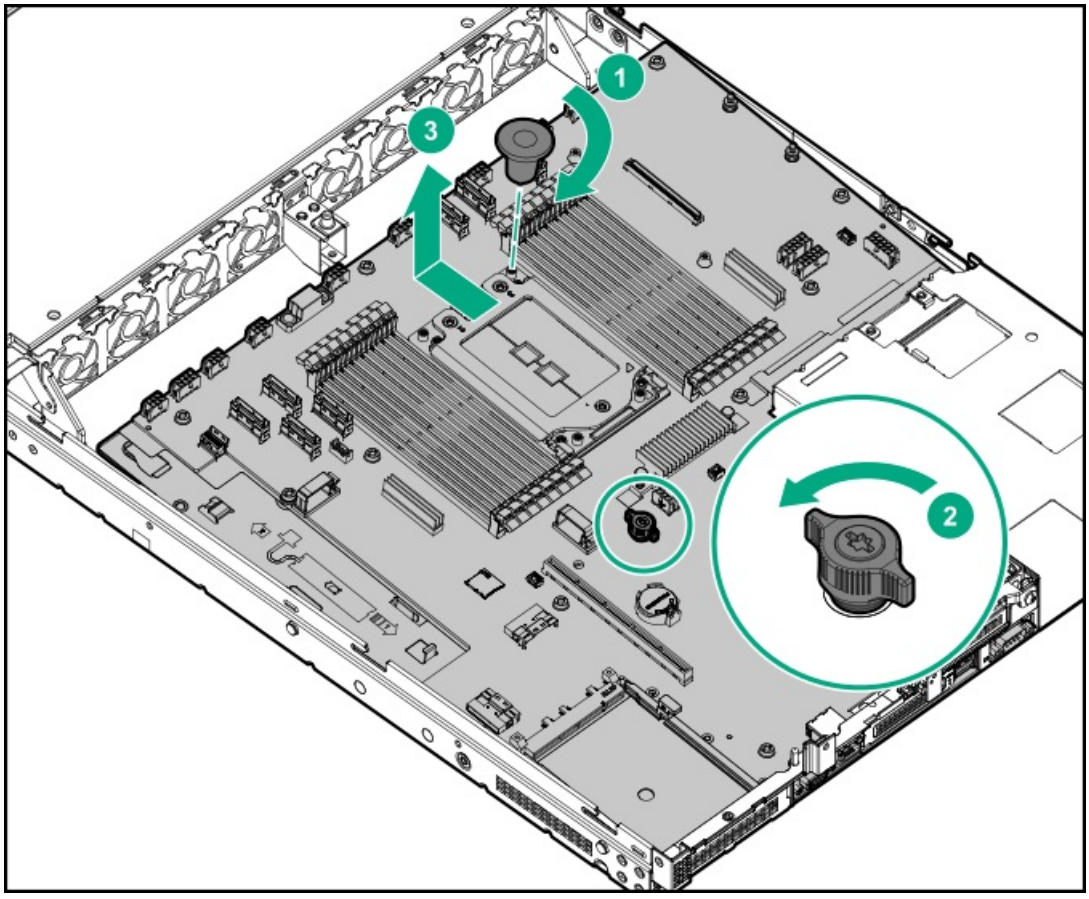


22. Remove the system board assembly:

    a. Install the system board handle (callout 1).

    b. Loosen the system board thumbscrew (callout 2).

    c. Use the system board handle and thumbscrew to lift the system board (callout 3).



23. Remove the system board handle.

Installing the system board assembly

CAUTION:

A discharge of static electricity from a finger or other conductor might damage system boards or other static-sensitive devices. To prevent damage, observe antistatic precautions.

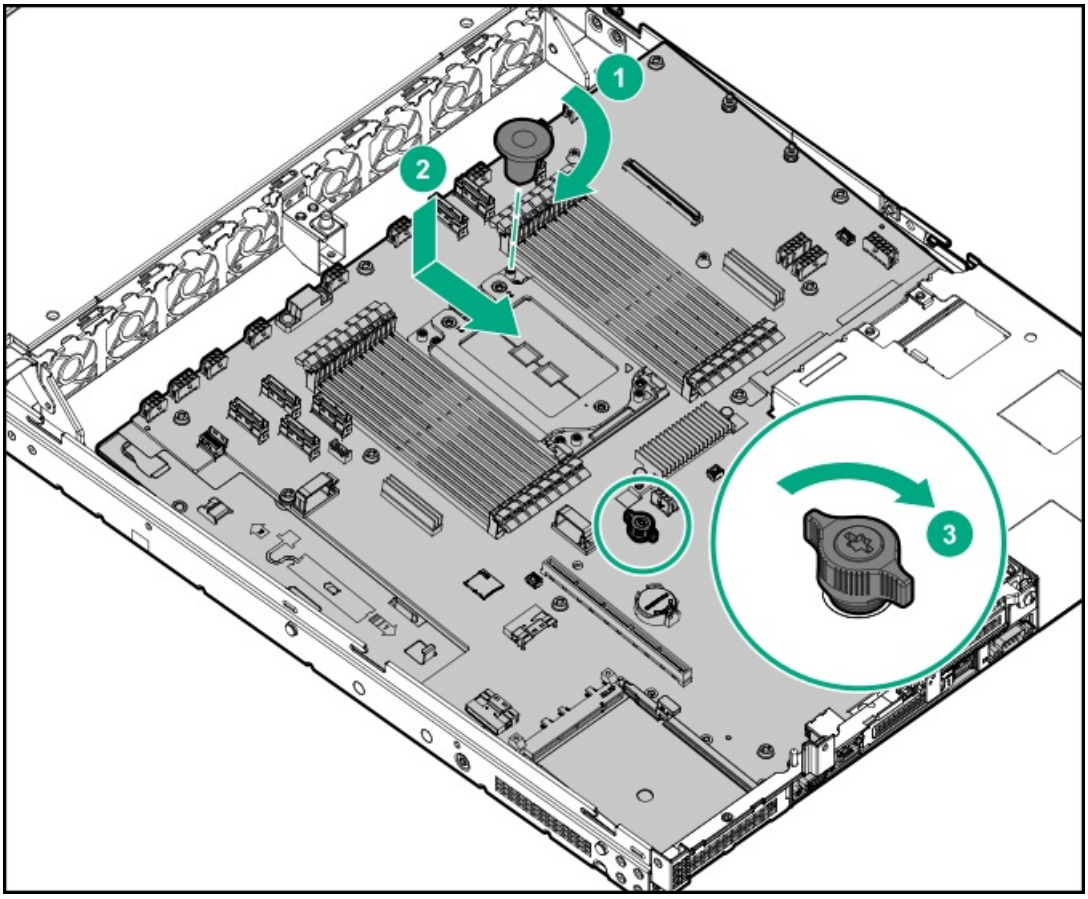
Prerequisites

Before you perform this procedure, make sure that you have the following items available:

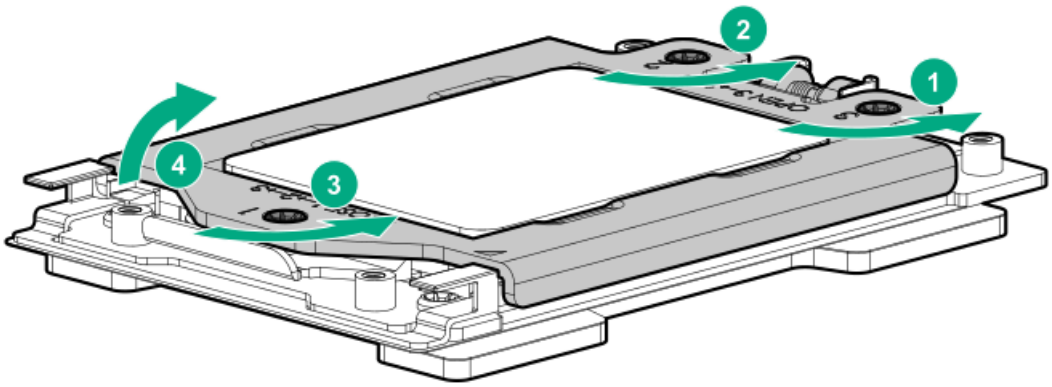
- T-15 Torx screwdriver
- T-20 Torx screwdriver
- Hex screwdriver—This tool is required if the serial port cable is to be installed.
- Thermal grease (spare part number: 777298-001)
- System board handle (ships with the system board spare)

Procedure

1. Install the new system board assembly:
   a. Install the system board handle (callout 1).
   b. Use the system board handle and thumbscrew to position the system board on the chassis (callout 2).
   c. Tighten the thumbscrew (callout 3).

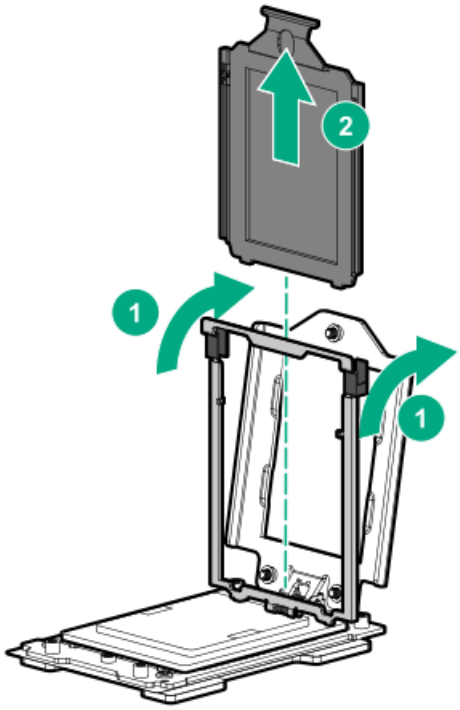


2. Remove the system board handle.
3. Use a T-20 Torx screwdriver to loosen the three captive screws in the sequence shown in the following image, and then pivot the force frame upward.



4. Remove the external cap:
   a. Hold the lift tabs near the front end of the rail frame, and then pivot the rail frame to the vertical position.
   b. Slide the external cap out of the rail frame.

      Retain the external cap for future use.



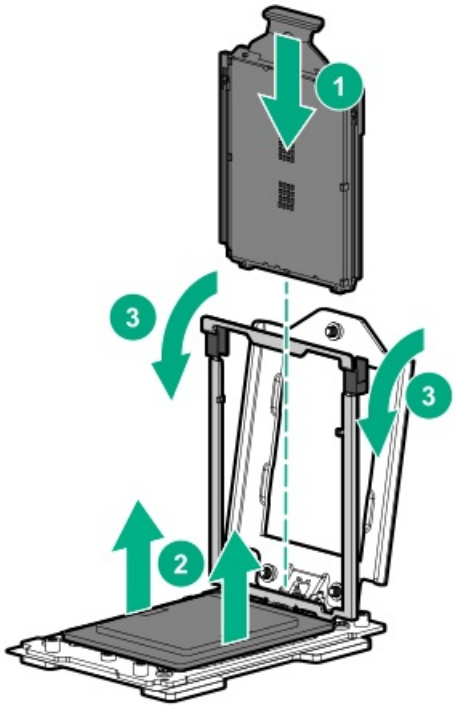
5. Install the processor:
   a. Hold the processor by its carrier handle and slide the processor into the rail frame until it engages with a click sound.
   b. Remove the pin field cover cap.

      CAUTION:

      To prevent the risk of damaging the pins in the processor socket, do not reinstall the pin field cover cap after removing it.

   c. Hold the lift tabs near the front end of the rail frame, and then pivot the rail frame to the closed position.

      A click sound indicates that the rail frame is properly engaged.



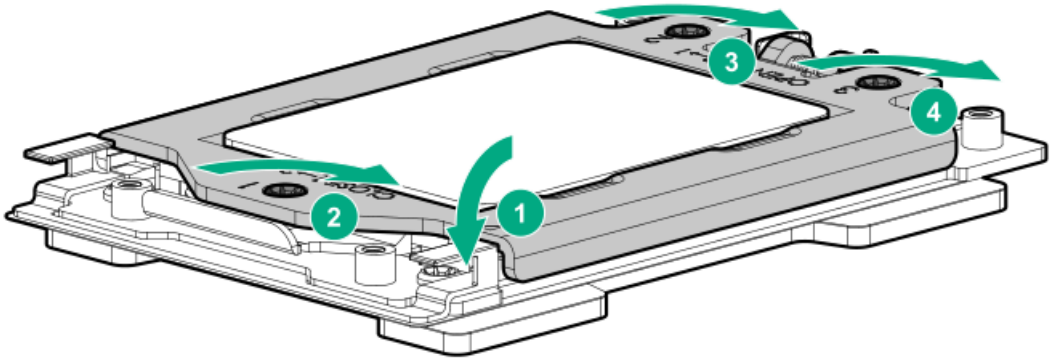
6. Close the force frame:

> **CAUTION:**
>
> Do not overtighten the screws as this might damage the system board or the processor socket.

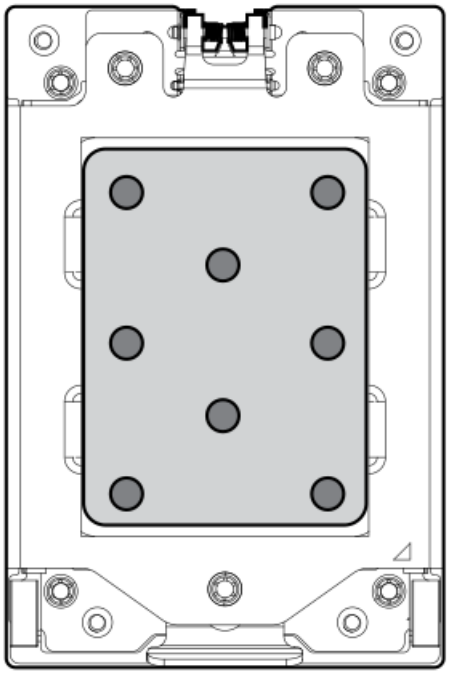
   a. Pivot the spring loaded force frame downward and hold it down (callout 1).

   b. Use a T-20 Torx screwdriver to tighten the captive screws in the sequence shown in the following image (callouts 2–4).

      When using a torque wrench to tighten the screws, apply a torque of 1.58 N·m (14 lbf-in).



7. Apply new thermal grease to the processor in the pattern shown in the following image. Use the full contents of the thermal grease syringe.



8. Install the heatsink:

> **CAUTION:**
>
> To prevent mechanical damage or depositing oil on your hands or other contaminant to the heatsink contact surface, hold the heatsink only by the edge of its base plate. Do not touch the heatsink fins.

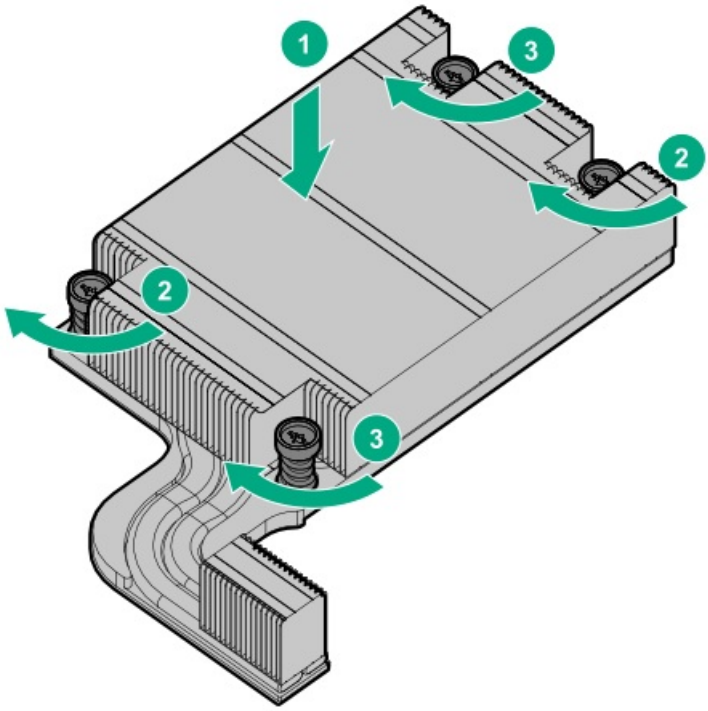
> **CAUTION:**
>
> To prevent thermal failure or component damage, do not move the heatsink once the bottom of its base plate touches the top of the processor. Excessive heatsink movement can cause the thermal grease to smear and become uneven. Voids in the compound can adversely impact the transfer of heat away from the processor.

> **CAUTION:**
>
> Heatsink screws must be tightened and loosened in alternating sequence. Do not overtighten the screws as this might damage the system board or the processor socket.

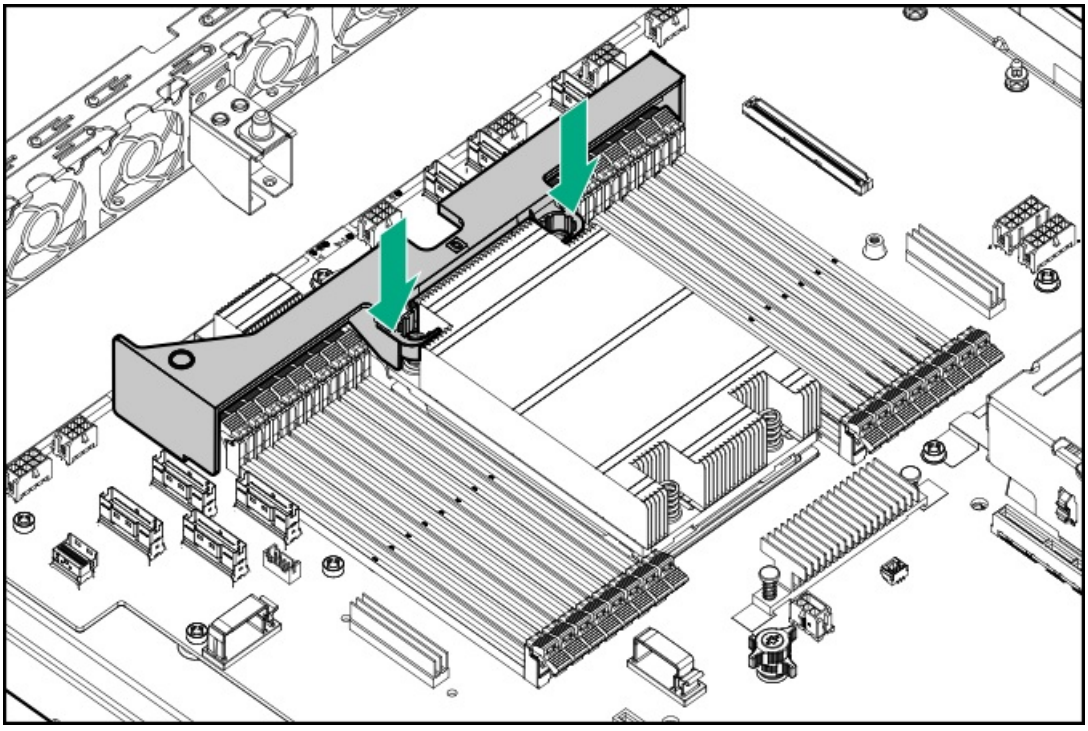
a. Position the heatsink on top of the processor, ensuring that it is properly seated before securing the screws.

b. Use a T-20 Torx screwdriver to tighten the captive screws in the sequence specified on the heatsink label.

   When using a torque wrench to tighten the screws, apply a torque of 1.58 N-m (14 lbf-in).



9. Install all removed components on the new system board.
10. Secure the air baffle hooks to the heatsink screws.



11. Install the access panel.
12. Install the server into the rack.
13. Install all power supplies.
14. Connect all peripheral cables to the server.
15. Connect each power cord to the server.
16. Connect each power cord to the power source.
17. Power up the server.
18. If removed, install the front bezel.
19. Make sure all firmware, including option cards and embedded devices, is updated to the same versions to ensure that the latest

drivers are being used.

20. Re-enter any Secure Boot keys that were previously added in the Secure Boot configuration.
21. Re-enter the server serial number and product ID, and configure the date and time settings .

Re-entering the server serial number and product ID

After replacing the system board, re-enter the system serial number and product ID, and configure the date and time settings.

Procedure

1. Access the UEFI System Utilities. During POST, press **F9**.
2. From the System Utilities screen, select System Configuration > BIOS/Platform Configuration (RBSU) > Advanced Options > Advanced Service Options.
3. Select Serial Number, and then press **Enter**.

   The following warning appears:

   `The serial number is modified by qualified service personnel and must match the serial number located on the chassis.`
4. Click OK.
5. Type the serial number, and then press **Enter**.
6. Select Product ID, and then press **Enter**.

   The following warning appears:

   `Product ID is modified only by qualified service personnel. This value must match the product ID located on the chassis.`
7. Type the product ID, and then press **Enter**.
8. From the System Utilities screen, select System Configuration > BIOS/Platform Configuration (RBSU) > Date and Time.
9. Configure the date and time settings:
   - Date (mm-dd-yyyy)—Enter the date in a month-day-year (mm-dd-yyyy) format.
   - Time (hh:mm:ss)—Enter the time in a 24-hour format (hh:mm:ss) format.
   - Hour Format—Select either a 12- or 24-hours format. (This menu is supported in Gen10 Plus and later servers.)
   - Time Format
     - Coordinated Universal Time (UTC) —Calculates the time stored in the hardware real-time clock (RTC) from the associated Time Zone setting.
     - Local Time—Removes the use of the Time Zone setting. This option is useful for addressing interaction issues in Windows operating systems set in legacy BIOS boot mode.
     - Time Zone—Select the time zone for the system.
     - Daylight Savings Time—Select whether to enable DST in the system time setting.
10. To confirm and save the settings, press **F12**.

    The server automatically reboots.

The installation is complete.

HPE Trusted Platform Module 2.0 Gen10 Plus option

The HPE Trusted Platform Module 2.0 Gen10 Plus option is not a customer-removable part.

> ⚠ **CAUTION:** If the TPM is removed from the original server and powered up on a different server, data stored in the TPM including keys will be erased.

If you suspect a TPM board failure, leave the TPM installed and remove the system board (removing the system board assembly). Contact a Hewlett Packard Enterprise authorized service provider for a replacement system board and TPM module.

Troubleshooting

- NMI functionality
- Troubleshooting resources

NMI functionality

An NMI crash dump enables administrators to create crash dump files when a system is hung and not responding to traditional debugging methods.

An analysis of the crash dump log is an essential part of diagnosing reliability problems, such as hanging operating systems, device drivers, and applications. Many crashes freeze a system, and the only available action for administrators is to cycle the system power. Resetting the system erases any information that could support problem analysis, but the NMI feature preserves that information by performing a memory dump before a hard reset.

To force the OS to initiate the NMI handler and generate a crash dump log, the administrator can use the iLO Generate NMI feature.

Troubleshooting resources

Troubleshooting resources are available for HPE Gen10 and Gen10 Plus server products in the following documents:

- Troubleshooting Guide for HPE ProLiant Gen10 and Gen10 Plus servers provides procedures for resolving common problems and comprehensive courses of action for fault isolation and identification, issue resolution, and software maintenance.
- Error Message Guide for HPE ProLiant Gen10 servers and HPE Synergy provides a list of error messages and information to assist with interpreting and resolving error messages.
- Integrated Management Log Messages and Troubleshooting Guide for HPE ProLiant Gen10 and Gen10 Plus servers and HPE Synergy provides IML messages and associated troubleshooting information to resolve critical and cautionary IML events.

To access troubleshooting resources for your product, see the **Hewlett Packard Enterprise website**.

Configuration and diagnostic utilities

This chapter provides information about common utilities that might not apply to your server. For information about server compatibility with the utilities listed in this chapter, see the product QuickSpecs at the Hewlett Packard Enterprise website (**https://www.hpe.com/info/qs**).

NOTE: Servers ordered from HPE Factory Express might have already been configured with all or some of the steps provided in this chapter. Refer to your order from HPE Factory Express to determine if any additional steps are required for setup.

Installing an operating system

To install an operating system on a server, first use iLO Virtual Media to connect the OS installation media to the server. Information about iLO Virtual Media is in the iLO User Guide at **www.hpe.com/support/ilo-docs**. Then, use the Intelligent Provisioning Setup Wizard (**www.hpe.com/info/intelligentprovisioning/docs**) to install the operating system.

For a list of supported operating systems, see the HPE Servers Support & Certification Matrices at **www.hpe.com/support/Servers-Certification-Matrices**.

Configuring the initial setup of a server

To configure	Use
Single server (graphical user interface)	• **Guided process:** Intelligent Provisioning (**www.hpe.com/info/intelligentprovisioning/docs**) • **Manual process:** HPE iLO web interface accessed by iLO remote console. Refer to the iLO online help for more information about iLO remote console. • **Menu-based process:** UEFI System Utilities (**https://www.hpe.com/info/UEFI-manual**)
Single server (scripting)	• **Using CLI for Windows and Linux to configure Redfish settings on a Gen10 or later server:** RESTful Interface Tool (**www.hpe.com/support/restfulinterface/docs**) • **Using Python:** Python iLO Redfish Library (python-ilorest-library) (**github.com/HewlettPackard/python-ilorest-library**) • **Using PowerShell for Windows-based environments:** PowerShell cmdlets (**https://www.hpe.com/info/powershell/docs**) • **Directly to the API using cURL or any other programming interface:** iLO RESTful API (**https://hewlettpackard.github.io/ilo-rest-api-docs/**)
Multiple servers (either UI or scripting)	HPE OneView (**https://www.hpe.com/support/oneview-docs**) [1]

[1] For servers running HPE OneView, do not use another tool, such as iLO, to delete or change certain settings. For more information about using HPE OneView and iLO to manage the same server, see the iLO User Guide at **www.hpe.com/support/ilo-docs**.

Configuring storage controllers

To determine the storage controllers that are supported by your server, see the product QuickSpecs at the Hewlett Packard Enterprise website (**https://www.hpe.com/info/qs**).

Controller type	Documentation
SR hardware RAID	—
Gen10 Plus	HPE SR Gen10 Plus Controller User Guide at **https://www.hpe.com/info/SR-Gen10Plus-UG**

Controller type	Documentation
Gen10	HPE Smart Array SR Controller Gen10 User Guide at https://www.hpe.com/support/SSC-SRGen10-ug
MR hardware RAID	—
Gen10 Plus	HPE MR Gen10 Plus Controller User Guide at https://www.hpe.com/info/MR-Gen10Plus-UG
Gen10	HPE Smart Array P824i-p MR Gen10 User Guide at https://www.hpe.com/info/p824ip-mr-gen10-contr-UG
Software RAID	• HPE SR Gen10 Plus Software RAID User Guide at https://www.hpe.com/support/SSC-SRGen10Plus-ug • User guides for the Intel Virtual RAID on CPU for HPE Gen10 Plus at https://www.hpe.com/support/IntelVROC-Gen10Plus-docs

Configuring NVMe OS boot devices

NVMe OS boot devices are plug and play as of Gen10. Device installation instructions are included in the packaging, server user guides, or server maintenance and service guides.

Configuring network controllers

To determine the network controllers that are supported by your server, see the product QuickSpecs at the Hewlett Packard Enterprise website (https://www.hpe.com/info/qs).

Network controllers are plug and play. For installation instructions, see the server user guide, the documentation included with the controller, or on the Hewlett Packard Enterprise Support Center website (https://www.hpe.com/support/hpesc) see:

Controller	Type	Documentation
OPC NIC 3.0	Network adapter	HPE OCP NIC 3.0 Adapter Installation Instructions at www.hpe.com/support/OCP3-NIC-Installation
PCIe	Network adapter	HPE PCIe Network Adapter Installation Instructions at www.hpe.com/support/PCIe-Installation
Synergy Type C and D	Mezzanine adapter	HPE Synergy Type C and Type D Mezzanine Adapters Installation Instructions at https://www.hpe.com/support/Synergy-Mezz-Installation
FlexibleLOM for Blades	Mezzanine card	HPE FlexibleLOM for Blades Installation Instructions at https://www.hpe.com/support/BLOM-Installation
FlexibleLOM for Racks	Network adapter	HPE FlexibleLOM for Racks Installation Instructions at https://www.hpe.com/support/ALOM-Installation
BladeSystem Type A and B	Mezzanine card	HPE BladeSystem Type A and B Mezzanine Card Installation Instructions at https://www.hpe.com/support/Blade-Mezz-Installation

Monitoring servers

To monitor	Use	Supported notifications
Single server	HPE iLO (www.hpe.com/support/ilo-docs)	• **SNMP** • **Redfish events** • **Email alerts** • **syslog**
Multiple servers	HPE OneView (www.hpe.com/support/oneview-docs)	• **SNMP** • **Redfish change events for Gen10 or later servers:** An example of a change event is adding a disk to a server. • **Email alerts:** HPE OneView provides email notifications based on alerts triggered from HPE iLO and other resources. • **syslogs from iLO:** HPE OneView can configure the iLO servers to forward their syslogs. HPE Oneview does not monitor the content of the forwarded syslogs.

Updating the server

- **HPE ProLiant servers:** HPE provides a comprehensive system software and firmware update solution through Service Packs for ProLiant (SPP).
- **HPE Synergy:** HPE provides updated firmware and software images through HPE Synergy Service Packs (SSPs).

To	Use
View supported operating systems and access operating system updates.	HPE Servers Support & Certification Matrices at www.hpe.com/support/Servers-Certification-Matrices
Determine and deploy which SSPs or SPPs to a single server.	Smart Update Manager (SUM) (www.hpe.com/info/sum-docs)
Deploy SSPs and SPPs to multiple servers.	HPE OneView (www.hpe.com/support/oneview-docs)
Download the SSP.	HPE Synergy management combinations and HPE Synergy Service Packs (SSPs) (www.hpe.com/info/synergy-sw-release-information)
Download the SPP.	HPE Service Pack for ProLiant (SPP) (www.hpe.com/servers/spp)

Optimizing the server

To	Use
Optimize server performance through management and tuning features.	HPE Server Performance Management and Tuning Guide at www.hpe.com/info/server-performance-management-tuning-en
Obtain recommendations for resolving incorrect settings.	HPE InfoSight for Servers (www.hpe.com/info/infosight-servers-docs)

Configuring security

To	See

To	See
Implement server security best practices.	• HPE Gen10 and Gen10 Plus Security Reference Guide at www.hpe.com/info/server-security-reference-en • HPE iLO 5 Security Technology Brief at www.hpe.com/support/ilo5-security-en
Configure and use the Server Configuration Lock feature on HPE Trusted Supply Chain servers and other servers that have the Server Configuration Lock feature enabled.	Server Configuration Lock User Guide for HPE ProLiant Gen10 and Gen10 Plus servers and HPE Synergy at www.hpe.com/info/server-config-lock-UG-en

Managing Linux-based high performance compute clusters

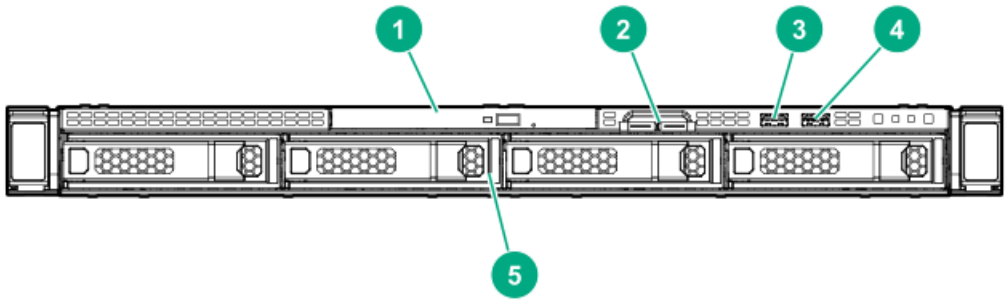
To	Use
Provision, manage, and monitor clusters.	HPE Performance Cluster Manager (www.hpe.com/support/hpcm_manuals)
Optimize your applications.	HPE Performance Analysis Tools (www.hpe.com/info/perftools)
Optimize software library for low latency and high bandwidth, both on-node and off-node, for point-to-point and collective communications.	HPE Cray Message Passing Toolkit in the HPE Cray Programming Environment User Guide for your server OS at www.hpe.com/info/cray-pe-user-guides
Optimize software libraries, runtime tools, and a scalable development environment for tuning and accelerating compute-intensive applications.	HPE Message Passing Interface (www.hpe.com/support/mpi-ug-038)

Component identification

This chapter describes the external and internal server features and components.

Front panel components

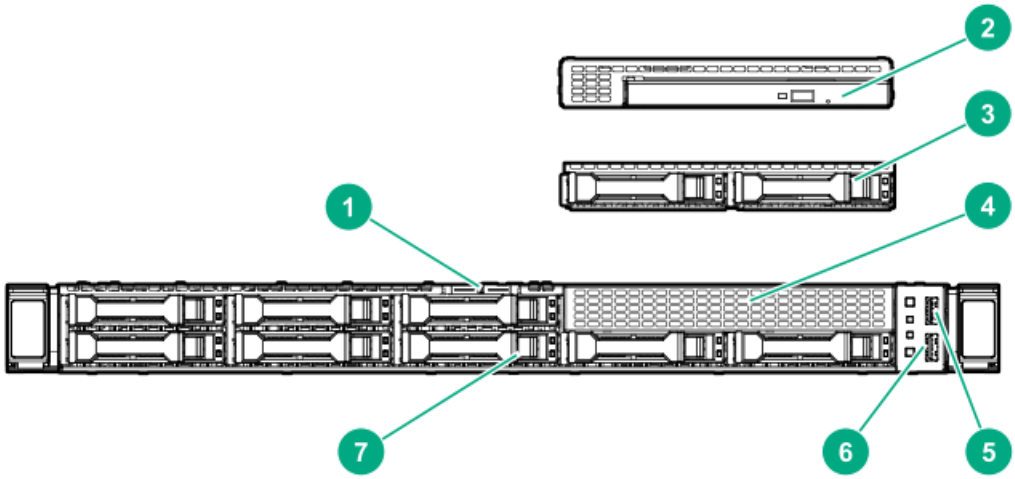
LFF front panel components



Item	Description
1	Optical drive (optional)
2	Serial number/iLO information pull tab [1]
3	iLO service port
4	USB 3.0 port
5	LFF drive bays [2]

[1] The serial number/iLO information pull tab is double-sided. One side shows the server serial number and the customer asset tag label. The other side shows the default iLO account information.
[2] The server supports LFF SAS and SATA drives.

SFF front panel components



Item	Description
1	Serial number/iLO information pull tab [1]
2	Optical drive (optional)
3	2 SFF drive cage [2]
4	Universal media bay [3]
5	USB 3.0 port
6	iLO service port
7	SFF drive bays [4]

[1] The serial number/iLO information pull tab is double-sided. One side shows the server serial number and the customer asset tag

label. The other side shows the default iLO account information.

2 The server supports two 2 SFF drive cage options. The following drive types are supported: SATA, SAS, U.2 NVMe, and U.3 NVMe drives.

3 The universal media bay supports the optical drive or the 2 SFF drive cage option.

4 The 8 SFF drive cage supports the following drive types: SATA, SAS, U.2 NVMe, and U.3 NVMe drives.

iLO Service Port

The Service Port is a USB port with the label **iLO** on supported servers and compute modules.

To find out if your server or compute module supports this feature, see the server specifications document at the following website: **https://www.hpe.com/info/qs**.

When you have physical access to a server, you can use the Service Port to do the following:

- Download the Active Health System Log to a supported USB flash drive.

  When you use this feature, the connected USB flash drive is not accessible by the host operating system.

- Connect a client (such as a laptop) with a supported USB to Ethernet adapter to access the following:
  - iLO web interface
  - Remote console
  - iLO RESTful API
  - CLI

  Hewlett Packard Enterprise recommends the HPE USB to Ethernet Adapter (part number Q7Y55A).

When you use the iLO Service Port:

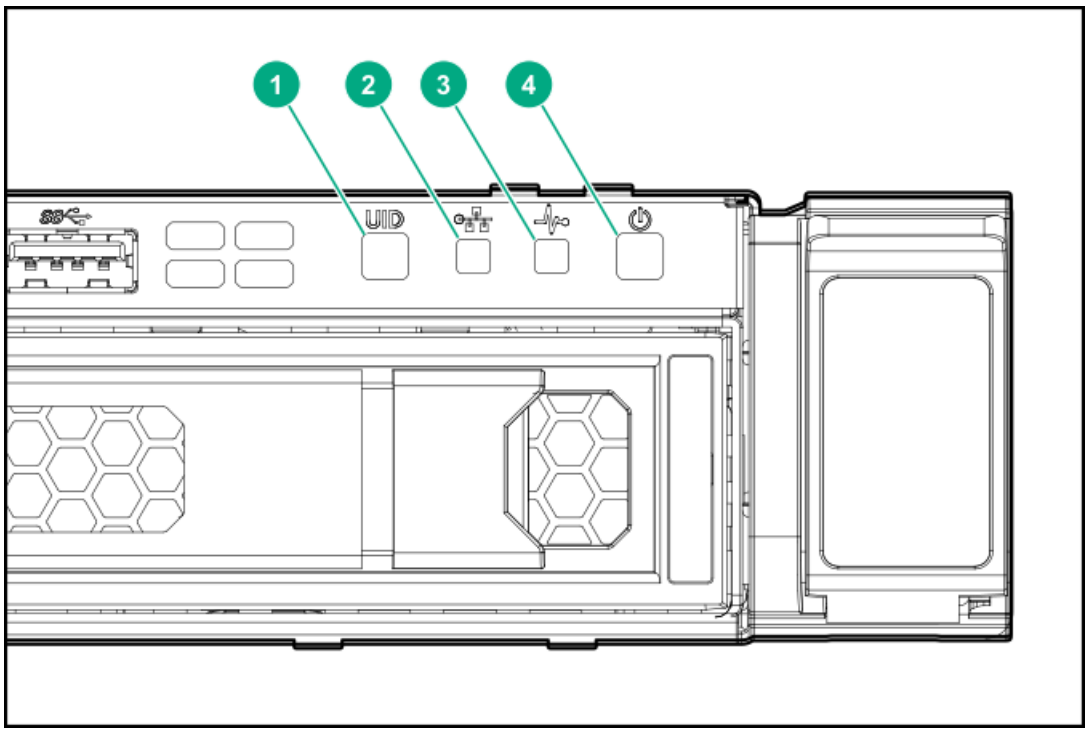
- Actions are logged in the iLO event log.
- The server UID flashes to indicate the Service Port status.

  You can also retrieve the Service Port status by using a REST client and the iLO RESTful API.
- You cannot use the Service Port to boot any device within the server, or the server itself.
- You cannot access the server by connecting to the Service Port.
- You cannot access the connected device from the server.

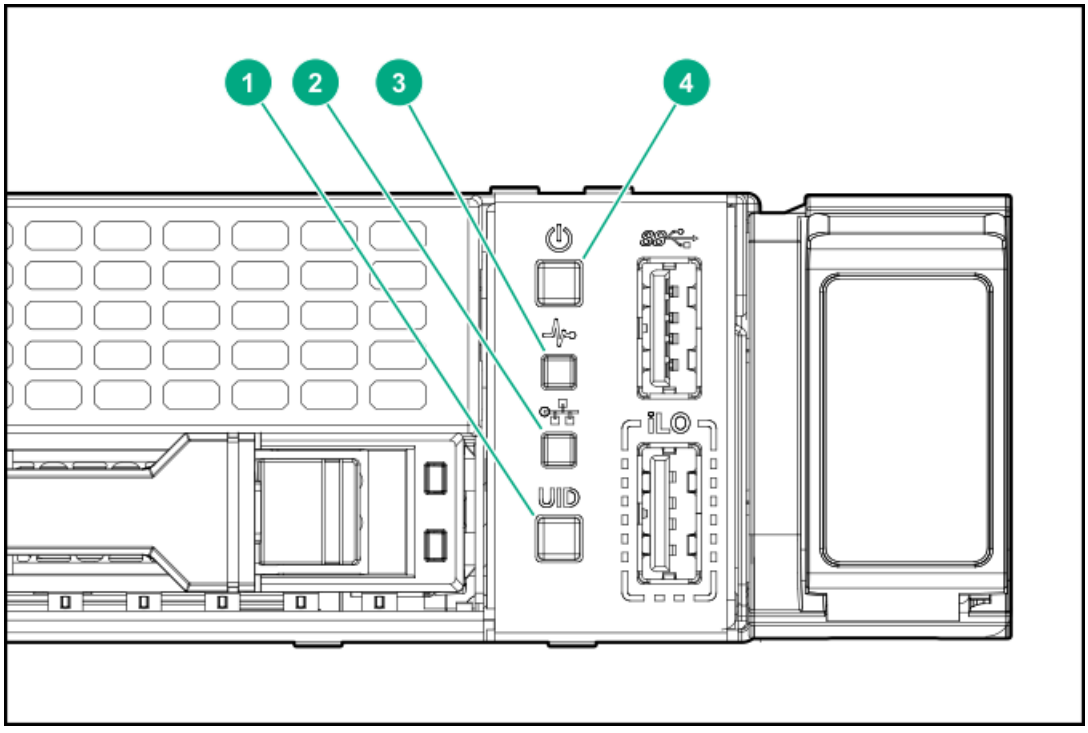
For more information about the iLO Service Port, see the iLO user guide at the following website: **https://www.hpe.com/support/ilo-docs**.

Front panel LEDs and buttons

LFF front panel LEDs and buttons



SFF front panel LEDs and button



Item	Description	Status	Definition
1	UID button/LED [1]	Solid blue	Activated

Item	Description	Status	Definition
		Flashing blue	• 1 flash per second = Remote management or firmware upgrade in progress • 4 flashes per second = iLO manual reboot sequence initiated • 8 flashes per second = iLO manual reboot sequence in progress
		Off	Deactivated
2	NIC status LED [1]	Solid green	Linked to network
		Flashing green	Network active
		Off	No network activity
3	Health LED [1]	Solid green	Normal
		Flashing green	iLO is rebooting
		Flashing amber	System degraded [2]
		Flashing red	System critical [2]
4	Power On/Standby button and system power LED [1]	Solid green	System on
		Flashing green	Performing power-on sequence
		Solid amber	System in standby
		Off	No power present [3]

[1] When all LEDs flash simultaneously, a power fault has occurred. For more information, see Front panel LED power fault codes.
[2] If the health LED indicates a degraded or critical state, review the system Integrated Management Log (IML) or use HPE iLO to review the system health status.
[3] Facility power is not present, power cord is not attached, no power supplies are installed, power supply failure has occurred, or the front I/O cable is disconnected.

Server UID LED

The UID LED is used to locate a particular server when it is deployed in a dense rack with other equipment. Activating the UID LED helps an on-site technician to quickly identify a server for maintenance tasks.

Using the UID button to view the Server Health Summary

You can use the UID button to display the iLO Server Health Summary screen on an external monitor. This function works both when the server is powered on or off. Use this feature for troubleshooting if the server will not start up.

> ⚠ **CAUTION:** Press and release the UID button. Holding it down at any time for more than five seconds initiates a graceful iLO reboot or a hardware iLO reboot. Data loss or NVRAM corruption might occur during a hardware iLO reboot.

Prerequisites

- An external monitor is connected.
- In the iLO web interface, the Show Server Health on External Monitor feature is enabled on the Access Settings page.

Procedure

1. Press and release the UID button.

   The Server Health Summary screen is displayed on the external monitor. For more information, see the iLO troubleshooting guide on the Hewlett Packard Enterprise website (**https://www.hpe.com/support/ilo-docs**).

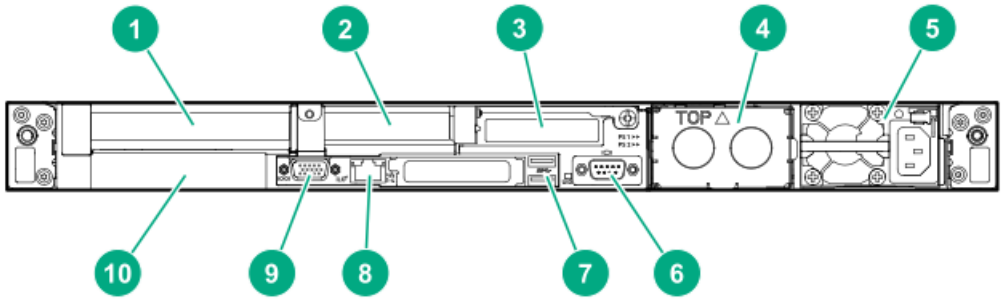
2. Press the UID button again to close the Server Health Summary screen.

Front panel LED power fault codes

The following table provides a list of power fault codes, and the subsystems that are affected. Not all power faults are used by all servers.

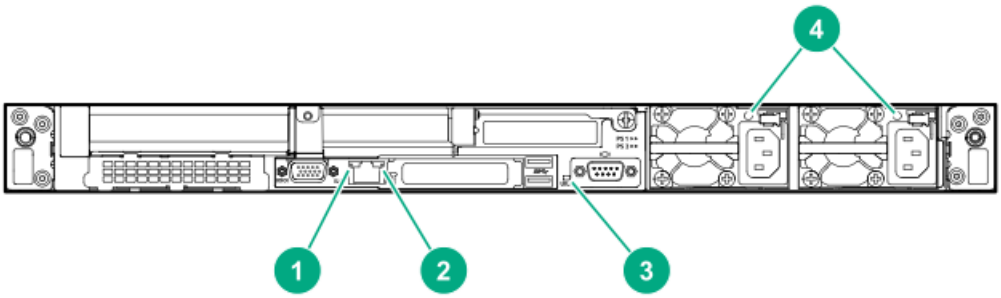
Subsystem	LED behavior
System board	1 flash
Processor	2 flashes
Memory	3 flashes
Riser board PCIe slots	4 flashes
FlexibleLOM	5 flashes
Storage controller	6 flashes
System board PCIe slots	7 flashes
Power backplane	8 flashes
Storage backplane	9 flashes
Power supply	10 flashes
PCIe expansion cards installed in riser board	11 flashes
Chassis	12 flashes
GPU card	13 flashes

Rear panel components



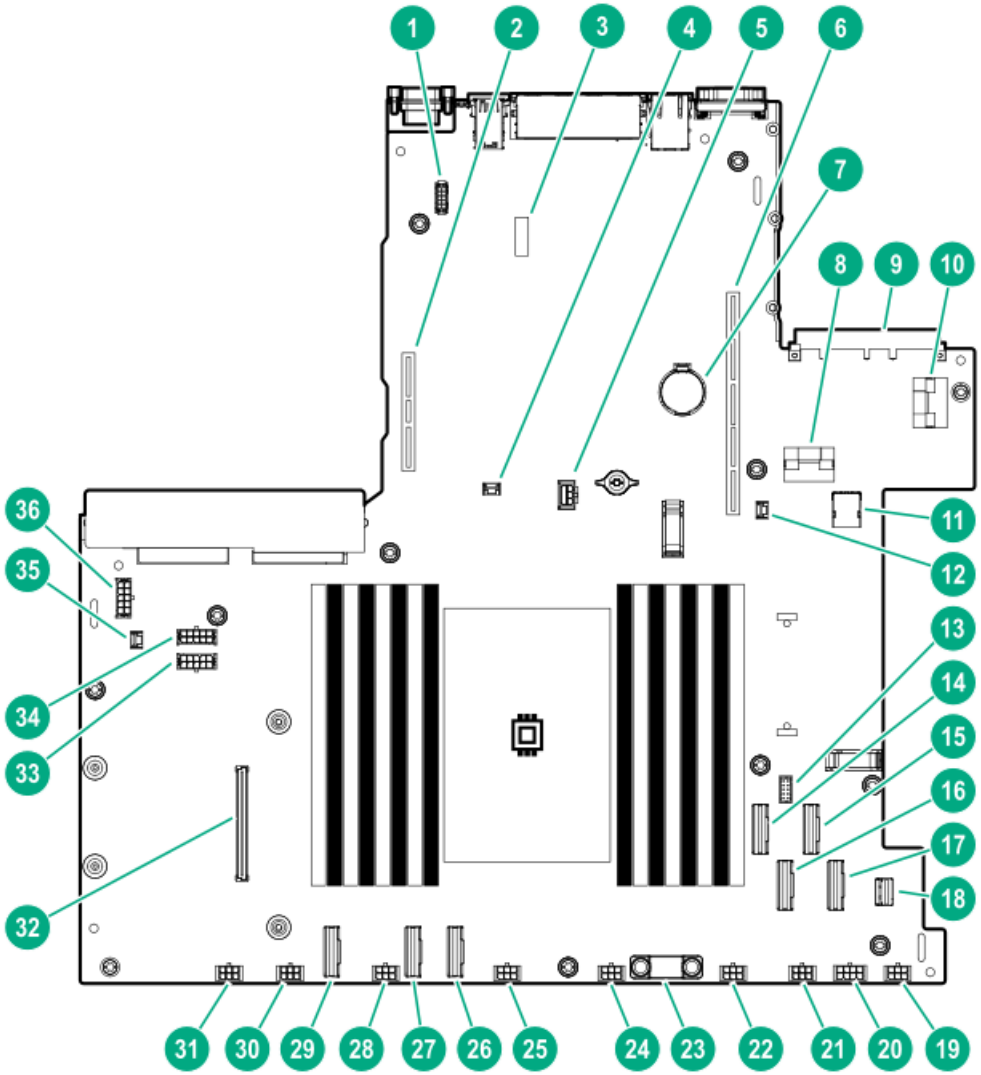
Item	Description
1	Slot 1 PCIe4 x16 (16, 8, 4, 1)
2	Slot 2 PCIe4 x16 (16, 8, 4, 1)
3	Slot 3 PCIe4 x16 (16, 8, 4, 1) (optional)
4	Flex Slot power supply 2 (optional)
5	Flex Slot power supply 1
6	Serial port (optional)
7	USB 3.0 ports (2)
8	iLO management port
9	Video port
10	OCP NIC 3.0 slot

Rear panel LEDs



Item	LED	Status	Definition
1	iLO link	Solid green	Network link
		Off	No network link
2	iLO status	Solid green	Linked to network
		Flashing green	Network active
		Off	No network activity
3	UID	Solid blue	Activated
		Flashing blue	• 1 flash per sec = Remote management or firmware upgrade in progress • 4 flashes per sec = iLO manual reboot sequence initiated • 8 flashes per sec = iLO manual reboot sequence in progress
		Off	Deactivated
4	Power supply	Solid green	The power supply is operating normally.
		Off	One or more of the following conditions exists: • Power is unavailable • Power supply failure • Power supply is in standby mode • Power supply error

System board components



Item	Description
1	Serial port connector
2	Secondary PCIe4 riser connector
3	System maintenance switch
4	Storage controller backup power connector 2
5	Graphics card power connector 2
6	Primary PCIe4 riser connector
7	System battery
8	NVMe port 6A
9	OCP NIC 3.0 slot
10	OCP NIC 3.0 x16 upgrade connector
11	Internal USB 3.0 port
12	Storage controller backup power connector 1
13	Energy pack connector
14	NVMe/SATA port 9A
15	NVMe port 4A
16	NVMe/SATA port 8A

Item	Description
17	NVMe port 5A
18	Front I/O connector
19	Fan connector 8
20	Graphics card power connector 1
21	Fan connector 7
22	Fan connector 6
23	TPM connector
24	Fan connector 5
25	Fan connector 4
26	NVMe port 3A
27	NVMe port 1A
28	Fan connector 3
29	NVMe port 2A
30	Fan connector 2
31	Fan connector 1
32	Type-a modular storage controller slot
33	Not for use in this server
34	Not for use in this server
35	Chassis intrusion detection switch connector
36	Drive backplane power connector

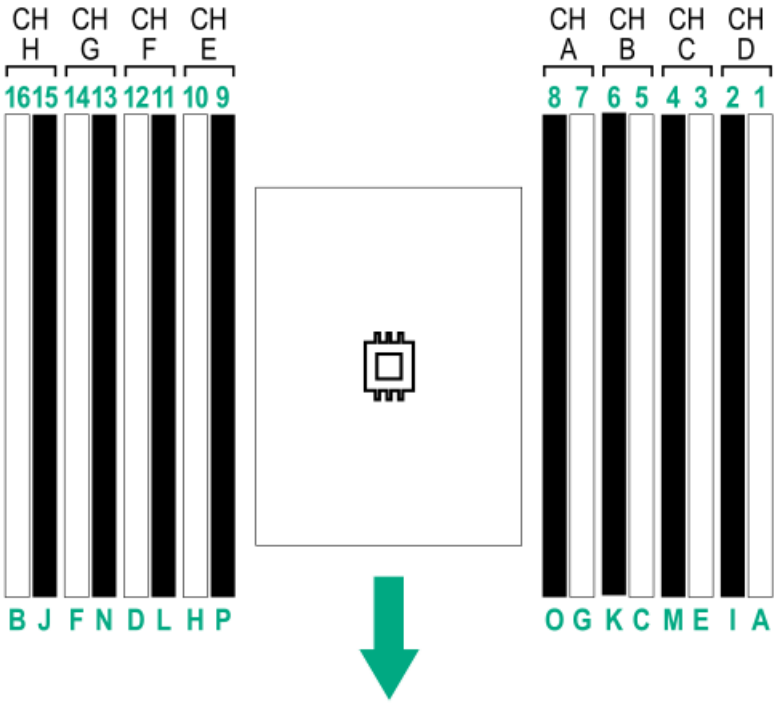
System maintenance switch descriptions

Position	Default	Function
S1 [1]	Off	• Off = iLO 5 security is enabled. • On = iLO 5 security is disabled.
S2	Off	Reserved
S3	Off	Reserved
S4	Off	Reserved
S5 [1]	Off	• Off = Power-on password is enabled. • On = Power-on password is disabled.
S6 [1], [2], [3]	Off	• Off = No function • On = Restore default manufacturing settings
S7	Off	Reserved
S8	—	Reserved
S9	—	Reserved
S10	—	Reserved
S11	—	Reserved
S12	—	Reserved

[1] To access the redundant ROM, set S1, S5, and S6 to On.
[2] When the system maintenance switch position 6 is set to the On position, the system is prepared to restore all configuration settings to their manufacturing defaults.
[3] When the system maintenance switch position 6 is set to the On position and Secure Boot is enabled, some configurations cannot be restored. For more information, see Configuring security.

DIMM slot locations

DIMM slots are numbered sequentially (1 through 16). The supported Advance Memory Protection (AMP) modes use the letter assignments for population guidelines.

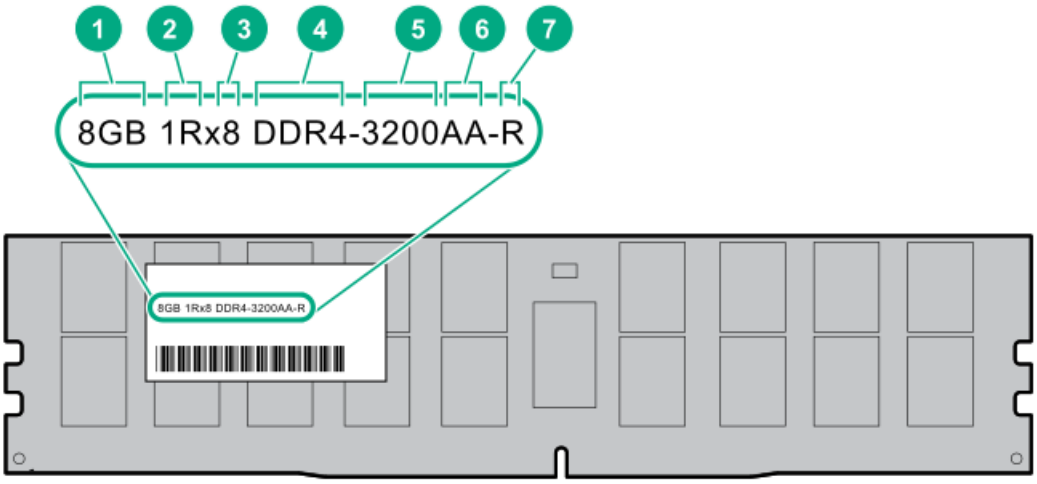


The arrow points to the front of the server.

DIMM label identification

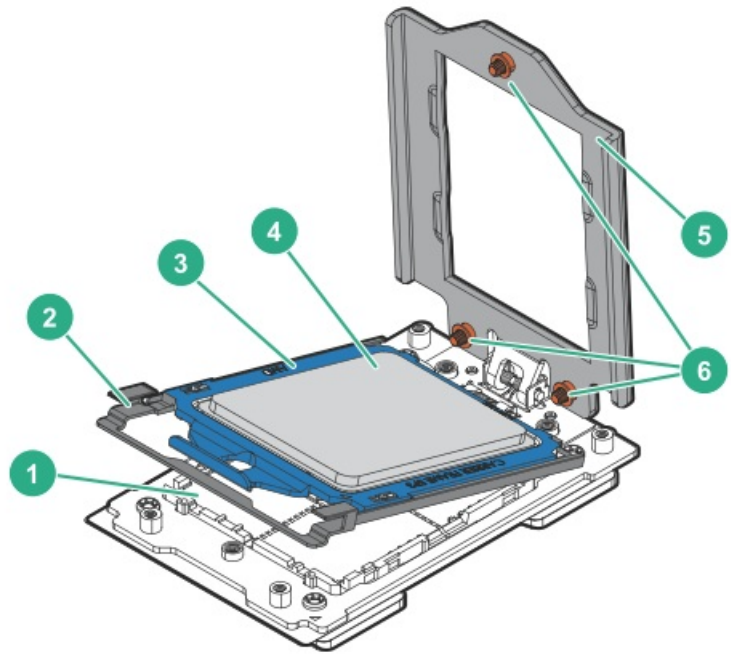
To determine DIMM characteristics, see the label attached to the DIMM. The information in this section helps you to use the label to locate specific information about the DIMM.

For more information about product features, specifications, options, configurations, and compatibility, see the HPE DDR4 SmartMemory QuickSpecs on the Hewlett Packard Enterprise website (**https://www.hpe.com/support/DDR4SmartMemoryQS**).



Item	Description	Example
1	Capacity	8 GB 16 GB 32 GB 64 GB 128 GB 256 GB
2	Rank	1R = Single rank 2R = Dual rank 4R = Quad rank 8R = Octal rank
3	Data width on DRAM	x4 = 4-bit x8 = 8-bit
4	Memory generation	PC4 = DDR4
5	Maximum memory speed	3200 MT/s
6	CAS latency	AA = CAS 22-22-22 AA = CAS 26-22-22 (for 3DS LRDIMM)
7	DIMM type	E = Unbuffered ECC (UDIMM) R = RDIMM (registered) L = LRDIMM (load reduced)

Processor and socket components



Item	Description
1	Pin field
2	Rail frame
3	Carrier frame
4	Processor
5	Force frame
6	Captive screws (Torx T-20)

Drive bay numbering

CAUTION:

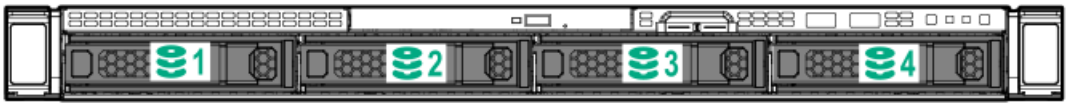
When a server is purchased without any drive installed, some drive bays might be empty while other drive bays might be populated with drive blanks. To maintain proper system cooling, do not operate the server without a drive or a drive blank installed.

- 4 LFF drive bay numbering
- 8 SFF + 2 SFF drive bay numbering

4 LFF drive bay numbering

In the LFF drive configuration:

- All drives belong to the same box 1.
- SAS and SATA drives are supported.
- All box 1 drives connected to the NVMe/SATA port 8A are covered in the SATA software RAID.

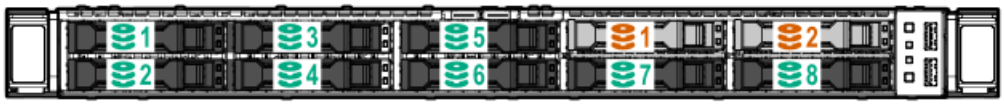


8 SFF + 2 SFF drive bay numbering

In the SFF drive configuration:

- Drives are assigned to box 1 (green) and the optional box 2 (orange).
- SAS, SATA, U.2 NVMe, and U.3 NVMe drives are supported.

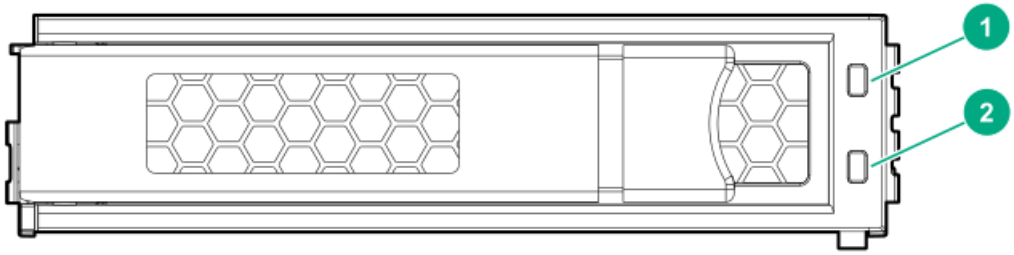
  When a Gen10 Plus tri-mode controller is used together with a U.3 drive backplane, the system will support mixed drive configuration.
- When installing NVMe drives, install either all U.2 or all U.3 drives. Mixed NVMe drive type installation is not supported.
- 8 SFF SAS/SATA: All box 1 drives connected to the NVMe/SATA port 8A supports SATA software RAID.
- 8 SFF NVMe: The box 1, drives 1–2 connected to the NVMe port 3A supports NVMe software RAID.
- 8 SFF SAS/SATA + 2 SFF NVMe:
  - All box 1 drives connected to the NVMe/SATA port 8A supports SATA software RAID.
  - All box 2 drives connected to the NVMe port 4A supports NVMe software RAID.
- 8 SFF NVMe + 2 SFF NVMe:
  - The box 1, drives 1–2 connected to the NVMe port 3A supports NVMe software RAID.
  - The box 1, drives 3–8 and the box 2 drives will not support software RAID.



HPE Basic Drive LED definitions

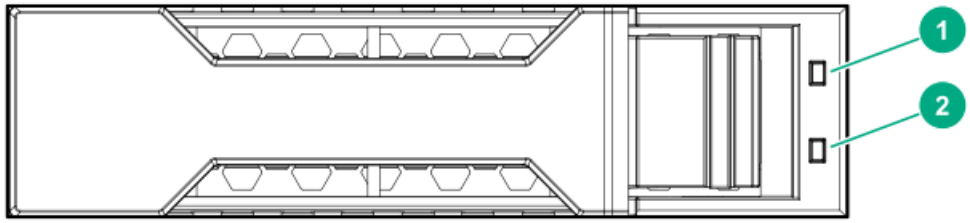
LFF low-profile drive carrier

The LFF low-profile drive carrier supports hot-plug SAS and SATA drives.



SFF basic drive carrier

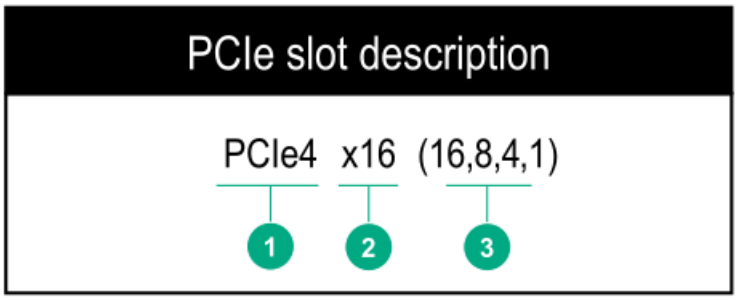
The SFF basic drive carrier supports hot-plug SAS, SATA, and U.2/U.3 NVMe drives.



Item	LED	Status	Definition
1	Fault/Locate	Solid amber	This drive has failed, is unsupported, or is invalid.
		Solid blue	The drive is operating normally and being identified by a management application.
		Flashing amber/blue	The drive has failed, or a predictive failure alert has been received for this drive. The drive has also been identified by a management application.
		Flashing amber	A predictive failure alert has been received for this drive. Replace the drive as soon as possible.
2	Online/Activity	Solid green	The drive is online and has no activity.
		Flashing green (1 flash per second)	The drive is doing one of the following: • Rebuilding or performing a RAID • Performing a stripe size migration • Performing a capacity expansion • Performing a logical drive extension • Erasing • Spare part activation
		Flashing green (4 flashes per second)	The drive is operation normally and has activity.

Item	LED	Status	Definition
		Off	The drive is not configured by a RAID controller or is a spare drive.

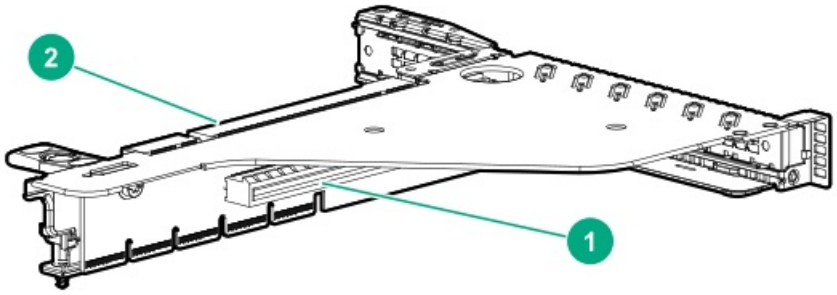
PCIe4 slot description



Item	Description	Definition
1	PCI Express version	Each PCIe version corresponds to a specific data transfer rate between the processor and peripheral devices. Generally, a version update corresponds to an increase in transfer rate. • PCIe 1.x • PCIe 2.x • PCIe 3.x • PCIe 4.x The PCIe technology is under constant development. For the latest information, see the **PCI-SIG website**.
2	Physical connector link width	PCIe devices communicate through a logical connection called an interconnect or link. At the physical level, a link is composed of one or more lanes. The number of lanes is written with an x prefix with x16 being the largest size in common use. • x1 • x2 • x4 • x8 • x16
3	Negotiable link width	These numbers correspond to the maximum link bandwidth supported by the slot.

Riser board components

Primary riser

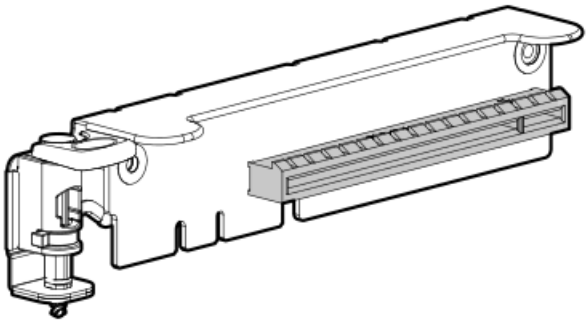


Slot number	Description	Supported form factors
1	PCIe4 x16 (16, 8, 4, 1) slot	• Full-height, full-length • Full-height, half-length • Half-height, half-length (low-profile)
2	PCIe4 x16 (16, 8, 4, 1) slot	Half-height, half-length (low-profile) [1]

[1] When a full-height expansion card is installed in the secondary riser slot 3, the primary riser slot 2 will no longer support card installation.

Secondary riser

The secondary riser has a single slot—Slot 3 PCIe4 x16 (16, 8, 4, 1). Slot 3 supports a full-height, half-length or a half-height, half-length (low-profile) expansion card.



DSC-25 2-port SFP28 card ports and LEDs

Ports

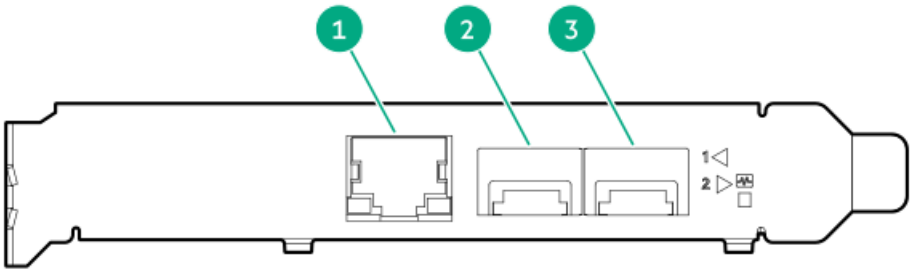


Table 1: Ports

Item	Port	Description
1	Management port	1GbE RJ45
2	Network interface port	10/25G SFP+ based
3	Network interface port	10/25G SFP+ based

LEDs

The HPE for Pensando DSP DSC-25 2p SFP28 card is a dual-port, single-slot, half-height, half-length (HHHL) SFP28 network adapter. It has LEDs for Link (L) and Activity (A) for each port. A half-height bracket is shown in the following illustration with SFP28 ports and LEDs.

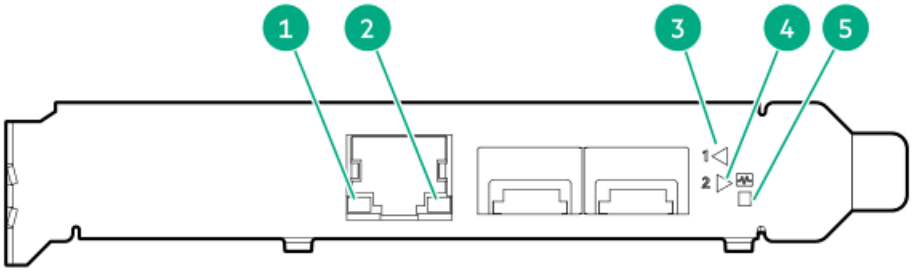
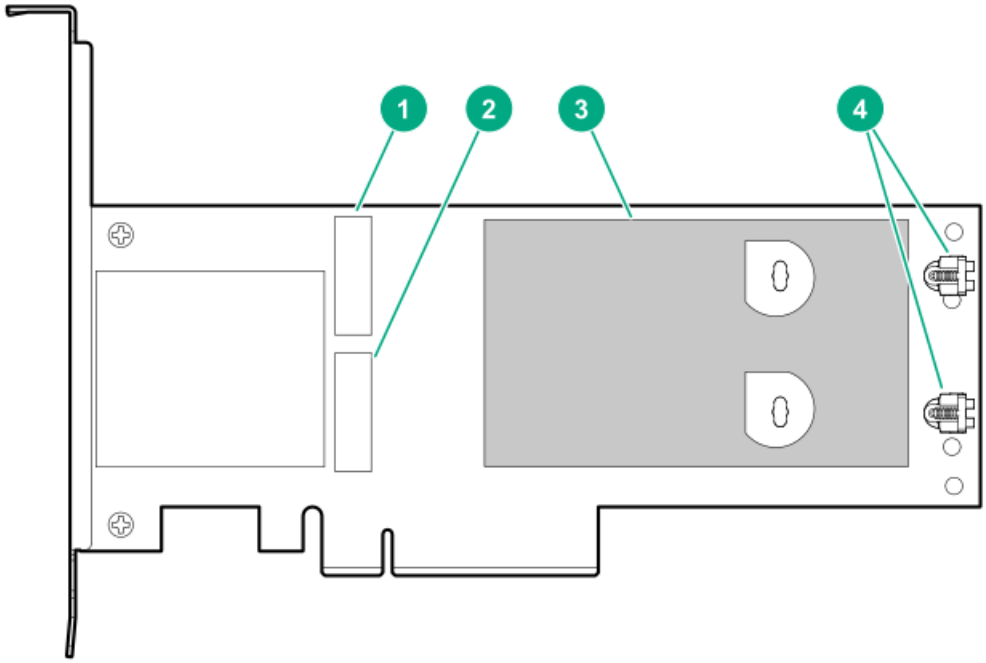


Table 2: LED indicators

Item	LED	Status	Description
1	Management Port Activity LED	Off	No activity
		Flashing	Passing traffic; flashing frequency indicates traffic intensity
2	Management Port Link LED	Off	A link has not been established
		Solid green	Valid Ethernet link
3	SFP Port 1 Link/Activity LED	Off	A link has not been established
		Solid green	Valid Ethernet link
		Flashing green	Passing traffic; flashing frequency indicates traffic intensity
		Solid amber	Link fault

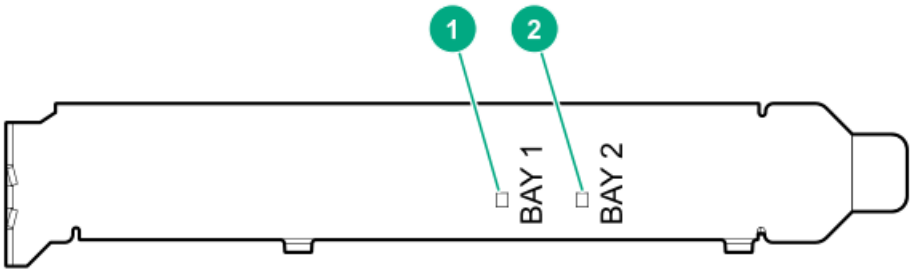
Item	LED	Status	Description
4	SFP Port 2 Link/Activity LED	Off	A link has not been established
		Solid green	Valid Ethernet link
		Flashing green	Passing traffic; flashing frequency indicates traffic intensity
		Solid amber	Link fault
5	System status LED	Off	System is not powered
		Solid amber	Power is up, software has not booted yet
		Solid green	System is up and fully operational

HPE NS204i-p NVMe OS Boot Device components



Item	Description
1	Drive bay 1
2	Drive bay 2
3	Thermal interface pad with removable liner
4	M.2 drive retaining latches

HPE NS204i-p NVMe OS Boot Device LED definitions



Item	Description	Fault LED status
1	Bay 1 LED	Off: Normal
2	Bay 2 LED	Flashing 1Hz: Drive predictive failure Amber: Drive failure

Fan numbering

To provide sufficient airflow to the system, the server is by default populated by eight fans. The fans can either be standard, single-rotor fans or high-performance, dual-rotor fans. Mixed fan configuration is not supported.

The arrow points to the front of the server.

Cabling

This chapter includes cabling guidelines and diagrams for internal component cabling.

Cabling guidelines

The cable colors in the cabling diagrams used in this chapter are for illustration purposes only. Most of the system cables are black.

Observe the following guidelines when working with system cables.

Before connecting cables

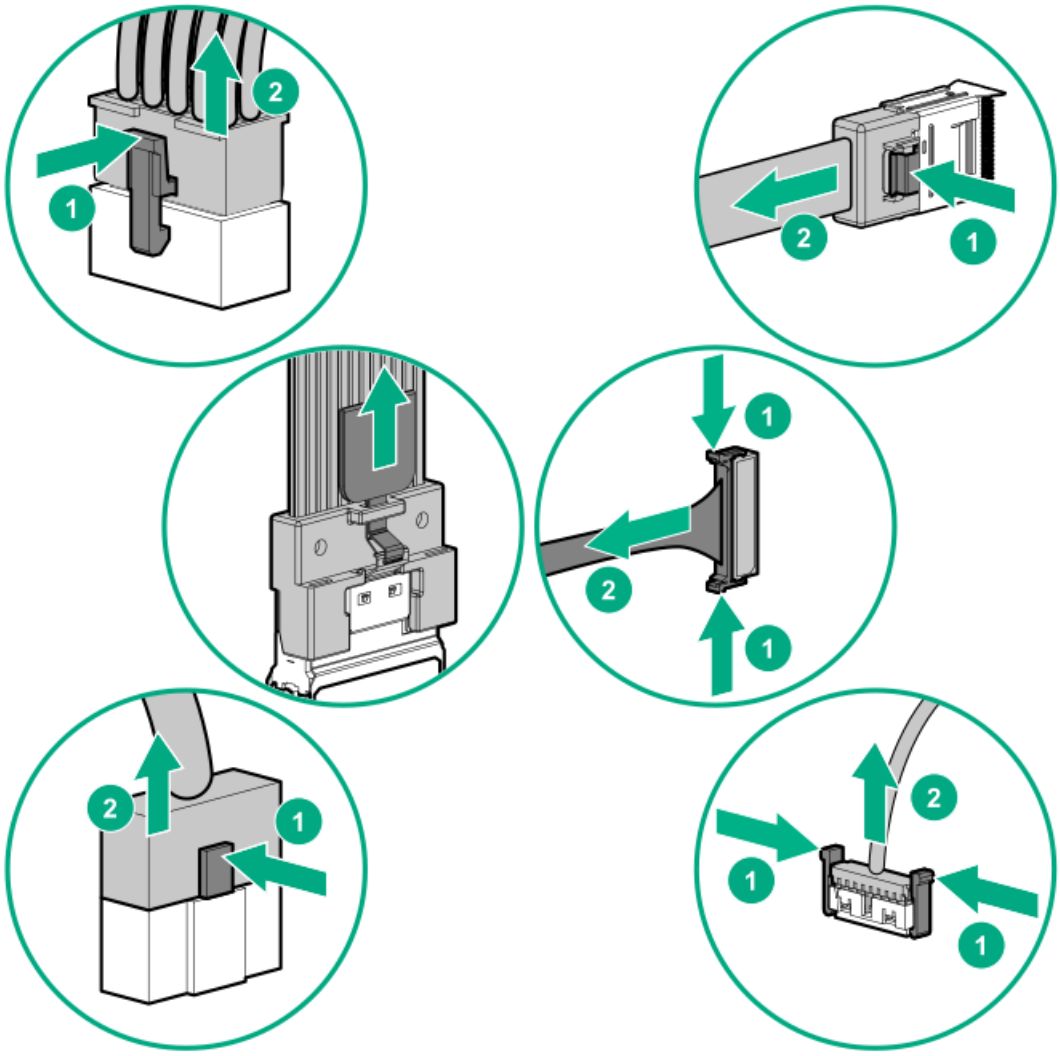
- Note the port labels on the PCA components. Not all of these components are used by all systems:
  - System board ports
  - Drive and power supply backplane ports
  - Expansion card ports (controllers, adapters, expanders, risers, and similar boards)
- Note the label near each cable connector. This label indicates the destination port for the cable connector.
- Some data cables are pre-bent. Do not unbend or manipulate the cables.
- To prevent mechanical damage or depositing oil that is present on your hands, and other contamination, do not touch the ends of the connectors.

When connecting cables

- Before connecting a cable to a port, lay the cable in place to verify the length of the cable.
- Use the internal cable management features to properly route and secure the cables.
- When routing cables, be sure that the cables are not in a position where they can be pinched or crimped.
- Avoid tight bend radii to prevent damaging the internal wires of a power cord or a server cable. Never bend power cords and server cables tight enough to cause a crease in the sheathing.
- Make sure that the excess length of cables are properly secured to avoid excess bends, interference issues, and airflow restriction.
- To prevent component damage and potential signal interference, make sure that all cables are in their appropriate routing position before installing a new component and before closing up the system after hardware installation/maintenance.

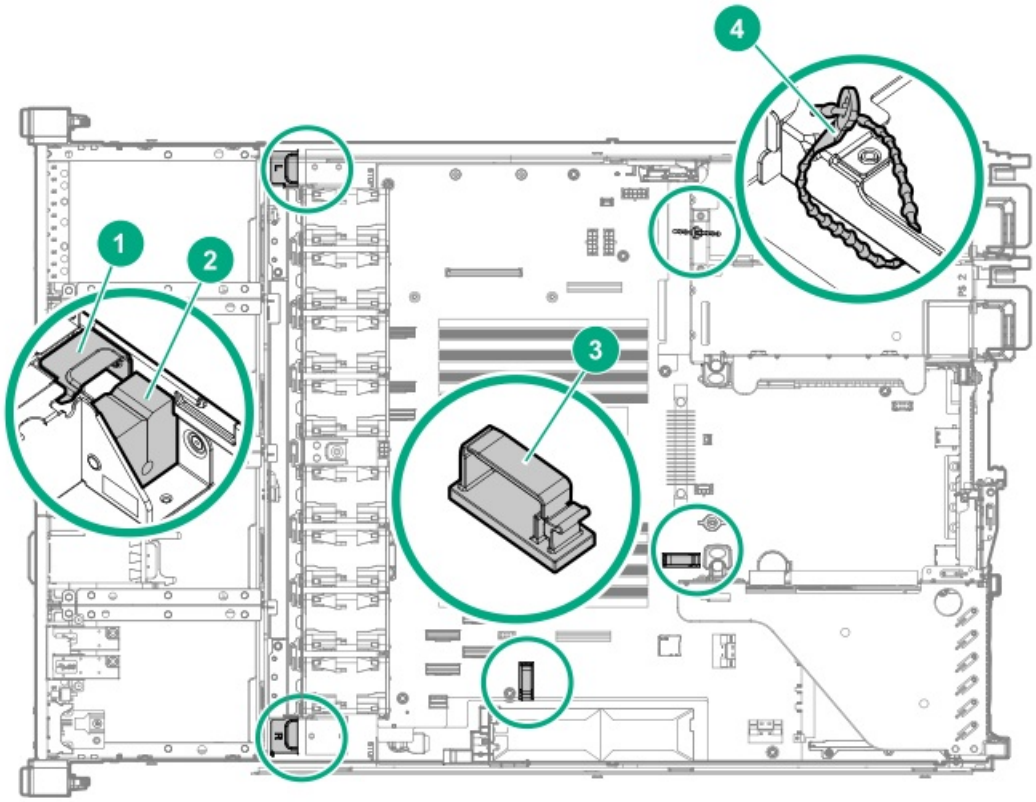
When disconnecting cables

- Grip the body of the cable connector. Do not pull on the cable itself because this action can damage the internal wires of the cable or the pins on the port.
- If a cable does not disconnect easily, check for any release latch that must be pressed to disconnect the cable.



- Remove cables that are no longer being used. Retaining them inside the system can restrict airflow. If you intend to use the removed cables later, label and store them for future use.

Internal cabling management



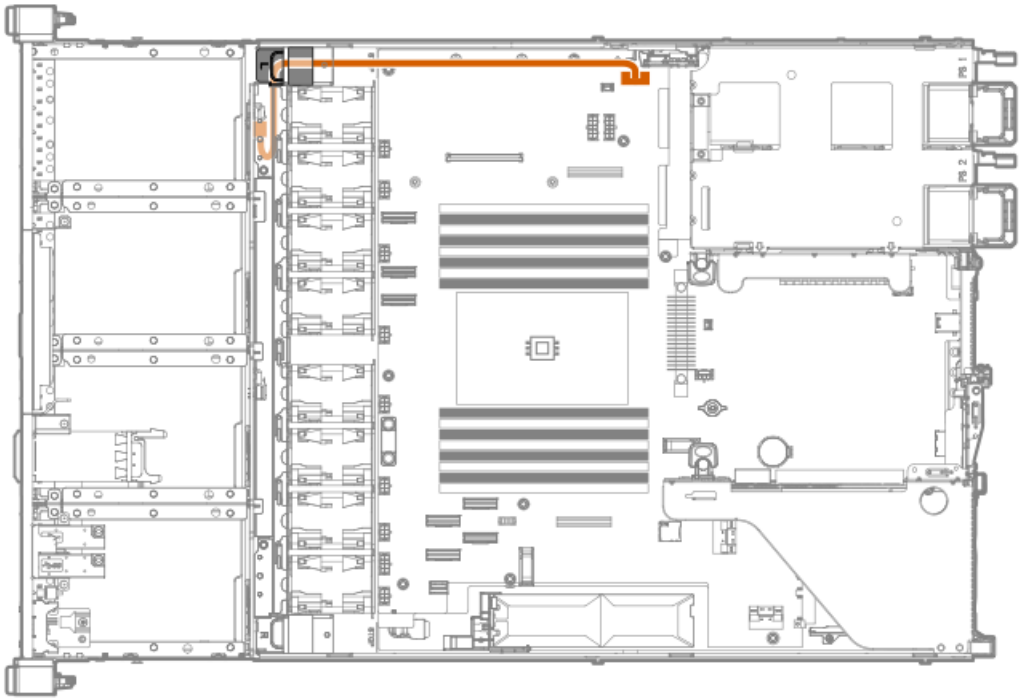
Item	Description
1	Fan wall brackets
2	Cable routing foams
3	Cable clips
4	Adjustable cable tie

Storage cabling

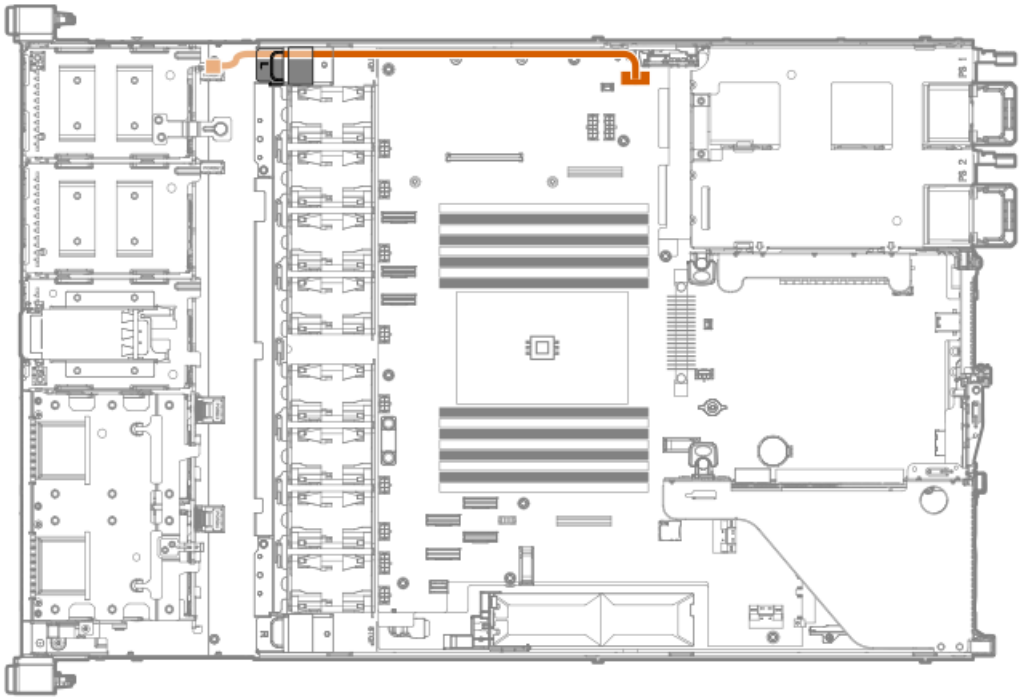
- Drive power cabling
- Storage controller cabling
- Energy pack cabling
- Storage controller backup power cabling

Drive power cabling

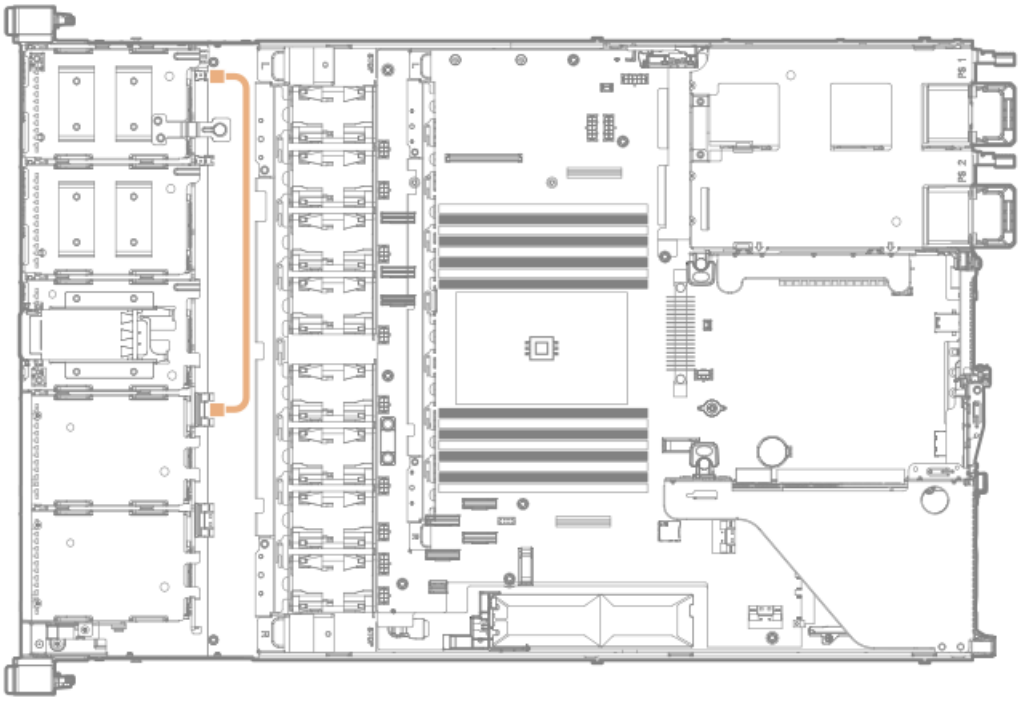
4 LFF drive power cabling



8 SFF drive power cabling



2 SFF drive power cabling

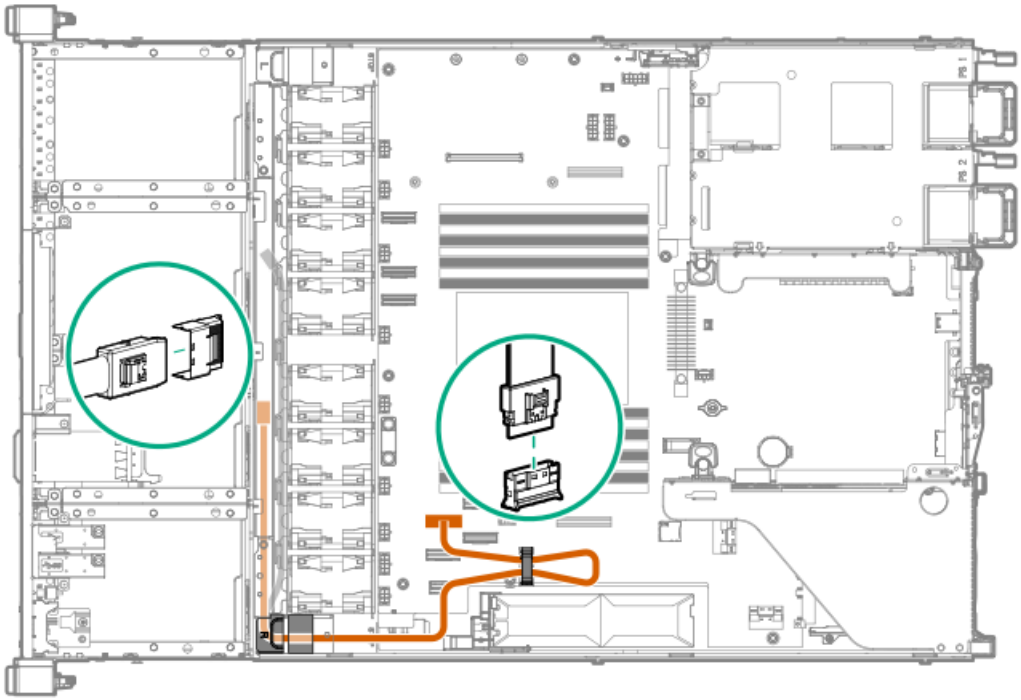


Storage controller cabling

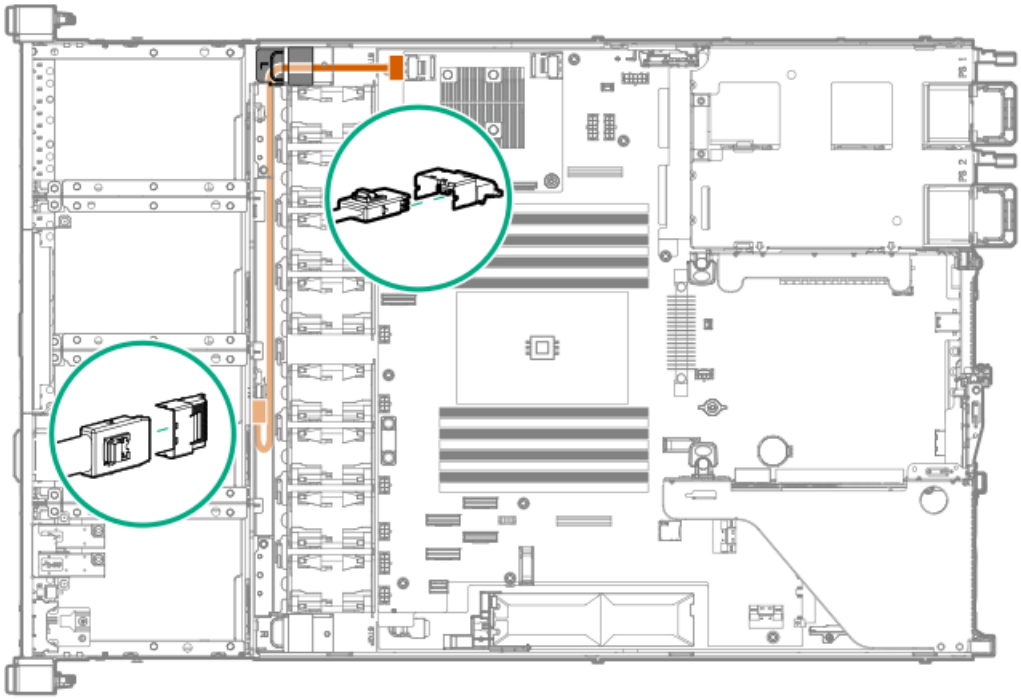
- 4 LFF SAS/SATA drive controller cabling
- 8 SFF SAS/SATA drive controller cabling
- 8 SFF NVMe drive controller cabling
- 2 SFF NVMe drive controller cabling
- 8 + 2 SFF drive controller cabling

4 LFF SAS/SATA drive controller cabling

4 LFF drive: Onboard SATA cabling

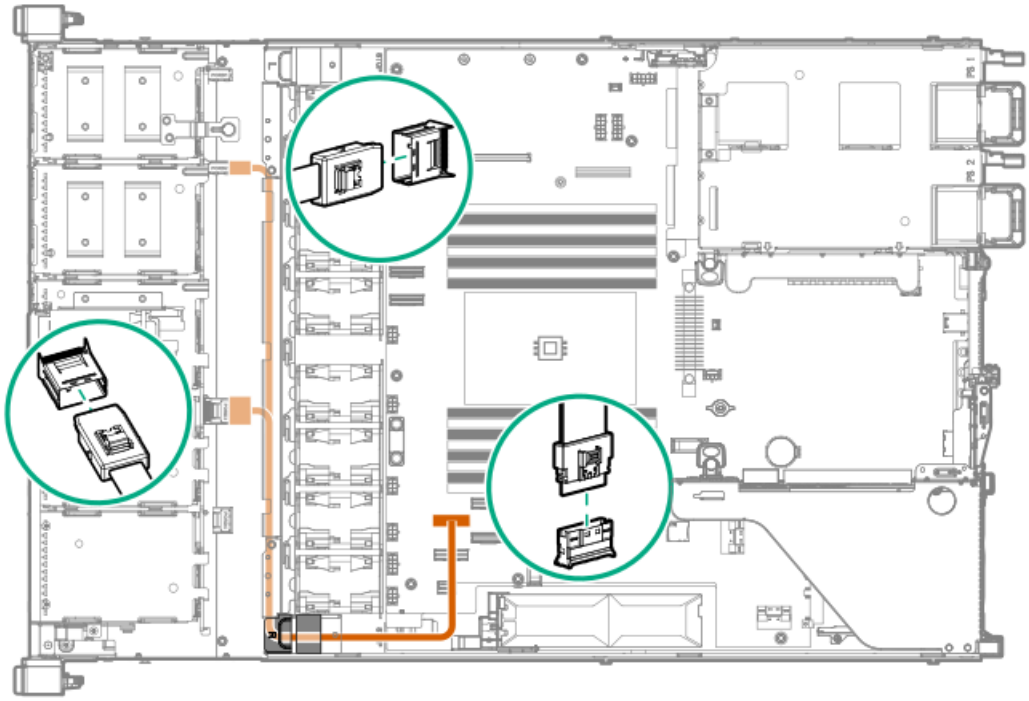


4 LFF drive: Type-a controller cabling

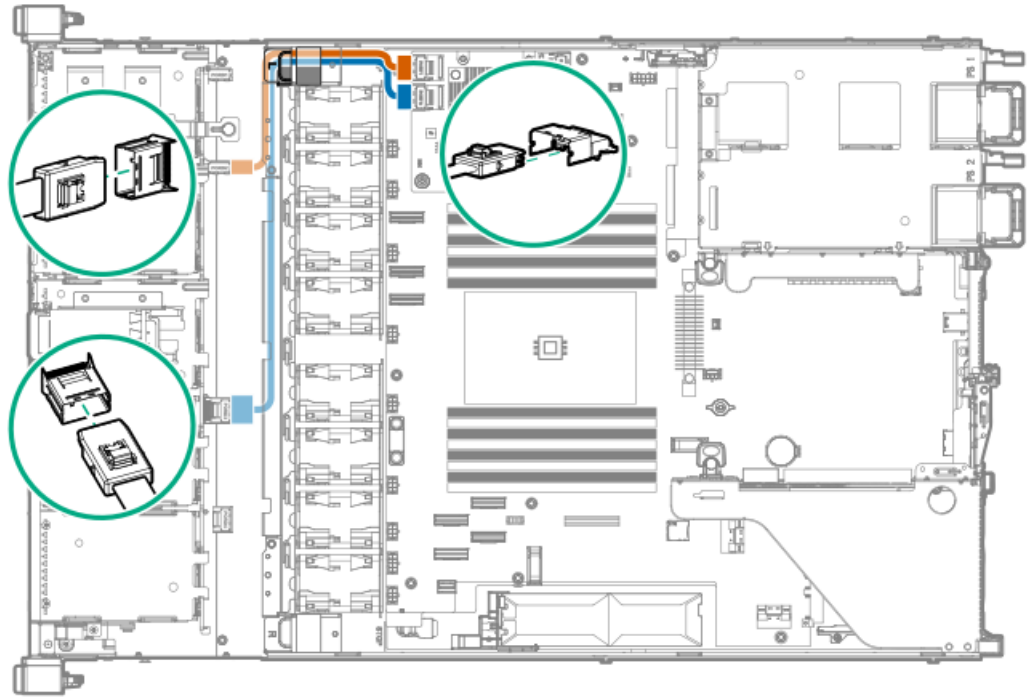


8 SFF SAS/SATA drive controller cabling

8 SFF drive: Onboard SATA cabling



8 SFF drive: Type-a controller cabling



Color	Description
Orange	Port 1 Mini-SAS cable
Blue	Port 2 Mini-SAS cable

8 SFF drive: Type-p controller cabling from the primary riser

Color	Description
Orange	Port 1 Mini-SAS cable
Blue	Port 2 Mini-SAS cable

8 SFF drive: Type-p controller cabling from the secondary riser

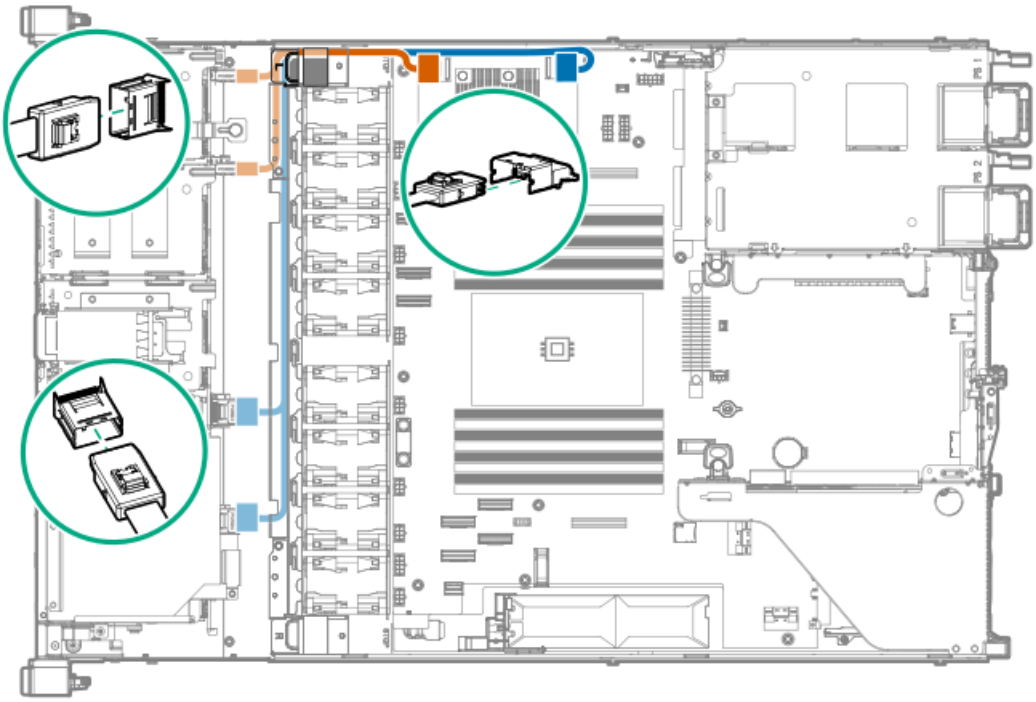
Color	Description
Orange	Port 1 Mini-SAS cable
Blue	Port 2 Mini-SAS cable

8 SFF NVMe drive controller cabling

8 SFF drive: Onboard NVMe cabling

Color	Description
Orange	NVMe port 3A SlimSAS cable
Blue	NVMe port 1A SlimSAS cable
Gold	NVMe port 5A SlimSAS cable
Pink	NVMe/SATA port 8A SlimSAS cable

8 SFF drive: Type-a controller cabling

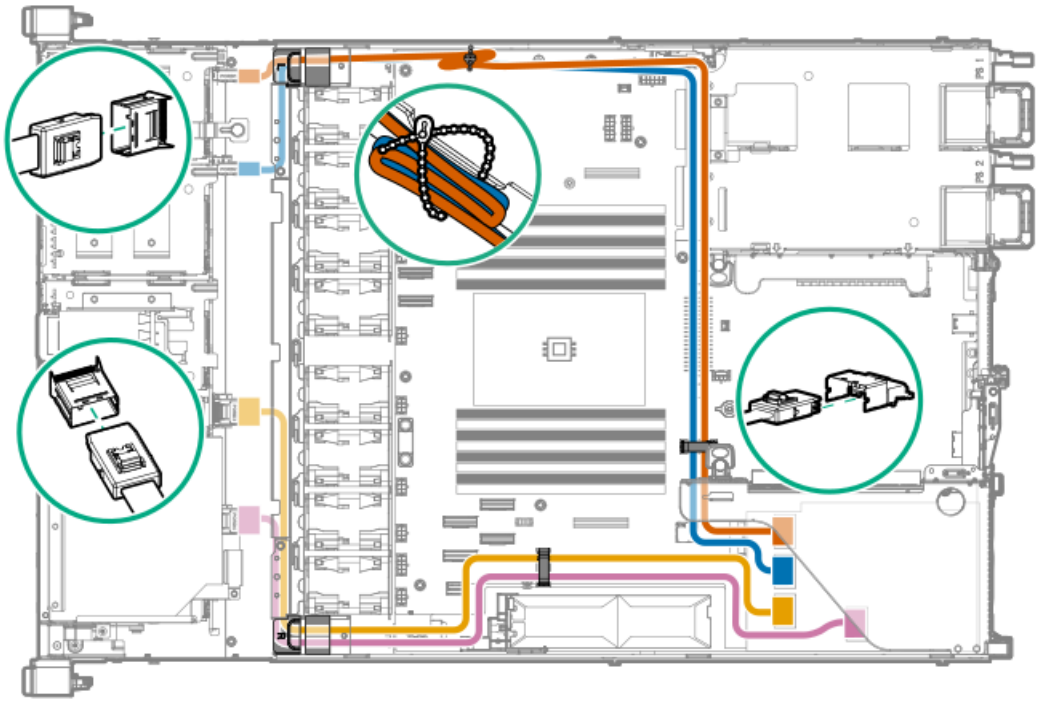


Color	Description
Orange	Port 1 SlimSAS Y-cable

Color	Description
Blue	Port 2 SlimSAS Y-cable

8 SFF drive: Type-p controller cabling from the primary riser

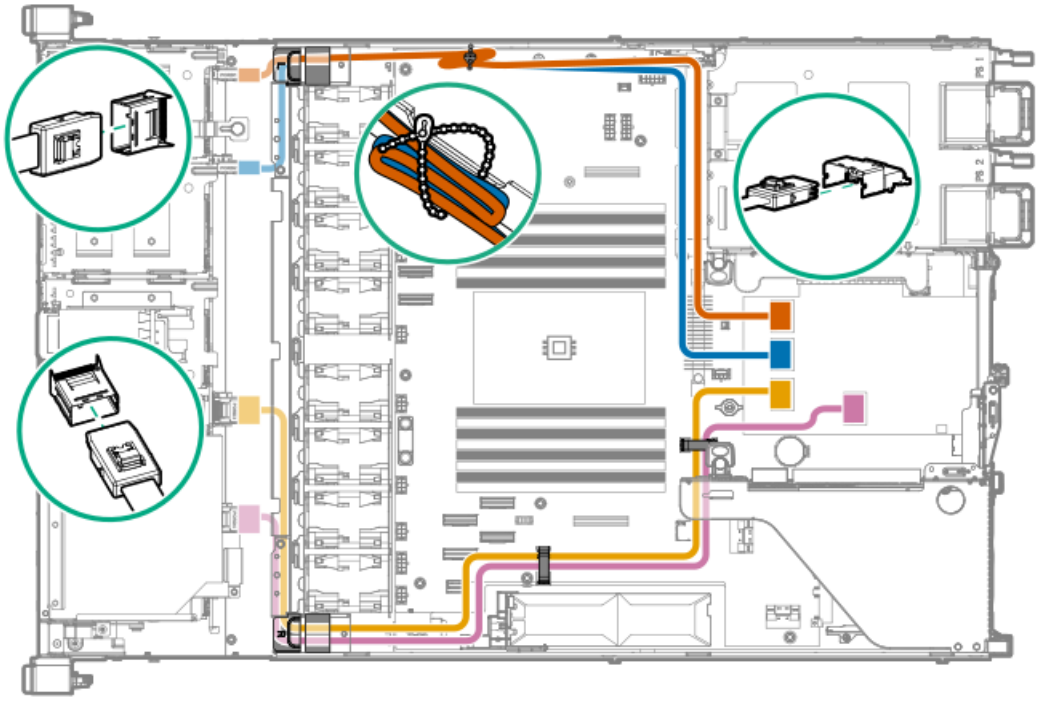
Use the cable tie that ships with cable kit to secure the cable on the side of the chassis wall.



Color	Description
Orange	Port 4 SlimSAS cable
Blue	Port 3 SlimSAS cable
Gold	Port 2 SlimSAS cable
Pink	Port 1 SlimSAS cable

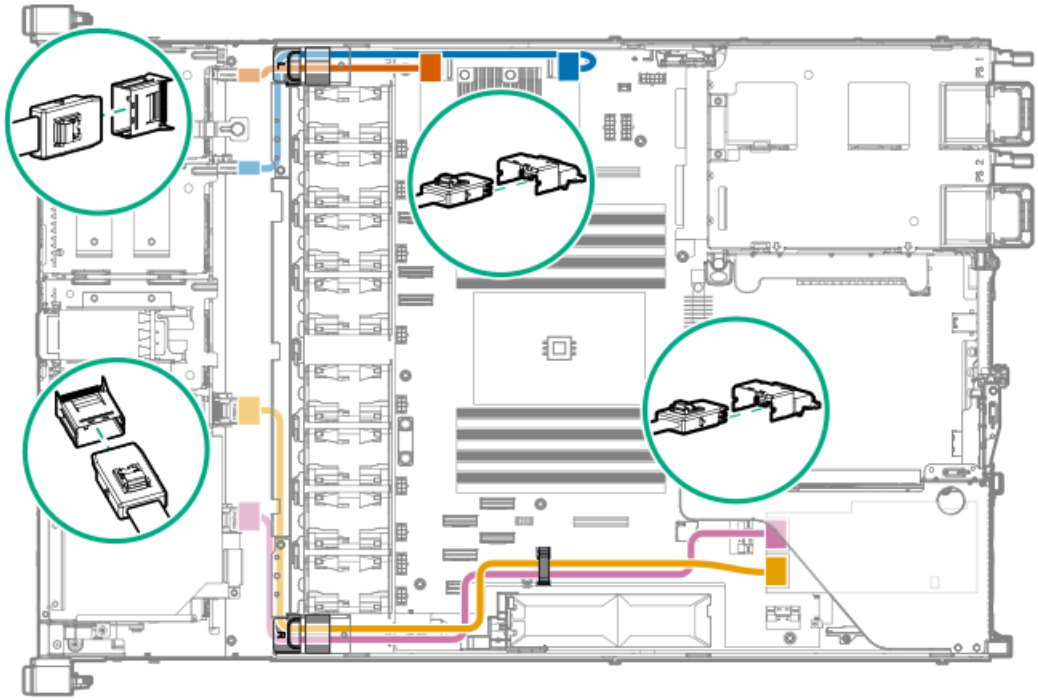
8 SFF drive: Type-p controller cabling from the secondary riser

Use the cable tie that ships with cable kit to secure the cable on the side of the chassis wall.



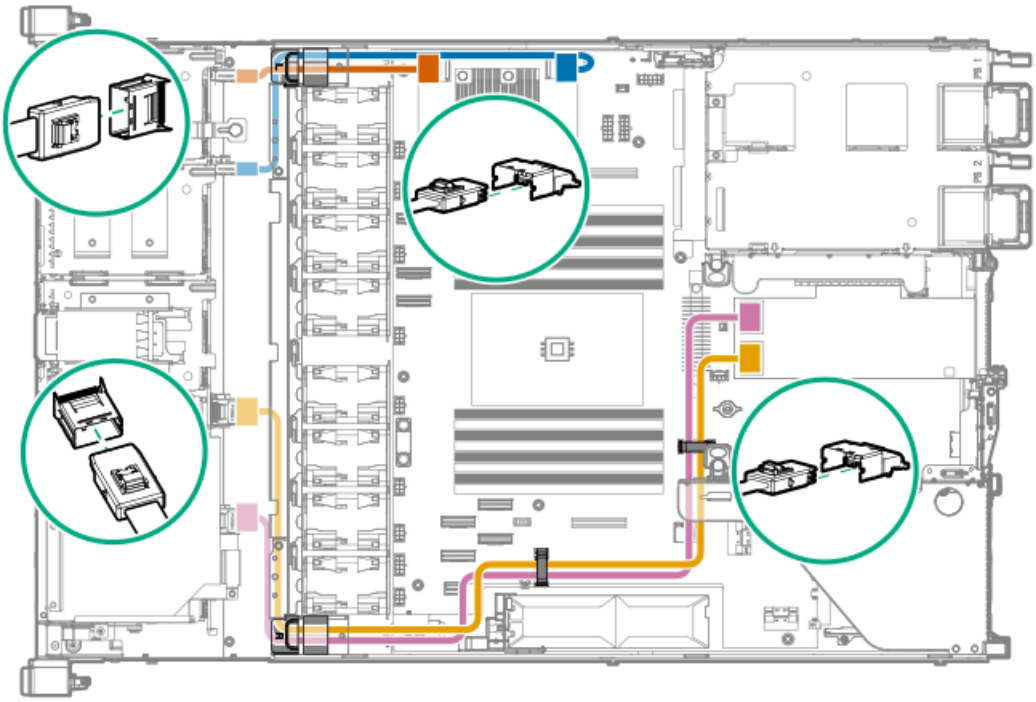
Color	Description
Orange	Port 4 SlimSAS cable
Blue	Port 3 SlimSAS cable
Gold	Port 2 SlimSAS cable
Pink	Port 1 SlimSAS cable

8 SFF drive: Type-a and type-p controller cabling from the primary riser



Color	Description
Orange	Type-a controller port 1 SlimSAS cable
Blue	Type-a controller port 2 SlimSAS cable
Gold	Type-p controller port 1 SlimSAS cable
Pink	Type-p controller port 2 SlimSAS cable

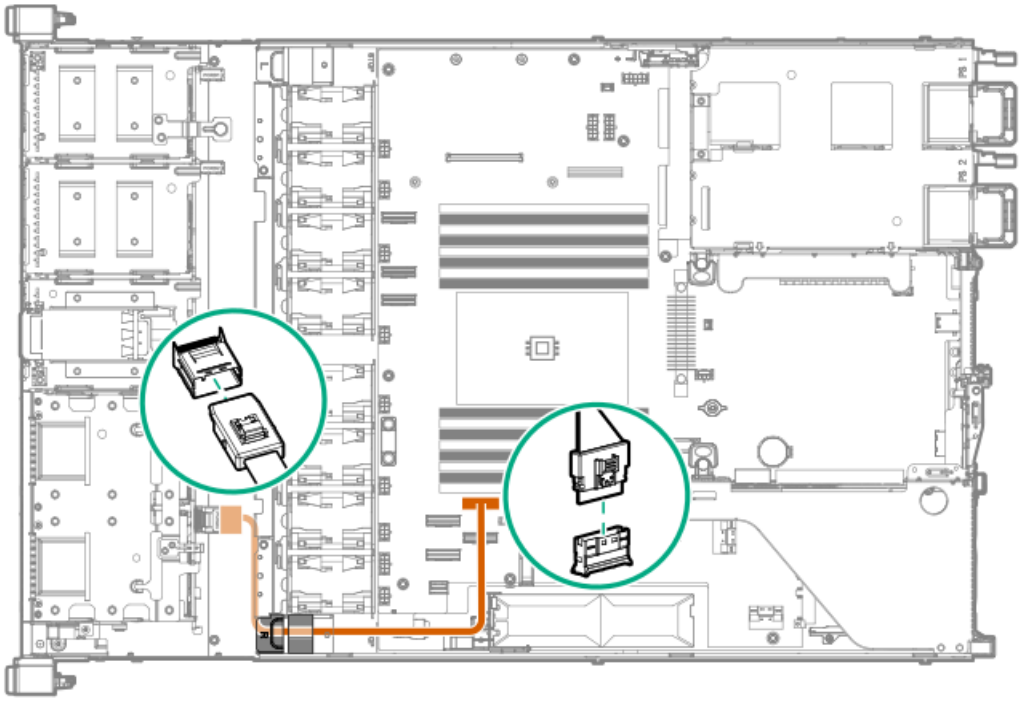
8 SFF drive: Type-a and type-p controller cabling from the secondary riser



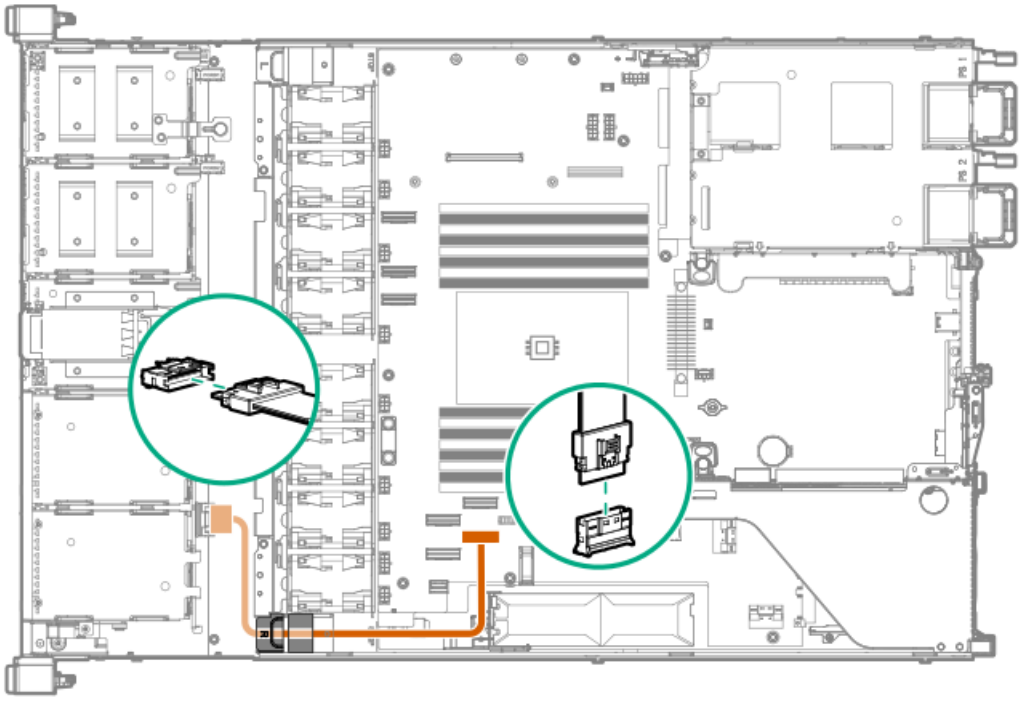
Color	Description
Orange	Type-a controller port 1 SlimSAS cable
Blue	Type-a controller port 2 SlimSAS cable
Gold	Type-p controller port 1 SlimSAS cable
Pink	Type-p controller port 2 SlimSAS cable

2 SFF NVMe drive controller cabling

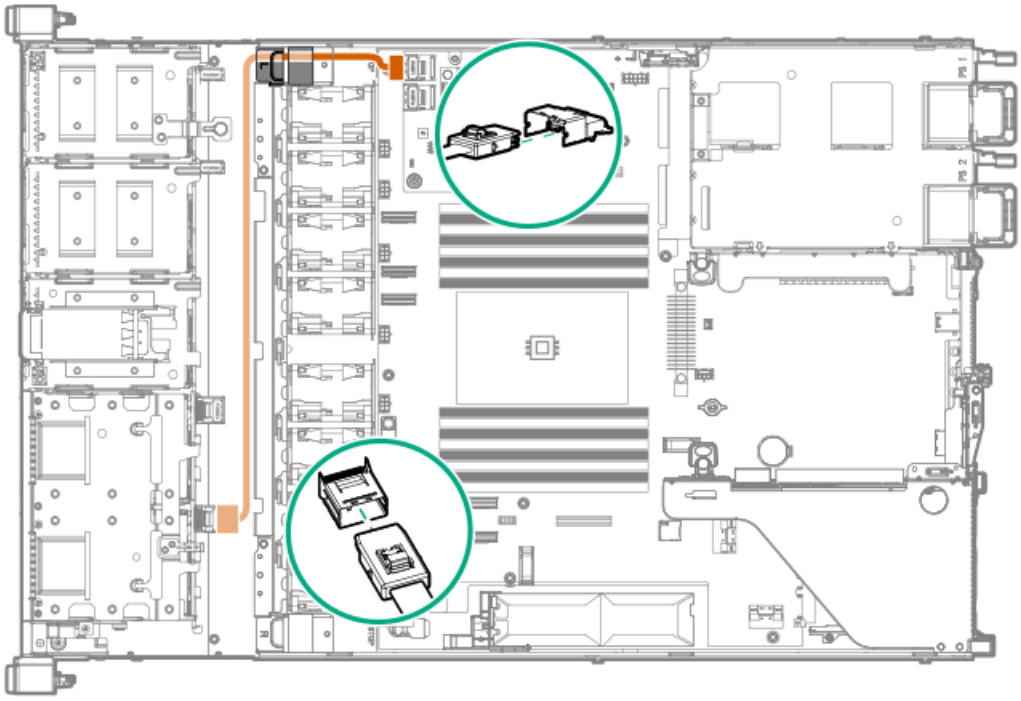
2 SFF drive: Onboard SATA cabling



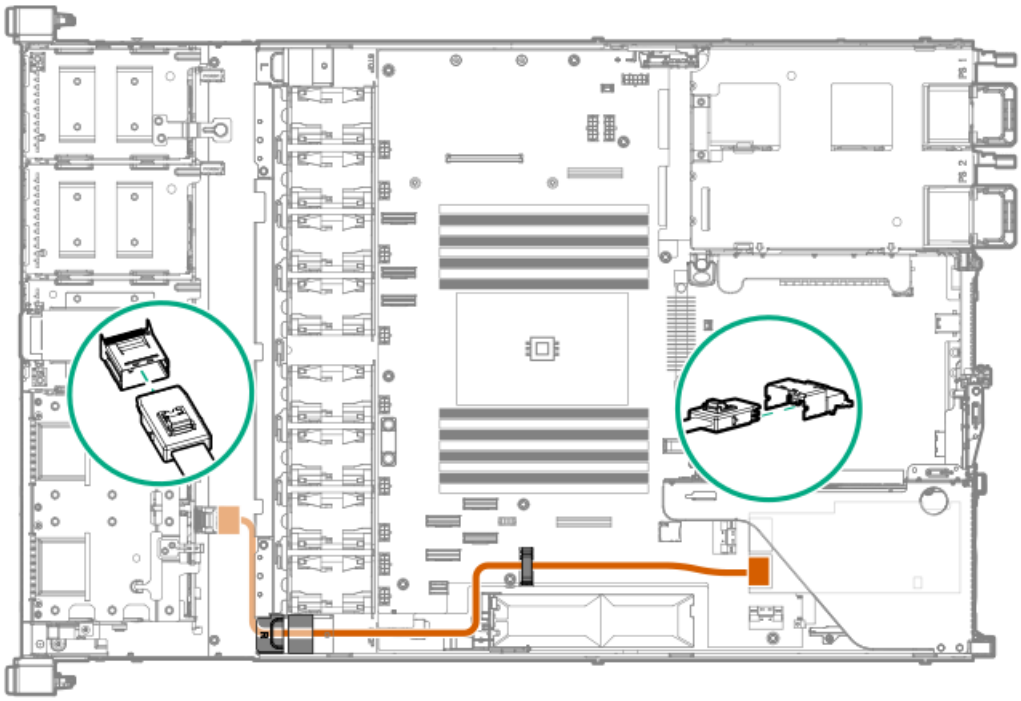
2 SFF drive: Onboard NVMe cabling



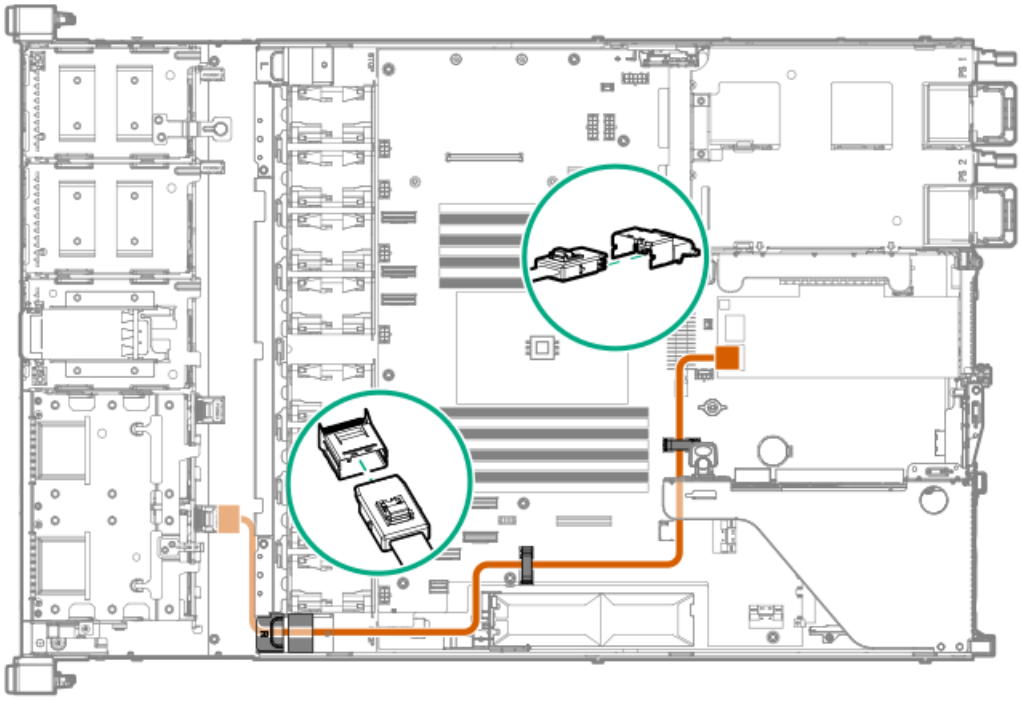
2 SFF drive: Type-a controller cabling



2 SFF drive: Type-p controller cabling from the primary riser



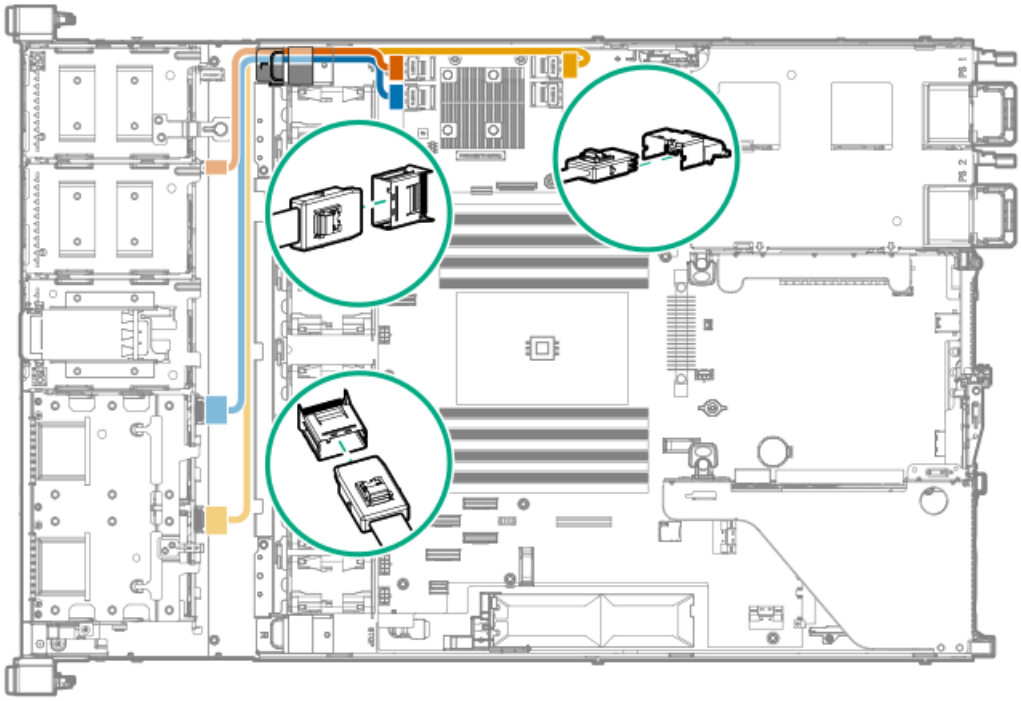
2 SFF drive: Type-p controller cabling from the secondary riser



8 + 2 SFF drive controller cabling

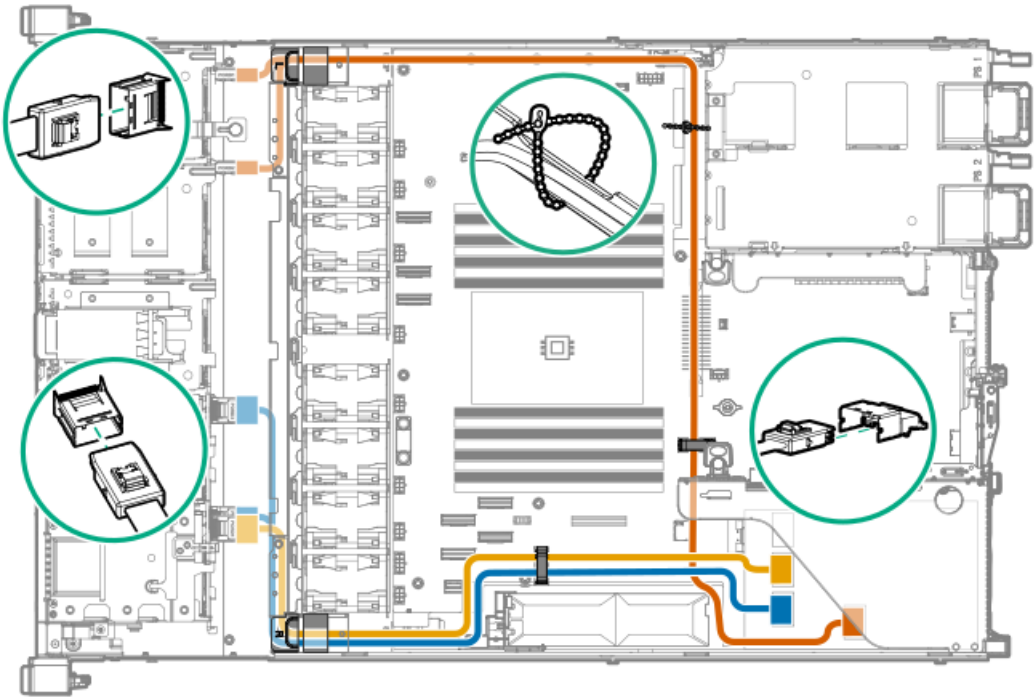
This drive configuration uses the 8 SFF SAS/SATA and 2 SFF U.2 or U.3 NVMe drive backplanes.

8 + 2 SFF drive: Type-a controller cabling



Color	Description
Orange	Port 1 SlimSAS cable
Blue	Port 2 SlimSAS cable
Gold	Port 3 SlimSAS cable

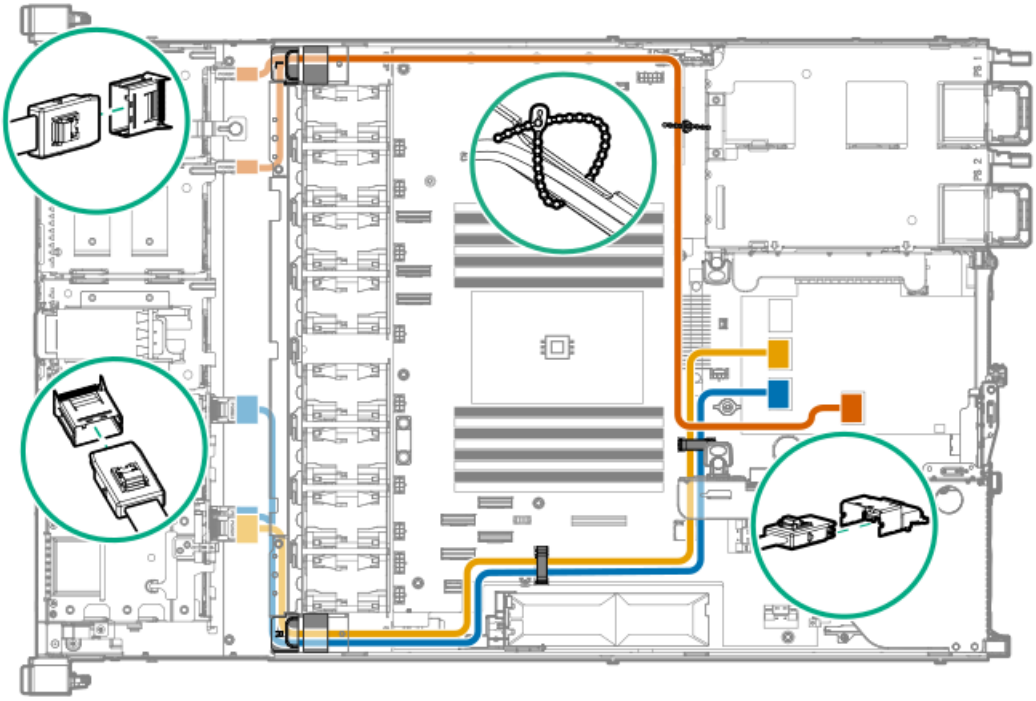
8 + 2 SFF drive: Type-p controller cabling from the primary riser



Color	Description
Orange	Port 1 SlimSAS Y-cable

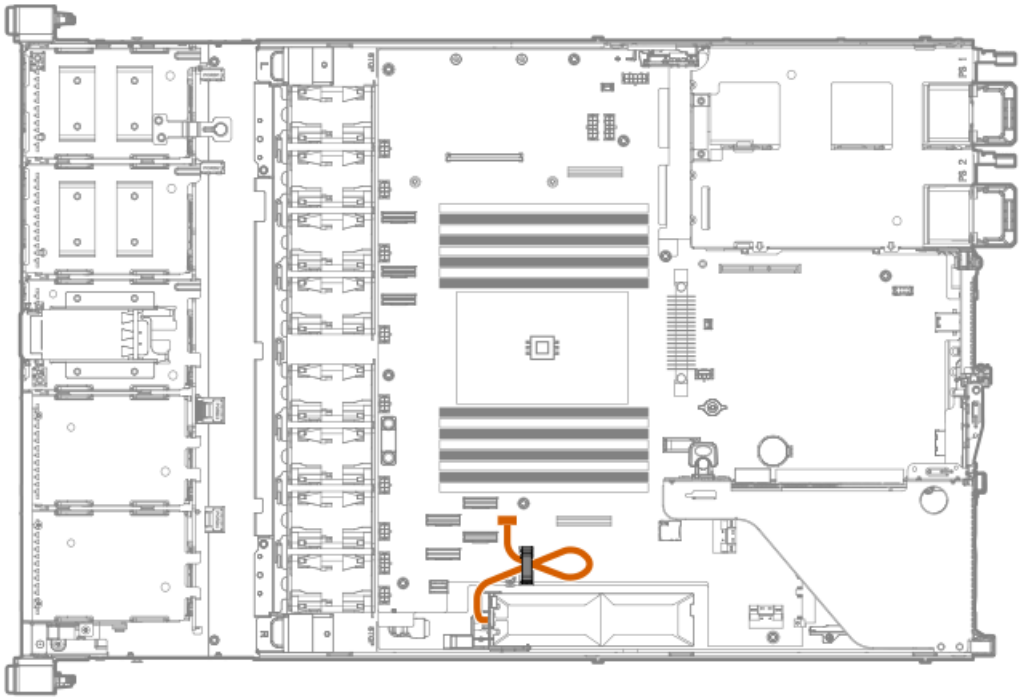
Color	Description
Blue	Port 2 SlimSAS Y-cable
Gold	Port 3 SlimSAS cable

8 + 2 SFF drive: Type-p controller cabling from the secondary riser



Color	Description
Orange	Port 1 SlimSAS Y-cable
Blue	Port 2 SlimSAS Y-cable
Gold	Port 3 SlimSAS cable

Energy pack cabling



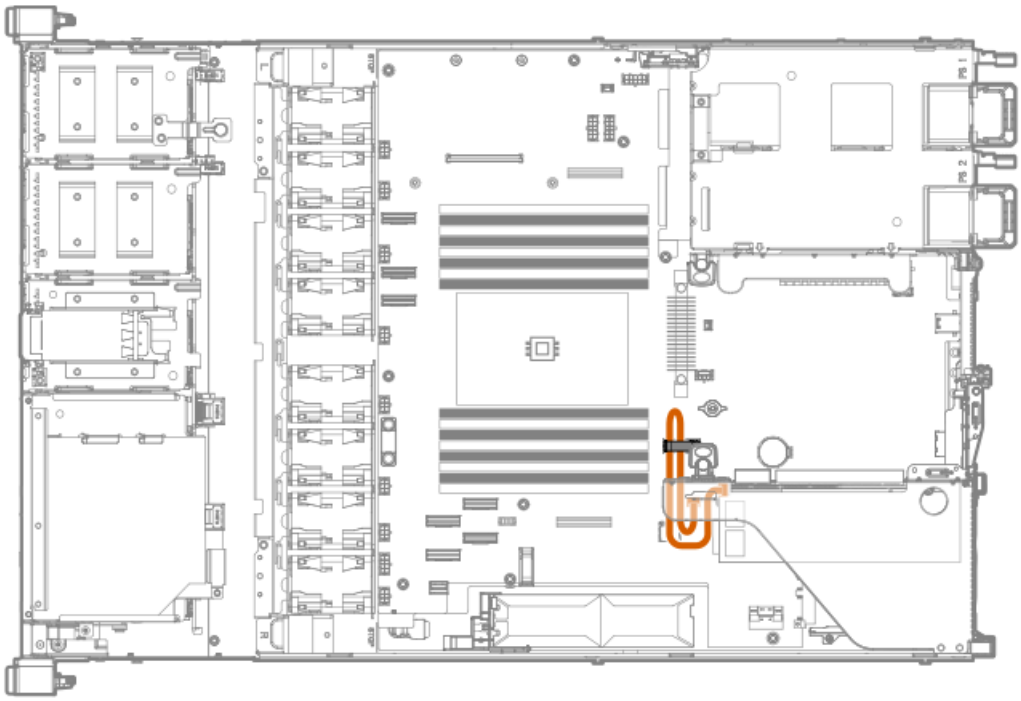
Storage controller backup power cabling

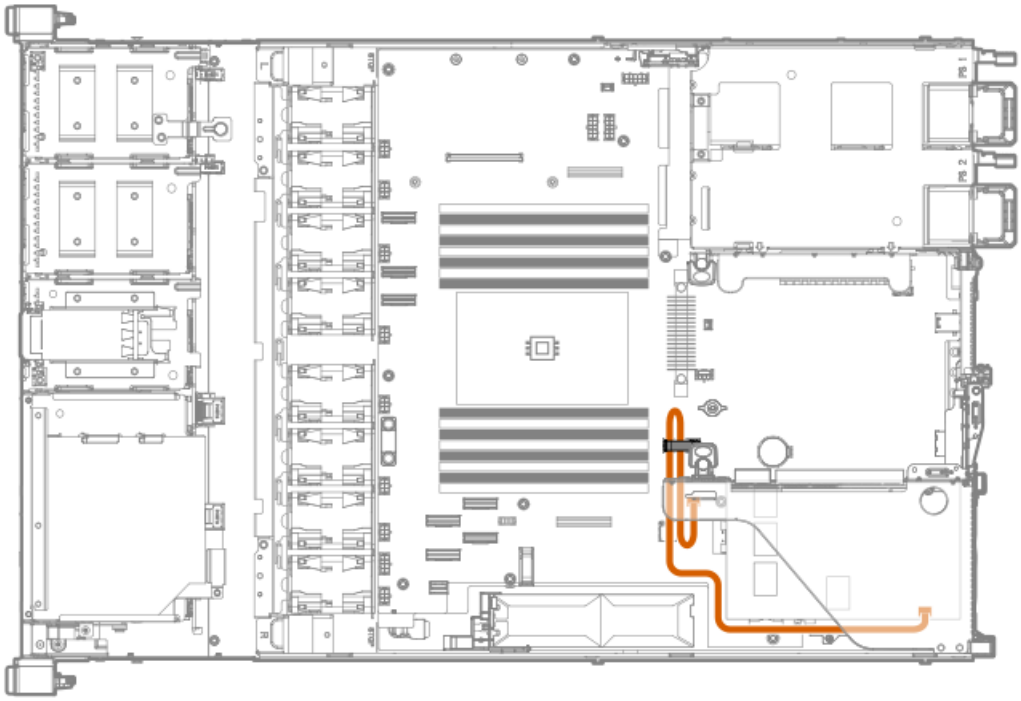
The exact route of the storage controller backup power cabling will depend on:

- The riser slot where the controller is installed
- The location of the storage controller backup power connector on the controller

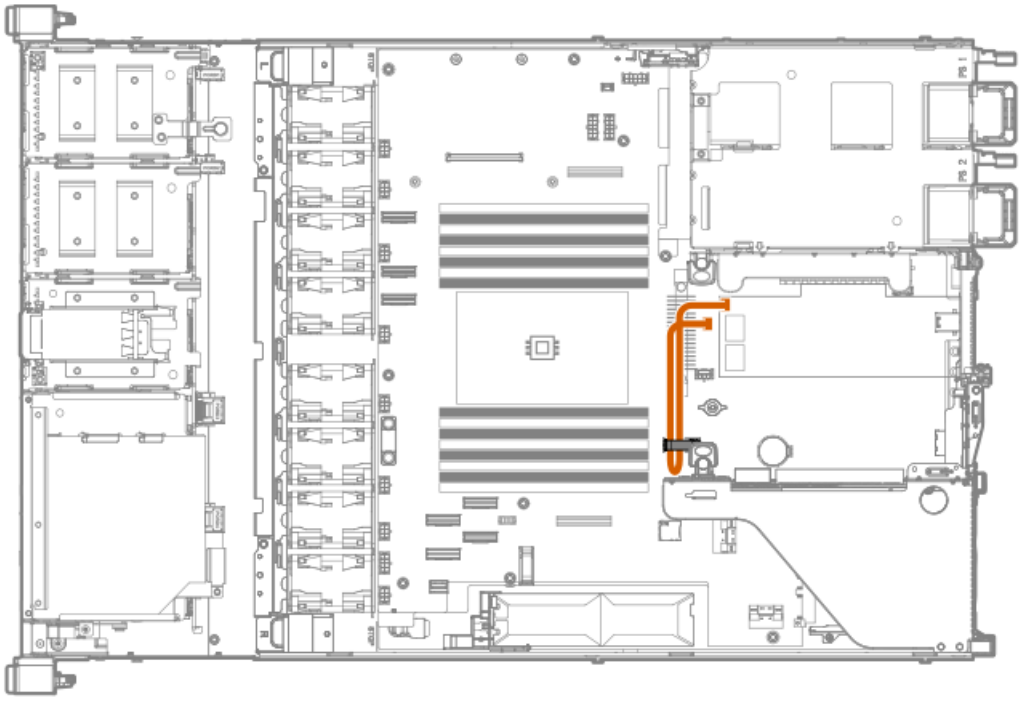
Use the following diagrams for reference only.

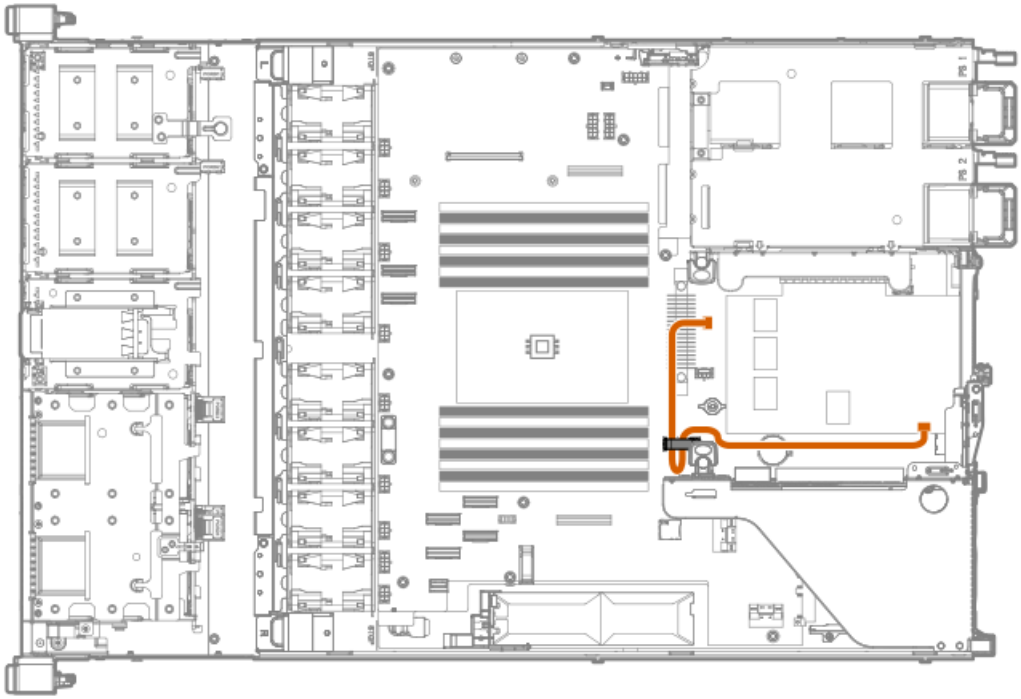
Storage controller backup power cabling from the primary riser





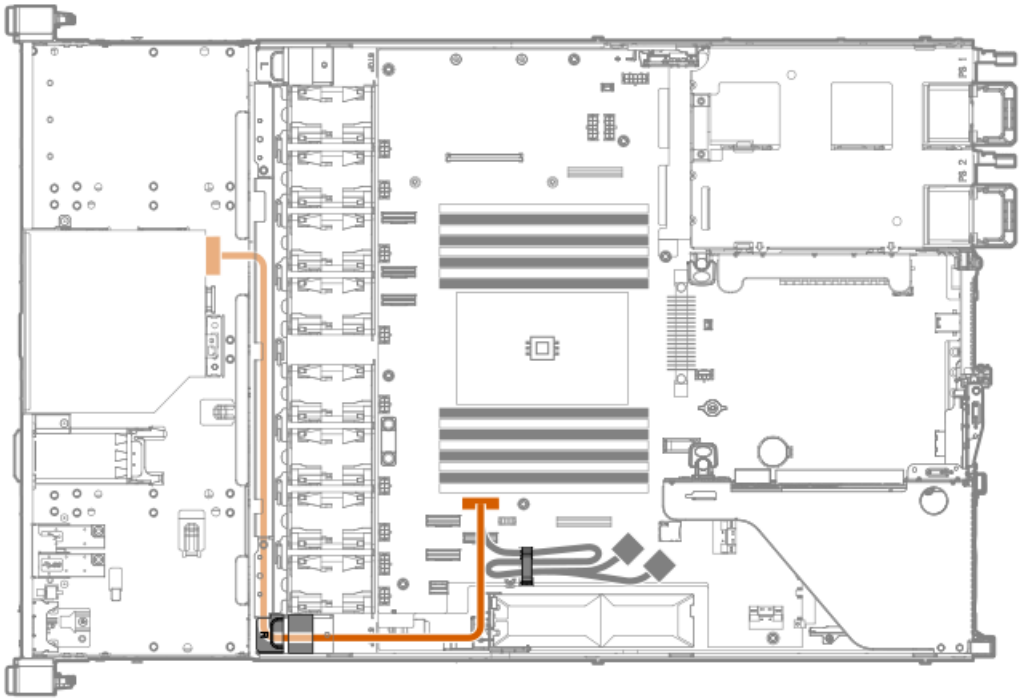
Storage controller backup power cabling from the secondary riser



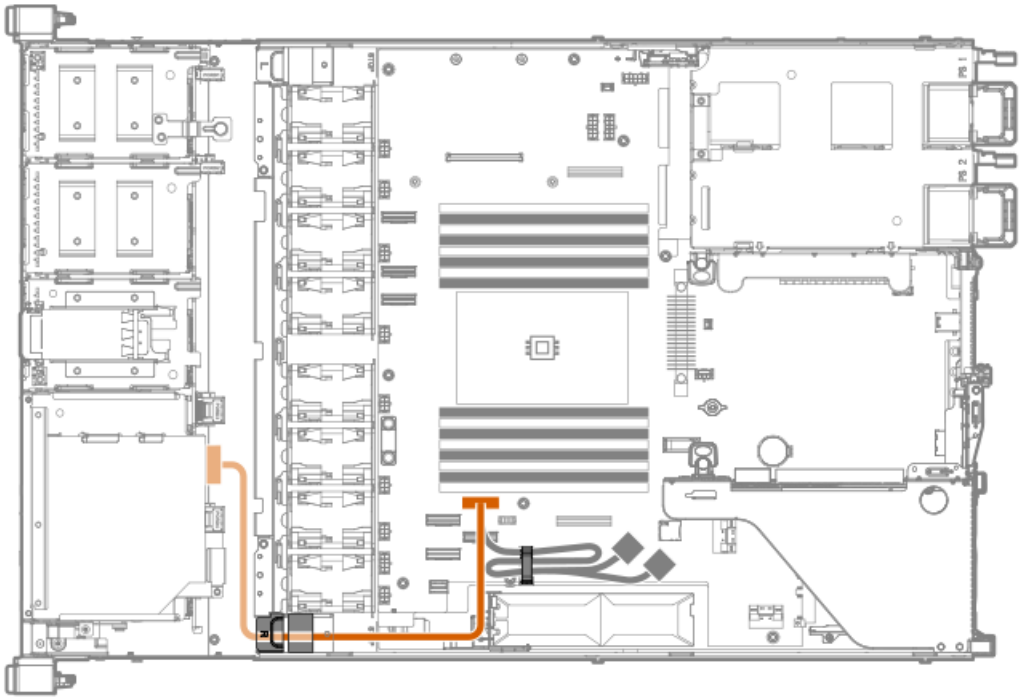


Optical drive cabling

Optical drive cabling in the LFF drive chassis

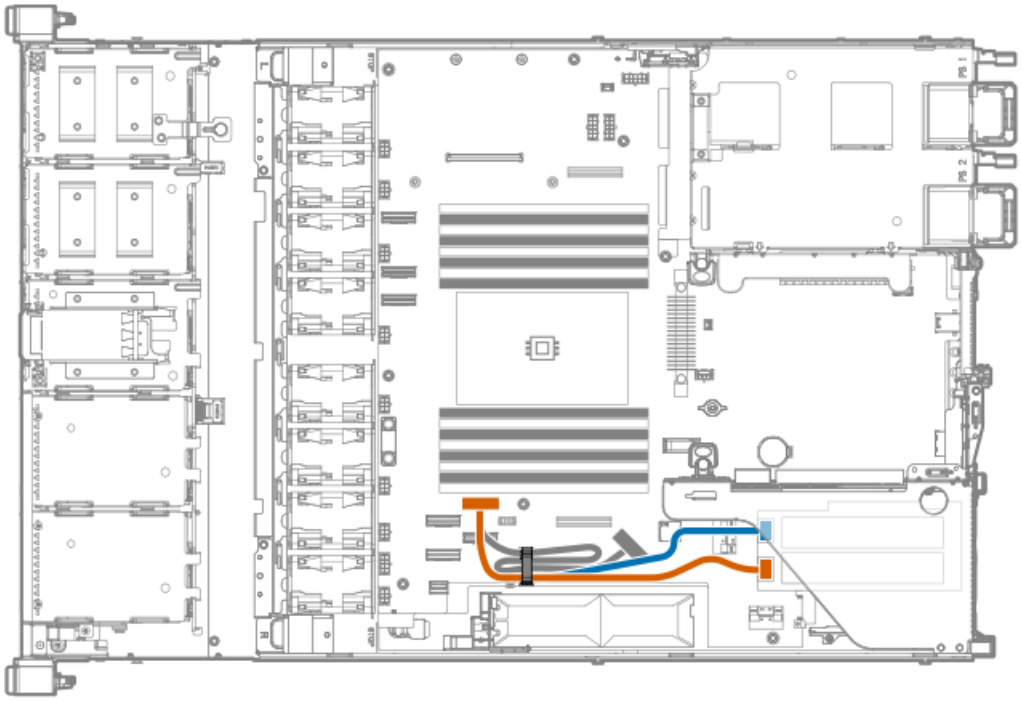


Optical drive cabling in the SFF drive chassis



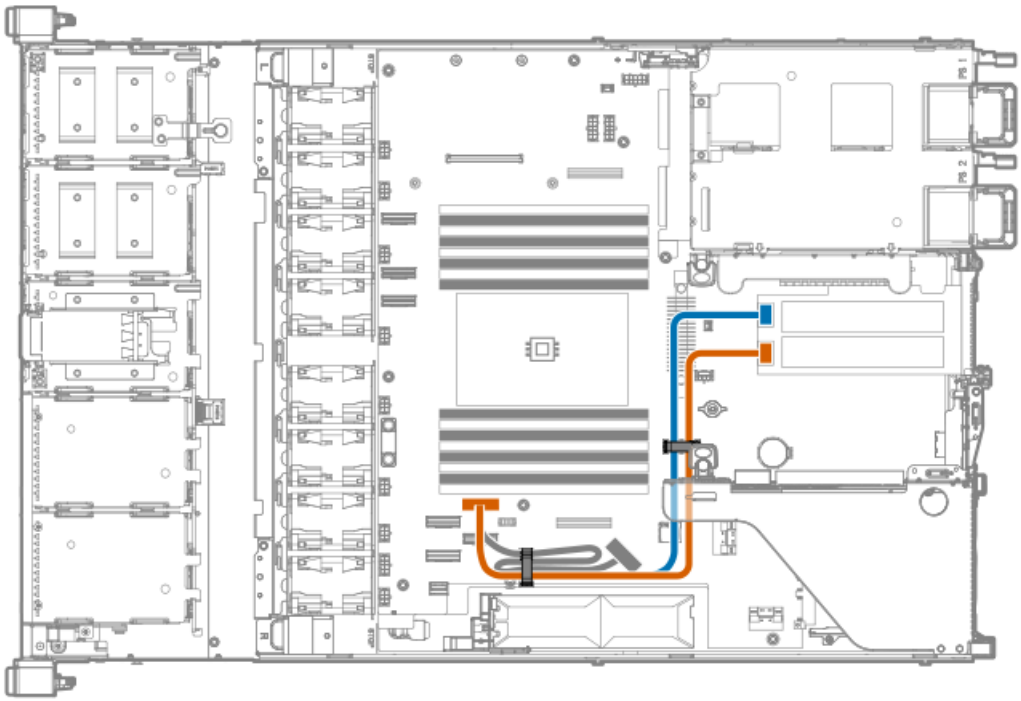
M.2 SATA SSD add-in card cabling

M.2 SATA SSD add-in card cabling from the primary riser



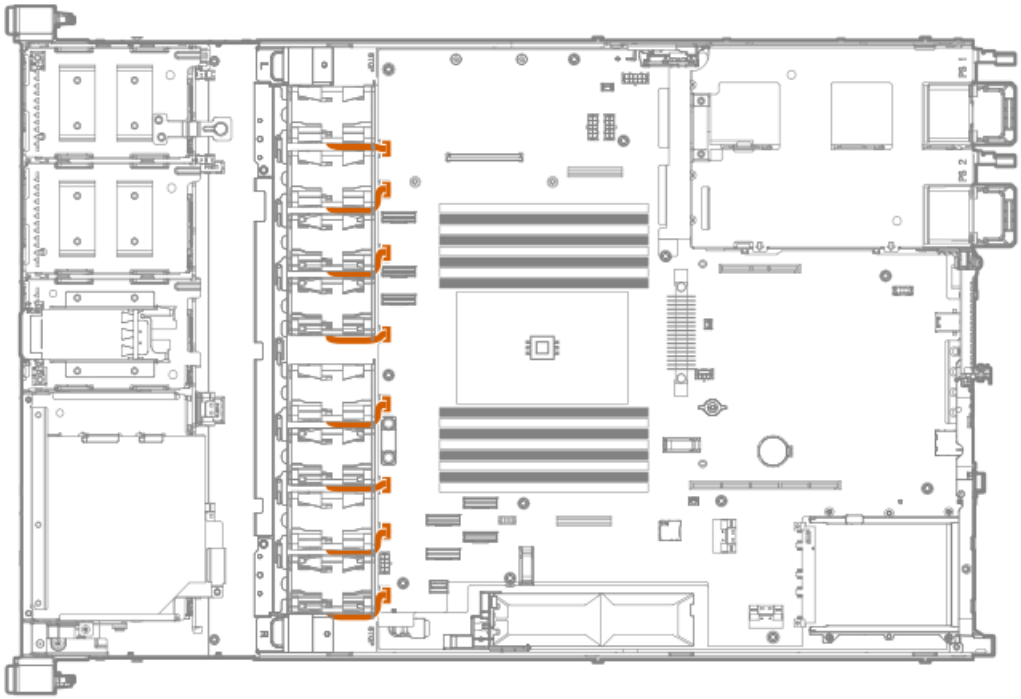
Color	Description
Orange	M.2 SATA SSD 1 cable
Blue	M.2 SATA SSD 2 cable

M.2 SATA SSD add-in card cabling from the secondary riser



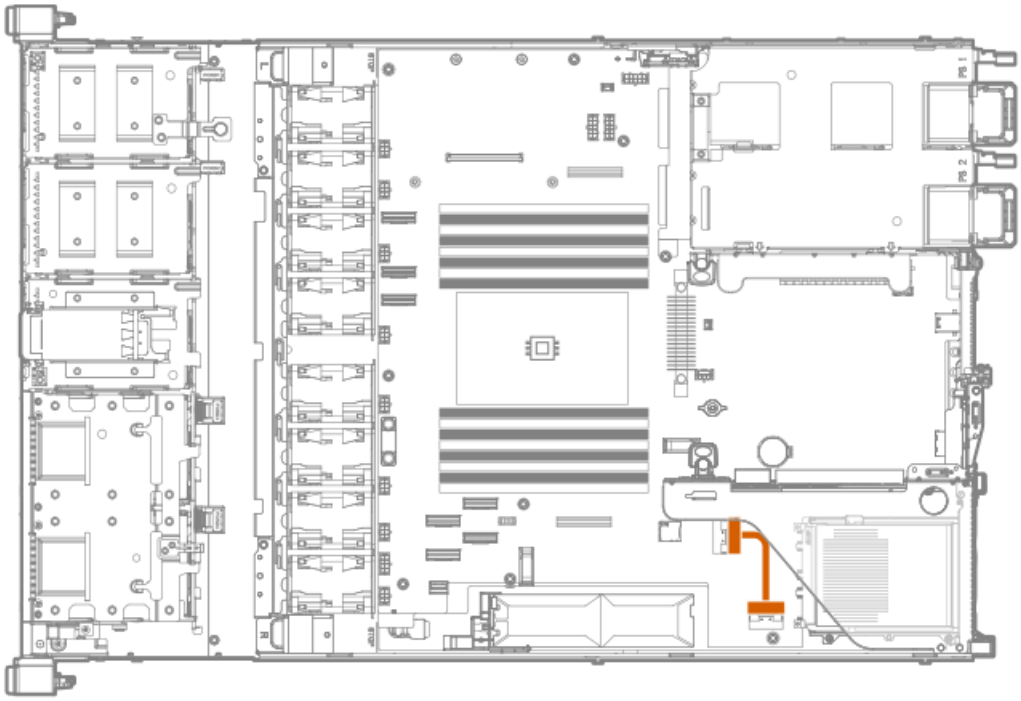
Color	Description
Orange	M.2 SATA SSD 1 cable
Blue	M.2 SATA SSD 2 cable

Fan cabling



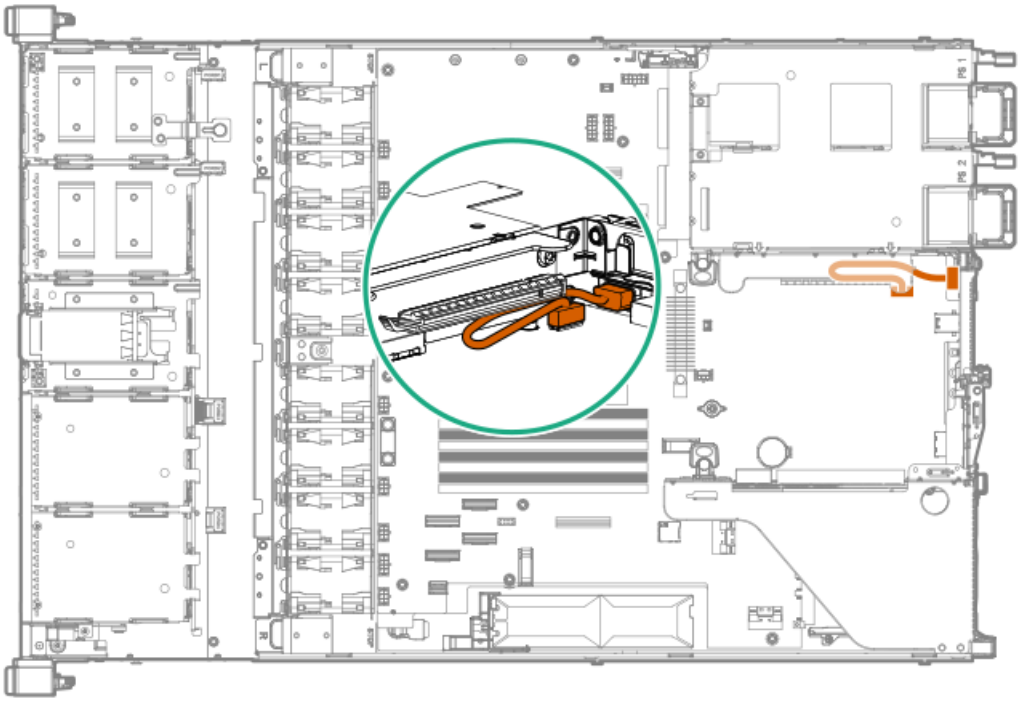
OCP bandwidth upgrade cabling

The OCP bandwidth upgrade cable is only required when installing an OCP NIC 3.0 x16 adapter.

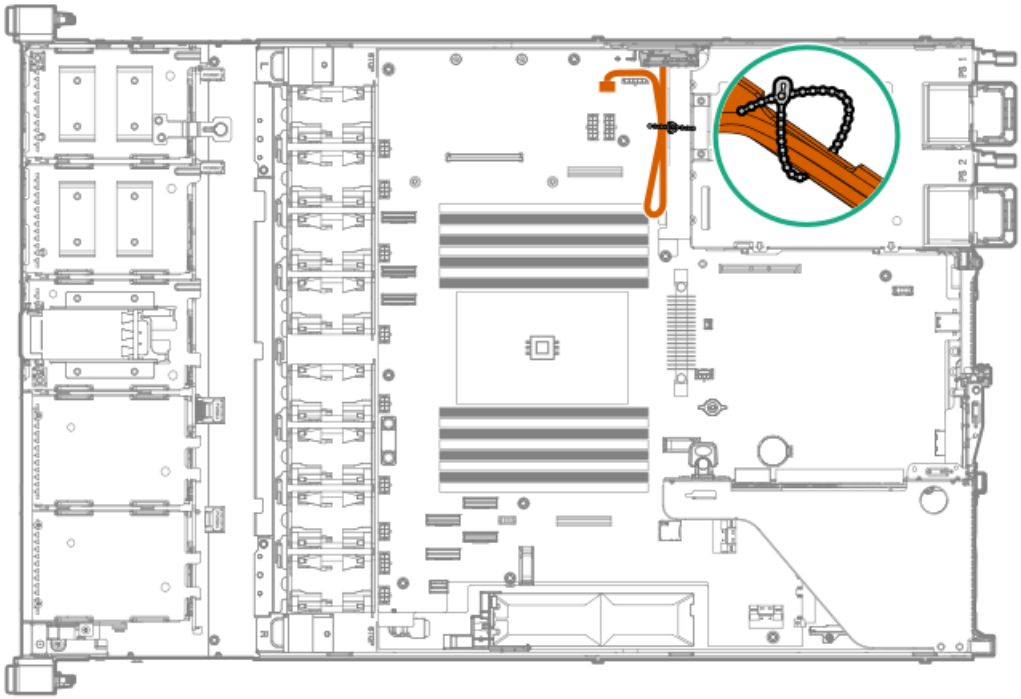


Serial port cabling

If the secondary riser cage is installed, position the serial port cable underneath the riser.

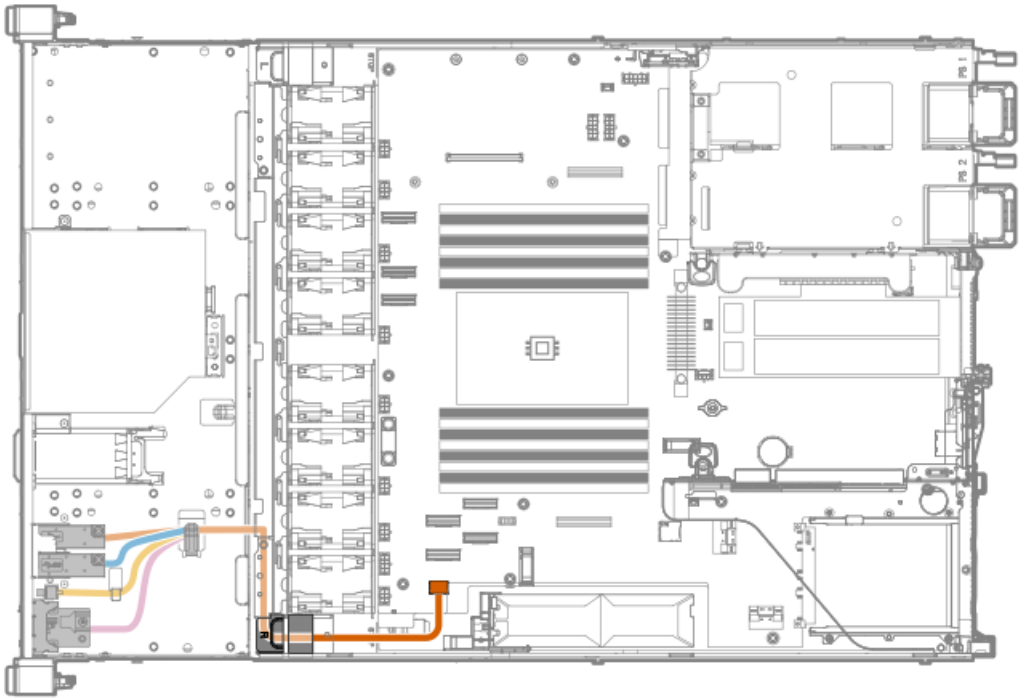


Chassis intrusion detection switch cabling



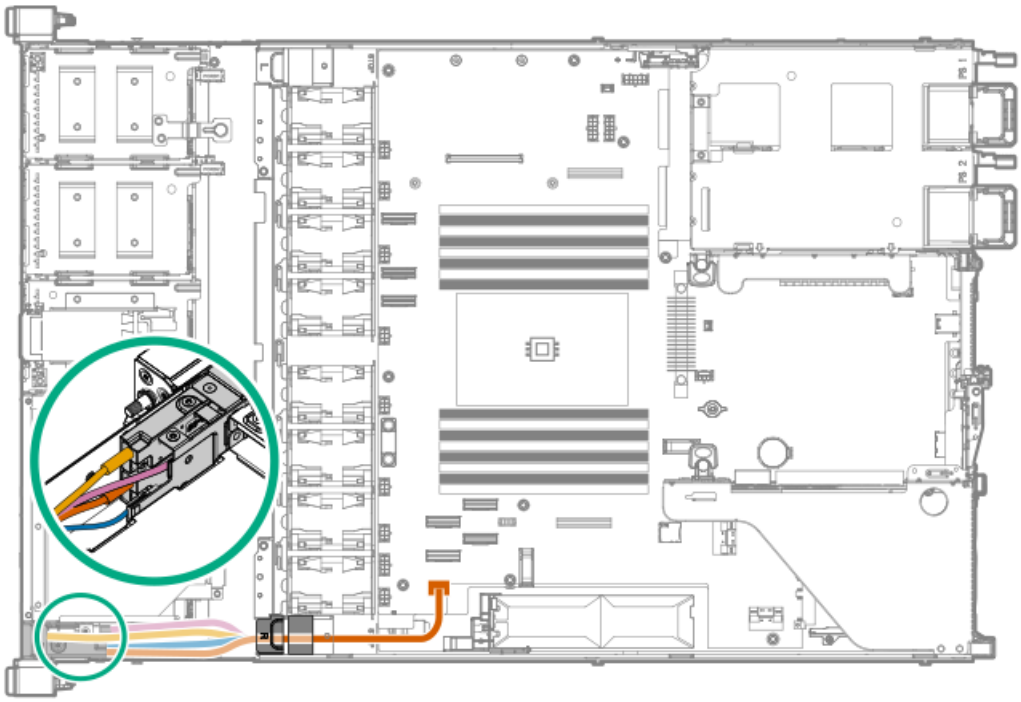
Front I/O cabling

Front I/O cabling in the LFF drive chassis



Color	Description
Orange	iLO service port cable
Blue	Ambient temperature sensor cable
Gold	USB 3.0 port cable
Pink	Front I/O LED/button cable

Front I/O cabling in the SFF drive chassis



Color	Description
Orange	USB 3.0 port cable

Color	Description
Pink	Front I/O LED/button cable
Gold	Ambient temperature sensor cable
Blue	iLO service port cable

Specifications

This chapter lists the technical specifications for the server, including:

- Environmental specifications
- Mechanical specifications
- Power supply specifications

Environmental specifications

Specifications	Value
Temperature range*	—
Operating	10°C to 35°C (50°F to 95°F)
Nonoperating	-30°C to 60°C (-22°F to 140°F)
Relative humidity (noncondensing)	—
Operating	8% to 90% 28°C (82.4°F) maximum wet bulb temperature, noncondensing
Nonoperating	5% to 95% 38.7°C (101.7°F) maximum wet bulb temperature, noncondensing
Altitude	—
Operating	3050 m (10,000 ft) This value may be limited by the type and number of options installed. Maximum allowable altitude change rate is 457 m/min (1,500 ft/min).
Nonoperating	9144 m (30,000 ft) Maximum allowable altitude change rate is 457 m/min (1,500 ft/min).

Standard operating support

10° to 35°C (50° to 95°F) at sea level with an altitude derating of 1.0°C per every 305 m (1.8°F per every 1,000 ft) above sea level to a maximum of 3,050 m (10,000 ft), no direct sustained sunlight. Maximum rate of change is 20°C/hr (36°F/hr). The upper limit and rate of change may be limited by the type and number of options installed.

System performance during standard operating support might be reduced if operating above 30°C (86°F).

Extended ambient operating support

For approved hardware configurations, the supported system inlet range is extended to be: 5° to 10°C (41° to 50°F) and 35° to 40°C (95° to 104°F) at sea level with an altitude derating of 1.0°C per every 175 m (1.8°F per every 574 ft) above 900 m (2,953 ft) to a maximum of 3050 m (10,000 ft). The approved hardware configurations for this system are listed at the **Hewlett Packard Enterprise website**.

40°C to 45°C (104°F to 113°F) at sea level with an altitude derating of 1.0°C per every 125 m (1.8°F per every 410 ft) above 900 m (2953 ft) to a maximum of 3,050 m (10,000 ft). The approved hardware configurations for this system are listed on the **Hewlett Packard Enterprise website**.

Mechanical specifications

Specification	Value
Dimensions	—
Height	4.29 cm (1.69 in)
Depth	64.43 cm (25.37 in)
Width	43.46 cm (17.11 in)
Weight, approximate values	—
Minimum	12.00 kg (26.46 lb)
Maximum	18.00 kg (39.68 lb)

Power supply specifications

Depending on the installed options and the regional location where the server was purchased, the server can be configured with one of the following power supplies:

- HPE 500 W Flex Slot Platinum Hot-plug Low Halogen Power Supply (94% efficiency)
- HPE 800 W Flex Slot Platinum Hot-plug Low Halogen Power Supply
- HPE 800 W Flex Slot Titanium Hot-plug Low Halogen Power Supply
- HPE 800 W Flex Slot Universal Hot-plug Low Halogen Power Supply
- HPE 800 W Flex Slot -48 VDC Hot-plug Low Halogen Power Supply
- HPE 1600 W Flex Slot Platinum Hot-plug Low Halogen Power Supply

For detailed power supply specifications, see the QuickSpecs on the **Hewlett Packard Enterprise website**.

HPE 500 W Flex Slot Platinum Hot-plug Low Halogen Power Supply (94% efficiency)

Specification	Value
Input requirements	—
Rated input voltage	100 VAC to 240 VAC 240 VDC for China only
Rated input frequency	50 Hz to 60 Hz Not applicable to 240 VDC
Rated input current	5.8 A at 100 VAC 2.8 A at 200 VAC 2.4 A at 240 VDC for China only
Maximum rated input power	580 W at 100 VAC 560 W at 200 VAC 558 W at 240 VDC for China only
BTUs per hour	1999 at 100 VAC 1912 at 200 VAC 1904 at 240 VDC for China only
Power supply output	—
Rated steady-state power	500 W at 100 VAC to 127 VAC input 500 W at 100 VAC to 240 VAC input 500 W at 240 VDC input for China only
Maximum peak power	500 W at 100 VAC to 127 VAC input 500 W at 100 VAC to 240 VAC input 500 W at 240 VDC input for China only

HPE 800 W Flex Slot Platinum Hot-plug Low Halogen Power Supply

Specification	Value
Input requirements	—
Rated input voltage	100 VAC to 127 VAC 200 VAC to 240 VAC 240 VDC for China only
Rated input frequency	50 Hz to 60 Hz Not applicable to 240 VDC
Rated input current	9.1 A at 100 VAC 4.4 A at 200 VAC 3.6 A at 240 VDC for China only
Maximum rated input power	899 W at 100 VAC 867 W at 200 VAC 864 W at 240 VDC for China only
BTUs per hour	3067 at 100 VAC 2958 at 200 VAC 2949 at 240 VAC for China only
Power supply output	—
Rated steady-state power	800 W at 100 VAC to 127 VAC input 800 W at 100 VAC to 240 VAC input 800 W at 240 VDC input for China only
Maximum peak power	800 W at 100 VAC to 127 VAC input 800 W at 100 VAC to 240 VAC input 800 W at 240 VDC input for China only

HPE 800 W Flex Slot Titanium Hot-plug Low Halogen Power Supply

Specification	Value
Input requirements	—
Rated input voltage	200 VAC to 240 VAC 240 VDC for China only
Rated input frequency	50 Hz to 60 Hz Not applicable to 240 VDC
Rated input current	4.3 A at 200 VAC 3.6 A at 240 VAC 3.6 A at 240 VDC for China only
Maximum rated input power	851 W at 200 VAC 848 W at 240 VAC 848 W at 240 VDC for China only
BTUs per hour	2905 at 200 VAC 2893 at 240 VAC 2893 at 240 VDC for China only
Power supply output	—
Rated steady-state power	800 W at 200 VAC to 240 VAC input 800 W at 240 VDC input for China only
Maximum peak power	800 W at 200 VAC to 240 VAC input 800 W at 240 VDC input for China only

HPE 800 W Flex Slot Universal Hot-plug Low Halogen Power Supply

Specification	Value
Input requirements	—
Rated input voltage	200 VAC to 277 VAC 380 VDC
Rated input frequency	50 Hz to 60 Hz
Rated input current	4.4 A at 200 VAC 3.8 A at 230 VAC 2.3 A at 380 VDC
Maximum rated input power	869 W at 200 VAC 865 W at 230 VAC 861 W at 277 VAC 863 W at 380 VDC
BTUs per hour	2964 at 200 VAC 2951 at 230 VAC 2936 at 277 VAC 2943 at 380 VDC
Power supply output	—
Rated steady-state power	800 W at 200 VAC to 277 VAC input
Maximum peak power	800 W at 200 VAC to 277 VAC input

HPE 800 W Flex Slot -48 VDC Hot-plug Low Halogen Power Supply

Specification	Value
Input requirements	—
Rated input voltage	-40 VDC to -72 VDC -48 VDC nominal input
Rated input current	22.1 A at -40 VDC input 18.2 A at -48 VDC input, nominal input 12.0 A at -72 VDC input
Rated input power	874 W at -40 VDC input 865 W at -48 VDC input, nominal input 854 W at -72 VDC input
Rated input power (BTUs per hour)	2983 at -40 VDC input 2951 at -48 VDC input, nominal input 2912 at -72 VDC input
Power supply output	—
Rated steady-state power	800 W at -40 VDC to -72 VDC
Maximum peak power	800 W at -40 VDC to -72 VDC
Maximum peak power	800 W at -40 VDC to -72 VDC input

⚠ **WARNING:** To reduce the risk of electric shock or energy hazards:

- This equipment must be installed by trained service personnel.
- Connect the equipment to a reliably grounded secondary circuit source. A secondary circuit has no direct connection to a primary circuit and derives its power from a transformer, converter, or equivalent isolation device.
- The branch circuit overcurrent protection must be rated 27 A.

⚠ **CAUTION:** This equipment is designed to permit the connection of the earthed conductor of the DC supply circuit to the earthing conductor at the equipment.

If this connection is made, all of the following must be met:

- This equipment must be connected directly to the DC supply system earthing electrode conductor or to a bonding jumper from an earthing terminal bar or bus to which the DC supply system earthing electrode conductor is connected.
- This equipment must be located in the same immediate area (such as adjacent cabinets) as any other equipment that has a connection between the earthed conductor of the same DC supply circuit and the earthing conductor, and also the point of earthing of the DC system. The DC system must be earthed elsewhere.
- The DC supply source is to be located within the same premises as the equipment.
- Switching or disconnecting devices must not be in the earthed circuit conductor between the DC source and the point of connection of the earthing electrode conductor.

HPE 1600 W Flex Slot Platinum Hot-plug Low Halogen Power Supply

Specification	Value
Input requirements	—
Rated input voltage	200 VAC to 240 VAC 240 VDC for China only
Rated input frequency	50 Hz to 60 Hz
Rated input current	8.7 A at 200 VAC 7.5 A at 230 VAC
Maximum rated input power	1734 W at 200 VAC 1727 W at 230 VAC
BTUs per hour	5918 at 200 VAC 5891 at 230 VAC
Power supply output	—
Rated steady-state power	1600 W at 200 VAC to 240 VAC input 1600 W at 240 VDC input
Maximum peak power	2200 W for 1 ms (turbo mode) at 200 VAC to 240 VAC input

Websites

General websites

Single Point of Connectivity Knowledge (SPOCK) Storage compatibility matrix

https://www.hpe.com/storage/spock

Storage white papers and analyst reports

https://www.hpe.com/storage/whitepapers

For additional websites, see Support and other resources.

Product websites

HPE ProLiant DL325 Gen10 Plus v2 Server product page

https://www.hpe.com/servers/dl325-gen10-plus-v2

HPE ProLiant DL325 Gen10 Plus v2 Server user documents

https://www.hpe.com/info/dl325gen10plusv2-docs

Support and other resources

- Accessing Hewlett Packard Enterprise Support
- Accessing updates
- Remote support
- Warranty information
- Regulatory information
- Documentation feedback

Accessing Hewlett Packard Enterprise Support

- For live assistance, go to the Contact Hewlett Packard Enterprise Worldwide website:

  https://www.hpe.com/info/assistance

- To access documentation and support services, go to the Hewlett Packard Enterprise Support Center website:

  https://www.hpe.com/support/hpesc

Information to collect

- Technical support registration number (if applicable)
- Product name, model or version, and serial number
- Operating system name and version
- Firmware version
- Error messages
- Product-specific reports and logs
- Add-on products or components
- Third-party products or components

Accessing updates

- Some software products provide a mechanism for accessing software updates through the product interface. Review your product documentation to identify the recommended software update method.
- To download product updates:

  Hewlett Packard Enterprise Support Center

  https://www.hpe.com/support/hpesc

  Hewlett Packard Enterprise Support Center: Software downloads

  https://www.hpe.com/support/downloads

  My HPE Software Center

  https://www.hpe.com/software/hpesoftwarecenter
- To subscribe to eNewsletters and alerts:

  https://www.hpe.com/support/e-updates
- To view and update your entitlements, and to link your contracts and warranties with your profile, go to the Hewlett Packard Enterprise Support Center More Information on Access to Support Materials page:

  https://www.hpe.com/support/AccessToSupportMaterials

IMPORTANT:

Access to some updates might require product entitlement when accessed through the Hewlett Packard Enterprise Support Center. You must have an HPE Passport set up with relevant entitlements.

Remote support

Remote support is available with supported devices as part of your warranty or contractual support agreement. It provides intelligent event diagnosis, and automatic, secure submission of hardware event notifications to Hewlett Packard Enterprise, which initiates a fast and accurate resolution based on the service level of your product. Hewlett Packard Enterprise strongly recommends that you register your device for remote support.

If your product includes additional remote support details, use search to locate that information.

HPE Get Connected

https://www.hpe.com/services/getconnected

HPE Pointnext Tech Care

https://www.hpe.com/services/techcare

HPE Complete Care

https://www.hpe.com/services/completecare

Warranty information

To view the warranty information for your product, see the links provided below:

HPE ProLiant and IA-32 Servers and Options

https://www.hpe.com/support/ProLiantServers-Warranties

HPE Enterprise and Cloudline Servers

https://www.hpe.com/support/EnterpriseServers-Warranties

HPE Storage Products

https://www.hpe.com/support/Storage-Warranties

HPE Networking Products

https://www.hpe.com/support/Networking-Warranties

Regulatory information

To view the regulatory information for your product, view the Safety and Compliance Information for Server, Storage, Power, Networking, and Rack Products, available at the Hewlett Packard Enterprise Support Center:

https://www.hpe.com/support/Safety-Compliance-EnterpriseProducts

Additional regulatory information

Hewlett Packard Enterprise is committed to providing our customers with information about the chemical substances in our products as needed to comply with legal requirements such as REACH (Regulation EC No 1907/2006 of the European Parliament and the Council). A chemical information report for this product can be found at:

https://www.hpe.com/info/reach

For Hewlett Packard Enterprise product environmental and safety information and compliance data, including RoHS and REACH, see:

https://www.hpe.com/info/ecodata

For Hewlett Packard Enterprise environmental information, including company programs, product recycling, and energy efficiency, see:

https://www.hpe.com/info/environment

Documentation feedback

Hewlett Packard Enterprise is committed to providing documentation that meets your needs. To help us improve the documentation, use the Feedback button and icons (located at the bottom of an opened document) on the Hewlett Packard Enterprise Support Center portal (**https://www.hpe.com/support/hpesc**) to send any errors, suggestions, or comments. All document information is captured by the process.